

PIC18F45J10 Family Data Sheet

28/40/44-Pin High-Performance, RISC Microcontrollers with nanoWatt Technology

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28/40/44-Pin High-Performance, RISC Microcontrollers with nanoWatt Technology

Special Microcontroller Features:

- Operating voltage range: 2.0V to 3.6V
- 5.5V tolerant input (digital pins only)
- · On-chip 2.5V regulator
- · Low-power, high-speed CMOS Flash technology
- C compiler optimized architecture:
 - Optional extended instruction set designed to optimize re-entrant code
- · Priority levels for interrupts
- 8 x 8 Single-Cycle Hardware Multiplier
- Extended Watchdog Timer (WDT):
 - Programmable period from 4 ms to 131s
- Single-Supply In-Circuit Serial Programming[™] (ICSP[™]) via two pins
- In-Circuit Debug (ICD) with three Break points via two pins
- · Power-Managed modes:
 - Run: CPU on, peripherals on
 - Idle: CPU off, peripherals on
 - Sleep: CPU off, peripherals off

Flexible Oscillator Structure:

- Two Crystal modes, up to 40 MHz
- Two External Clock modes, up to 40 MHz
- Internal 31 kHz oscillator
- Secondary oscillator using Timer1 @ 32 kHz
- · Two-Speed Oscillator Start-up
- Fail-Safe Clock Monitor:
 - Allows for safe shutdown if peripheral clock stops

Peripheral Highlights:

- High-current sink/source 25 mA/25 mA (PORTB and PORTC)
- Three programmable external interrupts
- · Four input change interrupts
- · One Capture/Compare/PWM (CCP) module
- One Enhanced Capture/Compare/PWM (ECCP) module:
 - One, two or four PWM outputs
 - Selectable polarity
 - Programmable dead time
 - Auto-Shutdown and Auto-Restart
- Two Master Synchronous Serial Port (MSSP) modules supporting 3-wire SPI™ (all 4 modes) and I²C™ Master and Slave modes
- One Enhanced Addressable USART module:
 - Supports RS-485, RS-232 and LIN 1.2
 - Auto-Wake-up on Start bit
 - Auto-Baud Detect
- 10-bit, up to 13-channel Analog-to-Digital Converter module (A/D):
 - Auto-acquisition capability
 - Conversion available during Sleep
 - Self-calibration feature
- Dual analog comparators with input multiplexing

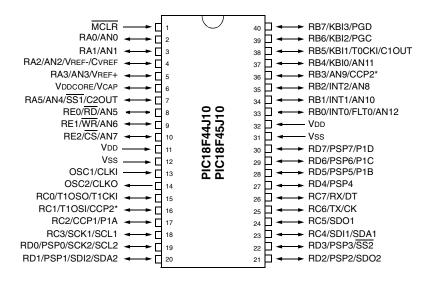
	Prog	ram Memory						MSSI	•	RT	ators	
Device	Flash (bytes)	# Single-Word Instructions	SRAM Data Memory (bytes)	I/O	10-bit A/D (ch)	CCP/ ECCP (PWM)		SPI™	Master I ² C™	EUSAR	Comparat	Timers 8/16-bit
PIC18F24J10	16K	8192	1024	21	10	2/0	1	Υ	Υ	1	2	1/2
PIC18F25J10	32K	16384	1024	21	10	2/0	1	Υ	Υ	1	2	1/2
PIC18F44J10	16K	8192	1024	32	13	1/1	2	Υ	Υ	1	2	1/2
PIC18F45J10	32K	16384	1024	32	13	1/1	2	Υ	Υ	1	2	1/2

Pin Diagrams

28-Pin SPDIP, SOIC, SSOP (300 MIL) ➤ RB7/KBI3/PGD MCLR 27 RA0/AN0 RB6/KBI2/PGC 26 RB5/KBI1/T0CKI/C1OUT RA1/AN1 → RB4/KBI0/AN11 RA2/AN2/VREF-/CVREF PIC18F24J10 PIC18F25J10 → RB3/AN9/CCP2* RA3/AN3/VREF+ [◄] 23 ☐ ←► RB2/INT2/AN8 VDDCORE/VCAP ☐ ← RB1/INT1/AN10 22 RA5/AN4/SS1/C2OUT 21 → RB0/INT0/FLT0/AN12 20 ☐ ← VDD OSC1/CLKI OSC2/CLKO ◀ RC0/T1OSO/T1CKI ◀ → RC6/TX/CK 17 RC1/T1OSI/CCP2* ◄ 16 → RC5/SDO1 RC2/CCP1 RC4/SDI1/SDA1 RC3/SCK1/SCL1 * Pin feature is dependent on device configuration. 28-Pin QFN RB6/KBI2/PGC RB5/KBI1/T0CKI/C1OUT 28272625242322 RA2/AN2/VREF-/CVREF → RB3/AN9/CCP2* RA3/AN3/VREF+ → RB2/INT2/AN8 2 20 VDDCORE/VCAP PIC18F24J10 ➤ RB1/INT1/AN10 RA5/AN4/SS1/C2OUT RB0/INT0/FLT0/AN12 18 PIC18F25J10 Vss 5 17 ✓ VDD OSC1/CLKI 16 Vss OSC2/CLKO RC7/RX/DT 15 8 9 10 11 12 13 14 RC0/T10SO/T1CKI A RC1/T10SI/CCP2* A RC2/CCP1 A RC3/SCK1/SCL1 A RC4/SD11/SDA1 A RC5/SD01 A RC6/TX/CK A * Pin feature is dependent on device configuration.

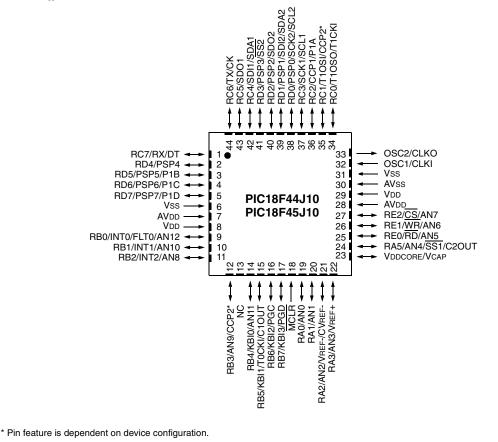
Pin Diagrams (Continued)

40-Pin PDIP (600 MIL)



^{*} Pin feature is dependent on device configuration.

44-Pin QFN



Pin Diagrams (Continued)

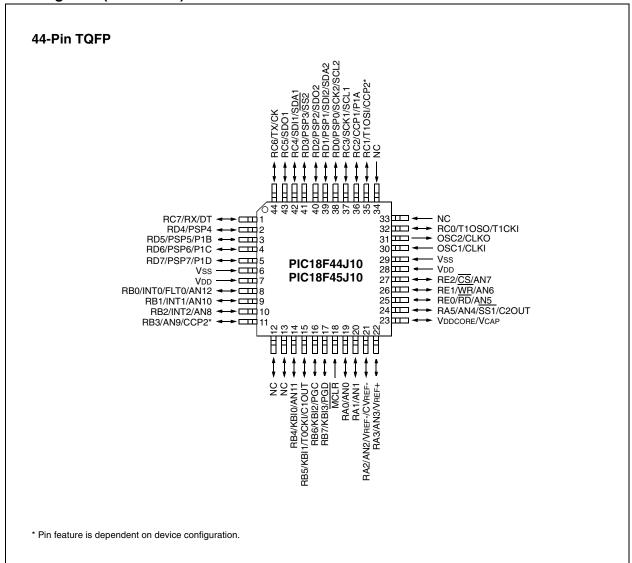


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1.0 DEVICE OVERVIEW

This document contains device specific information for the following devices:

- PIC18F24J10
- PIC18LF24J10
- PIC18F25J10
- PIC18LF25J10
- PIC18F44J10
- PIC18LF44J10
- PIC18F45J10
- PIC18LF45J10

This family offers the advantages of all PIC18 microcontrollers – namely, high computational performance at an economical price. The PIC18F45J10 family introduces design enhancements that make these microcontrollers a logical choice for many high-performance, power sensitive applications.

1.1 New Core Features

1.1.1 nanoWatt TECHNOLOGY

All of the devices in the PIC18F45J10 family incorporate a range of features that can significantly reduce power consumption during operation. Key items include:

- Alternate Run Modes: By clocking the controller from the Timer1 source or the internal oscillator block, power consumption during code execution can be reduced by as much as 90%.
- Multiple Idle Modes: The controller can also run
 with its CPU core disabled but the peripherals still
 active. In these states, power consumption can be
 reduced even further, to as little as 4% of normal
 operation requirements.
- On-the-fly Mode Switching: The power-managed modes are invoked by user code during operation, allowing the user to incorporate power-saving ideas into their application's software design.
- Low Consumption in Key Modules: The power requirements for both Timer1 and the Watchdog Timer are minimized. See Section 23.0 "Electrical Characteristics" for values.

1.1.2 MULTIPLE OSCILLATOR OPTIONS AND FEATURES

All of the devices in the PIC18F45J10 family offer three different oscillator options. These include:

- One Crystal mode, using crystals or ceramic resonators
- · One External Clock mode
- INTRC source (approximately 31 kHz)

Besides its availability as a clock source, the internal oscillator block provides a stable reference source that gives the family additional features for robust operation:

- Fail-Safe Clock Monitor: This option constantly
 monitors the main clock source against a reference signal provided by the internal oscillator. If a
 clock failure occurs, the controller is switched to
 the internal oscillator block, allowing for continued
 low-speed operation or a safe application
 shutdown.
- Two-Speed Start-up: This option allows the internal oscillator to serve as the clock source from Power-on Reset, or wake-up from Sleep mode, until the primary clock source is available.

1.2 Other Special Features

- Communications: The PIC18F45J10 family incorporates a range of serial communication peripherals, including 1 independent Enhanced USART and 2 Master SSP modules capable of both SPI and I²C (Master and Slave) modes of operation. Also, one of the general purpose I/O ports can be reconfigured as an 8-bit Parallel Slave Port for direct processor-to-processor communications.
- Self-programmability: These devices can write to their own program memory spaces under internal software control. By using a bootloader routine, it becomes possible to create an application that can update itself in the field.
- Extended Instruction Set: The PIC18F45J10 family introduces an optional extension to the PIC18 instruction set, which adds 8 new instructions and an Indexed Addressing mode. This extension, enabled as a device configuration option, has been specifically designed to optimize re-entrant application code originally developed in high-level languages, such as C.
- Enhanced CCP module: In PWM mode, this
 module provides 1, 2 or 4 modulated outputs for
 controlling half-bridge and full-bridge drivers.
 Other features include Auto-Shutdown, for
 disabling PWM outputs on interrupt or other select
 conditions and Auto-Restart, to reactivate outputs
 once the condition has cleared.
- Enhanced Addressable USART: This serial communication module is capable of standard RS-232 operation and provides support for the LIN bus protocol. Other enhancements include automatic baud rate detection and a 16-bit Baud Rate Generator for improved resolution.
- 10-bit A/D Converter: This module incorporates programmable acquisition time, allowing for a channel to be selected and a conversion to be initiated without waiting for a sampling period and thus, reduce code overhead.
- Extended Watchdog Timer (WDT): This
 enhanced version incorporates a 16-bit prescaler,
 allowing an extended time-out range that is stable
 across operating voltage and temperature. See
 Section 23.0 "Electrical Characteristics" for
 time-out periods.

1.3 Details on Individual Family Members

Devices in the PIC18F45J10 family are available in 28-pin and 40/44-pin packages. Block diagrams for the two groups are shown in Figure 1-1 and Figure 1-2.

The devices are differentiated from each other in five ways:

- Flash program memory (16 Kbytes for PIC18F24J10/44J10 devices and 32 Kbytes for PIC18F25J10/45J10).
- 2. A/D channels (10 for 28-pin devices, 13 for 40/44-pin devices).
- 3. I/O ports (3 bidirectional ports on 28-pin devices, 5 bidirectional ports on 40/44-pin devices).
- CCP and Enhanced CCP implementation (28-pin devices have 2 standard CCP modules, 40/44-pin devices have one standard CCP module and one ECCP module).
- Parallel Slave Port (present only on 40/44-pin devices).
- One MSSP module for PIC18F24J10/25J10 devices and 2 MSSP modules for PIC18F44J10/45J10 devices
- Parts designated with an "F" part number (i.e., PIC18F25J10) have a minimum VDD of 2.8 volts, whereas parts designated with an "LF" part number (i.e., PIC18LF25J10) can operate between 2.0-3.6 volts on VDD; however, VDDCORE should never exceed VDD.

All other features for devices in this family are identical. These are summarized in Table 1-1.

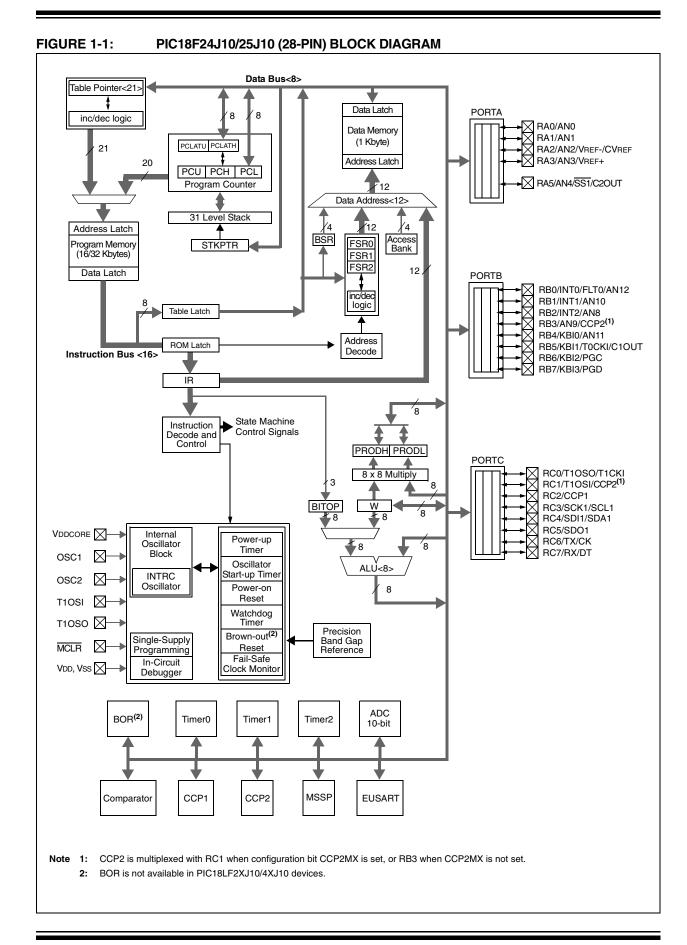
The pinouts for all devices are listed in Table 1-2 and Table 1-3.

The PIC18F45J10 family of devices provides an on-chip voltage regulator to supply the correct voltage levels to the core. Parts designated with an "F" part number (such as PIC18F25J10) have the voltage regulator enabled. These parts can run from 2.7-3.6 volts on VDD but should have the VDDCORE pin connected to VSs through a low-ESR capacitor. Parts designated with an "LF" part number (such as PIC18LF24J10) do not enable the voltage regulator. An external supply of 2.0-2.7 Volts has to be supplied to the VDDCORE pin while 2.0-3.6 Volts can be supplied to VDD (VDDCORE should never exceed VDD). See Section 20.3 "On-Chip Voltage Regulator" for more details about the internal voltage regulator.

TABLE 1-1: DEVICE FEATURES

Features	PIC18F24J10	PIC18F25J10	PIC18F44J10	PIC18F45J10
Operating Frequency	DC – 40 MHz			
Program Memory (Bytes)	16384	32768	16384	32768
Program Memory (Instructions)	8192	16384	8192	16384
Data Memory (Bytes)	768	1536	768	1536
Interrupt Sources	19	19	20	20
I/O Ports	Ports A, B, C	Ports A, B, C	Ports A, B, C, D, E	Ports A, B, C, D, E
Timers	3	3	3	3
Capture/Compare/PWM Modules	2	2	1	1
Enhanced Capture/Compare/PWM Modules	0	0	1	1
Serial Communications	MSSP, Enhanced USART	MSSP, Enhanced USART	MSSP, Enhanced USART	MSSP, Enhanced USART
Parallel Communications (PSP)	No	No	Yes	Yes
10-bit Analog-to-Digital Module	10 Input Channels	10 Input Channels	13 Input Channels	13 Input Channels
Resets (and Delays)	POR, BOR ⁽¹⁾ , RESET Instruction, Stack Full, Stack Underflow (PWRT, OST), MCLR, WDT	POR, BOR ⁽¹⁾ , RESET Instruction, Stack Full, Stack Underflow (PWRT, OST), MCLR, WDT	POR, BOR ⁽¹⁾ , RESET Instruction, Stack Full, Stack Underflow (PWRT, OST), MCLR, WDT	POR, BOR ⁽¹⁾ , RESET Instruction, Stack Full, Stack Underflow (PWRT, OST), MCLR, WDT
Programmable Brown-out Reset	Yes	Yes	Yes	Yes
Instruction Set	75 Instructions; 83 with Extended Instruction Set enabled			
Packages	28-pin SPDIP 28-pin SOIC 28-pin SSOP 28-pin QFN	28-pin SPDIP 28-pin SOIC 28-pin SSOP 28-pin QFN	40-pin PDIP 44-pin QFN 44-pin TQFP	40-pin PDIP 44-pin QFN 44-pin TQFP

Note 1: BOR is not available in PIC18LF2XJ10/4XJ10 devices.



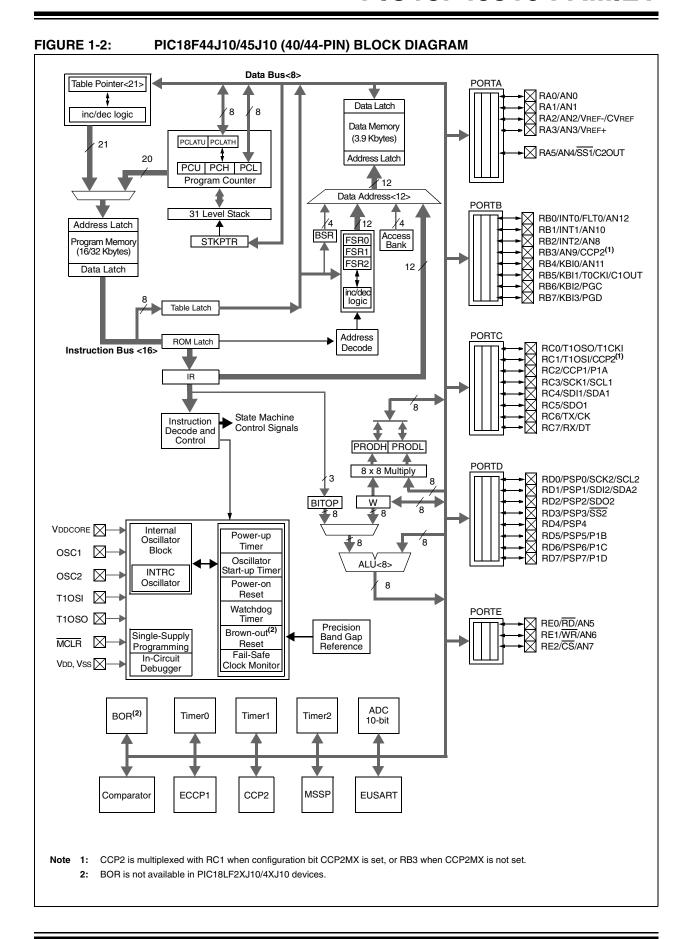


TABLE 1-2: PIC18F24J10/25J10 PINOUT I/O DESCRIPTIONS

	Pin Nu	ımber						
Pin Name	SPDIP, SOIC, SSOP	QFN	Pin Type	Buffer Type	Description			
MCLR MCLR	1	26	I	ST	Master Clear (input) or programming voltage (input). Master Clear (Reset) input. This pin is an active-low Reset to the device.			
OSC1/CLKI OSC1 CLKI	9	6	1	_ CMOS	Oscillator crystal or external clock input. Oscillator crystal input or external clock source input. External clock source input. Always associated with pin function OSC1. See related OSC2/CLKO pins.			
OSC2/CLKO OSC2 CLKO	10	7	0	_	Oscillator crystal or clock output. Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode. In EC mode, OSC2 pin outputs CLKO which has 1/4 the frequency of OSC1 and denotes the instruction cycle rate.			

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels I = Input = Output = Power

Note 1: Default assignment for CCP2 when configuration bit CCP2MX is set.

TABLE 1-2: PIC18F24J10/25J10 PINOUT I/O DESCRIPTIONS (CONTINUED)

	Pin Nu	ımber			, ,	
Pin Name	SPDIP, SOIC, SSOP	QFN	Pin Type	Buffer Type	Description	
					PORTA is a bidirectional I/O port.	
RAO/ANO RAO ANO	2	27	I/O I	TTL Analog	Digital I/O. Analog input 0.	
RA1/AN1 RA1 AN1	3	28	I/O I	TTL Analog	Digital I/O. Analog input 1.	
RA2/AN2/VREF-/CVREF RA2 AN2 VREF- CVREF	4	1	I/O 	TTL Analog Analog Analog	A/D reference voltage (low) input.	
RA3/AN3/VREF+ RA3 AN3 VREF+	5	2	I/O I I	TTL Analog Analog	Digital I/O. Analog input 3. A/D reference voltage (high) input.	
RA5/AN4/SS1/C2OUT RA5 AN4 SS1 C2OUT	7	4	I/O - - -	TTL Analog TTL —	Digital I/O. Analog input 4. SPI™ slave select input. Comparator 2 output.	

Legend: TTL = TTL compatible input

CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels

I = Input

O = Output

P = Power

Note 1: Default assignment for CCP2 when configuration bit CCP2MX is set.

TABLE 1-2: PIC18F24J10/25J10 PINOUT I/O DESCRIPTIONS (CONTINUED)

TABLE 1-2. PICTO	Pin Nu				O DESCRIPTIONS (CONTINUED)
Pin Name	SPDIP, SOIC, SSOP	QFN	Pin Type	Buffer Type	Description
					PORTB is a bidirectional I/O port. PORTB can be software programmed for internal weak pull-ups on all inputs.
RB0/INT0/FLT0/AN12 RB0 INT0 FLT0 AN12	21	18	I/O I I I	TTL ST ST Analog	Digital I/O. External interrupt 0. PWM Fault input for CCP1. Analog input 12.
RB1/INT1/AN10 RB1 INT1 AN10	22	19	I/O I I	TTL ST Analog	Digital I/O. External interrupt 1. Analog input 10.
RB2/INT2/AN8 RB2 INT2 AN8	23	20	I/O I I	TTL ST Analog	Digital I/O. External interrupt 2. Analog input 8.
RB3/AN9/CCP2 RB3 AN9 CCP2 ⁽¹⁾	24	21	I/O I I/O	TTL Analog ST	Digital I/O. Analog input 9. Capture 2 input/Compare 2 output/PWM 2 output.
RB4/KBI0/AN11 RB4 KBI0 AN11	25	22	I/O I I	TTL TTL Analog	Digital I/O. Interrupt-on-change pin. Analog input 11.
RB5/KBI1/T0CKI/ C1OUT RB5 KBI1 T0CKI C1OUT	26	23	I/O I I O	TTL TTL ST	Digital I/O. Interrupt-on-change pin. Timer0 external clock input. Comparator 1 output.
RB6/KBI2/PGC RB6 KBI2 PGC	27	24	I/O I I/O	TTL TTL ST	Digital I/O. Interrupt-on-change pin. In-Circuit Debugger and ICSP™ programming clock pin.
RB7/KBI3/PGD RB7 KBI3 PGD	28	25	I/O I I/O	TTL TTL ST	Digital I/O. Interrupt-on-change pin. In-Circuit Debugger and ICSP programming data pin.

Legend: TTL = TTL compatible input

CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels

I = Input

O = Output

P = Power

Note 1: Default assignment for CCP2 when configuration bit CCP2MX is set.

TABLE 1-2: PIC18F24J10/25J10 PINOUT I/O DESCRIPTIONS (CONTINUED)

	Pin Nu				O BESSELL TIONS (OCKTINGES)
Pin Name	SPDIP, SOIC, SSOP	QFN	Pin Type	Buffer Type	Description
					PORTC is a bidirectional I/O port.
RC0/T1OSO/T1CKI RC0 T1OSO T1CKI	11	8	I/O O I	ST — ST	Digital I/O. Timer1 oscillator output. Timer1 external clock input.
RC1/T1OSI/CCP2 RC1 T1OSI CCP2 ⁽²⁾	12	9	I/O I I/O	ST Analog ST	Digital I/O. Timer1 oscillator input. Capture 2 input/Compare 2 output/PWM 2 output.
RC2/CCP1 RC2 CCP1	13	10	I/O I/O	ST ST	Digital I/O. Capture 1 input/Compare 1 output/PWM 1 output.
RC3/SCK1/SCL1 RC3 SCK1 SCL1	14	11	I/O I/O I/O	ST ST ST	Digital I/O. Synchronous serial clock input/output for SPI™ mode. Synchronous serial clock input/output for I ² C™ mode.
RC4/SDI1/SDA1 RC4 SDI1 SDA1	15	12	I/O I I/O	ST ST ST	Digital I/O. SPI data in. I ² C data I/O.
RC5/SDO1 RC5 SDO1	16	13	I/O O	ST —	Digital I/O. SPI data out.
RC6/TX/CK RC6 TX CK	17	14	I/O O I/O	ST — ST	Digital I/O. EUSART asynchronous transmit. EUSART synchronous clock (see related RX/DT).
RC7/RX/DT RC7 RX DT	18	15	I/O I I/O	ST ST ST	Digital I/O. EUSART asynchronous receive. EUSART synchronous data (see related TX/CK).
Vss	8, 19	5, 16	Р	_	Ground reference for logic and I/O pins.
VDD	20	17	Р	_	Positive supply for logic and I/O pins.
VDDCORE/VCAP VDDCORE VCAP	6	3	P P	_	Positive supply for logic and I/O pins. Ground reference for logic and I/O pins.

Legend: TTL = TTL compatible input

CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels

I = Input

O = Output

out P = Power

2: Alternate assignment for CCP2 when configuration bit CCP2MX is cleared.

Note 1: Default assignment for CCP2 when configuration bit CCP2MX is set.

TABLE 1-3: PIC18F44J10/45J10 PINOUT I/O DESCRIPTIONS

Pin Name	Piı	n Numb	oer	Pin	Buffer	Description
Pin Name	PDIP	QFN	TQFP	Туре	Туре	Description
MCLR MCLR	1	18	18	I	ST	Master Clear (input) or programming voltage (input). Master Clear (Reset) input. This pin is an active-low Reset to the device.
OSC1/CLKI OSC1 CLKI	13	32	30	 	_ CMOS	Oscillator crystal or external clock input. Oscillator crystal input or external clock source input. External clock source input. Always associated with pin function OSC1. See related OSC2/CLKO pins.
OSC2/CLKO OSC2 CLKO	14	33	31	0		Oscillator crystal or clock output. Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode. In RC mode, OSC2 pin outputs CLKO which has 1/4 the frequency of OSC1 and denotes the instruction cycle rate.

Legend: TTL = TTL compatible input

ST = Schmitt Trigger input with CMOS levels

O = Output

CMOS = CMOS compatible input or output

I = Input P = Power

Note 1: Default assignment for CCP2 when configuration bit CCP2MX is set.

TABLE 1-3: PIC18F44J10/45J10 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number			Pin	Buffer	Description		
Pili Naille	PDIP	QFN	TQFP	Туре	Type	Description		
						PORTA is a bidirectional I/O port.		
RA0/AN0 RA0 AN0	2	19	19	I/O I	TTL Analog	Digital I/O. Analog input 0.		
RA1/AN1 RA1 AN1	3	20	20	I/O I	TTL Analog	Digital I/O. Analog input 1.		
RA2/AN2/VREF-/CVREF RA2 AN2 VREF- CVREF	4	21	21	I/O I I O	TTL Analog Analog Analog	A/D reference voltage (low) input.		
RA3/AN3/VREF+ RA3 AN3 VREF+	5	22	22	I/O I I	TTL Analog Analog			
RA5/AN4/SS1/C2OUT RA5 AN4 SS1 C2OUT	7	24	24	I/O I I O	TTL Analog TTL —	Digital I/O. Analog input 4. SPI™ slave select input. Comparator 2 output.		

Legend: TTL = TTL compatible input

ST = Schmitt Trigger input with CMOS levels

O = Output

CMOS = CMOS compatible input or output

I = Input P = Power

Note 1: Default assignment for CCP2 when configuration bit CCP2MX is set.

TABLE 1-3: PIC18F44J10/45J10 PINOUT I/O DESCRIPTIONS (CONTINUED)

Din Nama	Piı	n Numb	er	Pin Buffer		Description		
Pin Name	PDIP	QFN	TQFP	Туре	Туре	Description		
RB0/INT0/FLT0/AN12 RB0 INT0	33	9	8	I/O I	TTL ST	PORTB is a bidirectional I/O port. PORTB can be software programmed for internal weak pull-ups on all inputs. Digital I/O. External interrupt 0.		
FLT0 AN12				l I	ST Analog	PWM Fault input for Enhanced CCP1. Analog input 12.		
RB1/INT1/AN10 RB1 INT1 AN10	34	10	9	I/O I I	TTL ST Analog	Digital I/O. External interrupt 1. Analog input 10.		
RB2/INT2/AN8 RB2 INT2 AN8	35	11	10	I/O I I	TTL ST Analog	Digital I/O. External interrupt 2. Analog input 8.		
RB3/AN9/CCP2 RB3 AN9 CCP2 ⁽¹⁾	36	12	11	I/O I I/O	TTL Analog ST	Digital I/O. Analog input 9. Capture 2 input/Compare 2 output/PWM 2 output.		
RB4/KBI0/AN11 RB4 KBI0 AN11	37	14	14	I/O I I	TTL TTL Analog	Digital I/O. Interrupt-on-change pin. Analog input 11.		
RB5/KBI1/C1OUT RB5 KBI1 C1OUT	38	15	15	I/O I O	TTL TTL	Digital I/O. Interrupt-on-change pin. Comparator 1 output.		
RB6/KBI2/PGC RB6 KBI2 PGC	39	16	16	I/O I I/O	TTL TTL ST	Digital I/O. Interrupt-on-change pin. In-Circuit Debugger and ICSP™ programming clock pin.		
RB7/KBI3/PGD RB7 KBI3 PGD	40	17	17	I/O /O	TTL TTL ST	Digital I/O. Interrupt-on-change pin. In-Circuit Debugger and ICSP programming data pin.		

Legend: TTL = TTL compatible input

CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels
O = Output

I = Input P = Power

Note 1: Default assignment for CCP2 when configuration bit CCP2MX is set.

TABLE 1-3: PIC18F44J10/45J10 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Piı	n Numb	er	Pin	Buffer	Description		
Pili Naille	PDIP	QFN	TQFP	Туре	Туре	Description		
						PORTC is a bidirectional I/O port.		
RC0/T1OSO/T1CKI RC0 T1OSO T1CKI	15	34	32	I/O O I	ST — ST	Digital I/O. Timer1 oscillator output. Timer1 external clock input.		
RC1/T1OSI/CCP2 RC1 T1OSI CCP2 ⁽²⁾	16	35	35	I/O I I/O	ST CMOS ST	Digital I/O. Timer1 oscillator input. Capture 2 input/Compare 2 output/PWM 2 output.		
RC2/CCP1/P1A RC2 CCP1 P1A	17	36	36	I/O I/O O	ST ST —	Digital I/O. Capture 1 input/Compare 1 output/PWM 1 output. Enhanced CCP1 output.		
RC3/SCK1/SCL1 RC3 SCK1	18	37	37	I/O I/O	ST ST	Digital I/O. Synchronous serial clock input/output for SPI™ mode.		
SCL1				I/O	ST	Synchronous serial clock input/output for I ² C™ mode.		
RC4/SDI1/SDA1 RC4 SDI1 SDA1	23	42	42	I/O I I/O	ST ST ST	Digital I/O. SPI data in. I ² C data I/O.		
RC5/SDO1 RC5 SDO1	24	43	43	I/O O	ST —	Digital I/O. SPI data out.		
RC6/TX/CK RC6 TX CK	25	44	44	I/O O I/O	ST — ST	Digital I/O. EUSART asynchronous transmit. EUSART synchronous clock (see related RX/DT).		
RC7/RX/DT RC7 RX DT	26	1	1	I/O I I/O	ST ST ST	Digital I/O. EUSART asynchronous receive. EUSART synchronous data (see related TX/CK).		

Legend: TTL = TTL compatible input

CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels

I = Input

O = Output

P = Power

Note 1: Default assignment for CCP2 when configuration bit CCP2MX is set.

TABLE 1-3: PIC18F44J10/45J10 PINOUT I/O DESCRIPTIONS (CONTINUED)

	1	n Numb		Pin	Buffer	CRIPTIONS (CONTINUED)
Pin Name	PDIP	QFN	TQFP	Туре	Туре	Description
						PORTD is a bidirectional I/O port or a Parallel Slave Port (PSP) for interfacing to a microprocessor port. These pins have TTL input buffers when PSP module is enabled.
RD0/PSP0/SCK2/ SCL2	19	38	38			
RD0 PSP0 SCK2				I/O I/O I/O	ST TTL ST	Digital I/O. Parallel Slave Port data. Synchronous serial clock input/output for SPI™ mode.
SCL2				I/O	ST	Synchronous serial clock input/output for I ² C™ mode.
RD1/PSP1/SDI2/SDA2 RD1 PSP1 SDI2 SDA2	20	39	39	I/O I/O I I/O	ST TTL ST ST	Digital I/O. Parallel Slave Port data. SPI data in. I ² C data I/O.
RD2/PSP2/SDO2 RD2 PSP2 SDO2	21	40	40	I/O I/O O	ST TTL —	Digital I/O. Parallel Slave Port data. SPI data out.
RD3/PSP3/SS2 RD3 PSP3 SS2	22	41	41	I/O I/O I	ST TTL TTL	Digital I/O. Parallel Slave Port data. SPI slave select input.
RD4/PSP4 RD4 PSP4	27	2	2	I/O I/O	ST TTL	Digital I/O. Parallel Slave Port data.
RD5/PSP5/P1B RD5 PSP5 P1B	28	3	3	I/O I/O O	ST TTL —	Digital I/O. Parallel Slave Port data. Enhanced CCP1 output.
RD6/PSP6/P1C RD6 PSP6 P1C	29	4	4	I/O I/O O	ST TTL —	Digital I/O. Parallel Slave Port data. Enhanced CCP1 output.
RD7/PSP7/P1D RD7 PSP7 P1D	30	5	5	I/O I/O O	ST TTL —	Digital I/O. Parallel Slave Port data. Enhanced CCP1 output.

Legend: TTL = TTL compatible input

CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels
O = Output

I = Input P = Power

Note 1: Default assignment for CCP2 when configuration bit CCP2MX is set.

TABLE 1-3: PIC18F44J10/45J10 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number			Pin	Buffer	Description		
Fill Name	PDIP	QFN	TQFP	Туре	Type	Description		
						PORTE is a bidirectional I/O port.		
RE0/RD/AN5	8	25	25			B: " 110		
RE0 RD				I/O I	ST TTL	Digital I/O. Read control for Parallel Slave Port		
110				'		(see also WR and CS pins).		
AN5				ı	Analog	Analog input 5.		
RE1/WR/AN6	9	26	26					
RE1				I/O	ST	Digital I/O.		
WR				ı	TTL	Write <u>co</u> ntrol <u>for</u> Parallel Slave Port (see CS and RD pins).		
AN6				ı	Analog	Analog input 6.		
RE2/CS/AN7	10	27	27					
RE2				I/O	ST	Digital I/O.		
CS				I	TTL	Chip Select control for Parallel Slave Port (see related RD and WR pins).		
AN7				ı	Analog	Analog input 7.		
Vss	12, 31	6, 30,	6, 29	Р	_	Ground reference for logic and I/O pins.		
		31						
VDD	11, 32	7, 8, 28, 29	7, 28	Р	_	Positive supply for logic and I/O pins.		
VDDCORE/VCAP	6	23	23					
VDDCORE				Р		Positive supply for logic and I/O pins.		
VCAP				Р	_	Ground reference for logic and I/O pins.		
NC	_	13	12, 13,	_	_	No connect.		
			33, 34					

Legend: TTL = TTL compatible input

ST = Schmitt Trigger input with CMOS levels

= Output

CMOS = CMOS compatible input or output

= Input

= Power

Note 1: Default assignment for CCP2 when configuration bit CCP2MX is set.

NOTES:

2.0 OSCILLATOR CONFIGURATIONS

2.1 Oscillator Types

The PIC18F45J10 family of devices can be operated in five different oscillator modes:

HS High-Speed Crystal/Resonator
 HSPLL High-Speed Crystal/Resonator with Software PLL Control

 EC External Clock with Fosc/4 Output
 ECPLL External Clock with Software PLL Control

5. INTRC Internal 31 kHz Oscillator

Four of these are selected by the user by programming the FOSC2:FOSC0 configuration bits. The fifth mode (INTRC) may be invoked under software control; it can also be configured as the default mode on device Resets.

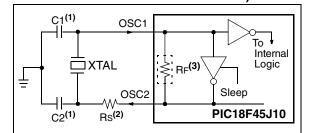
2.2 Crystal Oscillator/Ceramic Resonators (HS Modes)

In HS or HSPLL Oscillator modes, a crystal or ceramic resonator is connected to the OSC1 and OSC2 pins to establish oscillation. Figure 2-1 shows the pin connections.

The oscillator design requires the use of a parallel cut crystal.

Note: Use of a series cut crystal may give a frequency out of the crystal manufacturer's specifications.

FIGURE 2-1: CRYSTAL/CERAMIC
RESONATOR OPERATION
(HS OR HSPLL
CONFIGURATION)



Note 1: See Table 2-1 and Table 2-2 for initial values of C1 and C2.

- 2: A series resistor (Rs) may be required for AT strip cut crystals.
- 3: RF varies with the oscillator mode chosen.

TABLE 2-1: CAPACITOR SELECTION FOR CERAMIC RESONATORS

7	Typical Capacitor Values Used:					
Mode	Freq.	OSC1	OSC2			
HS	8.0 MHz 16.0 MHz	27 pF 22 pF	27 pF 22 pF			

Capacitor values are for design guidance only.

These capacitors were tested with the resonators listed below for basic start-up and operation. **These values are not optimized**.

Different capacitor values may be required to produce acceptable oscillator operation. The user should test the performance of the oscillator over the expected VDD and temperature range for the application.

See the notes following Table 2-2 for additional information.

Resonators Used:
4.0 MHz
8.0 MHz
16.0 MHz

TABLE 2-2: CAPACITOR SELECTION FOR CRYSTAL OSCILLATOR

Osc Type	Crystal Freg.	Typical Capacitor Values Tested:			
	rieq.	C1	C2		
HS	4 MHz	27 pF	27 pF		
	8 MHz	22 pF	22 pF		
20 MHz		15 pF	15 pF		

Capacitor values are for design guidance only.

These capacitors were tested with the crystals listed below for basic start-up and operation. **These values are not optimized.**

Different capacitor values may be required to produce acceptable oscillator operation. The user should test the performance of the oscillator over the expected VDD and temperature range for the application.

See the notes following this table for additional information.

Crystals Used:				
4 MHz				
8 MHz				
20 MHz				

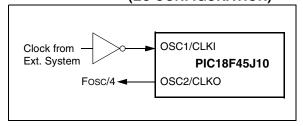
- **Note 1:** Higher capacitance increases the stability of oscillator but also increases the start-up time.
 - 2: Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components.
 - **3:** Rs may be required to avoid overdriving crystals with low drive level specification.
 - **4:** Always verify oscillator performance over the VDD and temperature range that is expected for the application.

2.3 External Clock Input (EC Modes)

The EC and ECPLL Oscillator modes require an external clock source to be connected to the OSC1 pin. There is no oscillator start-up time required after a Power-on Reset or after an exit from Sleep mode.

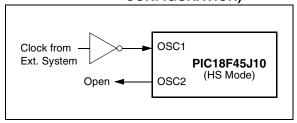
In the EC Oscillator mode, the oscillator frequency divided by 4 is available on the OSC2 pin. This signal may be used for test purposes or to synchronize other logic. Figure 2-2 shows the pin connections for the EC Oscillator mode.

FIGURE 2-2: EXTERNAL CLOCK INPUT OPERATION (EC CONFIGURATION)



An external clock source may also be connected to the OSC1 pin in the HS mode, as shown in Figure 2-3. In this configuration, the divide-by-4 output on OSC2 is not available.

FIGURE 2-3: EXTERNAL CLOCK INPUT OPERATION (HS OSC CONFIGURATION)



2.4 PLL Frequency Multiplier

A Phase Locked Loop (PLL) circuit is provided as an option for users who want to use a lower frequency oscillator circuit, or to clock the device up to its highest rated frequency from a crystal oscillator. This may be useful for customers who are concerned with EMI due to high-frequency crystals, or users who require higher clock speeds from an internal oscillator. For these reasons, the HSPLL and ECPLL modes are available.

The HSPLL and ECPLL modes provide the ability to selectively run the device at 4 times the external oscillating source to produce frequencies up to 40 MHz. The PLL is enabled by setting the PLLEN bit in the OSCTUNE register (Register 2-1).

FIGURE 2-4: PLL BLOCK DIAGRAM HSPLL or ECPLL (CONFIG2L) PLL Enable (OSCTUNE) -OSC₂ Phase - \boxtimes -FIN Comparator HS or EC OSC₁ Mode FOUT \boxtimes Loop Filter ÷4 VCO **SYSCLK**

REGISTER 2-1: OSCTUNE: PLL CONTROL REGISTER

U-0	R/W-0 ⁽¹⁾	U-0	U-0	U-0	U-0	U-0	U-0
_	PLLEN ⁽¹⁾	_	_	_	_	_	_
bit 7							bit 0

bit 7 **Unimplemented:** Read as '0'

bit 6 PLLEN: Frequency Multiplier PLL Enable bit⁽¹⁾

1 = PLL enabled0 = PLL disabled

Note 1: Available only for ECPLL and HSPLL oscillator configurations; otherwise, this bit is unavailable and read as '0'.

bit 5-0 Unimplemented: Read as '0'

2.5 Internal Oscillator Block

The PIC18F45J10 family of devices includes an internal oscillator source (INTRC) which provides a nominal 31 kHz output. The INTRC is enabled on device power-up and clocks the device during its configuration cycle until it enters operating mode. INTRC is also enabled if it is selected as the device clock source or if any of the following are enabled:

- · Fail-Safe Clock Monitor
- · Watchdog Timer
- · Two-Speed Start-up

These features are discussed in greater detail in Section 20.0 "Special Features of the CPU".

The INTRC can also be optionally configured as the default clock source on device start-up by setting the FOSC2 configuration bit. This is discussed in **Section 2.6.1 "Oscillator Control Register"**.

2.6 Clock Sources and Oscillator Switching

The PIC18F45J10 family includes a feature that allows the device clock source to be switched from the main oscillator to an alternate clock source. PIC18F45J10 family devices offer two alternate clock sources. When an alternate clock source is enabled, the various power-managed operating modes are available.

Essentially, there are three clock sources for these devices:

- · Primary oscillators
- · Secondary oscillators
- · Internal oscillator

The **primary oscillators** include the External Crystal and Resonator modes and the External Clock modes. The particular mode is defined by the FOSC2:FOSC0 configuration bits. The details of these modes are covered earlier in this chapter.

The **secondary oscillators** are those external sources not connected to the OSC1 or OSC2 pins. These sources may continue to operate even after the controller is placed in a power-managed mode.

PIC18F45J10 family devices offer the Timer1 oscillator as a secondary oscillator. This oscillator, in all power-managed modes, is often the time base for functions such as a real-time clock.

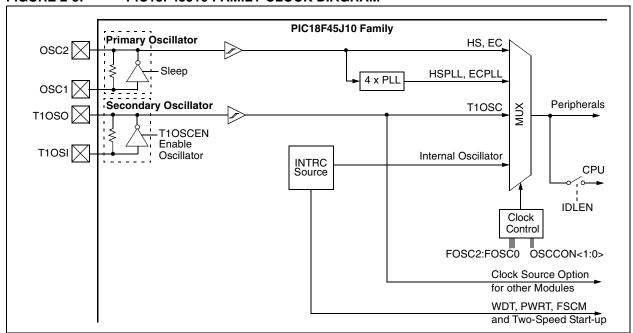
Most often, a 32.768 kHz watch crystal is connected between the RC0/T10S0/T13CKI and RC1/T10SI pins. Loading capacitors are also connected from each pin to ground.

The Timer1 oscillator is discussed in greater detail in Section 11.3 "Timer1 Oscillator".

In addition to being a primary clock source, the **internal oscillator** is available as a power-managed mode clock source. The INTRC source is also used as the clock source for several special features, such as the WDT and Fail-Safe Clock Monitor.

The clock sources for the PIC18F45J10 family devices are shown in Figure 2-5. See **Section 20.0 "Special Features of the CPU"** for Configuration register details.





2.6.1 OSCILLATOR CONTROL REGISTER

The OSCCON register (Register 2-2) controls several aspects of the device clock's operation, both in full power operation and in power-managed modes.

The System Clock Select bits, SCS1:SCS0, select the clock source. The available clock sources are the primary clock (defined by the FOSC2:FOSC0 configuration bits), the secondary clock (Timer1 oscillator) and the internal oscillator. The clock source changes after one or more of the bits are written to, following a brief clock transition interval.

The OSTS (OSCCON<3>) and T1RUN (T1CON<6>) bits indicate which clock source is currently providing the device clock. The OSTS bit indicates that the Oscillator Start-up Timer (OST) has timed out and the primary clock is providing the device clock in primary clock modes. The T1RUN bit indicates when the Timer1 oscillator is providing the device clock in secondary clock modes. In power-managed modes, only one of these bits will be set at any time. If neither of these bits are set, the INTRC is providing the clock, or the internal oscillator has just started and is not yet stable.

The IDLEN bit determines if the device goes into Sleep mode or one of the Idle modes when the SLEEP instruction is executed.

The use of the flag and control bits in the OSCCON register is discussed in more detail in **Section 3.0** "Power-Managed Modes".

- Note 1: The Timer1 oscillator must be enabled to select the secondary clock source. The Timer1 oscillator is enabled by setting the T1OSCEN bit in the Timer1 Control register (T1CON<3>). If the Timer1 oscillator is not enabled, then any attempt to select a secondary clock source when executing a SLEEP instruction will be ignored.
 - 2: It is recommended that the Timer1 oscillator be operating and stable before executing the SLEEP instruction or a very long delay may occur while the Timer1 oscillator starts.

2.6.1.1 System Clock Selection and the FOSC2 Configuration Bit

The SCS bits are cleared on all forms of Reset. In the device's default configuration, this means the primary oscillator defined by FOSC1:FOSC0 (that is, one of the HC or EC modes) is used as the primary clock source on device Resets.

The default clock configuration on Reset can be changed with the FOSC2 configuration bit. The effect of this bit is to set the clock source selected when SCS1:SCS0 = 00. When FOSC2 = 1 (default), the oscillator source defined by FOSC1:FOSC0 is selected whenever SCS1:SCS0 = 00. When FOSC2 = 0, the INTRC oscillator is selected whenever SCS1:SCS2 = 00. Because the SCS bits are cleared on Reset, the FOSC2 setting also changes the default oscillator mode on Reset.

Regardless of the setting of FOSC2, INTRC will always be enabled on device power-up. It will serve as the clock source until the device has loaded its configuration values from memory. It is at this point that the FOSC configuration bits are read and the oscillator selection of operational mode is made.

Note that either the primary clock or the internal oscillator will have two bit setting options, at any given time, depending on the setting of FOSC2.

2.6.2 OSCILLATOR TRANSITIONS

PIC18F45J10 family devices contain circuitry to prevent clock "glitches" when switching between clock sources. A short pause in the device clock occurs during the clock switch. The length of this pause is the sum of two cycles of the old clock source and three to four cycles of the new clock source. This formula assumes that the new clock source is stable.

Clock transitions are discussed in greater detail in **Section 3.1.2 "Entering Power-Managed Modes"**.

REGISTER 2-2: OSCCON: OSCILLATOR CONTROL REGISTER

R/W-0	U-0	U-0	U-0	R-q ⁽¹⁾	U-0	R/W-0	R/W-0
IDLEN	_	_	_	OSTS	_	SCS1	SCS0
bit 7							bit 0

bit 0

bit 7 IDLEN: Idle Enable bit

> 1 = Device enters Idle mode on SLEEP instruction 0 = Device enters Sleep mode on SLEEP instruction

bit 6-4 Unimplemented: Read as '0'

OSTS: Oscillator Start-up Time-out Status bit⁽¹⁾ bit 3

1 = Oscillator Start-up Timer time-out has expired; primary oscillator is running

0 = Oscillator Start-up Timer time-out is running; primary oscillator is not ready

Note 1: The Reset value is '0' when HS mode and Two-Speed Start-up are both enabled; otherwise, it is '1'.

bit 2 Unimplemented: Read as '0'

bit 1-0 SCS1:SCS0: System Clock Select bits

11 = Internal oscillator

10 = Primary oscillator

01 = Timer1 oscillator

When FOSC2 = 1:

00 = Primary oscillator

When FOSC2 = 0:

00 = Internal oscillator

Legend:

U = Unimplemented, read as '0' 'q' = Value determined by configuration -n = Value at POR R = Readable bit '0' = Bit is cleared W = Writable bit

2.7 **Effects of Power-Managed Modes** on the Various Clock Sources

When PRI_IDLE mode is selected, the designated primary oscillator continues to run without interruption. For all other power-managed modes, the oscillator using the OSC1 pin is disabled. The OSC1 pin (and OSC2 pin if used by the oscillator) will stop oscillating.

In Secondary Clock modes (SEC_RUN and SEC_IDLE), the Timer1 oscillator is operating and providing the device clock. The Timer1 oscillator may also run in all power-managed modes if required to clock Timer1 or Timer3.

In RC_RUN and RC_IDLE modes, the internal oscillator provides the device clock source. The 31 kHz INTRC output can be used directly to provide the clock and may be enabled to support various special features, regardless of the power-managed mode (see Section 20.2 "Watchdog Timer (WDT)" through Section 20.5 "Fail-Safe Clock Monitor" for more information on WDT, Fail-Safe Clock Monitor and Two-Speed Start-up).

If the Sleep mode is selected, all clock sources are stopped. Since all the transistor switching currents have been stopped, Sleep mode achieves the lowest current consumption of the device (only leakage currents).

Enabling any on-chip feature that will operate during Sleep will increase the current consumed during Sleep. The INTRC is required to support WDT operation. The Timer1 oscillator may be operating to support a real-time clock. Other features may be operating that do not require a device clock source (i.e., MSSP slave, PSP, INTn pins and others). Peripherals that may add significant current consumption are listed in Section 23.2 "DC Characteristics: Power-Down and Supply Current".

2.8 Power-up Delays

Power-up delays are controlled by two timers, so that no external Reset circuitry is required for most applications. The delays ensure that the device is kept in Reset until the device power supply is stable under normal circumstances and the primary clock is operating and stable. For additional information on power-up delays, see **Section 4.5** "Power-up Timer (PWRT)".

The first timer is the Power-up Timer (PWRT), which provides a fixed delay on power-up (parameter 33, Table 23-10). It is always enabled.

The second timer is the Oscillator Start-up Timer (OST), intended to keep the chip in Reset until the crystal oscillator is stable (HS modes). The OST does this by counting 1024 oscillator cycles before allowing the oscillator to clock the device.

There is a delay of interval TCSD (parameter 38, Table 23-10), following POR, while the controller becomes ready to execute instructions.

TABLE 2-3: OSC1 AND OSC2 PIN STATES IN SLEEP MODE

Oscillator Mode	OSC1 Pin	OSC2 Pin
EC, ECPLL	Floating, pulled by external clock	At logic low (clock/4 output)
HS, HSPLL	Feedback inverter disabled at quiescent voltage level	Feedback inverter disabled at quiescent voltage level

Note: See Table 4-2 in Section 4.0 "Reset" for time-outs due to Sleep and MCLR Reset.

NOTES:

3.0 POWER-MANAGED MODES

The PIC18F45J10 family devices provide the ability to manage power consumption by simply managing clocking to the CPU and the peripherals. In general, a lower clock frequency and a reduction in the number of circuits being clocked constitutes lower consumed power. For the sake of managing power in an application, there are three primary modes of operation:

- · Run mode
- Idle mode
- Sleep mode

These modes define which portions of the device are clocked and at what speed. The Run and Idle modes may use any of the three available clock sources (primary, secondary or internal oscillator block); the Sleep mode does not use a clock source.

The power-managed modes include several power-saving features offered on previous PICmicro® devices. One is the clock switching feature, offered in other PIC18 devices, allowing the controller to use the Timer1 oscillator in place of the primary oscillator. Also included is the Sleep mode, offered by all PICmicro devices, where all device clocks are stopped.

3.1 Selecting Power-Managed Modes

Selecting a power-managed mode requires two decisions: if the CPU is to be clocked or not and which clock source is to be used. The IDLEN bit (OSCCON<7>) controls CPU clocking, while the SCS1:SCS0 bits (OSCCON<1:0>) select the clock source. The individual modes, bit settings, clock sources and affected modules are summarized in Table 3-1.

3.1.1 CLOCK SOURCES

The SCS1:SCS0 bits allow the selection of one of three clock sources for power-managed modes. They are:

- the primary clock, as defined by the FOSC1:FOSC0 configuration bits
- the secondary clock (Timer1 oscillator)
- · the internal oscillator

3.1.2 ENTERING POWER-MANAGED MODES

Switching from one power-managed mode to another begins by loading the OSCCON register. The SCS1:SCS0 bits select the clock source and determine which Run or Idle mode is to be used. Changing these bits causes an immediate switch to the new clock source, assuming that it is running. The switch may also be subject to clock transition delays. These are discussed in **Section 3.1.3** "Clock Transitions and Status Indicators" and subsequent sections.

Entry to the power-managed Idle or Sleep modes is triggered by the execution of a SLEEP instruction. The actual mode that results depends on the status of the IDLEN bit.

Depending on the current mode and the mode being switched to, a change to a power-managed mode does not always require setting all of these bits. Many transitions may be done by changing the oscillator select bits, or changing the IDLEN bit, prior to issuing a SLEEP instruction. If the IDLEN bit is already configured correctly, it may only be necessary to perform a SLEEP instruction to switch to the desired mode.

TABLE 3-1: POWER-MANAGED MODES

Mode	oso	CCON bits	Modul	e Clocking	Available Clock and Oscillator Source	
Wode	IDLEN<7>(1)	SCS1:SCS0<1:0>	CPU Peripherals		Available Clock and Oscillator Source	
Sleep	0	N/A	Off	Off	None – All clocks are disabled	
PRI_RUN	N/A	10	Clocked		Primary – HS, EC; this is the normal full power execution mode	
SEC_RUN	N/A	01	Clocked	Clocked	Secondary – Timer1 Oscillator	
RC_RUN	N/A	11	Clocked	Clocked	Internal Oscillator	
PRI_IDLE	1	10	Off	Clocked	Primary – HS, EC	
SEC_IDLE	1	01	Off	Clocked	Secondary – Timer1 Oscillator	
RC_IDLE	1	11	Off	Clocked	Internal Oscillator	

Note 1: IDLEN reflects its value when the SLEEP instruction is executed.

3.1.3 CLOCK TRANSITIONS AND STATUS INDICATORS

The length of the transition between clock sources is the sum of two cycles of the old clock source and three to four cycles of the new clock source. This formula assumes that the new clock source is stable.

Two bits indicate the current clock source and its status: OSTS (OSCCON<3>) and T1RUN (T1CON<6>). In general, only one of these bits will be set while in a given power-managed mode. When the OSTS bit is set, the primary clock is providing the device clock. When the T1RUN bit is set, the Timer1 oscillator is providing the clock. If neither of these bits is set, INTRC is clocking the device.

Note:

Executing a SLEEP instruction does not necessarily place the device into Sleep mode. It acts as the trigger to place the controller into either the Sleep mode or one of the Idle modes, depending on the setting of the IDLEN bit.

3.1.4 MULTIPLE SLEEP COMMANDS

The power-managed mode that is invoked with the SLEEP instruction is determined by the setting of the IDLEN bit at the time the instruction is executed. If another SLEEP instruction is executed, the device will enter the power-managed mode specified by IDLEN at that time. If IDLEN has changed, the device will enter the new power-managed mode specified by the new setting.

3.2 Run Modes

In the Run modes, clocks to both the core and peripherals are active. The difference between these modes is the clock source.

3.2.1 PRI RUN MODE

The PRI_RUN mode is the normal, full power execution mode of the microcontroller. This is also the default mode upon a device Reset unless Two-Speed Start-up is enabled (see **Section 20.4 "Two-Speed Start-up"** for details). In this mode, the OSTS bit is set. (see **Section 2.6.1 "Oscillator Control Register"**).

3.2.2 SEC RUN MODE

The SEC_RUN mode is the compatible mode to the "clock switching" feature offered in other PIC18 devices. In this mode, the CPU and peripherals are clocked from the Timer1 oscillator. This gives users the option of lower power consumption while still using a high-accuracy clock source.

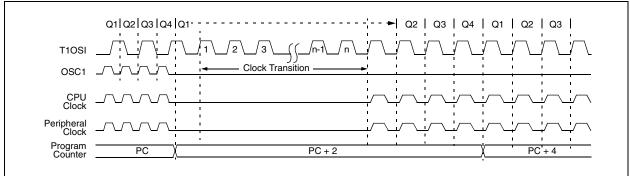
SEC_RUN mode is entered by setting the SCS1:SCS0 bits to '01'. The device clock source is switched to the Timer1 oscillator (see Figure 3-1), the primary oscillator is shut down, the T1RUN bit (T1CON<6>) is set and the OSTS bit is cleared.

Note:

The Timer1 oscillator should already be running prior to entering SEC_RUN mode. If the T1OSCEN bit is not set when the SCS1:SCS0 bits are set to '01', entry to SEC_RUN mode will not occur. If the Timer1 oscillator is enabled, but not yet running, device clocks will be delayed until the oscillator has started. In such situations, initial oscillator operation is far from stable and unpredictable operation may result.

On transitions from SEC_RUN mode to PRI_RUN mode, the peripherals and CPU continue to be clocked from the Timer1 oscillator while the primary clock is started. When the primary clock becomes ready, a clock switch back to the primary clock occurs (see Figure 3-2). When the clock switch is complete, the T1RUN bit is cleared, the OSTS bit is set and the primary clock is providing the clock. The IDLEN and SCS bits are not affected by the wake-up; the Timer1 oscillator continues to run.





3.2.3 RC RUN MODE

In RC_RUN mode, the CPU and peripherals are clocked from the internal oscillator; the primary clock is shut down. This mode provides the best power conservation of all the Run modes, while still executing code. It works well for user applications which are not highly timing-sensitive or do not require high-speed clocks at all times.

This mode is entered by setting SCS to '11'. When the clock source is switched to the INTRC (see Figure 3-2), the primary oscillator is shut down and the OSTS bit is cleared.

On transitions from RC_RUN mode to PRI_RUN mode, the device continues to be clocked from the INTRC while the primary clock is started. When the primary clock becomes ready, a clock switch to the primary clock occurs (see Figure 3-3). When the clock switch is complete, the OSTS bit is set and the primary clock is providing the device clock. The IDLEN and SCS bits are not affected by the switch. The INTRC source will continue to run if either the WDT or the Fail-Safe Clock Monitor is enabled.



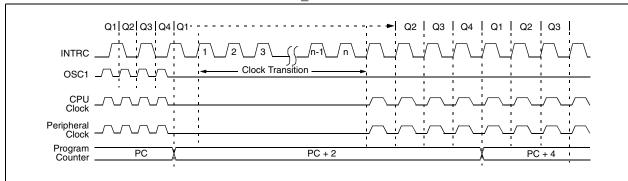
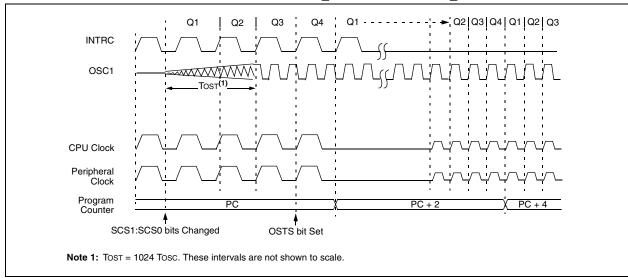


FIGURE 3-3: TRANSITION TIMING FROM RC_RUN MODE TO PRI_RUN MODE



3.3 Sleep Mode

The power-managed Sleep mode is identical to the legacy Sleep mode offered in all other PICmicro devices. It is entered by clearing the IDLEN bit (the default state on device Reset) and executing the SLEEP instruction. This shuts down the selected oscillator (Figure 3-4). All clock source status bits are cleared.

Entering the Sleep mode from any other mode does not require a clock switch. This is because no clocks are needed once the controller has entered Sleep. If the WDT is selected, the INTRC source will continue to operate. If the Timer1 oscillator is enabled, it will also continue to run.

When a wake event occurs in Sleep mode (by interrupt, Reset or WDT time-out), the device will not be clocked until the clock source selected by the SCS1:SCS0 bits becomes ready (see Figure 3-5), or it will be clocked from the internal oscillator if either the Two-Speed Start-up or the Fail-Safe Clock Monitor are enabled (see Section 20.0 "Special Features of the CPU"). In either case, the OSTS bit is set when the primary clock is providing the device clocks. The IDLEN and SCS bits are not affected by the wake-up.

3.4 Idle Modes

The Idle modes allow the controller's CPU to be selectively shut down while the peripherals continue to operate. Selecting a particular Idle mode allows users to further manage power consumption.

If the IDLEN bit is set to a '1' when a SLEEP instruction is executed, the peripherals will be clocked from the clock source selected using the SCS1:SCS0 bits; however, the CPU will not be clocked. The clock source status bits are not affected. Setting IDLEN and executing a SLEEP instruction provides a quick method of switching from a given Run mode to its corresponding Idle mode.

If the WDT is selected, the INTRC source will continue to operate. If the Timer1 oscillator is enabled, it will also continue to run.

Since the CPU is not executing instructions, the only exits from any of the Idle modes are by interrupt, WDT time-out or a Reset. When a wake event occurs, CPU execution is delayed by an interval of TCSD (parameter 38, Table 23-10) while it becomes ready to execute code. When the CPU begins executing code, it resumes with the same clock source for the current Idle mode. For example, when waking from RC_IDLE mode, the internal oscillator block will clock the CPU and peripherals (in other words, RC_RUN mode). The IDLEN and SCS bits are not affected by the wake-up.

While in any Idle mode or the Sleep mode, a WDT time-out will result in a WDT wake-up to the Run mode currently specified by the SCS1:SCS0 bits.

FIGURE 3-4: TRANSITION TIMING FOR ENTRY TO SLEEP MODE

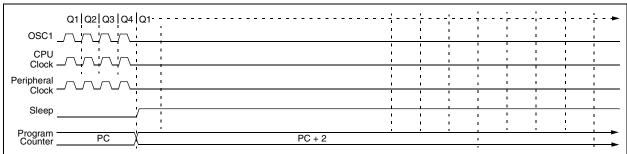
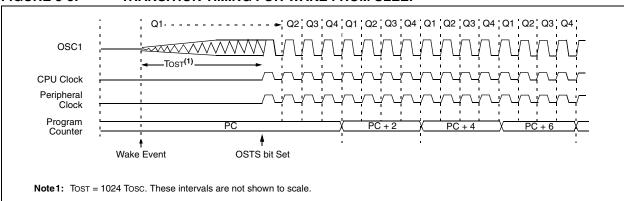


FIGURE 3-5: TRANSITION TIMING FOR WAKE FROM SLEEP



3.4.1 PRI IDLE MODE

This mode is unique among the three low-power Idle modes, in that it does not disable the primary device clock. For timing-sensitive applications, this allows for the fastest resumption of device operation with its more accurate primary clock source, since the clock source does not have to "warm up" or transition from another oscillator.

PRI_IDLE mode is entered from PRI_RUN mode by setting the IDLEN bit and executing a SLEEP instruction. If the device is in another Run mode, set IDLEN first, then set the SCS bits to '10' and execute SLEEP. Although the CPU is disabled, the peripherals continue to be clocked from the primary clock source specified by the FOSC0 configuration bit. The OSTS bit remains set (see Figure 3-6).

When a wake event occurs, the CPU is clocked from the primary clock source. A delay of interval TCSD is required between the wake event and when code execution starts. This is required to allow the CPU to become ready to execute instructions. After the wake-up, the OSTS bit remains set. The IDLEN and SCS bits are not affected by the wake-up (see Figure 3-7).

3.4.2 SEC IDLE MODE

In SEC_IDLE mode, the CPU is disabled but the peripherals continue to be clocked from the Timer1 oscillator. This mode is entered from SEC_RUN by setting the IDLEN bit and executing a SLEEP instruction. If the device is in another Run mode, set IDLEN first, then set SCS1:SCS0 to '01' and execute SLEEP. When the clock source is switched to the Timer1 oscillator, the primary oscillator is shut-down, the OSTS bit is cleared and the T1RUN bit is set.

When a wake event occurs, the peripherals continue to be clocked from the Timer1 oscillator. After an interval of TCSD following the wake event, the CPU begins executing code being clocked by the Timer1 oscillator. The IDLEN and SCS bits are not affected by the wake-up; the Timer1 oscillator continues to run (see Figure 3-7).

Note: The Timer1 oscillator should already be running prior to entering SEC_IDLE mode. If the T1OSCEN bit is not set when the SLEEP instruction is executed, the SLEEP instruction will be ignored and entry to SEC_IDLE mode will not occur. If the Timer1 oscillator is enabled, but not yet running, peripheral clocks will be delayed until the oscillator has started. In such situations, initial oscillator operation is far from stable and unpredictable operation may result.



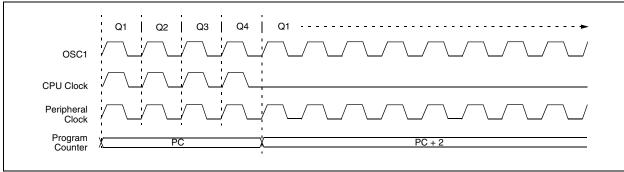
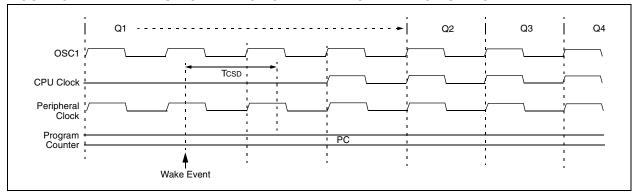


FIGURE 3-7: TRANSITION TIMING FOR WAKE FROM IDLE TO RUN MODE



3.4.3 RC IDLE MODE

In RC_IDLE mode, the CPU is disabled but the peripherals continue to be clocked from the internal oscillator. This mode allows for controllable power conservation during Idle periods.

From RC_RUN, this mode is entered by setting the IDLEN bit and executing a SLEEP instruction. If the device is in another Run mode, first set IDLEN, then clear the SCS bits and execute SLEEP. When the clock source is switched to the INTRC, the primary oscillator is shut down and the OSTS bit is cleared.

When a wake event occurs, the peripherals continue to be clocked from the INTRC. After a delay of TCSD following the wake event, the CPU begins executing code being clocked by the INTRC. The IDLEN and SCS bits are not affected by the wake-up. The INTRC source will continue to run if either the WDT or the Fail-Safe Clock Monitor is enabled.

3.5 Exiting Idle and Sleep Modes

An exit from Sleep mode, or any of the Idle modes, is triggered by an interrupt, a Reset or a WDT time-out. This section discusses the triggers that cause exits from power-managed modes. The clocking subsystem actions are discussed in each of the power-managed modes sections (see Section 3.2 "Run Modes", Section 3.3 "Sleep Mode" and Section 3.4 "Idle Modes").

3.5.1 EXIT BY INTERRUPT

Any of the available interrupt sources can cause the device to exit from an Idle mode, or the Sleep mode, to a Run mode. To enable this functionality, an interrupt source must be enabled by setting its enable bit in one of the INTCON or PIE registers. The exit sequence is initiated when the corresponding interrupt flag bit is set.

On all exits from Idle or Sleep modes by interrupt, code execution branches to the interrupt vector if the GIE/GIEH bit (INTCON<7>) is set. Otherwise, code execution continues or resumes without branching (see **Section 8.0 "Interrupts"**).

A fixed delay of interval TCSD following the wake event is required when leaving Sleep and Idle modes. This delay is required for the CPU to prepare for execution. Instruction execution resumes on the first clock cycle following this delay.

3.5.2 EXIT BY WDT TIME-OUT

A WDT time-out will cause different actions depending on which power-managed mode the device is in when the time-out occurs.

If the device is not executing code (all Idle modes and Sleep mode), the time-out will result in an exit from the power-managed mode (see Section 3.2 "Run Modes" and Section 3.3 "Sleep Mode"). If the device is executing code (all Run modes), the time-out will result in a WDT Reset (see Section 20.2 "Watchdog Timer (WDT)").

The WDT timer and postscaler are cleared by one of the following events:

- executing a SLEEP or CLRWDT instruction
- the loss of a currently selected clock source (if the Fail-Safe Clock Monitor is enabled)

3.5.3 EXIT BY RESET

Exiting an Idle or Sleep mode by Reset automatically forces the device to run from the INTRC.

3.5.4 EXIT WITHOUT AN OSCILLATOR START-UP DELAY

Certain exits from power-managed modes do not invoke the OST at all. There are two cases:

- PRI_IDLE mode where the primary clock source is not stopped; and
- the primary clock source is the EC mode.

In these instances, the primary clock source either does not require an oscillator start-up delay, since it is already running (PRI_IDLE), or normally does not require an oscillator start-up delay (EC). However, a fixed delay of interval TCSD following the wake event is still required when leaving Sleep and Idle modes to allow the CPU to prepare for execution. Instruction execution resumes on the first clock cycle following this delay.

4.0 RESET

The PIC18F45J10 family of devices differentiate between various kinds of Reset:

- a) Power-on Reset (POR)
- b) MCLR Reset during normal operation
- c) MCLR Reset during power-managed modes
- d) Watchdog Timer (WDT) Reset (during execution)
- e) Brown-out Reset (BOR)
- f) RESET Instruction
- g) Stack Full Reset
- h) Stack Underflow Reset

This section discusses Resets generated by MCLR, POR and BOR and covers the operation of the various start-up timers. Stack Reset events are covered in Section 5.1.2.4 "Stack Full and Underflow Resets". WDT Resets are covered in Section 20.2 "Watchdog Timer (WDT)".

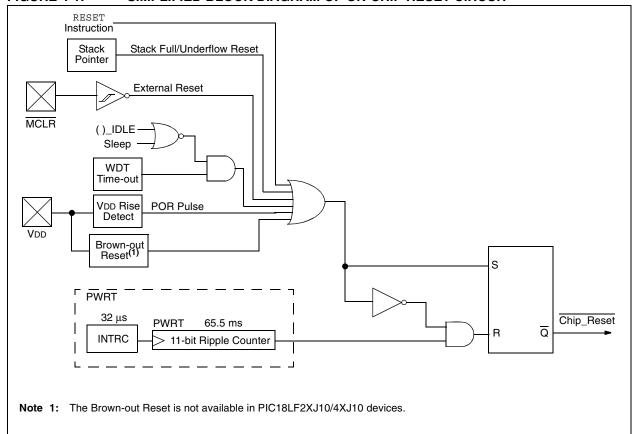
A simplified block diagram of the On-Chip Reset Circuit is shown in Figure 4-1.

4.1 RCON Register

Device Reset events are tracked through the RCON register (Register 4-1). The lower five bits of the register indicate that a specific Reset event has occurred. In most cases, these bits can only be set by the event and must be cleared by the application after the event. The state of these flag bits, taken together, can be read to indicate the type of Reset that just occurred. This is described in more detail in **Section 4.6 "Reset State of Registers"**.

The RCON register also has a control bit for setting interrupt priority (IPEN). Interrupt priority is discussed in **Section 8.0 "Interrupts"**.

FIGURE 4-1: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT



REGISTER 4-1: RCON: RESET CONTROL REGISTER

R/W-0	U-0	U-0	R/W-1	R-1	R-1	R/W-0	R/W-0
IPEN	_	_	RI	TO	PD	POR	BOR
bit 7							bit 0

bit 0

- bit 7 IPEN: Interrupt Priority Enable bit
 - 1 = Enable priority levels on interrupts
 - 0 = Disable priority levels on interrupts (PIC16CXXX Compatibility mode)
- bit 6-5 Unimplemented: Read as '0'
- bit 4 RI: RESET Instruction Flag bit
 - 1 = The RESET instruction was not executed (set by firmware only)
 - 0 = The RESET instruction was executed causing a device Reset (must be set in software after a Brown-out Reset occurs)
- bit 3 TO: Watchdog Time-out Flag bit
 - 1 = Set by power-up, CLRWDT instruction or SLEEP instruction
 - 0 = A WDT time-out occurred
- bit 2 PD: Power-Down Detection Flag bit
 - 1 = Set by power-up or by the CLRWDT instruction
 - 0 = Set by execution of the SLEEP instruction
- bit 1 POR: Power-on Reset Status bit
 - 1 = A Power-on Reset has not occurred (set by firmware only)
 - 0 = A Power-on Reset occurred (must be set in software after a Power-on Reset occurs)
- bit 0 **BOR:** Brown-out Reset Status bit
 - 1 = A Brown-out Reset has not occurred (set by firmware only)
 - 0 = A Brown-out Reset occurred (must be set in software after a Brown-out Reset occurs)

BOR is not available in PIC18LF2XJ10/4XJ10 devices. Note:

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

- Note 1: It is recommended that the POR bit be set after a Power-on Reset has been detected, so that subsequent Power-on Resets may be detected.
 - 2: If the on-chip voltage regulator is disabled, BOR remains '0' at all times. See Section 4.4.1 "Detecting BOR" for more information.
 - 3: Brown-out Reset is said to have occurred when BOR is '0' and POR is '1' (assuming that \overline{POR} was set to '1' by software immediately after POR).

4.2 Master Clear (MCLR)

The MCLR pin provides a method for triggering a hard external Reset of the device. A Reset is generated by holding the pin low. PIC18 extended microcontroller devices have a noise filter in the MCLR Reset path which detects and ignores small pulses.

The $\overline{\text{MCLR}}$ pin is not driven low by any internal Resets, including the WDT.

4.3 Power-on Reset (POR)

A Power-on Reset condition is generated on-chip whenever VDD rises above a certain threshold. This allows the device to start in the initialized state when VDD is adequate for operation.

To take advantage of the POR circuitry, tie the \overline{MCLR} pin through a resistor (1 k Ω to 10 k Ω) to VDD. This will eliminate external RC components usually needed to create a Power-on Reset delay. A minimum rise rate for VDD is specified (parameter D004). For a slow rise time, see Figure 4-2.

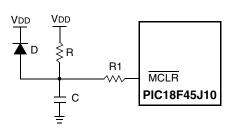
When the device starts normal operation (i.e., exits the Reset condition), device operating parameters (voltage, frequency, temperature, etc.) must be met to ensure operation. If these conditions are not met, the device must be held in Reset until the operating conditions are met.

POR events are captured by the POR bit (RCON<1>). The state of the bit is set to '0' whenever a POR occurs; it does not change for any other Reset event. POR is not reset to '1' by any hardware event. To capture multiple events, the user manually resets the bit to '1' in software following any POR.

4.4 Brown-out Reset (BOR) (PIC18F2XJ10/4XJ10 Devices Only)

Once a BOR has occurred, the Power-up Timer will keep the chip in Reset for TPWRT (parameter 33). If VDD drops below VBOR while the Power-up Timer is running, the chip will go back into a Brown-out Reset and the Power-up Timer will be initialized. Once VDD rises above VBOR, the Power-up Timer will execute the additional time delay.

FIGURE 4-2: EXTERNAL POWER-ON RESET CIRCUIT (FOR SLOW VDD POWER-UP)



- Note 1: External Power-on Reset circuit is required only if the VDD power-up slope is too slow. The diode D helps discharge the capacitor quickly when VDD powers down.
 - 2: $R < 40 \text{ k}\Omega$ is recommended to make sure that the voltage drop across R does not violate the device's electrical specification.
 - 3: $R1 \ge 1$ k Ω will limit any current flowing into \overline{MCLR} from external capacitor C, in the event of \overline{MCLR} pin breakdown, due to Electrostatic Discharge (ESD) or Electrical Overstress (EOS).

4.4.1 DETECTING BOR

The BOR bit always resets to '0' on any BOR or POR event. This makes it difficult to determine if a BOR event has occurred just by reading the state of BOR alone. A more reliable method is to simultaneously check the state of both POR and BOR. This assumes that the POR bit is reset to '1' in software immediately after any POR event. If BOR is '0' while POR is '1', it can be reliably assumed that a BOR event has occurred.

In devices designated with an "LF" part number (such as PIC18LF25J10), Brown-out Reset functionality is disabled. In this case, the BOR bit cannot be used to determine a BOR event. The BOR bit is still cleared by a POR event.

4.5 Power-up Timer (PWRT)

PIC18F45J10 family devices incorporate an on-chip Power-up Timer (PWRT) to help regulate the Power-on Reset process. The PWRT is always enabled. The main function is to ensure that the device voltage is stable before code is executed.

The Power-up Timer (PWRT) of the PIC18F45J10 family devices is an 11-bit counter which uses the INTRC source as the clock input. This yields an approximate time interval of 2048 x 32 $\mu s = 65.6$ ms. While the PWRT is counting, the device is held in Reset.

The power-up time delay depends on the INTRC clock and will vary from chip to chip due to temperature and process variation. See DC parameter 33 for details.

4.5.1 TIME-OUT SEQUENCE

If enabled, the PWRT time-out is invoked after the POR pulse has cleared. The total time-out will vary based on the status of the PWRT. Figure 4-3, Figure 4-4, Figure 4-5 and Figure 4-6 all depict time-out sequences on power-up with the Power-up Timer enabled.

Since the time-outs occur from the POR pulse, if MCLR is kept low long enough, the PWRT will expire. Bringing MCLR high will begin execution immediately (Figure 4-5). This is useful for testing purposes, or to synchronize more than one PIC18F device operating in parallel.



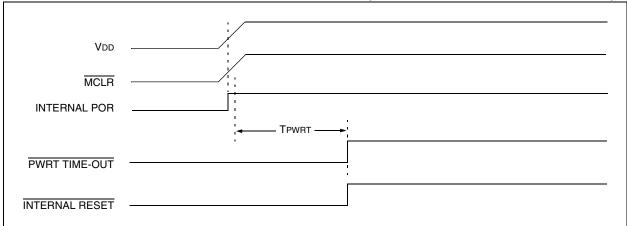


FIGURE 4-4: TIME-OUT SEQUENCE ON POWER-UP (MCLR NOT TIED TO VDD): CASE 1

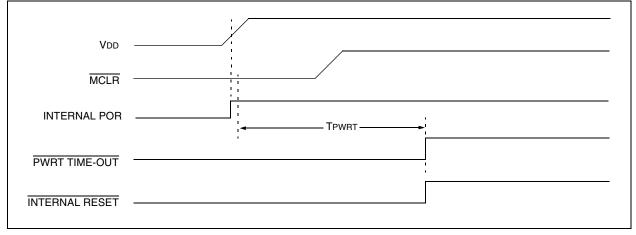


FIGURE 4-5: TIME-OUT SEQUENCE ON POWER-UP (MCLR NOT TIED TO VDD): CASE 2

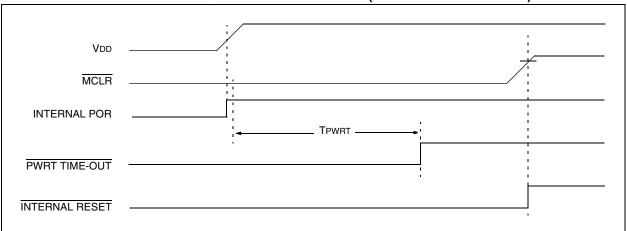
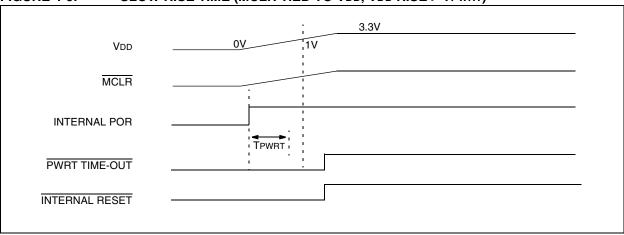


FIGURE 4-6: SLOW RISE TIME (MCLR TIED TO VDD, VDD RISE > TPWRT)



4.6 Reset State of Registers

Most registers are unaffected by a Reset. Their status is unknown on POR and unchanged by all other Resets. The other registers are forced to a "Reset state" depending on the type of Reset that occurred.

Most registers are not affected by a WDT wake-up, since this is viewed as the resumption of normal operation. Status bits from the RCON register, $\overline{\text{RI}}$, $\overline{\text{TO}}$, $\overline{\text{PD}}$, $\overline{\text{POR}}$ and $\overline{\text{BOR}}$, are set or cleared differently in different Reset situations, as indicated in Table 4-1. These bits are used in software to determine the nature of the Reset.

Table 4-2 describes the Reset states for all of the Special Function Registers. These are categorized by Power-on and Brown-out Resets, Master Clear and WDT Resets and WDT wake-ups.

TABLE 4-1: STATUS BITS, THEIR SIGNIFICANCE AND THE INITIALIZATION CONDITION FOR RCON REGISTER

	Program		RC	ON Regi	ster		STKPTR Register	
Condition	Counter ⁽¹⁾	RI	TO	PD	POR	BOR ⁽²⁾	STKFUL	STKUNF
Power-on Reset	0000h	1	1	1	0	0	0	0
RESET instruction	0000h	0	u	u	u	u	u	u
Brown-out	0000h	1	1	1	u	0	u	u
MCLR during power-managed Run modes	0000h	u	1	u	u	u	u	u
MCLR during power-managed Idle modes and Sleep mode	0000h	u	1	0	u	u	u	u
WDT time-out during full power or power-managed Run modes	0000h	u	0	u	u	u	u	u
MCLR during full power execution	0000h	u	u	u	u	u	u	u
Stack Full Reset (STVREN = 1)	0000h	u	u	u	u	u	1	u
Stack Underflow Reset (STVREN = 1)	0000h	u	u	u	u	u	u	1
Stack Underflow Error (not an actual Reset, STVREN = 0)	0000h	u	u	u	u	u	u	1
WDT time-out during power-managed Idle or Sleep modes	PC + 2	u	0	0	u	u	u	u
Interrupt exit from power-managed modes	PC + 2	u	u	0	u	u	u	u

Legend: u = unchanged

Note 1: When the wake-up is due to an interrupt and the GIEH or GIEL bits are set, the PC is loaded with the interrupt vector (0008h or 0018h).

2: BOR is not available in PIC18LF2XJ10/4XJ10 devices.

TABLE 4-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS

Register	Applicable Devices		Power-on Reset, Brown-out Reset	MCLR Resets WDT Reset RESET Instruction Stack Resets	Wake-up via WDT or Interrupt
TOSU	PIC18F2XJ10	PIC18F4XJ10	0 0000	0 0000	0 uuuu (1)
TOSH	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	uuuu uuuu(1)
TOSL	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	uuuu uuuu ⁽¹⁾
STKPTR	PIC18F2XJ10	PIC18F4XJ10	00-0 0000	uu-0 0000	uu-u uuuu ⁽¹⁾
PCLATU	PIC18F2XJ10	PIC18F4XJ10	0 0000	0 0000	u uuuu
PCLATH	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	uuuu uuuu
PCL	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	PC + 2 ⁽²⁾
TBLPTRU	PIC18F2XJ10	PIC18F4XJ10	00 0000	00 0000	uu uuuu
TBLPTRH	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	uuuu uuuu
TBLPTRL	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	uuuu uuuu
TABLAT	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	uuuu uuuu
PRODH	PIC18F2XJ10	PIC18F4XJ10	xxxx xxxx	uuuu uuuu	uuuu uuuu
PRODL	PIC18F2XJ10	PIC18F4XJ10	xxxx xxxx	uuuu uuuu	uuuu uuuu
INTCON	PIC18F2XJ10	PIC18F4XJ10	0000 000x	0000 000u	uuuu uuuu(3)
INTCON2	PIC18F2XJ10	PIC18F4XJ10	1111 -1-1	1111 -1-1	uuuu -u-u ⁽³⁾
INTCON3	PIC18F2XJ10	PIC18F4XJ10	11-0 0-00	11-0 0-00	uu-u u-uu ⁽³⁾
INDF0	PIC18F2XJ10	PIC18F4XJ10	N/A	N/A	N/A
POSTINC0	PIC18F2XJ10	PIC18F4XJ10	N/A	N/A	N/A
POSTDEC0	PIC18F2XJ10	PIC18F4XJ10	N/A	N/A	N/A
PREINC0	PIC18F2XJ10	PIC18F4XJ10	N/A	N/A	N/A
PLUSW0	PIC18F2XJ10	PIC18F4XJ10	N/A	N/A	N/A
FSR0H	PIC18F2XJ10	PIC18F4XJ10	xxxx	uuuu	uuuu
FSR0L	PIC18F2XJ10	PIC18F4XJ10	xxxx xxxx	uuuu uuuu	uuuu uuuu
WREG	PIC18F2XJ10	PIC18F4XJ10	xxxx xxxx	uuuu uuuu	uuuu uuuu
INDF1	PIC18F2XJ10	PIC18F4XJ10	N/A	N/A	N/A
POSTINC1	PIC18F2XJ10	PIC18F4XJ10	N/A	N/A	N/A
POSTDEC1	PIC18F2XJ10	PIC18F4XJ10	N/A	N/A	N/A
PREINC1	PIC18F2XJ10	PIC18F4XJ10	N/A	N/A	N/A
PLUSW1	PIC18F2XJ10	PIC18F4XJ10	N/A	N/A	N/A
FSR1H	PIC18F2XJ10	PIC18F4XJ10	xxxx	uuuu	uuuu
FSR1L	PIC18F2XJ10	PIC18F4XJ10	xxxx xxxx	uuuu uuuu	uuuu uuuu
BSR	PIC18F2XJ10	PIC18F4XJ10	0000	0000	uuuu

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', <math>q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

- 3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
- 4: See Table 4-1 for Reset value for specific condition.

Note 1: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

^{2:} When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).

TABLE 4-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register	Applicable Devices		Power-on Reset, Brown-out Reset	MCLR Resets WDT Reset RESET Instruction Stack Resets	Wake-up via WDT or Interrupt	
INDF2	PIC18F2XJ10	PIC18F4XJ10	N/A	N/A	N/A	
POSTINC2	PIC18F2XJ10	PIC18F4XJ10	N/A	N/A	N/A	
POSTDEC2	PIC18F2XJ10	PIC18F4XJ10	N/A	N/A	N/A	
PREINC2	PIC18F2XJ10	PIC18F4XJ10	N/A	N/A	N/A	
PLUSW2	PIC18F2XJ10	PIC18F4XJ10	N/A	N/A	N/A	
FSR2H	PIC18F2XJ10	PIC18F4XJ10	xxxx	uuuu	uuuu	
FSR2L	PIC18F2XJ10	PIC18F4XJ10	xxxx xxxx	uuuu uuuu	uuuu uuuu	
STATUS	PIC18F2XJ10	PIC18F4XJ10	x xxxx	u uuuu	u uuuu	
TMR0H	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	uuuu uuuu	
TMR0L	PIC18F2XJ10	PIC18F4XJ10	xxxx xxxx	uuuu uuuu	uuuu uuuu	
T0CON	PIC18F2XJ10	PIC18F4XJ10	1111 1111	1111 1111	uuuu uuuu	
OSCCON	PIC18F2XJ10	PIC18F4XJ10	0 d-00	0 d-00	u q-uu	
WDTCON	PIC18F2XJ10	PIC18F4XJ10	0	0	u	
RCON ⁽⁴⁾	PIC18F2XJ10	PIC18F4XJ10	01 11q0	0q qquu	uu qquu	
TMR1H	PIC18F2XJ10	PIC18F4XJ10	xxxx xxxx	uuuu uuuu	uuuu uuuu	
TMR1L	PIC18F2XJ10	PIC18F4XJ10	xxxx xxxx	uuuu uuuu	uuuu uuuu	
T1CON	PIC18F2XJ10	PIC18F4XJ10	0000 0000	u0uu uuuu	uuuu uuuu	
TMR2	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	uuuu uuuu	
PR2	PIC18F2XJ10	PIC18F4XJ10	1111 1111	1111 1111	1111 1111	
T2CON	PIC18F2XJ10	PIC18F4XJ10	-000 0000	-000 0000	-uuu uuuu	
SSP1BUF	PIC18F2XJ10	PIC18F4XJ10	xxxx xxxx	uuuu uuuu	uuuu uuuu	
SSP1ADD	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	uuuu uuuu	
SSP1STAT	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	uuuu uuuu	
SSP1CON1	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	uuuu uuuu	
SSP1CON2	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	uuuu uuuu	
ADRESH	PIC18F2XJ10	PIC18F4XJ10	xxxx xxxx	uuuu uuuu	uuuu uuuu	
ADRESL	PIC18F2XJ10	PIC18F4XJ10	xxxx xxxx	uuuu uuuu	uuuu uuuu	
ADCON0	PIC18F2XJ10	PIC18F4XJ10	0-00 0000	0-00 0000	u-uu uuuu	
ADCON1	PIC18F2XJ10	PIC18F4XJ10	00 0qqq	00 0qqq	uu uqqq	
ADCON2	PIC18F2XJ10	PIC18F4XJ10	0-00 0000	0-00 0000	u-uu uuuu	

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', <math>q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

- 2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).
- 3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
- 4: See Table 4-1 for Reset value for specific condition.

Note 1: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

TABLE 4-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register	Applicable Devices		Power-on Reset, Brown-out Reset	MCLR Resets WDT Reset RESET Instruction Stack Resets	Wake-up via WDT or Interrupt
CCPR1H	PIC18F2XJ10	PIC18F4XJ10	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCPR1L	PIC18F2XJ10	PIC18F4XJ10	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP1CON	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	uuuu uuuu
CCPR2H	PIC18F2XJ10	PIC18F4XJ10	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCPR2L	PIC18F2XJ10	PIC18F4XJ10	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP2CON	PIC18F2XJ10	PIC18F4XJ10	00 0000	00 0000	uu uuuu
BAUDCON	PIC18F2XJ10	PIC18F4XJ10	01-0 0-00	01-0 0-00	uu-u u-uu
ECCP1DEL	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	uuuu uuuu
ECCP1AS	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	uuuu uuuu
CVRCON	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	uuuu uuuu
CMCON	PIC18F2XJ10	PIC18F4XJ10	0000 0111	0000 0111	uuuu uuuu
SPBRGH	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	uuuu uuuu
SPBRG	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	uuuu uuuu
RCREG	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	uuuu uuuu
TXREG	PIC18F2XJ10	PIC18F4XJ10	xxxx xxxx	uuuu uuuu	uuuu uuuu
TXSTA	PIC18F2XJ10	PIC18F4XJ10	0000 0010	0000 0010	uuuu uuuu
RCSTA	PIC18F2XJ10	PIC18F4XJ10	0000 000x	0000 000x	uuuu uuuu
EECON2	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	uuuu uuuu
EECON1	PIC18F2XJ10	PIC18F4XJ10	0 x00-	0 x00-	u uuu-
IPR3	PIC18F2XJ10	PIC18F4XJ10	11	11	uu
PIR3	PIC18F2XJ10	PIC18F4XJ10	00	00	uu (3)
PIE3	PIC18F2XJ10	PIC18F4XJ10	00	00	uu
IPR2	PIC18F2XJ10	PIC18F4XJ10	11 11	11 11	uu uu
PIR2	PIC18F2XJ10	PIC18F4XJ10	00 00	00 00	uu uu ⁽³⁾
PIE2	PIC18F2XJ10	PIC18F4XJ10	00 00	00 00	uu uu
IPR1	PIC18F2XJ10	PIC18F4XJ10	1111 1111	1111 1111	uuuu uuuu
PIR1	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	uuuu uuuu(3)
PIE1	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	uuuu uuuu

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', <math>q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

- **Note 1:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.
 - 2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).
 - 3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
 - 4: See Table 4-1 for Reset value for specific condition.

TABLE 4-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register	Applicable Devices		Power-on Reset, Brown-out Reset	MCLR Resets WDT Reset RESET Instruction Stack Resets	Wake-up via WDT or Interrupt
TRISE	PIC18F2XJ10	PIC18F4XJ10	0000 -111	1111 -111	uuuu -uuu
TRISD	PIC18F2XJ10	PIC18F4XJ10	1111 1111	1111 1111	uuuu uuuu
TRISC	PIC18F2XJ10	PIC18F4XJ10	1111 1111	1111 1111	uuuu uuuu
TRISB	PIC18F2XJ10	PIC18F4XJ10	1111 1111	1111 1111	uuuu uuuu
TRISA	PIC18F2XJ10	PIC18F4XJ10	1- 1111	1- 1111	u- uuuu
SSP2BUF	PIC18F2XJ10	PIC18F4XJ10	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATE	PIC18F2XJ10	PIC18F4XJ10	xxx	uuu	uuu
LATD	PIC18F2XJ10	PIC18F4XJ10	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATC	PIC18F2XJ10	PIC18F4XJ10	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATB	PIC18F2XJ10	PIC18F4XJ10	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATA	PIC18F2XJ10	PIC18F4XJ10	x- xxxx	u- uuuu	u- uuuu
SSP2ADD	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	uuuu uuuu
SSP2STAT	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	uuuu uuuu
SSP2CON1	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	uuuu uuuu
SSP2CON2	PIC18F2XJ10	PIC18F4XJ10	0000 0000	0000 0000	uuuu uuuu
PORTE	PIC18F2XJ10	PIC18F4XJ10	xxx	uuu	uuu
PORTD	PIC18F2XJ10	PIC18F4XJ10	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTC	PIC18F2XJ10	PIC18F4XJ10	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTB	PIC18F2XJ10	PIC18F4XJ10	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTA	PIC18F2XJ10	PIC18F4XJ10	0- 0000	0- 0000	u- uuuu

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', <math>q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

- **Note 1:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.
 - 2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).
 - 3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
 - 4: See Table 4-1 for Reset value for specific condition.

5.0 MEMORY ORGANIZATION

There are two types of memory in PIC18 Enhanced microcontroller devices:

- Program Memory
- Data RAM

As Harvard architecture devices, the data and program memories use separate busses; this allows for concurrent access of the two memory spaces.

Additional detailed information on the operation of the Flash program memory is provided in **Section 6.0** "Flash Program Memory".

5.1 Program Memory Organization

PIC18 microcontrollers implement a 21-bit program counter, which is capable of addressing a 2-Mbyte program memory space. Accessing a location between the upper boundary of the physically implemented memory and the 2-Mbyte address will return all '0's (a NOP instruction).

The PIC18F24J10 and PIC18F44J10 each have 16 Kbytes of Flash memory and can store up to 8,192 single-word instructions. The PIC18F25J10 and PIC18F45J10 each have 32 Kbytes of Flash memory and can store up to 16,384 single-word instructions.

PIC18 devices have two interrupt vectors. The Reset vector address is at 0000h and the interrupt vector addresses are at 0008h and 0018h.

The program memory map for the PIC18F45J10 family devices is shown in Figure 5-1.

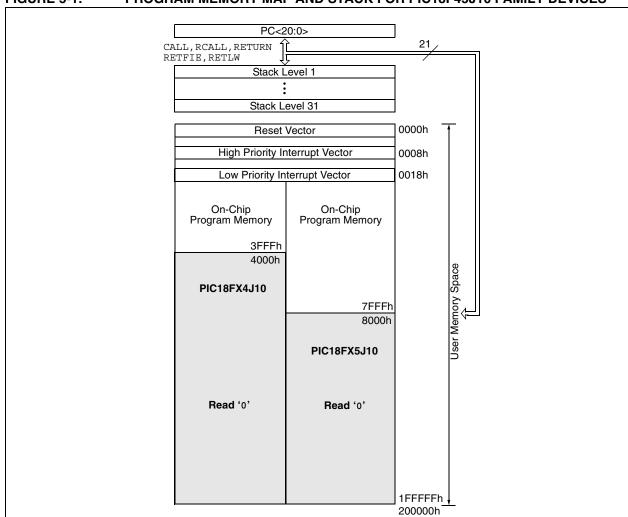


FIGURE 5-1: PROGRAM MEMORY MAP AND STACK FOR PIC18F45J10 FAMILY DEVICES

5.1.1 PROGRAM COUNTER

The Program Counter (PC) specifies the address of the instruction to fetch for execution. The PC is 21 bits wide and is contained in three separate 8-bit registers. The low byte, known as the PCL register, is both readable and writable. The high byte, or PCH register, contains the PC<15:8> bits; it is not directly readable or writable. Updates to the PCH register are performed through the PCLATH register. The upper byte is called PCU. This register contains the PC<20:16> bits; it is also not directly readable or writable. Updates to the PCU register are performed through the PCLATU register.

The contents of PCLATH and PCLATU are transferred to the program counter by any operation that writes PCL. Similarly, the upper two bytes of the program counter are transferred to PCLATH and PCLATU by an operation that reads PCL. This is useful for computed offsets to the PC (see Section 5.1.4.1 "Computed GOTO").

The PC addresses bytes in the program memory. To prevent the PC from becoming misaligned with word instructions, the Least Significant bit of PCL is fixed to a value of '0'. The PC increments by 2 to address sequential instructions in the program memory.

The CALL, RCALL, GOTO and program branch instructions write to the program counter directly. For these instructions, the contents of PCLATH and PCLATU are not transferred to the program counter.

5.1.2 RETURN ADDRESS STACK

The return address stack allows any combination of up to 31 program calls and interrupts to occur. The PC is pushed onto the stack when a CALL or RCALL instruction is executed or an interrupt is Acknowledged. The PC value is pulled off the stack on a RETURN, RETLW or RETFIE instruction. PCLATU and PCLATH are not affected by any of the RETURN or CALL instructions.

The stack operates as a 31-word by 21-bit RAM and a 5-bit Stack Pointer, STKPTR. The stack space is not part of either program or data space. The Stack Pointer is readable and writable and the address on the top of the stack is readable and writable through the top-ofstack Special File Registers. Data can also be pushed to, or popped from the stack, using these registers.

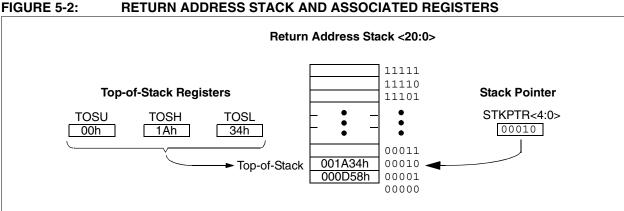
A CALL type instruction causes a push onto the stack; the Stack Pointer is first incremented and the location pointed to by the Stack Pointer is written with the contents of the PC (already pointing to the instruction following the CALL). A RETURN type instruction causes a pop from the stack; the contents of the location pointed to by the STKPTR are transferred to the PC and then the Stack Pointer is decremented.

The Stack Pointer is initialized to '00000' after all Resets. There is no RAM associated with the location corresponding to a Stack Pointer value of '00000': this is only a Reset value. Status bits indicate if the stack is full or has overflowed or has underflowed.

5.1.2.1 Top-of-Stack Access

Only the top of the return address stack (TOS) is readable and writable. A set of three registers, TOSU:TOSH:TOSL, hold the contents of the stack location pointed to by the STKPTR register (Figure 5-2). This allows users to implement a software stack if necessary. After a CALL, RCALL or interrupt, the software can read the pushed value by reading the TOSU:TOSH:TOSL registers. These values can be placed on a user-defined software stack. At return time, the software can return these values to TOSU:TOSH:TOSL and do a return.

The user must disable the global interrupt enable bits while accessing the stack to prevent inadvertent stack corruption.



5.1.2.2 Return Stack Pointer (STKPTR)

The STKPTR register (Register 5-1) contains the Stack Pointer value, the STKFUL (Stack Overflow) status bit and the STKUNF (Stack Underflow) status bits. The value of the Stack Pointer can be 0 through 31. The Stack Pointer increments before values are pushed onto the stack and decrements after values are popped off the stack. On Reset, the Stack Pointer value will be zero. The user may read and write the Stack Pointer value. This feature can be used by a Real-Time Operating System (RTOS) for return stack maintenance.

After the PC is pushed onto the stack 31 times (without popping any values off the stack), the STKFUL bit is set. The STKFUL bit is cleared by software or by a POR.

The action that takes place when the stack becomes full depends on the state of the STVREN (Stack Overflow Reset Enable) configuration bit. (Refer to Section 20.1 "Configuration Bits" for a description of the device configuration bits.) If STVREN is set (default), the 31st push will push the (PC + 2) value onto the stack, set the STKFUL bit and reset the device. The STKFUL bit will remain set and the Stack Pointer will be set to zero.

If STVREN is cleared, the STKFUL bit will be set on the 31st push and the Stack Pointer will increment to 31. Any additional pushes will not overwrite the 31st push and the STKPTR will remain at 31.

When the stack has been popped enough times to unload the stack, the next pop will return a value of zero to the PC and sets the STKUNF bit, while the Stack Pointer remains at zero. The STKUNF bit will remain set until cleared by software or until a POR occurs.

Note: Returning a value of zero to the PC on an underflow has the effect of vectoring the program to the Reset vector, where the stack conditions can be verified and appropriate actions can be taken. This is not the same as a Reset, as the contents of the SFRs are not affected.

5.1.2.3 PUSH and POP Instructions

Since the Top-of-Stack is readable and writable, the ability to push values onto the stack and pull values off the stack without disturbing normal program execution is a desirable feature. The PIC18 instruction set includes two instructions, PUSH and POP, that permit the TOS to be manipulated under software control. TOSU, TOSH and TOSL can be modified to place data or a return address on the stack.

The PUSH instruction places the current PC value onto the stack. This increments the Stack Pointer and loads the current PC value onto the stack.

The POP instruction discards the current TOS by decrementing the Stack Pointer. The previous value pushed onto the stack then becomes the TOS value.

REGISTER 5-1: STKPTR: STACK POINTER REGISTER

R/C-0	R/C-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
STKFUL ⁽¹⁾	STKUNF ⁽¹⁾	_	SP4	SP3	SP2	SP1	SP0
bit 7							hit 0

bit 7 STKFUL: Stack Overflow Flag bit⁽¹⁾

1 = Stack became full or overflowed

0 = Stack has not become full or overflowed

bit 6 STKUNF: Stack Underflow Flag bit⁽¹⁾

1 = Stack underflow occurred

0 = Stack underflow did not occur

bit 5 **Unimplemented:** Read as '0'

bit 4-0 SP4:SP0: Stack Pointer Location bits

Note 1: Bit 7 and bit 6 are cleared by user software or by a POR.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	C = Clearable only bit
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

5.1.2.4 Stack Full and Underflow Resets

Device Resets on stack overflow and stack underflow conditions are enabled by setting the STVREN bit in Configuration Register 4L. When STVREN is set, a full or underflow will set the appropriate STKFUL or STKUNF bit and then cause a device Reset. When STVREN is cleared, a full or underflow condition will set the appropriate STKFUL or STKUNF bit but not cause a device Reset. The STKFUL or STKUNF bits are cleared by the user software or a Power-on Reset.

5.1.3 FAST REGISTER STACK

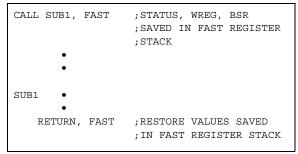
A fast register stack is provided for the STATUS, WREG and BSR registers, to provide a "fast return" option for interrupts. The stack for each register is only one level deep and is neither readable nor writable. It is loaded with the current value of the corresponding register when the processor vectors for an interrupt. All interrupt sources will push values into the stack registers. The values in the registers are then loaded back into their associated registers if the RETFIE, FAST instruction is used to return from the interrupt.

If both low and high priority interrupts are enabled, the stack registers cannot be used reliably to return from low priority interrupts. If a high priority interrupt occurs while servicing a low priority interrupt, the stack register values stored by the low priority interrupt will be overwritten. In these cases, users must save the key registers in software during a low priority interrupt.

If interrupt priority is not used, all interrupts may use the fast register stack for returns from interrupt. If no interrupts are used, the fast register stack can be used to restore the STATUS, WREG and BSR registers at the end of a subroutine call. To use the fast register stack for a subroutine call, a CALL label, FAST instruction must be executed to save the STATUS, WREG and BSR registers to the fast register stack. A RETURN, FAST instruction is then executed to restore these registers from the fast register stack.

Example 5-1 shows a source code example that uses the fast register stack during a subroutine call and return.

EXAMPLE 5-1: FAST REGISTER STACK CODE EXAMPLE



5.1.4 LOOK-UP TABLES IN PROGRAM MEMORY

There may be programming situations that require the creation of data structures, or look-up tables, in program memory. For PIC18 devices, look-up tables can be implemented in two ways:

- Computed GOTO
- Table Reads

5.1.4.1 Computed GOTO

A computed GOTO is accomplished by adding an offset to the program counter. An example is shown in Example 5-2.

A look-up table can be formed with an ADDWF PCL instruction and a group of RETLW $\,\mathrm{nn}$ instructions. The W register is loaded with an offset into the table before executing a call to that table. The first instruction of the called routine is the ADDWF PCL instruction. The next instruction executed will be one of the RETLW $\,\mathrm{nn}$ instructions that returns the value ' $\,\mathrm{nn}$ ' to the calling function.

The offset value (in WREG) specifies the number of bytes that the program counter should advance and should be multiples of 2 (LSb = 0).

In this method, only one data byte may be stored in each instruction location and room on the return address stack is required.

EXAMPLE 5-2: COMPUTED GOTO USING AN OFFSET VALUE

	MOVF CALL	OFFSET,	W
ORG	nn00h		
TABLE	ADDWF	PCL	
	RETLW	nnh	
	RETLW	nnh	
	RETLW	nnh	
	•		

5.1.4.2 Table Reads and Table Writes

A better method of storing data in program memory allows two bytes of data to be stored in each instruction location.

Look-up table data may be stored two bytes per program word by using table reads and writes. The Table Pointer (TBLPTR) register specifies the byte address and the Table Latch (TABLAT) register contains the data that is read from or written to program memory. Data is transferred to or from program memory one byte at a time.

Table read and table write operations are discussed further in Section 6.1 "Table Reads and Table Writes".

5.2 PIC18 Instruction Cycle

5.2.1 CLOCKING SCHEME

The microcontroller clock input, whether from an internal or external source, is internally divided by four to generate four non-overlapping quadrature clocks (Q1, Q2, Q3 and Q4). Internally, the program counter is incremented on every Q1; the instruction is fetched from the program memory and latched into the instruction register during Q4. The instruction is decoded and executed during the following Q1 through Q4. The clocks and instruction execution flow are shown in Figure 5-3.

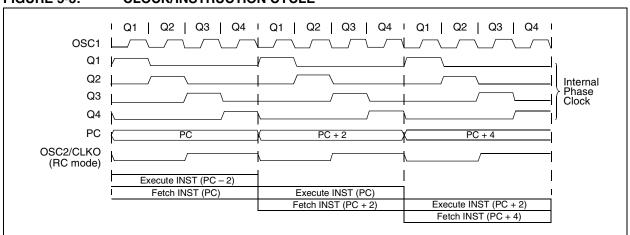
5.2.2 INSTRUCTION FLOW/PIPELINING

An "Instruction Cycle" consists of four Q cycles: Q1 through Q4. The instruction fetch and execute are pipelined in such a manner that a fetch takes one instruction cycle, while the decode and execute take another instruction cycle. However, due to the pipelining, each instruction effectively executes in one cycle. If an instruction causes the program counter to change (e.g., GOTO), then two cycles are required to complete the instruction (Example 5-3).

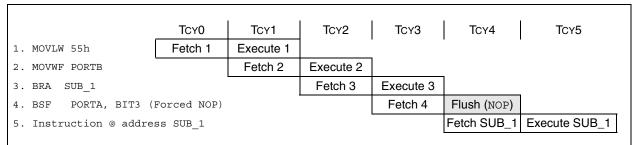
A fetch cycle begins with the Program Counter (PC) incrementing in Q1.

In the execution cycle, the fetched instruction is latched into the Instruction Register (IR) in cycle Q1. This instruction is then decoded and executed during the Q2, Q3 and Q4 cycles. Data memory is read during Q2 (operand read) and written during Q4 (destination write).





EXAMPLE 5-3: INSTRUCTION PIPELINE FLOW



All instructions are single cycle, except for any program branches. These take two cycles since the fetch instruction is "flushed" from the pipeline while the new instruction is being fetched and then executed.

5.2.3 INSTRUCTIONS IN PROGRAM MEMORY

The program memory is addressed in bytes. Instructions are stored as two bytes or four bytes in program memory. The Least Significant Byte of an instruction word is always stored in a program memory location with an even address (LSb = 0). To maintain alignment with instruction boundaries, the PC increments in steps of 2 and the LSb will always read '0' (see **Section 5.1.1** "**Program Counter**").

Figure 5-4 shows an example of how instruction words are stored in the program memory.

The CALL and GOTO instructions have the absolute program memory address embedded into the instruction. Since instructions are always stored on word boundaries, the data contained in the instruction is a word address. The word address is written to PC<20:1>, which accesses the desired byte address in program memory. Instruction #2 in Figure 5-4 shows how the instruction, GOTO 0006h, is encoded in the program memory. Program branch instructions, which encode a relative address offset, operate in the same manner. The offset value stored in a branch instruction represents the number of single-word instructions that the PC will be offset by. Section 21.0 "Instruction Set Summary" provides further details of the instruction set.

FIGURE 5-4: INSTRUCTIONS IN PROGRAM MEMORY

					Word Address
			LSB = 1	LSB = 0	\downarrow
	Program M	1emory			000000h
	Byte Locat	ions \rightarrow			000002h
					000004h
					000006h
Instruction 1:	MOVLW	055h	0Fh	55h	000008h
Instruction 2:	GOTO	0006h	EFh	03h	00000Ah
			F0h	00h	00000Ch
Instruction 3:	MOVFF	123h, 456h	C1h	23h	00000Eh
			F4h	56h	000010h
					000012h
					000014h

5.2.4 TWO-WORD INSTRUCTIONS

The standard PIC18 instruction set has four two-word instructions: CALL, MOVFF, GOTO and LSFR. In all cases, the second word of the instructions always has '1111' as its four Most Significant bits; the other 12 bits are literal data, usually a data memory address.

The use of '1111' in the 4 MSbs of an instruction specifies a special form of NOP. If the instruction is executed in proper sequence – immediately after the first word – the data in the second word is accessed and used by

the instruction sequence. If the first word is skipped for some reason and the second word is executed by itself, a \mathtt{NOP} is executed instead. This is necessary for cases when the two-word instruction is preceded by a conditional instruction that changes the PC. Example 5-4 shows how this works.

Note: See Section 5.6 "PIC18 Instruction Execution and the Extended Instruction Set" for information on two-word instructions in the extended instruction set.

EXAMPLE 5-4: TWO-WORD INSTRUCTIONS

CASE 1:		
Object Code	Source Code	
0110 0110 0000 0000	TSTFSZ REG1	; is RAM location 0?
1100 0001 0010 0011	MOVFF REG1, REG2	; No, skip this word
1111 0100 0101 0110		; Execute this word as a NOP
0010 0100 0000 0000	ADDWF REG3	; continue code
CASE 2:		
Object Code	Source Code	
0110 0110 0000 0000	TSTFSZ REG1	; is RAM location 0?
1100 0001 0010 0011	MOVFF REG1, REG2	; Yes, execute this word
1111 0100 0101 0110		; 2nd word of instruction
0010 0100 0000 0000	ADDWF REG3	; continue code

5.3 Data Memory Organization

Note:

The operation of some aspects of data memory are changed when the PIC18 extended instruction set is enabled. See Section 5.5 "Data Memory and the Extended Instruction Set" for more information.

The data memory in PIC18 devices is implemented as static RAM. Each register in the data memory has a 12-bit address, allowing up to 4096 bytes of data memory. The memory space is divided into as many as 16 banks that contain 256 bytes each; PIC18F45J10 family devices implement all 16 banks. Figure 5-5 shows the data memory organization for the PIC18F45J10 family devices.

The data memory contains Special Function Registers (SFRs) and General Purpose Registers (GPRs). The SFRs are used for control and status of the controller and peripheral functions, while GPRs are used for data storage and scratchpad operations in the user's application. Any read of an unimplemented location will read as '0's.

The instruction set and architecture allow operations across all banks. The entire data memory may be accessed by Direct, Indirect or Indexed Addressing modes. Addressing modes are discussed later in this subsection.

To ensure that commonly used registers (SFRs and select GPRs) can be accessed in a single cycle, PIC18 devices implement an Access Bank. This is a 256-byte memory space that provides fast access to SFRs and the lower portion of GPR Bank 0 without using the BSR. **Section 5.3.2 "Access Bank"** provides a detailed description of the Access RAM.

5.3.1 BANK SELECT REGISTER (BSR)

Large areas of data memory require an efficient addressing scheme to make rapid access to any address possible. Ideally, this means that an entire address does not need to be provided for each read or write operation. For PIC18 devices, this is accomplished with a RAM banking scheme. This divides the memory space into 16 contiguous banks of 256 bytes. Depending on the instruction, each location can be addressed directly by its full 12-bit address, or an 8-bit low-order address and a 4-bit bank pointer.

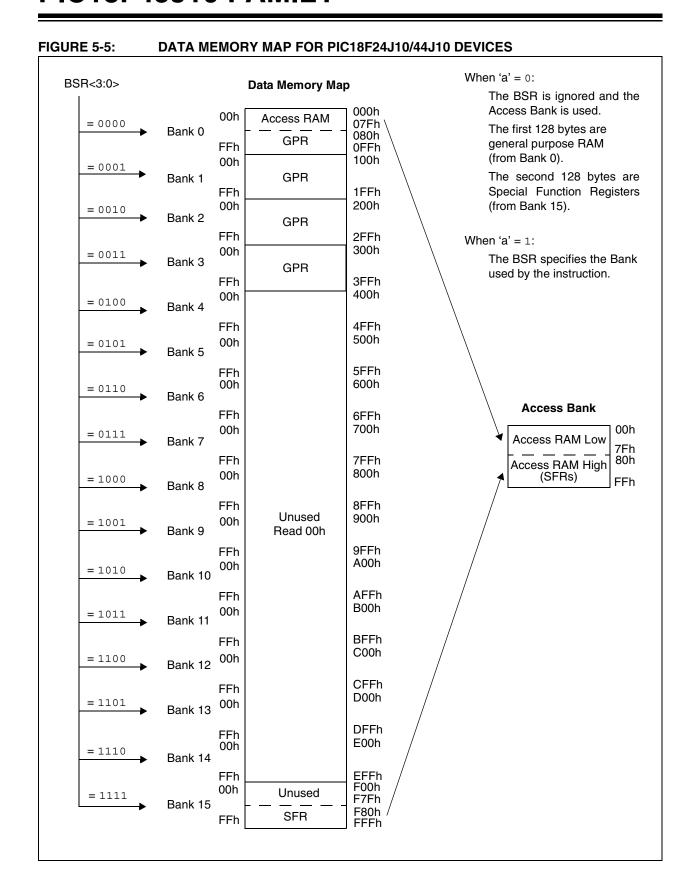
Most instructions in the PIC18 instruction set make use of the bank pointer, known as the Bank Select Register (BSR). This SFR holds the 4 Most Significant bits of a location's address; the instruction itself includes the 8 Least Significant bits. Only the four lower bits of the BSR are implemented (BSR3:BSR0). The upper four bits are unused; they will always read '0' and cannot be written to. The BSR can be loaded directly by using the MOVLB instruction.

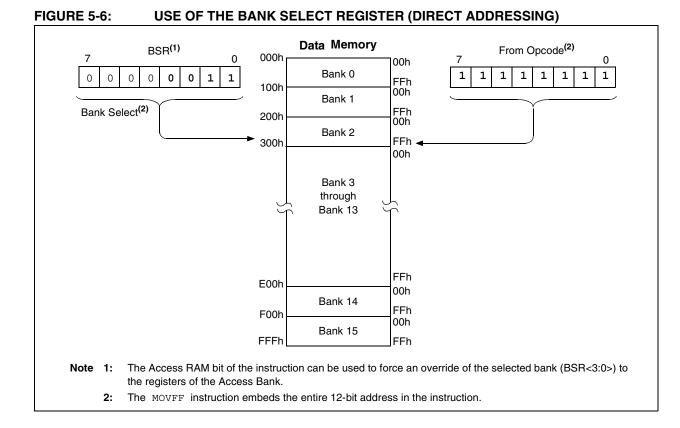
The value of the BSR indicates the bank in data memory. The 8 bits in the instruction show the location in the bank and can be thought of as an offset from the bank's lower boundary. The relationship between the BSR's value and the bank division in data memory is shown in Figure 5-6.

Since up to 16 registers may share the same low-order address, the user must always be careful to ensure that the proper bank is selected before performing a data read or write. For example, writing what should be program data to an 8-bit address of F9h while the BSR is 0Fh will end up resetting the program counter.

While any bank can be selected, only those banks that are actually implemented can be read or written to. Writes to unimplemented banks are ignored, while reads from unimplemented banks will return '0's. Even so, the STATUS register will still be affected as if the operation was successful. The data memory map in Figure 5-5 indicates which banks are implemented.

In the core PIC18 instruction set, only the <code>MOVFF</code> instruction fully specifies the 12-bit address of the source and target registers. This instruction ignores the BSR completely when it executes. All other instructions include only the low-order address as an operand and must use either the BSR or the Access Bank to locate their target registers.





5.3.2 ACCESS BANK

While the use of the BSR with an embedded 8-bit address allows users to address the entire range of data memory, it also means that the user must always ensure that the correct bank is selected. Otherwise, data may be read from or written to the wrong location. This can be disastrous if a GPR is the intended target of an operation but an SFR is written to instead. Verifying and/or changing the BSR for each read or write to data memory can become very inefficient.

To streamline access for the most commonly used data memory locations, the data memory is configured with an Access Bank, which allows users to access a mapped block of memory without specifying a BSR. The Access Bank consists of the first 128 bytes of memory (00h-7Fh) in Bank 0 and the last 128 bytes of memory (80h-FFh) in Block 15. The lower half is known as the "Access RAM" and is composed of GPRs. This upper half is also where the device's SFRs are mapped. These two areas are mapped contiguously in the Access Bank and can be addressed in a linear fashion by an 8-bit address (Figure 5-5).

The Access Bank is used by core PIC18 instructions that include the Access RAM bit (the 'a' parameter in the instruction). When 'a' is equal to '1', the instruction uses the BSR and the 8-bit address included in the opcode for the data memory address. When 'a' is '0',

however, the instruction is forced to use the Access Bank address map; the current value of the BSR is ignored entirely.

Using this "forced" addressing allows the instruction to operate on a data address in a single cycle without updating the BSR first. For 8-bit addresses of 80h and above, this means that users can evaluate and operate on SFRs more efficiently. The Access RAM below 80h is a good place for data values that the user might need to access rapidly, such as immediate computational results or common program variables. Access RAM also allows for faster and more code efficient context saving and switching of variables.

The mapping of the Access Bank is slightly different when the extended instruction set is enabled (XINST configuration bit = 1). This is discussed in more detail in Section 5.5.3 "Mapping the Access Bank in Indexed Literal Offset Mode".

5.3.3 GENERAL PURPOSE REGISTER

PIC18 devices may have banked memory in the GPR area. This is data RAM which is available for use by all instructions. GPRs start at the bottom of Bank 0 (address 000h) and grow upwards towards the bottom of the SFR area. GPRs are not initialized by a Power-on Reset and are unchanged on all other Resets.

5.3.4 SPECIAL FUNCTION REGISTERS

The Special Function Registers (SFRs) are registers used by the CPU and peripheral modules for controlling the desired operation of the device. These registers are implemented as static RAM. SFRs start at the top of data memory (FFFh) and extend downward to occupy the top half of Bank 15 (F80h to FFFh). A list of these registers is given in Table 5-1 and Table 5-2.

The SFRs can be classified into two sets: those associated with the "core" device functionality (ALU, Resets and interrupts) and those related to the peripheral functions. The reset and interrupt registers are described in their respective chapters, while the ALU's STATUS register is described later in this section. Registers related to the operation of a peripheral feature are described in the chapter for that peripheral.

The SFRs are typically distributed among the peripherals whose functions they control. Unused SFR locations are unimplemented and read as '0's.

TABLE 5-1: SPECIAL FUNCTION REGISTER MAP FOR PIC18F45J10 FAMILY DEVICES

Address	Name	Address	Name	Address	Name	Address	Name
FFFh	TOSU	FDFh	INDF2 ⁽¹⁾	FBFh	CCPR1H	F9Fh	IPR1
FFEh	TOSH	FDEh	POSTINC2 ⁽¹⁾	FBEh	CCPR1L	F9Eh	PIR1
FFDh	TOSL	FDDh	POSTDEC2 ⁽¹⁾	FBDh	CCP1CON	F9Dh	PIE1
FFCh	STKPTR	FDCh	PREINC2 ⁽¹⁾	FBCh	CCPR2H	F9Ch	(2)
FFBh	PCLATU	FDBh	PLUSW2 ⁽¹⁾	FBBh	CCPR2L	F9Bh	(2)
FFAh	PCLATH	FDAh	FSR2H	FBAh	CCP2CON	F9Ah	(2)
FF9h	PCL	FD9h	FSR2L	FB9h	(2)	F99h	(2)
FF8h	TBLPTRU	FD8h	STATUS	FB8h	BAUDCON	F98h	(2)
FF7h	TBLPTRH	FD7h	TMR0H	FB7h	ECCP1DEL(3)	F97h	(2)
FF6h	TBLPTRL	FD6h	TMR0L	FB6h	ECCP1AS ⁽³⁾	F96h	TRISE ⁽³⁾
FF5h	TABLAT	FD5h	T0CON	FB5h	CVRCON	F95h	TRISD ⁽³⁾
FF4h	PRODH	FD4h	(2)	FB4h	CMCON	F94h	TRISC
FF3h	PRODL	FD3h	OSCCON	FB3h	(2)	F93h	TRISB
FF2h	INTCON	FD2h	(2)	FB2h	(2)	F92h	TRISA
FF1h	INTCON2	FD1h	WDTCON	FB1h	(2)	F91h	(2)
FF0h	INTCON3	FD0h	RCON	FB0h	SPBRGH	F90h	(2)
FEFh	INDF0 ⁽¹⁾	FCFh	TMR1H	FAFh	SPBRG	F8Fh	(2)
FEEh	POSTINCO ⁽¹⁾	FCEh	TMR1L	FAEh	RCREG	F8Eh	SSP2BUF
FEDh	POSTDEC0 ⁽¹⁾	FCDh	T1CON	FADh	TXREG	F8Dh	LATE ⁽³⁾
FECh	PREINC0 ⁽¹⁾	FCCh	TMR2	FACh	TXSTA	F8Ch	LATD ⁽³⁾
FEBh	PLUSW0 ⁽¹⁾	FCBh	PR2	FABh	RCSTA	F8Bh	LATC
FEAh	FSR0H	FCAh	T2CON	FAAh	(2)	F8Ah	LATB
FE9h	FSR0L	FC9h	SSP1BUF	FA9h	(2)	F89h	LATA
FE8h	WREG	FC8h	SSP1ADD	FA8h	(2)	F88h	SSP2ADD ⁽³⁾
FE7h	INDF1 ⁽¹⁾	FC7h	SSP1STAT	FA7h	EECON2 ⁽¹⁾	F87h	SSP2STAT ⁽³⁾
FE6h	POSTINC1 ⁽¹⁾	FC6h	SSP1CON1	FA6h	EECON1	F86h	SSP2CON1 ⁽³⁾
FE5h	POSTDEC1 ⁽¹⁾	FC5h	SSP1CON2	FA5h	IPR3	F85h	SSP2CON2 ⁽³⁾
FE4h	PREINC1 ⁽¹⁾	FC4h	ADRESH	FA4h	PIR3	F84h	PORTE ⁽³⁾
FE3h	PLUSW1 ⁽¹⁾	FC3h	ADRESL	FA3h	PIE3	F83h	PORTD ⁽³⁾
FE2h	FSR1H	FC2h	ADCON0	FA2h	IPR2	F82h	PORTC
FE1h	FSR1L	FC1h	ADCON1	FA1h	PIR2	F81h	PORTB
FE0h	BSR	FC0h	ADCON2	FA0h	PIE2	F80h	PORTA

Note 1: This is not a physical register.

- 2: Unimplemented registers are read as '0'.
- 3: This register is not available in 28-pin devices.

TABLE 5-2: REGISTER FILE SUMMARY (PIC18F24J10/25J10/44J10/45J10)

File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Details on page:
TOSU	_			Top-of-Stack	Upper Byte (T	OS<20:16>)			0 0000	43, 48
TOSH	Top-of-Stack	High Byte (TO	S<15:8>)	•					0000 0000	43, 48
TOSL	Top-of-Stack	Low Byte (TOS	S<7:0>)						0000 0000	43, 48
STKPTR	STKFUL	STKUNF	_	Return Stack	Pointer				00-0 0000	43, 49
PCLATU	_		_	Holding Regis	ster for PC<20):16>			0 0000	43, 48
PCLATH	Holding Regis	ster for PC<15	:8>						0000 0000	43, 48
PCL	PC Low Byte	(PC<7:0>)							0000 0000	43, 48
TBLPTRU	_	_	bit 21	Program Mer	nory Table Po	nter Upper By	te (TBLPTR<2	20:16>)	00 0000	43, 70
TBLPTRH	Program Men	nory Table Poi	nter High Byte	e (TBLPTR<15	i:8>)				0000 0000	43, 70
TBLPTRL	Program Men	nory Table Poi	nter Low Byte	(TBLPTR<7:0)>)				0000 0000	43, 70
TABLAT	Program Men	nory Table Late	ch						0000 0000	43, 70
PRODH	Product Regis	ster High Byte							xxxx xxxx	43, 77
PRODL	Product Regis	ster Low Byte							xxxx xxxx	43, 77
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	0000 000x	43, 81
INTCON2	RBPU	INTEDG0	INTEDG1	INTEDG2	_	TMR0IP	_	RBIP	1111 -1-1	43, 82
INTCON3	INT2IP	INT1IP		INT2IE	INT1IE	_	INT2IF	INT1IF	11-0 0-00	43, 83
INDF0	Uses content	s of FSR0 to a	ddress data n	nemory – value	e of FSR0 not	changed (not	a physical reg	ister)	N/A	43, 62
POSTINC0	Uses content	s of FSR0 to a	ddress data n	nemory – value	e of FSR0 pos	t-incremented	(not a physica	ıl register)	N/A	43, 62
POSTDEC0	Uses content	s of FSR0 to a	ddress data n	nemory – value	e of FSR0 pos	t-decremented	l (not a physic	al register)	N/A	43, 62
PREINC0	Uses contents of FSR0 to address data memory – value of FSR0 pre-incremented (not a physical register)							N/A	43, 62	
PLUSW0	Uses contents of FSR0 to address data memory – value of FSR0 pre-incremented (not a physical register) – value of FSR0 offset by W							N/A	43, 62	
FSR0H	_	ı	I	_	Indirect Data	Memory Addr	ess Pointer 0 I	High Byte	xxxx	43, 62
FSR0L	Indirect Data	Memory Addre	ess Pointer 0	Low Byte					xxxx xxxx	43, 62
WREG	Working Regi	ster							xxxx xxxx	43
INDF1	Uses content	s of FSR1 to a	ddress data n	nemory – value	e of FSR1 not	changed (not	a physical reg	ister)	N/A	43, 62
POSTINC1	Uses content	s of FSR1 to a	ddress data n	nemory – value	e of FSR1 pos	t-incremented	(not a physica	ıl register)	N/A	43, 62
POSTDEC1	Uses content	s of FSR1 to a	ddress data n	nemory – value	e of FSR1 pos	t-decremented	l (not a physic	al register)	N/A	43, 62
PREINC1	Uses content	s of FSR1 to a	ddress data n	nemory – value	e of FSR1 pre-	incremented (not a physical	register)	N/A	43, 62
PLUSW1	Uses content value of FSR		ddress data n	nemory – value	e of FSR1 pre-	incremented (not a physical	register) –	N/A	43, 62
FSR1H	_	_	-	_	Indirect Data	Memory Addr	ess Pointer 1 I	High Byte	xxxx	43, 62
FSR1L	Indirect Data	Memory Addre	ess Pointer 1	Low Byte					xxxx xxxx	43, 62
BSR	_	ı	I	_	Bank Select I	Register			0000	43, 53
INDF2	Uses content	s of FSR2 to a	ddress data n	nemory – value	e of FSR2 not	changed (not	a physical reg	ister)	N/A	44, 62
POSTINC2	Uses content	s of FSR2 to a	ddress data n	nemory – value	e of FSR2 pos	t-incremented	(not a physica	ıl register)	N/A	44, 62
POSTDEC2	Uses content	s of FSR2 to a	ddress data n	nemory – value	e of FSR2 pos	t-decremented	l (not a physic	al register)	N/A	44, 62
PREINC2	Uses content	s of FSR2 to a	ddress data n	nemory – value	e of FSR2 pre-	incremented (not a physical	register)	N/A	44, 62
PLUSW2	Uses content value of FSR		ddress data n	nemory – value	e of FSR2 pre-	incremented (not a physical	register) –	N/A	44, 62
FSR2H		_	_		Indirect Data	Memory Addr	ess Pointer 2 I	ligh Byte	xxxx	44, 62
FSR2L	Indirect Data	Memory Addre	ess Pointer 2	Low Byte					xxxx xxxx	44, 62
STATUS		_	_	N	OV	Z	DC	С	x xxxx	44, 60

 $\textbf{Legend:} \qquad x = \text{unknown}, \, u = \text{unchanged}, \, \text{-} = \text{unimplemented}, \, q = \text{value depends on condition}$

Note 1: See Section 4.4 "Brown-out Reset (BOR) (PIC18F2XJ10/4XJ10 Devices Only)".

^{2:} These registers and/or bits are not implemented on 28-pin devices and are read as '0'. Reset values are shown for 40/44-pin devices; individual unimplemented bits should be interpreted as '-'.

TABLE 5-2: REGISTER FILE SUMMARY (PIC18F24J10/25J10/44J10/45J10) (CONTINUED)

File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Details on page:
TMR0H	Timer0 Regis	ter High Byte							0000 0000	44, 113
TMR0L	Timer0 Regis	ter Low Byte							xxxx xxxx	44, 113
T0CON	TMR0ON	T08BIT	T0CS	T0SE	PSA	T0PS2	T0PS1	T0PS0	1111 1111	44, 111
OSCCON	IDLEN	_	_	_	OSTS	_	SCS1	SCS0	0 q-00	28, 44
WDTCON	_	1	1	ı	_	-	_	SWDTEN	0	44, 235
RCON	IPEN	-	1	RI	TO	PD	POR	BOR ⁽¹⁾	01 11q0	38, 42, 90
TMR1H	Timer1 Regis	ter High Byte							xxxx xxxx	44, 119
TMR1L	Timer1 Regis	ter Low Byte							xxxx xxxx	44, 119
T1CON	RD16	T1RUN	T1CKPS1	T1CKPS0	T10SCEN	T1SYNC	TMR1CS	TMR10N	0000 0000	44, 115
TMR2	Timer2 Regis	ter			•		•		0000 0000	44, 122
PR2	Timer2 Period	d Register							1111 1111	44, 122
T2CON	_	T2OUTPS3	T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	44, 121
SSP1BUF	MSSP1 Rece	ive Buffer/Trai	nsmit Register		•		•		xxxx xxxx	44, 154
SSP1ADD	MSSP1 Addr	ess Register ir	ı I ² C™ Slave	mode. MSSP1	Baud Rate R	eload Registe	r in I ² C Master	mode.	0000 0000	44, 155
SSP1STAT	SMP	CKE	D/Ā	Р	S	R/W	UA	BF	0000 0000	44, 146, 156
SSP1CON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	44, 147, 157
SSP1CON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	0000 0000	44, 158
ADRESH	A/D Result Re	egister High B	yte						xxxx xxxx	44, 218
ADRESL	A/D Result Re	egister Low By	rte						xxxx xxxx	44, 218
ADCON0	ADCAL	-	CHS3	CHS2	CHS1	CHS0	GO/DONE	ADON	0-00 0000	44, 209
ADCON1	_	_	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0	00 0qqq	44, 210
ADCON2	ADFM	ı	ACQT2	ACQT1	ACQT0	ADCS2	ADCS1	ADCS0	0-00 0000	44, 211
CCPR1H	Capture/Com	pare/PWM Re	gister 1 High I	Byte					xxxx xxxx	45, 124
CCPR1L	Capture/Com	pare/PWM Re	gister 1 Low E	Byte					xxxx xxxx	45, 124
CCP1CON	P1M1 ⁽²⁾	P1M0 ⁽²⁾	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0	0000 0000	45, 123,
CCPR2H	Capture/Com	pare/PWM Re	gister 2 High I	Byte					xxxx xxxx	45, 124
CCPR2L	Capture/Com	pare/PWM Re	gister 2 Low E	Byte					xxxx xxxx	45, 124
CCP2CON	_	_	DC2B1	DC2B0	CCP2M3	CCP2M2	CCP2M1	CCP2M0	00 0000	45, 123
BAUDCON	ABDOVF	RCIDL	_	SCKP	BRG16	_	WUE	ABDEN	01-0 0-00	45, 190
ECCP1DEL	PRSEN	PDC6 ⁽²⁾	PDC5 ⁽²⁾	PDC4 ⁽²⁾	PDC3 ⁽²⁾	PDC2 ⁽²⁾	PDC1 ⁽²⁾	PDC0 ⁽²⁾	0000 0000	45, 140
ECCP1AS	ECCPASE	ECCPAS2	ECCPAS1	ECCPAS0	PSSAC1	PSSAC0	PSSBD1 ⁽²⁾	PSSBD0 ⁽²⁾	0000 0000	45, 141
CVRCON	CVREN	CVROE	CVRR	CVRSS	CVR3	CVR2	CVR1	CVR0	0000 0000	45, 225
CMCON	C2OUT	C1OUT	C2INV	C1INV	CIS	CM2	CM1	CM0	0000 0111	45, 219

 $\textbf{Legend:} \qquad x = \text{unknown, } u = \text{unchanged, } - = \text{unimplemented, } q = \text{value depends on condition}$

Note 1: See Section 4.4 "Brown-out Reset (BOR) (PIC18F2XJ10/4XJ10 Devices Only)".

^{2:} These registers and/or bits are not implemented on 28-pin devices and are read as '0'. Reset values are shown for 40/44-pin devices; individual unimplemented bits should be interpreted as '-'.

TABLE 5-2: REGISTER FILE SUMMARY (PIC18F24J10/25J10/44J10/45J10) (CONTINUED)

File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Details on page:
SPBRGH	EUSART Bau	ud Rate Gener	ator Register I	High Byte					0000 0000	45, 192
SPBRG	EUSART Baud Rate Generator Register Low Byte								0000 0000	45, 192
RCREG	EUSART Red	ceive Register							0000 0000	45, 199
TXREG	EUSART Trai	nsmit Register	•						xxxx xxxx	45, 197
TXSTA	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	0000 0010	45, 188
RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	0000 000x	45, 189
EECON2	EEPROM Co	ntrol Register	2 (not a physi	cal register)					0000 0000	45, 68
EECON1	_	_	I	FREE	WRERR	WREN	WR	I	0 x00-	45, 69
IPR3	SSP2IP	BCL2IP	_			_	_	-	11	45, 89
PIR3	SSP2IF	BCL2IF	I		I	_	I	I	00	45, 85
PIE3	SSP2IE	BCL2IE	I		I	_	I	I	00	45, 87
IPR2	OSCFIP	CMIP	_	_	BCL1IP	_	_	CCP2IP	11 11	45, 89
PIR2	OSCFIF	CMIF	_	_	BCL1IF	_	_	CCP2IF	00 00	45, 85
PIE2	OSCFIE	CMIE	_	_	BCL1IE	_	_	CCP2IE	00 00	45, 87
IPR1	PSPIP ⁽²⁾	ADIP	RCIP	TXIP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	1111 1111	45, 88
PIR1	PSPIF ⁽²⁾	ADIF	RCIF	TXIF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	0000 0000	45, 84
PIE1	PSPIE ⁽²⁾	ADIE	RCIE	TXIE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	0000 0000	45, 86
TRISE ⁽²⁾	IBF	OBF	IBOV	PSPMODE		TRISE2	TRISE1	TRISE0	1111 -111	46, 107
TRISD ⁽²⁾	PORTD Data Direction Control Register								1111 1111	46, 103
TRISC	PORTC Data Direction Control Register								1111 1111	46, 100
TRISB	PORTB Data	Direction Con	trol Register						1111 1111	46, 97
TRISA	_	_	TRISA5	_	TRISA3	TRISA2	TRISA1	TRISA0	1- 1111	46, 94
SSP2BUF	MSSP2 Rece	eive Buffer/Tra	nsmit Register	r					xxxx xxxx	46, 154
LATE ⁽²⁾	_	_	_	_	_		Latch Registe		xxx	46, 106
LATD ⁽²⁾	PORTD Data	Latch Registe	r (Read and V	Vrite to Data L	atch)				xxxx xxxx	46, 103
LATC	PORTC Data	Latch Registe	r (Read and V	Vrite to Data L	atch)				xxxx xxxx	46, 100
LATB	PORTB Data	Latch Registe	r (Read and V	Vrite to Data La	atch)				xxxx xxxx	46, 97
LATA	_	_	PORTA Data	Latch Registe	r (Read and V	Vrite to Data L	atch)		xx xxxx	46, 94
SSP2ADD	MSSP2 Addr	ess Register in	n I ² C™ Slave	mode. MSSP2	Baud Rate R	eload Registe	r in I ² C Master	mode.	0000 0000	46, 154
SSP2STAT	SMP	CKE	D/Ā	Р	S	R/W	UA	BF	0000 0000	46, 146, 156
SSP2CON1	WCOL	SSPOV	SSPEN	СКР	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	46, 147, 157
SSP2CON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	0000 0000	46, 158
PORTE ⁽²⁾	_	_	_	_	_	RE2 ⁽²⁾	RE1 ⁽²⁾	RE0 ⁽²⁾	xxx	46, 106
PORTD ⁽²⁾	RD7	RD6	RD5	RD4	RD3	RD2	RD1	RD0	xxxx xxxx	46, 103
PORTC	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0	xxxx xxxx	46, 100
PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	xxxx xxxx	46, 97
PORTA	_	_	RA5	_	RA3	RA2	RA1	RA0	0- 0000	46, 94

 $[\]textbf{Legend:} \qquad x = \text{unknown}, \, u = \text{unchanged}, \, \text{-} = \text{unimplemented}, \, q = \text{value depends on condition}$

Note 1: See Section 4.4 "Brown-out Reset (BOR) (PIC18F2XJ10/4XJ10 Devices Only)".

^{2:} These registers and/or bits are not implemented on 28-pin devices and are read as '0'. Reset values are shown for 40/44-pin devices; individual unimplemented bits should be interpreted as '-'.

5.3.5 STATUS REGISTER

The STATUS register, shown in Register 5-2, contains the arithmetic status of the ALU. As with any other SFR, it can be the operand for any instruction.

If the STATUS register is the destination for an instruction that affects the Z, DC, C, OV or N bits, the results of the instruction are not written; instead, the STATUS register is updated according to the instruction performed. Therefore, the result of an instruction with the STATUS register as its destination may be different than intended. As an example, CLRF STATUS will set the Z bit and leave the remaining status bits unchanged ('000u uluu').

It is recommended that only BCF, BSF, SWAPF, MOVFF and MOVWF instructions are used to alter the STATUS register, because these instructions do not affect the Z, C, DC, OV or N bits in the STATUS register.

For other instructions that do not affect Status bits, see the instruction set summaries in Table 21-2 and Table 21-3.

Note:	The	C and	DC bits	opera	ate as the born	ow
	and	digit	borrow	bits,	respectively,	in
	subt	ractior	١.			

REGISTER 5-2: STATUS REGISTER

	U-0	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
Ī	_	_	_	N	OV	Z	DC	С
	bit 7		•			•		bit 0

bit 7-5 Unimplemented: Read as '0'

bit 4 N: Negative bit

This bit is used for signed arithmetic (2's complement). It indicates whether the result was negative (ALU MSB = 1).

- 1 = Result was negative
- 0 = Result was positive
- bit 3 **OV:** Overflow bit

This bit is used for signed arithmetic (2's complement). It indicates an overflow of the 7-bit magnitude which causes the sign bit (bit 7 of the result) to change state.

- 1 = Overflow occurred for signed arithmetic (in this arithmetic operation)
- 0 = No overflow occurred
- bit 2 Z: Zero bit
 - 1 = The result of an arithmetic or logic operation is zero
 - 0 = The result of an arithmetic or logic operation is not zero
- bit 1 **DC:** Digit Carry/borrow bit

For ADDWF, ADDLW, SUBLW and SUBWF instructions:

- 1 = A carry-out from the 4th low-order bit of the result occurred
- 0 = No carry-out from the 4th low-order bit of the result

Note: For borrow, the polarity is reversed. A subtraction is executed by adding the 2's complement of the second operand. For rotate (RRF, RLF) instructions, this bit is loaded with either bit 4 or bit 3 of the source register.

bit 0 C: Carry/borrow bit

For ADDWF, ADDLW, SUBLW and SUBWF instructions:

- 1 = A carry-out from the Most Significant bit of the result occurred
- 0 = No carry-out from the Most Significant bit of the result occurred

Note: For borrow, the polarity is reversed. A subtraction is executed by adding the 2's complement of the second operand. For rotate (RRF, RLF) instructions, this bit is loaded with either the high or low-order bit of the source register.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	l bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

5.4 Data Addressing Modes

Note:

The execution of some instructions in the core PIC18 instruction set are changed when the PIC18 extended instruction set is enabled. See Section 5.5 "Data Memory and the Extended Instruction Set" for more information.

While the program memory can be addressed in only one way – through the program counter – information in the data memory space can be addressed in several ways. For most instructions, the addressing mode is fixed. Other instructions may use up to three modes, depending on which operands are used and whether or not the extended instruction set is enabled.

The addressing modes are:

- Inherent
- Literal
- Direct
- Indirect

An additional addressing mode, Indexed Literal Offset, is available when the extended instruction set is enabled (XINST configuration bit = 1). Its operation is discussed in greater detail in **Section 5.5.1 "Indexed Addressing with Literal Offset"**.

5.4.1 INHERENT AND LITERAL ADDRESSING

Many PIC18 control instructions do not need any argument at all; they either perform an operation that globally affects the device or they operate implicitly on one register. This addressing mode is known as Inherent Addressing. Examples include SLEEP, RESET and DAW.

Other instructions work in a similar way but require an additional explicit argument in the opcode. This is known as Literal Addressing mode because they require some literal value as an argument. Examples include ADDLW and MOVLW, which respectively, add or move a literal value to the W register. Other examples include CALL and GOTO, which include a 20-bit program memory address.

5.4.2 DIRECT ADDRESSING

Direct addressing specifies all or part of the source and/or destination address of the operation within the opcode itself. The options are specified by the arguments accompanying the instruction.

In the core PIC18 instruction set, bit-oriented and byteoriented instructions use some version of direct addressing by default. All of these instructions include some 8-bit literal address as their Least Significant Byte. This address specifies either a register address in one of the banks of data RAM (Section 5.3.3 "General Purpose Register File") or a location in the Access Bank (Section 5.3.2 "Access Bank") as the data source for the instruction. The Access RAM bit 'a' determines how the address is interpreted. When 'a' is '1', the contents of the BSR (Section 5.3.1 "Bank Select Register (BSR)") are used with the address to determine the complete 12-bit address of the register. When 'a' is '0', the address is interpreted as being a register in the Access Bank. Addressing that uses the Access RAM is sometimes also known as Direct Forced Addressing mode.

A few instructions, such as MOVFF, include the entire 12-bit address (either source or destination) in their opcodes. In these cases, the BSR is ignored entirely.

The destination of the operation's results is determined by the destination bit 'd'. When 'd' is '1', the results are stored back in the source register, overwriting its original contents. When 'd' is '0', the results are stored in the W register. Instructions without the 'd' argument have a destination that is implicit in the instruction; their destination is either the target register being operated on or the W register.

5.4.3 INDIRECT ADDRESSING

Indirect addressing allows the user to access a location in data memory without giving a fixed address in the instruction. This is done by using File Select Registers (FSRs) as pointers to the locations to be read or written to. Since the FSRs are themselves located in RAM as Special File Registers, they can also be directly manipulated under program control. This makes FSRs very useful in implementing data structures, such as tables and arrays in data memory.

The registers for indirect addressing are also implemented with Indirect File Operands (INDFs) that permit automatic manipulation of the pointer value with auto-incrementing, auto-decrementing or offsetting with another value. This allows for efficient code, using loops, such as the example of clearing an entire RAM bank in Example 5-5.

EXAMPLE 5-5: HOW TO CLEAR RAM
(BANK 1) USING
INDIRECT ADDRESSING

	LFSR	FSR0, 100h	;	
NEXT	CLRF	POSTINC0	;	Clear INDF
			;	register then
			;	inc pointer
	BTFSS	FSROH, 1	;	All done with
			;	Bank1?
	BRA	NEXT	;	NO, clear next
CONTINU	JΕ		;	YES, continue

5.4.3.1 FSR Registers and the INDF Operand

At the core of indirect addressing are three sets of registers: FSR0, FSR1 and FSR2. Each represents a pair of 8-bit registers, FSRnH and FSRnL. The four upper bits of the FSRnH register are not used, so each FSR pair holds a 12-bit value. This represents a value that can address the entire range of the data memory in a linear fashion. The FSR register pairs, then, serve as pointers to data memory locations.

Indirect addressing is accomplished with a set of Indirect File Operands, INDF0 through INDF2. These can be thought of as "virtual" registers; they are mapped in the SFR space but are not physically implemented. Reading or writing to a particular INDF register actually accesses its corresponding FSR register pair. A read from INDF1, for example, reads the data at the address indicated by FSR1H:FSR1L. Instructions that use the INDF registers as operands actually use the contents of their corresponding FSR as a pointer to the instruction's target. The INDF operand is just a convenient way of using the pointer.

Because indirect addressing uses a full 12-bit address, data RAM banking is not necessary. Thus, the current contents of the BSR and the Access RAM bit have no effect on determining the target address.

5.4.3.2 FSR Registers and POSTINC, POSTDEC, PREINC and PLUSW

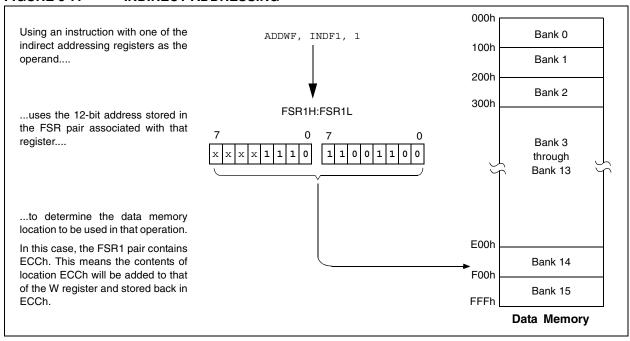
In addition to the INDF operand, each FSR register pair also has four additional indirect operands. Like INDF, these are "virtual" registers that cannot be indirectly read or written to. Accessing these registers actually accesses the associated FSR register pair, but also performs a specific action on it stored value. They are:

- POSTDEC: accesses the FSR value, then automatically decrements it by 1 afterwards
- POSTINC: accesses the FSR value, then automatically increments it by 1 afterwards
- PREINC: increments the FSR value by 1, then uses it in the operation
- PLUSW: adds the signed value of the W register (range of -127 to 128) to that of the FSR and uses the new value in the operation.

In this context, accessing an INDF register uses the value in the FSR registers without changing them. Similarly, accessing a PLUSW register gives the FSR value offset by that in the W register; neither value is actually changed in the operation. Accessing the other virtual registers changes the value of the FSR registers.

Operations on the FSRs with POSTDEC, POSTINC and PREINC affect the entire register pair; that is, roll-overs of the FSRnL register, from FFh to 00h, carry over to the FSRnH register. On the other hand, results of these operations do not change the value of any flags in the STATUS register (e.g., Z, N, OV, etc.).





The PLUSW register can be used to implement a form of indexed addressing in the data memory space. By manipulating the value in the W register, users can reach addresses that are fixed offsets from pointer addresses. In some applications, this can be used to implement some powerful program control structure, such as software stacks, inside of data memory.

5.4.3.3 Operations by FSRs on FSRs

Indirect addressing operations that target other FSRs or virtual registers represent special cases. For example, using an FSR to point to one of the virtual registers will not result in successful operations. As a specific case, assume that FSR0H:FSR0L contains FE7h, the address of INDF1. Attempts to read the value of the INDF1 using INDF0 as an operand will return 00h. Attempts to write to INDF1 using INDF0 as the operand will result in a NOP.

On the other hand, using the virtual registers to write to an FSR pair may not occur as planned. In these cases, the value will be written to the FSR pair but without any incrementing or decrementing. Thus, writing to INDF2 or POSTDEC2 will write the same value to the FSR2H:FSR2L.

Since the FSRs are physical registers mapped in the SFR space, they can be manipulated through all direct operations. Users should proceed cautiously when working on these registers, particularly if their code uses indirect addressing.

Similarly, operations by indirect addressing are generally permitted on all other SFRs. Users should exercise the appropriate caution that they do not inadvertently change settings that might affect the operation of the device.

5.5 Data Memory and the Extended Instruction Set

Enabling the PIC18 extended instruction set (XINST configuration bit = 1) significantly changes certain aspects of data memory and its addressing. Specifically, the use of the Access Bank for many of the core PIC18 instructions is different; this is due to the introduction of a new addressing mode for the data memory space.

What does not change is just as important. The size of the data memory space is unchanged, as well as its linear addressing. The SFR map remains the same. Core PIC18 instructions can still operate in both Direct and Indirect Addressing mode; inherent and literal instructions do not change at all. Indirect addressing with FSR0 and FSR1 also remain unchanged.

5.5.1 INDEXED ADDRESSING WITH LITERAL OFFSET

Enabling the PIC18 extended instruction set changes the behavior of indirect addressing using the FSR2 register pair within Access RAM. Under the proper conditions, instructions that use the Access Bank – that is, most bit-oriented and byte-oriented instructions – can invoke a form of indexed addressing using an offset specified in the instruction. This special addressing mode is known as Indexed Addressing with Literal Offset, or Indexed Literal Offset mode.

When using the extended instruction set, this addressing mode requires the following:

- The use of the Access Bank is forced ('a' = 0) and
- The file address argument is less than or equal to 5Fh.

Under these conditions, the file address of the instruction is not interpreted as the lower byte of an address (used with the BSR in direct addressing), or as an 8-bit address in the Access Bank. Instead, the value is interpreted as an offset value to an address pointer, specified by FSR2. The offset and the contents of FSR2 are added to obtain the target address of the operation.

5.5.2 INSTRUCTIONS AFFECTED BY INDEXED LITERAL OFFSET MODE

Any of the core PIC18 instructions that can use direct addressing are potentially affected by the Indexed Literal Offset Addressing mode. This includes all byte-oriented and bit-oriented instructions, or almost one-half of the standard PIC18 instruction set. Instructions that only use Inherent or Literal Addressing modes are unaffected.

Additionally, byte-oriented and bit-oriented instructions are not affected if they do not use the Access Bank (Access RAM bit is '1'), or include a file address of 60h or above. Instructions meeting these criteria will continue to execute as before. A comparison of the different possible addressing modes when the extended instruction set is enabled in shown in Figure 5-8.

Those who desire to use byte-oriented or bit-oriented instructions in the Indexed Literal Offset mode should note the changes to assembler syntax for this mode. This is described in more detail in **Section 21.2.1** "Extended Instruction Syntax".

FIGURE 5-8: COMPARING ADDRESSING OPTIONS FOR BIT-ORIENTED AND BYTE-ORIENTED INSTRUCTIONS (EXTENDED INSTRUCTION SET ENABLED)

Example Instruction: ADDWF, f, d, a (Opcode: 0010 01da fffff fffff)

When 'a' = 0 and $f \ge 60h$:

The instruction executes in Direct Forced mode. 'f' is interpreted as a location in the Access RAM between 060h and 0FFh. This is the same as locations 060h to 07Fh (Bank 0) and F80h to FFFh (Bank 15) of data memory.

Locations below 60h are not available in this addressing mode.

When 'a' = 0 and $f \le 5Fh$:

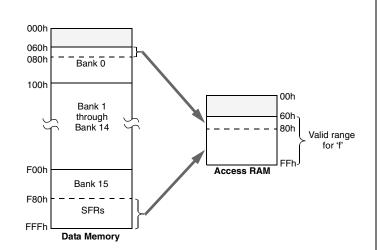
The instruction executes in Indexed Literal Offset mode. 'f' is interpreted as an offset to the address value in FSR2. The two are added together to obtain the address of the target register for the instruction. The address can be anywhere in the data memory space.

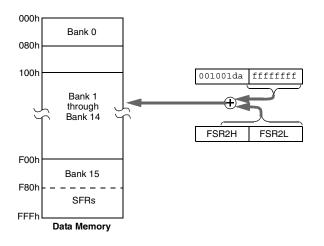
Note that in this mode, the correct syntax is now: $\label{eq:add_power} \text{ADDWF } \left[k \right], \ d$

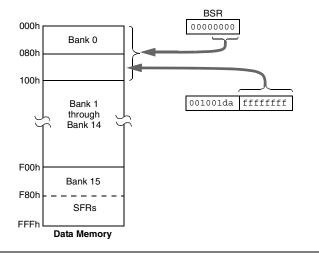
where 'k' is the same as 'f'.

When 'a' = 1 (all values of f):

The instruction executes in Direct mode (also known as Direct Long mode). 'f' is interpreted as a location in one of the 16 banks of the data memory space. The bank is designated by the Bank Select Register (BSR). The address can be in any implemented bank in the data memory space.







5.5.3 MAPPING THE ACCESS BANK IN INDEXED LITERAL OFFSET MODE

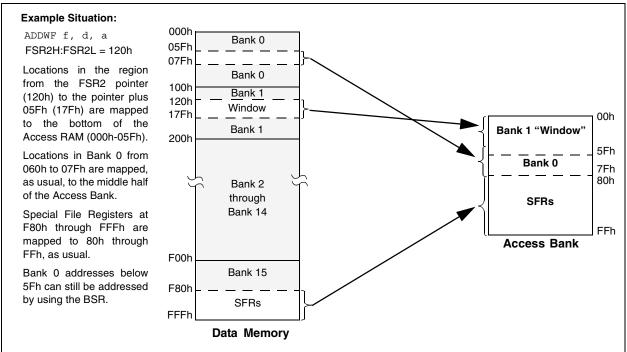
The use of Indexed Literal Offset Addressing mode effectively changes how the first 96 locations of Access RAM (00h to 5Fh) are mapped. Rather than containing just the contents of the bottom half of Bank 0, this mode maps the contents from Bank 0 and a user-defined "window" that can be located anywhere in the data memory space. The value of FSR2 establishes the lower boundary of the addresses mapped into the window, while the upper boundary is defined by FSR2 plus 95 (5Fh). Addresses in the Access RAM above 5Fh are mapped as previously described (see Section 5.3.2 "Access Bank"). An example of Access Bank remapping in this addressing mode is shown in Figure 5-9.

Remapping of the Access Bank applies *only* to operations using the Indexed Literal Offset mode. Operations that use the BSR (Access RAM bit is '1') will continue to use direct addressing as before.

5.6 PIC18 Instruction Execution and the Extended Instruction Set

Enabling the extended instruction set adds eight additional commands to the existing PIC18 instruction set. These instructions are executed as described in Section 21.2 "Extended Instruction Set".

FIGURE 5-9: REMAPPING THE ACCESS BANK WITH INDEXED LITERAL OFFSET ADDRESSING



NOTES:

6.0 FLASH PROGRAM MEMORY

The Flash program memory is readable, writable and erasable during normal operation over the entire VDD

A read from program memory is executed on one byte at a time. A write to program memory is executed on blocks of 64 bytes at a time. Program memory is erased in blocks of 1024 bytes at a time. A bulk erase operation may not be issued from user code.

Writing or erasing program memory will cease instruction fetches until the operation is complete. The program memory cannot be accessed during the write or erase; therefore, code cannot execute. An internal programming timer terminates program memory writes

A value written to program memory does not need to be a valid instruction. Executing a program memory location that forms an invalid instruction results in a NOP.

6.1 Table Reads and Table Writes

In order to read and write program memory, there are two operations that allow the processor to move bytes between the program memory space and the data RAM:

- Table Read (TBLRD)
- Table Write (TBLWT)

The program memory space is 16 bits wide, while the data RAM space is 8 bits wide. Table reads and table writes move data between these two memory spaces through an 8-bit register (TABLAT).

Table read operations retrieve data from program memory and place it into the data RAM space. Figure 6-1 shows the operation of a table read with program memory and data RAM.

Table write operations store data from the data memory space into holding registers in program memory. The procedure to write the contents of the holding registers into program memory is detailed in **Section 6.5 "Writing**" to Flash Program Memory". Figure 6-2 shows the operation of a table write with program memory and data RAM.

Table operations work with byte entities. A table block containing data, rather than program instructions, is not required to be word aligned. Therefore, a table block can start and end at any byte address. If a table write is being used to write executable code into program memory, program instructions will need to be word aligned.

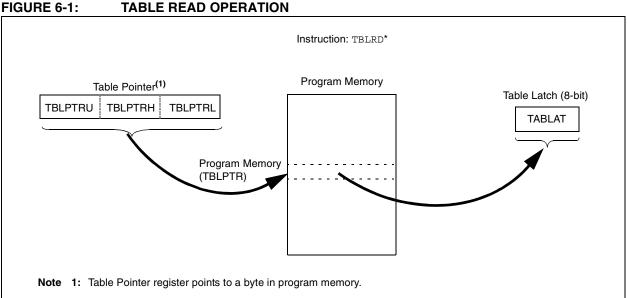
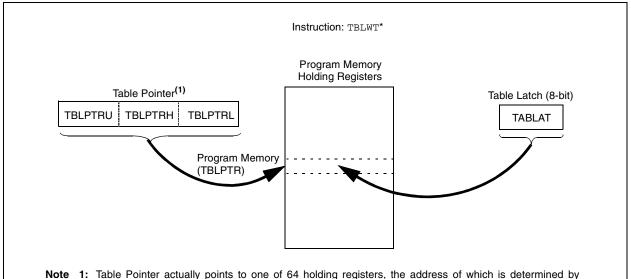


FIGURE 6-2: TABLE WRITE OPERATION



Note 1: Table Pointer actually points to one of 64 holding registers, the address of which is determined by TBLPTRL<5:0>. The process for physically writing data to the program memory array is discussed in Section 6.5 "Writing to Flash Program Memory".

6.2 Control Registers

Several control registers are used in conjunction with the ${\tt TBLRD}$ and ${\tt TBLRD}$ instructions. These include the:

- EECON1 register
- · EECON2 register
- · TABLAT register
- TBLPTR registers

6.2.1 EECON1 AND EECON2 REGISTERS

The EECON1 register (Register 6-1) is the control register for memory accesses. The EECON2 register is not a physical register; it is used exclusively in the memory write and erase sequences. Reading EECON2 will read all '0's.

The FREE bit, when set, will allow a program memory erase operation. When FREE is set, the erase operation is initiated on the next WR command. When FREE is clear, only writes are enabled.

The WREN bit, when set, will allow a write operation. On power-up, the WREN bit is clear. The WRERR bit is set in hardware when the WR bit is set and cleared when the internal programming timer expires and the write operation is complete.

Note: During normal operation, the WRERR is read as '1'. This can indicate that a write operation was prematurely terminated by a Reset, or a write operation was attempted improperly.

The WR control bit initiates write operations. The bit cannot be cleared, only set, in software; it is cleared in hardware at the completion of the write operation.

REGISTER 6-1: EECON1: DATA EEPROM CONTROL REGISTER 1

U-0	U-0	U-0	R/W-0	R/W-x	R/W-0	R/S-0	U-0
_	_	_	FREE	WRERR	WREN	WR	_

bit 7 bit 0

bit 7-5 **Unimplemented:** Read as '0'

bit 4 FREE: Flash Row Erase Enable bit

1 = Erase the program memory row addressed by TBLPTR on the next WR command (cleared by completion of erase operation)

0 = Perform write only

bit 3 WRERR: Flash Program/Data EEPROM Error Flag bit

1 = A write operation is prematurely terminated (any Reset during self-timed programming in normal operation, or an improper write attempt)

0 = The write operation completed

bit 2 WREN: Flash Program/Data EEPROM Write Enable bit

1 = Allows write cycles to Flash program/data EEPROM

0 = Inhibits write cycles to Flash program/data EEPROM

bit 1 WR: Write Control bit

1 = Initiates a data EEPROM erase/write cycle or a program memory erase cycle or write cycle. (The operation is self-timed and the bit is cleared by hardware once write is complete. The WR bit can only be set (not cleared) in software.)

0 = Write cycle to the EEPROM is complete

bit 0 Unimplemented: Read as '0'

Legend:

R = Readable bit W = Writable bit

S = Bit can be set by software, but not cleared U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

6.2.2 TABLAT – TABLE LATCH REGISTER

The Table Latch (TABLAT) is an 8-bit register mapped into the SFR space. The Table Latch register is used to hold 8-bit data during data transfers between program memory and data RAM.

6.2.3 TBLPTR – TABLE POINTER REGISTER

The Table Pointer (TBLPTR) register addresses a byte within the program memory. The TBLPTR is comprised of three SFR registers: Table Pointer Upper Byte, Table Pointer High Byte and Table Pointer Low Byte (TBLPTRU:TBLPTRH:TBLPTRL). These three registers join to form a 22-bit wide pointer. The low-order 21 bits allow the device to address up to 2 Mbytes of program memory space. The 22nd bit allows access to the device ID, the user ID and the configuration bits.

The Table Pointer register, TBLPTR, is used by the TBLRD and TBLWT instructions. These instructions can update the TBLPTR in one of four ways based on the table operation. These operations are shown in Table 6-1. These operations on the TBLPTR only affect the low-order 21 bits.

6.2.4 TABLE POINTER BOUNDARIES

TBLPTR is used in reads, writes and erases of the Flash program memory.

When a TBLRD is executed, all 22 bits of the TBLPTR determine which byte is read from program memory into TABLAT.

When a TBLWT is executed, the six LSbs of the Table Pointer register (TBLPTR<5:0>) determine which of the 64 program memory holding registers is written to. When the timed write to program memory begins (via the WR bit), the 16 MSbs of the TBLPTR (TBLPTR<21:6>) determine which program memory block of 64 bytes is written to. For more detail, see Section 6.5 "Writing to Flash Program Memory".

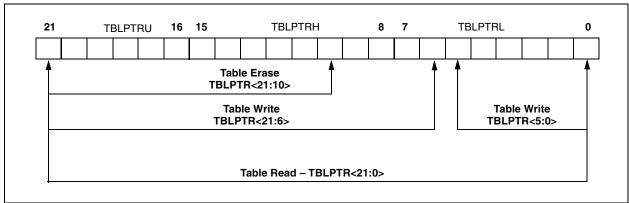
When an erase of program memory is executed, the 7 MSbs of the Table Pointer register (TBLPTR<21:10>) point to the 1024-byte block that will be erased. The Least Significant bits (TBLPTR<9:0>) are ignored.

Figure 6-3 describes the relevant boundaries of TBLPTR based on Flash program memory operations.

TABLE C 1.	TABLE POINTER OPERATIONS WITH TRURD AND TRUWT INSTRUCTIONS
TABLE 6-1:	TABLE POINTER OPERATIONS WITH TBLBD AND TBLWT INSTRUCTIONS

Example	Operation on Table Pointer
TBLRD* TBLWT*	TBLPTR is not modified
TBLRD*+ TBLWT*+	TBLPTR is incremented after the read/write
TBLRD*- TBLWT*-	TBLPTR is decremented after the read/write
TBLRD+* TBLWT+*	TBLPTR is incremented before the read/write

FIGURE 6-3: TABLE POINTER BOUNDARIES BASED ON OPERATION



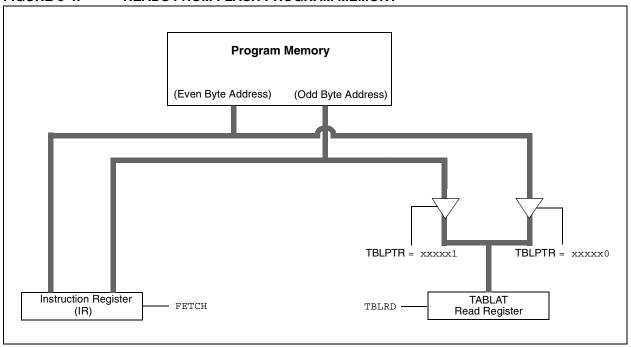
6.3 Reading the Flash Program Memory

The TBLRD instruction is used to retrieve data from program memory and places it into data RAM. Table reads from program memory are performed one byte at a time.

TBLPTR points to a byte address in program space. Executing TBLRD places the byte pointed to into TABLAT. In addition, TBLPTR can be modified automatically for the next table read operation.

The internal program memory is typically organized by words. The Least Significant bit of the address selects between the high and low bytes of the word. Figure 6-4 shows the interface between the internal program memory and the TABLAT.

FIGURE 6-4: READS FROM FLASH PROGRAM MEMORY



EXAMPLE 6-1: READING A FLASH PROGRAM MEMORY WORD

	MOVLW MOVWF MOVWF MOVLW MOVWF	CODE_ADDR_UPPER TBLPTRU CODE_ADDR_HIGH TBLPTRH CODE_ADDR_LOW TBLPTRL	;	Load TBLPTR with the base address of the word
READ_WORD				
	TBLRD*+		;	read into TABLAT and increment
	MOVF	TABLAT, W	;	get data
	MOVWF	WORD_EVEN		
	TBLRD*+		;	read into TABLAT and increment
	MOVFW	TABLAT, W	;	get data
	MOVF	WORD_ODD		

6.4 Erasing Flash Program Memory

The minimum erase block is 1024 bytes. Only through the use of an external programmer, or through ICSP control, can larger blocks of program memory be bulk erased. Word erase in the Flash array is not supported.

When initiating an erase sequence from the micro-controller itself, a block of 1024 bytes of program memory is erased. The Most Significant 7 bits of the TBLPTR<21:10> point to the block being erased. TBLPTR<9:0> are ignored.

The EECON1 register commands the erase operation. The WREN bit must be set to enable write operations. The FREE bit is set to select an erase operation.

For protection, the write initiate sequence for EECON2 must be used.

A long write is necessary for erasing the internal Flash. Instruction execution is halted while in a long write cycle. The long write will be terminated by the internal programming timer.

6.4.1 FLASH PROGRAM MEMORY ERASE SEQUENCE

The sequence of events for erasing a block of internal program memory location is:

- Load Table Pointer register with address of row being erased.
- 2. Set the EECON1 register for the erase operation:
 - set WREN bit to enable writes;
 - · set FREE bit to enable the erase.
- Disable interrupts.
- 4. Write 55h to EECON2.
- Write 0AAh to EECON2.
- 6. Set the WR bit. This will begin the row erase cycle.
- 7. The CPU will stall for duration of the erase (about 2 ms using internal timer).
- 8. Re-enable interrupts.

EXAMPLE 6-2: ERASING A FLASH PROGRAM MEMORY ROW

	MOVLW MOVWF MOVLW MOVWF	CODE_ADDR_UPPER TBLPTRU CODE_ADDR_HIGH TBLPTRH	; load TBLPTR with the base ; address of the memory block
	MOVLW MOVWF	CODE_ADDR_LOW TBLPTRL	
ERASE_ROW	BSF BSF BCF	EECON1, WREN EECON1, FREE INTCON, GIE	<pre>; enable write to memory ; enable Row Erase operation ; disable interrupts</pre>
Required Sequence	MOVLW MOVWF MOVWF BSF	55h EECON2 0AAh EECON2 EECON1, WR	<pre>; write 55h ; write 0AAh ; start erase (CPU stall)</pre>
	BSF	INTCON, GIE	; re-enable interrupts

6.5 Writing to Flash Program Memory

The minimum programming block is 32 words or 64 bytes. Word or byte programming is not supported.

Table writes are used internally to load the holding registers needed to program the Flash memory. There are 64 holding registers used by the table writes for programming.

Since the Table Latch (TABLAT) is only a single byte, the TBLWT instruction may need to be executed 64 times for each programming operation. All of the table write operations will essentially be short writes because only the holding registers are written. At the end of updating the 64 holding registers, the EECON1 register must be written to in order to start the programming operation with a long write.

The long write is necessary for programming the internal Flash. Instruction execution is halted while in a long write cycle. The long write will be terminated by the internal programming timer.

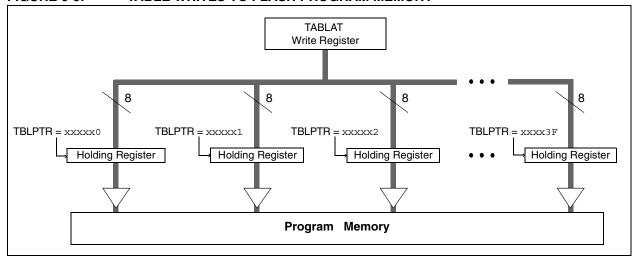
The EEPROM on-chip timer controls the write time. The write/erase voltages are generated by an on-chip charge pump, rated to operate over the voltage range of the device.

Note:

Unlike previous devices, the PIC18F45J10 family of devices does not reset the holding registers after a write occurs. The holding registers must be cleared or overwritten before a programming sequence.

In order to maintain the endurance of the cells, each Flash byte should not be programmed more then twice between erase operations. Either a bulk or row erase of the target row is required before attempting to modify the contents a third time.

FIGURE 6-5: TABLE WRITES TO FLASH PROGRAM MEMORY



6.5.1 FLASH PROGRAM MEMORY WRITE SEQUENCE

The sequence of events for programming an internal program memory location should be:

- If the section of program memory to be written to has been programmed previously, then the memory will need to be erased before the write occurs (see 6.4.1 "Flash Program Memory Erase Sequence").
- 2. Write the 64 bytes into the holding registers with auto-increment.
- 3. Set the EECON1 register for the write operation:
 - · set WREN to enable byte writes.
- 4. Disable interrupts.

- Write 55h to EECON2.
- 6. Write 0AAh to EECON2.
- 7. Set the WR bit. This will begin the write cycle.
- 8. The CPU will stall for duration of the write (about 2 ms using internal timer).
- 9. Re-enable interrupts.
- 10. Verify the memory (table read).

An example of the required code is shown in Example 6-3.

Note: Before setting the WR bit, the Table Pointer address needs to be within the intended address range of the 64 bytes in the holding register.

EXAMPLE 6-3: WRITING TO FLASH PROGRAM MEMORY

```
MOVLW CODE ADDR UPPER
                                                    ; Load TBLPTR with the base
                  MOVWF
                         TBLPTRU
                                                    ; address of the memory block
                  MOVLW CODE ADDR HIGH
                  MOVWF TBLPTRH
                  MOVLW CODE ADDR LOW
                  MOVWF TBLPTRL
ERASE BLOCK
                         EECON1, WREN
                                                    ; enable write to memory
                  BSF
                  BSF
                         EECON1, FREE
                                                    ; enable Row Erase operation
                         INTCON, GIE
                  BCF
                                                    ; disable interrupts
                  MOVLW 55h
                  MOVWF EECON2
                                                    ; write 55h
                  MOVLW 0AAh
                  MOVWF EECON2
                                                   ; write OAAh
                  BSF
                         EECON1, WR
                                                   ; start erase (CPU stall)
                         INTCON, GIE
                  BSF
                                                   ; re-enable interrupts
                  MOVLW D'16'
                  MOVWF WRITE COUNTER
                                                    ; Need to write 16 blocks of 64 to write
                                                    ; one erase block of 1024
RESTART_BUFFER
                  MOVLW D'64'
                  MOVWF COUNTER
                  MOVLW BUFFER ADDR HIGH
                                                    ; point to buffer
                  MOVWF FSR0H
                  MOVLW BUFFER ADDR LOW
                  MOVWF FSR0L
FILL BUFFER
                                                    ; read the new data from I2C, SPI,
                                                    ; PSP, USART, etc.
WRITE BUFFER
                  MOVLW D'64
                                                    ; number of bytes in holding register
                  MOVWF COUNTER
WRITE BYTE TO HREGS
                  MOVFF POSTINCO, WREG
                                                    ; get low byte of buffer data
                  MOVWF TABLAT
                                                    ; present data to table latch
                  TBLWT+*
                                                    ; write data, perform a short write
                                                    ; to internal TBLWT holding register.
                  DECFSZ COUNTER
                                                    ; loop until buffers are full
                         WRITE_WORD_TO_HREGS
                  BRA
PROGRAM MEMORY
                  BSF
                         EECON1, WREN
                                                    ; enable write to memory
                         INTCON, GIE
                                                    ; disable interrupts
                  BCF
                  MOVLW 55h
                  MOVWF EECON2
   Required
                                                    ; write 55h
                  MOVLW
                         OAAh
   Sequence
                  MOVWF
                         EECON2
                                                    ; write OAAh
                  BSF
                         EECON1, WR
                                                    ; start program (CPU stall)
                                                    ; re-enable interrupts
                  BSF
                         INTCON, GIE
                         EECON1, WREN
                  BCF
                                                    ; disable write to memory
                  DECFSZ WRITE COUNTER
                                                    ; done with one write cycle
                         RESTART BUFFER
                                                    ; if not done replacing the erase block
```

6.5.2 WRITE VERIFY

Depending on the application, good programming practice may dictate that the value written to the memory should be verified against the original value. This should be used in applications where excessive writes can stress bits near the specification limit.

6.5.3 UNEXPECTED TERMINATION OF WRITE OPERATION

If a write is terminated by an unplanned event, such as loss of power or an unexpected Reset, the memory location just programmed should be verified and reprogrammed if needed. If the write operation is interrupted by a MCLR Reset or a WDT Time-out Reset during normal operation, the user can check the WRERR bit and rewrite the location(s) as needed.

6.5.4 PROTECTION AGAINST SPURIOUS WRITES

To protect against spurious writes to Flash program memory, the write initiate sequence must also be followed. See Section 20.0 "Special Features of the CPU" for more detail.

6.6 Flash Program Operation During Code Protection

See Section 20.6 "Program Verification and Code Protection" for details on code protection of Flash program memory.

TABLE 6-2: REGISTERS ASSOCIATED WITH PROGRAM FLASH MEMORY

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
TBLPTRU	_	— bit 21 Program Memory Table Pointer Upper Byte (TBLPTR<20:16>)							43
TBPLTRH	Program Memory Table Pointer High Byte (TBLPTR<15:8>)								43
TBLPTRL	Program Memory Table Pointer Low Byte (TBLPTR<7:0>)								43
TABLAT	Program Memory Table Latch							43	
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INTOIF	RBIF	43
EECON2	EEPROM C	Control Regis	ster 2 (not	a physical r	egister)				45
EECON1	_	_	_	FREE	WRERR	WREN	WR	_	45
IPR2	OSCFIP	CMIP	_	_	BCL1IP	-	_	CCP2IP	45
PIR2	OSCFIF	CMIF	_	_	BCL1IF	_	_	CCP2IF	45
PIE2	OSCFIE	CMIE		_	BCL1IE	_	_	CCP2IE	45

Legend: — = unimplemented, read as '0'. Shaded cells are not used during Flash/EEPROM access.

NOTES:

7.0 8 x 8 HARDWARE MULTIPLIER

7.1 Introduction

All PIC18 devices include an 8 x 8 hardware multiplier as part of the ALU. The multiplier performs an unsigned operation and yields a 16-bit result that is stored in the product register pair, PRODH:PRODL. The multiplier's operation does not affect any flags in the STATUS register.

Making multiplication a hardware operation allows it to be completed in a single instruction cycle. This has the advantages of higher computational throughput and reduced code size for multiplication algorithms and allows the PIC18 devices to be used in many applications previously reserved for digital signal processors. A comparison of various hardware and software multiply operations, along with the savings in memory and execution time, is shown in Table 7-1.

7.2 Operation

Example 7-1 shows the instruction sequence for an 8×8 unsigned multiplication. Only one instruction is required when one of the arguments is already loaded in the WREG register.

Example 7-2 shows the sequence to do an 8×8 signed multiplication. To account for the sign bits of the arguments, each argument's Most Significant bit (MSb) is tested and the appropriate subtractions are done.

EXAMPLE 7-1: 8 x 8 UNSIGNED MULTIPLY ROUTINE

MOVF ARG1, W ;
MULWF ARG2 ; ARG1 * ARG2 ->
; PRODH:PRODL

EXAMPLE 7-2: 8 x 8 SIGNED MULTIPLY ROUTINE

```
MOVF
       ARG1, W
                  ; ARG1 * ARG2 ->
MULWF
       ARG2
                  ; PRODH:PRODL
BTFSC
       ARG2, SB
                 ; Test Sign Bit
SUBWF
       PRODH, F ; PRODH = PRODH
                            - ARG1
MOVE
       ARG2, W
BTFSC
       ARG1, SB
                  ; Test Sign Bit
SUBWF
       PRODH, F
                  ; PRODH = PRODH
                            - ARG2
```

TABLE 7-1: PERFORMANCE COMPARISON FOR VARIOUS MULTIPLY OPERATIONS

	M. 102 - 1 - M 1 - 1	Program	Cycles	Time			
Routine	Multiply Method	Memory (Words)	(Max)	@ 40 MHz	@ 10 MHz	@ 4 MHz	
0 v 0 unaignad	Without hardware multiply	13	69	6.9 μs	27.6 μs	69 μs	
8 x 8 unsigned	Hardware multiply	1	1	100 ns	400 ns	1 μs	
9 v 9 signed	Without hardware multiply	33	91	9.1 μs	36.4 μs	91 μs	
8 x 8 signed	Hardware multiply	6	6	600 ns	2.4 μs	6 μs	
16 v 16 upgigned	Without hardware multiply	21	242	24.2 μs	96.8 μs	242 μs	
16 x 16 unsigned	Hardware multiply	28	28	2.8 μs	11.2 μs	28 μs	
10 v 10 signad	Without hardware multiply	52	254	25.4 μs	102.6 μs	254 μs	
16 x 16 signed	Hardware multiply	35	40	4.0 μs	16.0 μs	40 μs	

Example 7-3 shows the sequence to do a 16 x 16 unsigned multiplication. Equation 7-1 shows the algorithm that is used. The 32-bit result is stored in four registers (RES3:RES0).

EQUATION 7-1: 16 x 16 UNSIGNED MULTIPLICATION ALGORITHM

```
RES3:RES0 = ARG1H:ARG1L \bullet ARG2H:ARG2L

= (ARG1H \bullet ARG2H \bullet 2<sup>16</sup>) +

(ARG1H \bullet ARG2L \bullet 2<sup>8</sup>) +

(ARG1L \bullet ARG2H \bullet 2<sup>8</sup>) +

(ARG1L \bullet ARG2L)
```

EXAMPLE 7-3: 16 x 16 UNSIGNED MULTIPLY ROUTINE

```
MOVF
       ARG1L, W
MULWF
       ARG2L
                       ; ARG1L * ARG2L->
                       ; PRODH: PRODL
MOVFF
       PRODH, RES1
                       ;
MOVFF
       PRODL, RESO
MOVF
       ARG1H, W
MULWF
       ARG2H
                       ; ARG1H * ARG2H->
                      ; PRODH:PRODL
       PRODH, RES3
MOVFF
MOVFF
       PRODL, RES2
MOVF
       ARG1L, W
                       ; ARG1L * ARG2H->
MULWF
       ARG2H
                       ; PRODH:PRODL
MOVF
       PRODL, W
ADDWF
       RES1, F
                      ; Add cross
MOVF
       PRODH, W
                       ; products
ADDWFC RES2, F
       WREG
CLRF
ADDWFC RES3, F
MOVF
       ARG1H, W
                       ; ARG1H * ARG2L->
MULWF
       ARG2L
                       ; PRODH:PRODL
MOVF
       PRODL, W
                      ; Add cross
ADDWF
       RES1, F
       PRODH, W
MOVF
                       ; products
ADDWFC RES2, F
CLRF
       WREG
                       ;
ADDWFC RES3, F
                       ;
```

Example 7-4 shows the sequence to do a 16 x 16 signed multiply. Equation 7-2 shows the algorithm used. The 32-bit result is stored in four registers (RES3:RES0). To account for the sign bits of the arguments, the MSb for each argument pair is tested and the appropriate subtractions are done.

EQUATION 7-2: 16 x 16 SIGNED MULTIPLICATION ALGORITHM

```
RES3:RES0 = ARG1H:ARG1L \bullet ARG2H:ARG2L

= (ARG1H \bullet ARG2H \bullet 2^{16}) +

(ARG1H \bullet ARG2L \bullet 2^{8}) +

(ARG1L \bullet ARG2H \bullet 2^{8}) +

(ARG1L \bullet ARG2L) +

(-1 \bullet ARG2H<7> \bullet ARG1H:ARG1L \bullet 2^{16}) +

(-1 \bullet ARG1H<7> \bullet ARG2H:ARG2L \bullet 2^{16})
```

EXAMPLE 7-4: 16 x 16 SIGNED MULTIPLY ROUTINE

```
MOVF
           ARG1L, W
                         ; ARG1L * ARG2L ->
   MULWF
           ARG2L
                         ; PRODH:PRODL
   MOVFF
           PRODH, RES1
           PRODL, RESO
   MOVFF
   MOVF
           ARG1H, W
                         ; ARG1H * ARG2H ->
   MULWF
           ARG2H
                         ; PRODH: PRODL
   MOVFF
           PRODH, RES3
   MOVFF
           PRODL, RES2
   MOVF
           ARG1L, W
                         ; ARG1L * ARG2H ->
   MULWF
           ARG2H
                        ; PRODH: PRODL
   MOVF
           PRODL, W
                        ; Add cross
           RES1, F
   ADDWF
           PRODH, W
                        ; products
   MOVF
   ADDWFC RES2, F
   CLRF
           WREG
   ADDWFC RES3, F
   MOVF
           ARG1H, W
                        ; ARG1H * ARG2L ->
   \mathtt{MULWF}
           ARG2L
                        ; PRODH: PRODL
           PRODL, W
   MOVF
                        ; Add cross
   ADDWF
           RES1, F
                        ; products
   MOVF
           PRODH, W
   ADDWFC RES2, F
   CLRF
           WREG
   ADDWFC RES3, F
   BTFSS
           ARG2H, 7
                        ; ARG2H:ARG2L neg?
   BRA
           SIGN ARG1
                        ; no, check ARG1
   MOVF
           ARG1L, W
                        ;
   SUBWF
           RES2
   MOVF
           ARG1H. W
   SUBWFB RES3
SIGN_ARG1
   BTFSS
           ARG1H, 7
                        ; ARG1H: ARG1L neg?
           CONT_CODE
   BRA
                        ; no, done
   MOVF
           ARG2L, W
   SUBWF
           RES2
   MOVF
           ARG2H, W
   SUBWFB RES3
CONT_CODE
```

8.0 INTERRUPTS

Members of the PIC18F45J10 family of devices have multiple interrupt sources and an interrupt priority feature that allows most interrupt sources to be assigned a high priority level or a low priority level. The high priority interrupt vector is at 0008h and the low priority interrupt vector is at 0018h. High priority interrupt events will interrupt any low priority interrupts that may be in progress.

There are thirteen registers which are used to control interrupt operation. These registers are:

- RCON
- INTCON
- INTCON2
- INTCON3
- PIR1, PIR2, PIR3
- PIE1, PIE2, PIE3
- IPR1, IPR2, IPR3

It is recommended that the Microchip header files supplied with MPLAB® IDE be used for the symbolic bit names in these registers. This allows the assembler/compiler to automatically take care of the placement of these bits within the specified register.

In general, interrupt sources have three bits to control their operation. They are:

- Flag bit to indicate that an interrupt event occurred
- Enable bit that allows program execution to branch to the interrupt vector address when the flag bit is set
- Priority bit to select high priority or low priority

The interrupt priority feature is enabled by setting the IPEN bit (RCON<7>). When interrupt priority is enabled, there are two bits which enable interrupts globally. Setting the GIEH bit (INTCON<7>) enables all interrupts that have the priority bit set (high priority). Setting the GIEL bit (INTCON<6>) enables all interrupts that have the priority bit cleared (low priority). When the interrupt flag, enable bit and appropriate global interrupt enable bit are set, the interrupt will vector immediately to address 0008h or 0018h, depending on the priority bit setting. Individual interrupts can be disabled through their corresponding enable bits.

When the IPEN bit is cleared (default state), the interrupt priority feature is disabled and interrupts are compatible with PICmicro® mid-range devices. In Compatibility mode, the interrupt priority bits for each source have no effect. INTCON<6> is the PEIE bit which enables/disables all peripheral interrupt sources. INTCON<7> is the GIE bit which enables/disables all interrupt sources. All interrupts branch to address 0008h in Compatibility mode.

When an interrupt is responded to, the global interrupt enable bit is cleared to disable further interrupts. If the IPEN bit is cleared, this is the GIE bit. If interrupt priority levels are used, this will be either the GIEH or GIEL bit. High priority interrupt sources can interrupt a low priority interrupt. Low priority interrupts are not processed while high priority interrupts are in progress.

The return address is pushed onto the stack and the PC is loaded with the interrupt vector address (0008h or 0018h). Once in the Interrupt Service Routine, the source(s) of the interrupt can be determined by polling the interrupt flag bits. The interrupt flag bits must be cleared in software before re-enabling interrupts to avoid recursive interrupts.

The "return from interrupt" instruction, RETFIE, exits the interrupt routine and sets the GIE bit (GIEH or GIEL if priority levels are used) which re-enables interrupts.

For external interrupt events, such as the INT pins or the PORTB input change interrupt, the interrupt latency will be three to four instruction cycles. The exact latency is the same for one or two-cycle instructions. Individual interrupt flag bits are set regardless of the status of their corresponding enable bit or the GIE bit.

Note:

Do not use the MOVFF instruction to modify any of the interrupt control registers while **any** interrupt is enabled. Doing so may cause erratic microcontroller behavior.

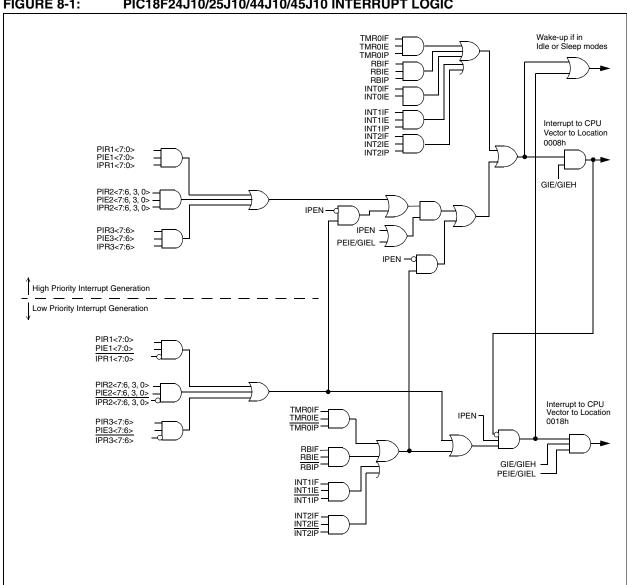


FIGURE 8-1: PIC18F24J10/25J10/44J10/45J10 INTERRUPT LOGIC

8.1 INTCON Registers

The INTCON registers are readable and writable registers which contain various enable, priority and flag bits.

Interrupt flag bits are set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global interrupt enable bit. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt. This feature allows for software polling.

REGISTER 8-1: INTCON: INTERRUPT CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-x
GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INTOIF	RBIF
hit 7							hit 0

Note:

bit 7 GIE/GIEH: Global Interrupt Enable bit

When IPEN = 0:

- 1 = Enables all unmasked interrupts
- 0 = Disables all interrupts

When IPEN = 1:

- 1 = Enables all high priority interrupts
- 0 = Disables all interrupts
- bit 6 **PEIE/GIEL:** Peripheral Interrupt Enable bit

When IPEN = 0:

- 1 = Enables all unmasked peripheral interrupts
- 0 = Disables all peripheral interrupts

When IPEN = 1:

- 1 = Enables all low priority peripheral interrupts
- 0 = Disables all low priority peripheral interrupts
- bit 5 TMR0IE: TMR0 Overflow Interrupt Enable bit
 - 1 = Enables the TMR0 overflow interrupt
 - 0 = Disables the TMR0 overflow interrupt
- bit 4 INTOIE: INTO External Interrupt Enable bit
 - 1 = Enables the INT0 external interrupt
 - 0 = Disables the INT0 external interrupt
- bit 3 RBIE: RB Port Change Interrupt Enable bit
 - 1 = Enables the RB port change interrupt
 - 0 = Disables the RB port change interrupt
- bit 2 TMR0IF: TMR0 Overflow Interrupt Flag bit
 - 1 = TMR0 register has overflowed (must be cleared in software)
 - 0 = TMR0 register did not overflow
- bit 1 INT0IF: INT0 External Interrupt Flag bit
 - 1 = The INT0 external interrupt occurred (must be cleared in software)
 - 0 = The INT0 external interrupt did not occur
- bit 0 RBIF: RB Port Change Interrupt Flag bit
 - 1 = At least one of the RB7:RB4 pins changed state (must be cleared in software)
 - 0 = None of the RB7:RB4 pins have changed state

Note: A mismatch condition will continue to set this bit. Reading PORTB will end the mismatch condition and allow the bit to be cleared.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	l bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

REGISTER 8-2: INTCON2: INTERRUPT CONTROL REGISTER 2

	R/W-1	R/W-1	R/W-1	R/W-1	U-0	R/W-1	U-0	R/W-1
	RBPU	INTEDG0	INTEDG1	INTEDG2	_	TMR0IP	1	RBIP
Ī	oit 7							bit 0

RBPU: PORTB Pull-up Enable bit bit 7

1 = All PORTB pull-ups are disabled

0 = PORTB pull-ups are enabled by individual port latch values

INTEDG0: External Interrupt 0 Edge Select bit bit 6

> 1 = Interrupt on rising edge 0 = Interrupt on falling edge

bit 5 INTEDG1: External Interrupt 1 Edge Select bit

> 1 = Interrupt on rising edge 0 = Interrupt on falling edge

bit 4 INTEDG2: External Interrupt 2 Edge Select bit

> 1 = Interrupt on rising edge 0 = Interrupt on falling edge

bit 3 Unimplemented: Read as '0'

bit 2 TMR0IP: TMR0 Overflow Interrupt Priority bit

> 1 = High priority 0 = Low priority

bit 1 Unimplemented: Read as '0'

bit 0 RBIP: RB Port Change Interrupt Priority bit

> 1 = High priority0 = Low priority

> > Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

Note: Interrupt flag bits are set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global interrupt enable bit. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt. This feature allows for software polling.

REGISTER 8-3: INTCON3: INTERRUPT CONTROL REGISTER 3

R/W-1	R/W-1	U-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0
INT2IP	INT1IP	_	INT2IE	INT1IE	1	INT2IF	INT1IF

bit 7 bit 0

bit 7 INT2IP: INT2 External Interrupt Priority bit

1 = High priority

0 = Low priority

bit 6 INT1IP: INT1 External Interrupt Priority bit

1 = High priority0 = Low priority

bit 5 Unimplemented: Read as '0'

bit 4 INT2IE: INT2 External Interrupt Enable bit

1 = Enables the INT2 external interrupt

0 = Disables the INT2 external interrupt

bit 3 INT1IE: INT1 External Interrupt Enable bit

1 = Enables the INT1 external interrupt

0 = Disables the INT1 external interrupt

bit 2 Unimplemented: Read as '0'

bit 1 INT2IF: INT2 External Interrupt Flag bit

1 = The INT2 external interrupt occurred (must be cleared in software)

0 = The INT2 external interrupt did not occur

bit 0 INT1IF: INT1 External Interrupt Flag bit

1 = The INT1 external interrupt occurred (must be cleared in software)

0 = The INT1 external interrupt did not occur

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

Note: Interrupt flag bits are set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global interrupt enable bit. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an

interrupt. This feature allows for software polling.

8.2 PIR Registers

The PIR registers contain the individual flag bits for the peripheral interrupts. Due to the number of peripheral interrupt sources, there are three Peripheral Interrupt Request (Flag) registers (PIR1, PIR2, PIR3).

- Note 1: Interrupt flag bits are set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the Global Interrupt Enable bit, GIE (INTCON<7>).
 - 2: User software should ensure the appropriate interrupt flag bits are cleared prior to enabling an interrupt and after servicing that interrupt.

REGISTER 8-4: PIR1: PERIPHERAL INTERRUPT REQUEST (FLAG) REGISTER 1

R/W-0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0
PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSP1IF	CCP1IF	TMR2IF	TMR1IF
bit 7							bit 0

- bit 7 **PSPIF:** Parallel Slave Port Read/Write Interrupt Flag bit⁽¹⁾
 - 1 = A read or a write operation has taken place (must be cleared in software)
 - 0 = No read or write has occurred

Note: This bit is not implemented on 28-pin devices and should be read as '0'.

- bit 6 ADIF: A/D Converter Interrupt Flag bit
 - 1 = An A/D conversion completed (must be cleared in software)
 - 0 = The A/D conversion is not complete
- bit 5 RCIF: EUSART Receive Interrupt Flag bit
 - 1 = The EUSART receive buffer, RCREG, is full (cleared when RCREG is read)
 - 0 = The EUSART receive buffer is empty
- bit 4 TXIF: EUSART Transmit Interrupt Flag bit
 - 1 = The EUSART transmit buffer, TXREG, is empty (cleared when TXREG is written)
 - 0 = The EUSART transmit buffer is full
- bit 3 SSP1IF: Master Synchronous Serial Port 1 Interrupt Flag bit
 - 1 = The transmission/reception is complete (must be cleared in software)
 - 0 = Waiting to transmit/receive
- bit 2 CCP1IF: ECCP1/CCP1 Interrupt Flag bit

Capture mode:

- 1 = A TMR1 register capture occurred (must be cleared in software)
- 0 = No TMR1 register capture occurred

Compare mode:

- 1 = A TMR1 register compare match occurred (must be cleared in software)
- 0 = No TMR1 register compare match occurred

PWM mode:

Unused in this mode.

- bit 1 TMR2IF: TMR2 to PR2 Match Interrupt Flag bit
 - 1 = TMR2 to PR2 match occurred (must be cleared in software)
 - 0 = No TMR2 to PR2 match occurred
- bit 0 TMR1IF: TMR1 Overflow Interrupt Flag bit
 - 1 = TMR1 register overflowed (must be cleared in software)
 - 0 = TMR1 register did not overflow

Legend

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

REGISTER 8-5: PIR2: PERIPHERAL INTERRUPT REQUEST (FLAG) REGISTER 2

R/W-0	R/W-0	U-0	U-0	R/W-0	U-0	U-0	R/W-0
OSCFIF	CMIF	_	_	BCL1IF	_	_	CCP2IF
bit 7							bit 0

bit 0

- bit 7 **OSCFIF:** Oscillator Fail Interrupt Flag bit
 - 1 = Device oscillator failed, clock input has changed to INTOSC (must be cleared in software)
 - 0 = Device clock operating
- CMIF: Comparator Interrupt Flag bit bit 6
 - 1 = Comparator input has changed (must be cleared in software)
 - 0 = Comparator input has not changed
- Unimplemented: Read as '0' bit 5-4
- bit 3 **BCL1IF:** Bus Collision Interrupt Flag bit (MSSP1 module)
 - 1 = A bus collision occurred (must be cleared in software)
 - 0 = No bus collision occurred
- bit 2-1 Unimplemented: Read as '0'
- bit 0 CCP2IF: CCP2 Interrupt Flag bit

Capture mode:

- 1 = A TMR1 register capture occurred (must be cleared in software)
- 0 = No TMR1 register capture occurred

Compare mode:

- 1 = A TMR1 register compare match occurred (must be cleared in software)
- 0 = No TMR1 register compare match occurred

PWM mode:

Unused in this mode.

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' '1' = Bit is set '0' = Bit is cleared -n = Value at POR x = Bit is unknown

REGISTER 8-6: PIR3: PERIPHERAL INTERRUPT REQUEST (FLAG) REGISTER 3

R/W-0	R/W-0	U-0	U-0	U-0	U-0	U-0	U-0
SSP2IF	BCL2IF	_	_	_	_	_	_
bit 7							bit 0

- bit 7 SSP2IF: Master Synchronous Serial Port 2 Interrupt Flag bit
 - 1 = The transmission/reception is complete (must be cleared in software)
 - 0 = Waiting to transmit/receive
- bit 6 **BCL2IF:** Bus Collision Interrupt Flag bit (MSSP2 module)
 - 1 = A bus collision occurred (must be cleared in software)
 - 0 = No bus collision occurred
- bit 5-0 Unimplemented: Read as '0'

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

8.3 PIE Registers

The PIE registers contain the individual enable bits for the peripheral interrupts. Due to the number of peripheral interrupt sources, there are three Peripheral Interrupt Enable registers (PIE1, PIE2, PIE3). When IPEN = 0, the PEIE bit must be set to enable any of these peripheral interrupts.

REGISTER 8-7: PIE1: PERIPHERAL INTERRUPT ENABLE REGISTER 1

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PSPIE ⁽¹⁾	ADIE	RCIE	TXIE	SSP1IE	CCP1IE	TMR2IE	TMR1IE
bit 7							bit 0

bit 7 **PSPIE:** Parallel Slave Port Read/Write Interrupt Enable bit⁽¹⁾

1 = Enables the PSP read/write interrupt

0 = Disables the PSP read/write interrupt

Note: This bit is not implemented on 28-pin devices and should be read as '0'.

bit 6 ADIE: A/D Converter Interrupt Enable bit

1 =Enables the A/D interrupt

0 = Disables the A/D interrupt

bit 5 RCIE: EUSART Receive Interrupt Enable bit

1 = Enables the EUSART receive interrupt

0 = Disables the EUSART receive interrupt

bit 4 TXIE: EUSART Transmit Interrupt Enable bit

1 = Enables the EUSART transmit interrupt

0 = Disables the EUSART transmit interrupt

bit 3 SSP1IE: Master Synchronous Serial Port 1 Interrupt Enable bit

1 = Enables the MSSP1 interrupt

0 = Disables the MSSP1 interrupt

bit 2 CCP1IE: ECCP1/CCP1 Interrupt Enable bit

1 = Enables the ECCP1/CCP1 interrupt

0 = Disables the ECCP1/CCP1 interrupt

bit 1 TMR2IE: TMR2 to PR2 Match Interrupt Enable bit

1 = Enables the TMR2 to PR2 match interrupt

0 = Disables the TMR2 to PR2 match interrupt

bit 0 TMR1IE: TMR1 Overflow Interrupt Enable bit

1 = Enables the TMR1 overflow interrupt

0 = Disables the TMR1 overflow interrupt

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

REGISTER 8-8: PIE2: PERIPHERAL INTERRUPT ENABLE REGISTER 2

R/W-0	R/W-0	U-0	U-0	R/W-0	U-0	U-0	R/W-0
OSCFIE	CMIE	_	_	BCL1IE	1	_	CCP2IE

bit 7

bit 7 OSCFIE: Oscillator Fail Interrupt Enable bit

1 = Enabled0 = Disabled

bit 6 CMIE: Comparator Interrupt Enable bit

1 = Enabled
0 = Disabled

bit 5-4 **Unimplemented:** Read as '0'

bit 3 BCL1IE: Bus Collision Interrupt Enable bit (MSSP1 module)

1 = Enabled0 = Disabled

bit 2-1 Unimplemented: Read as '0'

bit 0 CCP2IE: CCP2 Interrupt Enable bit

1 = Enabled
0 = Disabled

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

REGISTER 8-9: PIE3: PERIPHERAL INTERRUPT ENABLE REGISTER 3

R/W-0	R/W-0	U-0	U-0	U-0	U-0	U-0	U-0
SSP2IE	BCL2IE	1		_			1

bit 7

bit 7 SSP2IE: Master Synchronous Serial Port 2 Interrupt Enable bit

1 = Enabled

0 = Disabled

bit 6 BCL2IE: Bus Collision Interrupt Enable bit (MSSP2 module)

1 = Enabled0 = Disabled

bit 5-0 Unimplemented: Read as '0'

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

8.4 IPR Registers

The IPR registers contain the individual priority bits for the peripheral interrupts. Due to the number of peripheral interrupt sources, there are three Peripheral Interrupt Priority registers (IPR1, IPR2, IPR3). Using the priority bits requires that the Interrupt Priority Enable (IPEN) bit be set.

REGISTER 8-10: IPR1: PERIPHERAL INTERRUPT PRIORITY REGISTER 1

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
PSPIP ⁽¹⁾	ADIP	RCIP	TXIP	SSP1IP	CCP1IP	TMR2IP	TMR1IP
bit 7							bit 0

bit 7 **PSPIP:** Parallel Slave Port Read/Write Interrupt Priority bit⁽¹⁾

1 = High priority

0 = Low priority

Note: This bit is not implemented on 28-pin devices and should be read as '0'.

bit 6 ADIP: A/D Converter Interrupt Priority bit

1 = High priority0 = Low priority

bit 5 RCIP: EUSART Receive Interrupt Priority bit

1 = High priority0 = Low priority

bit 4 TXIP: EUSART Transmit Interrupt Priority bit

1 = High priority0 = Low priority

bit 3 SSP1IP: Master Synchronous Serial Port 1 Interrupt Priority bit

1 = High priority0 = Low priority

bit 2 CCP1IP: ECCP1/CCP1 Interrupt Priority bit

1 = High priority0 = Low priority

bit 1 TMR2IP: TMR2 to PR2 Match Interrupt Priority bit

1 = High priority0 = Low priority

bit 0 TMR1IP: TMR1 Overflow Interrupt Priority bit

1 = High priority0 = Low priority

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

REGISTER 8-11: IPR2: PERIPHERAL INTERRUPT PRIORITY REGISTER 2

R/W-1	R/W1	U-0	U-0	R/W-1	U-0	U-0	R/W-1
OSCFIP	CMIP	_	_	BCL1IP	-	_	CCP2IP

bit 7 bit 0

bit 7 OSCFIP: Oscillator Fail Interrupt Priority bit

1 = High priority0 = Low priority

bit 6 CMIP: Comparator Interrupt Priority bit

1 = High priority0 = Low priority

bit 5-4 **Unimplemented:** Read as '0'

bit 3 BCL1IP: Bus Collision Interrupt Priority bit (MSSP1 module)

1 = High priority0 = Low priority

bit 2-1 Unimplemented: Read as '0'

bit 0 CCP2IP: CCP2 Interrupt Priority bit

1 = High priority0 = Low priority

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

REGISTER 8-12: IPR3: PERIPHERAL INTERRUPT PRIORITY REGISTER 3

R/W-1	R/W-1	U-0	U-0	U-0	U-0	U-0	U-0
SSP2IP	BCL2IP		1			1	

bit 7

bit 7 SSP2IP: Master Synchronous Serial Port 2 Interrupt Priority bit

1 = High priority0 = Low priority

bit 6 BCL2IP: Bus Collision Interrupt Priority bit (MSSP2 module)

1 = High priority0 = Low priority

bit 5-0 Unimplemented: Read as '0'

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

8.5 RCON Register

The RCON register contains bits used to determine the cause of the last Reset or wake-up from Idle or Sleep modes. RCON also contains the bit that enables interrupt priorities (IPEN).

REGISTER 8-13: RCON: RESET CONTROL REGISTER

R/W-0	U-0	U-0	R/W-1	R-1	R-1	R/W-0	R/W-0	_
IPEN	_	_	RI	TO	PD	POR	BOR	
bit 7							bit 0	

1 = Enable priority levels on interrupts

0 = Disable priority levels on interrupts (PIC16CXXX Compatibility mode)

bit 6-5 Unimplemented: Read as '0'

bit 4 RESET Instruction Flag bit

For details of bit operation, see Register 4-1.

bit 3 **TO**: Watchdog Timer Time-out Flag bit

For details of bit operation, see Register 4-1.

bit 2 PD: Power-Down Detection Flag bit

For details of bit operation, see Register 4-1.

bit 1 POR: Power-on Reset Status bit

For details of bit operation, see Register 4-1.

bit 0 BOR: Brown-out Reset Status bit

For details of bit operation, see Register 4-1.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	l bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

8.6 INTn Pin Interrupts

External interrupts on the RB0/INT0, RB1/INT1 and RB2/INT2 pins are edge-triggered. If the corresponding INTEDGx bit in the INTCON2 register is set (= 1), the interrupt is triggered by a rising edge; if the bit is clear, the trigger is on the falling edge. When a valid edge appears on the RBx/INTx pin, the corresponding flag bit, INTxIF, is set. This interrupt can be disabled by clearing the corresponding enable bit, INTxIE. Flag bit, INTxIF, must be cleared in software in the Interrupt Service Routine before re-enabling the interrupt.

All external interrupts (INT0, INT1 and INT2) can wake-up the processor from the power-managed modes if bit INTxIE was set prior to going into the power-managed modes. If the Global Interrupt Enable bit, GIE, is set, the processor will branch to the interrupt vector following wake-up.

Interrupt priority for INT1 and INT2 is determined by the value contained in the interrupt priority bits, INT1IP (INTCON3<6>) and INT2IP (INTCON3<7>). There is no priority bit associated with INT0. It is always a high priority interrupt source.

8.7 TMR0 Interrupt

In 8-bit mode (which is the default), an overflow in the TMR0 register (FFh \rightarrow 00h) will set flag bit, TMR0IF. In 16-bit mode, an overflow in the TMR0H:TMR0L register pair (FFFFh \rightarrow 0000h) will set TMR0IF. The interrupt can be enabled/disabled by setting/clearing enable bit, TMR0IE (INTCON<5>). Interrupt priority for Timer0 is determined by the value contained in the interrupt priority bit, TMR0IP (INTCON2<2>). See **Section 10.0** "**Timer0 Module**" for further details on the Timer0 module.

8.8 PORTB Interrupt-on-Change

An input change on PORTB<7:4> sets flag bit, RBIF (INTCON<0>). The interrupt can be enabled/disabled by setting/clearing enable bit, RBIE (INTCON<3>). Interrupt priority for PORTB interrupt-on-change is determined by the value contained in the interrupt priority bit, RBIP (INTCON2<0>).

8.9 Context Saving During Interrupts

During interrupts, the return PC address is saved on the stack. Additionally, the WREG, STATUS and BSR registers are saved on the fast return stack. If a fast return from interrupt is not used (see **Section 5.3** "**Data Memory Organization**"), the user may need to save the WREG, STATUS and BSR registers on entry to the Interrupt Service Routine. Depending on the user's application, other registers may also need to be saved. Example 8-1 saves and restores the WREG, STATUS and BSR registers during an Interrupt Service Routine.

EXAMPLE 8-1: SAVING STATUS, WREG AND BSR REGISTERS IN RAM

```
MOVWF
         W TEMP
                                       ; W TEMP is in virtual bank
MOVFF
         STATUS, STATUS TEMP
                                       ; STATUS_TEMP located anywhere
MOVFF
         BSR, BSR TEMP
                                       ; BSR TMEP located anywhere
; USER ISR CODE
MOVFF
         BSR TEMP, BSR
                                       ; Restore BSR
MOVF
         W TEMP, W
                                       ; Restore WREG
         STATUS TEMP, STATUS
                                       ; Restore STATUS
```

NOTES:

9.0 I/O PORTS

Depending on the device selected and features enabled, there are up to five ports available. Some pins of the I/O ports are multiplexed with an alternate function from the peripheral features on the device. In general, when a peripheral is enabled, that pin may not be used as a general purpose I/O pin.

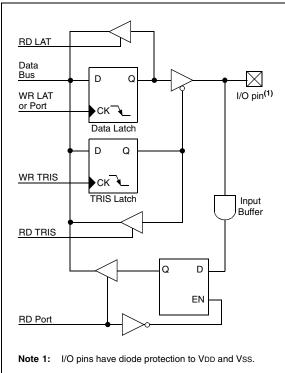
Each port has three registers for its operation. These registers are:

- TRIS register (data direction register)
- Port register (reads the levels on the pins of the device)
- · LAT register (output latch)

The Data Latch (LAT register) is useful for read-modify-write operations on the value that the I/O pins are driving.

A simplified model of a generic I/O port, without the interfaces to other peripherals, is shown in Figure 9-1.

FIGURE 9-1: GENERIC I/O PORT OPERATION



9.1 I/O Port Pin Capabilities

When developing an application, the capabilities of the port pins must be considered. Outputs on some pins have higher output drive strength than others. Similarly, some pins can tolerate higher than VDD input levels.

9.1.1 PIN OUTPUT DRIVE

The output pin drive strengths vary for groups of pins intended to meet the needs for a variety of applications. PORTB and PORTC are designed to drive higher loads, such as LEDs. All other ports are designed for small loads, typically indication only. Table 9-1 summarizes the output capabilities. Refer to **Section 23.0** "Electrical Characteristics" for more details.

TABLE 9-1: OUTPUT DRIVE LEVELS

Port	Drive	Description			
PORTA					
PORTD	Minimum	Intended for indication.			
PORTE					
PORTB	∐iah	Suitable for direct LED drive			
PORTC	High	levels.			

9.1.2 INPUT PINS AND VOLTAGE CONSIDERATIONS

The voltage tolerance of pins used as device inputs is dependent on the pin's input function. Pins that are used as digital only inputs are able to handle DC voltages up to 5.5V; a level typical for digital logic circuits. In contrast, pins that also have analog input functions of any kind can only tolerate voltages up to VDD. Voltage excursions beyond VDD on these pins should be avoided. Table 9-2 summarizes the input capabilities. Refer to **Section 23.0 "Electrical Characteristics"** for more details.

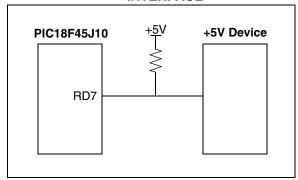
TABLE 9-2: INPUT VOLTAGE LEVELS

Port or Pin	Tolerated Input	Description		
PORTA<5:0>				
PORTB<5:0>	VDD	Only VDD input levels tolerated.		
PORTC<1:0>	VDD			
PORTE<2:0>				
PORTB<7:6>		Tolerates input levels		
PORTC<7:2>	5.5V	above VDD, useful for		
PORTD<7:0>		most standard logic.		

9.1.3 INTERFACING TO A 5V SYSTEM

Though the VDDMAX of the PIC18F45J10 family is 3.6V, these devices are still capable of interfacing with 5V systems, even if the VIH of the target system is above 3.6V. This is accomplished by adding a pull-up resistor to the port pin (Figure 9-2), clearing the LAT bit for that pin and manipulating the corresponding TRIS bit (Figure 9-1) to either allow the line to be pulled high or to drive the pin low. Only port pins that are tolerant of voltages up to 5.5V can be used for this type of interface (refer to Section 9.1.2 "Input Pins and Voltage Considerations").

FIGURE 9-2: +5V SYSTEM HARDWARE INTERFACE



EXAMPLE 9-1: COMMUNICATING WITH THE +5V SYSTEM

```
BCF LATD, 7 ; set up LAT register so ; changing TRIS bit will ; drive line low

BCF TRISD, 7 ; send a 0 to the 5V system

BCF TRISD, 7 ; send a 1 to the 5V system
```

9.2 PORTA, TRISA and LATA Registers

PORTA is a 5-bit wide, bidirectional port. The corresponding data direction register is TRISA. Setting a TRISA bit (= 1) will make the corresponding PORTA pin an input (i.e., put the corresponding output driver in a high-impedance mode). Clearing a TRISA bit (= 0) will make the corresponding PORTA pin an output (i.e., put the contents of the output latch on the selected pin).

Reading the PORTA register reads the status of the pins, whereas writing to it, will write to the port latch.

The Data Latch (LATA) register is also memory mapped. Read-modify-write operations on the LATA register read and write the latched output value for PORTA.

The other PORTA pins are multiplexed with analog inputs, the analog VREF+ and VREF- inputs and the comparator voltage reference output. The operation of pins RA3:RA0 and RA5 as A/D converter inputs is selected by clearing or setting the control bits in the ADCON1 register (A/D Control Register 1).

Pins RA0 and RA3 may also be used as comparator inputs and RA5 may be used as the C2 comparator output by setting the appropriate bits in the CMCON register. To use RA3:RA0 as digital inputs, it is also necessary to turn off the comparators.

Note: On a Power-on Reset, RA5 and RA3:RA0 are configured as analog inputs and read as '0'.

All PORTA pins have TTL input levels and full CMOS output drivers.

The TRISA register controls the direction of the PORTA pins, even when they are being used as analog inputs. The user must ensure the bits in the TRISA register are maintained set when using them as analog inputs.

EXAMPLE 9-2: INITIALIZING PORTA

CLRF	PORTA		Initialize PORTA by clearing output
		,	3 2
		;	data latches
CLRF	LATA	;	Alternate method
		;	to clear output
		;	data latches
MOVLW	07h	;	Configure A/D
MOVWF	ADCON1	;	for digital inputs
MOVWF	07h	;	Configure comparators
MOVWF	CMCON	;	for digital input
MOVLW	0CFh	;	Value used to
		;	initialize data
		;	direction
MOVWF	TRISA	;	Set RA<3:0> as inputs
		;	RA<5:4> as outputs

TABLE 9-3: PORTA I/O SUMMARY

Pin	Function	TRIS Setting	I/O	I/O Type	Description
RA0/AN0	RA0	0	0	DIG	LATA<0> data output; not affected by analog input.
		1	ı	TTL	PORTA<0> data input; disabled when analog input enabled.
	AN0	1	I	ANA	A/D input channel 0 and Comparator C1- input. Default input configuration on POR; does not affect digital output.
RA1/AN1	RA1	0	0	DIG	LATA<1> data output; not affected by analog input.
		1	1	TTL	PORTA<1> data input; disabled when analog input enabled.
	AN1	1	I	ANA	A/D input channel 1 and Comparator C2- input. Default input configuration on POR; does not affect digital output.
RA2/AN2/ VREF-/CVREF	RA2	0	0	DIG	LATA<2> data output; not affected by analog input. Disabled when CVREF output enabled.
		1	I	TTL	PORTA<2> data input. Disabled when analog functions enabled; disabled when CVREF output enabled.
	AN2	1	I	ANA	A/D input channel 2 and Comparator C2+ input. Default input configuration on POR; not affected by analog output.
	VREF-	1	I	ANA	A/D and comparator voltage reference low input.
	CVREF	х	0	ANA	Comparator voltage reference output. Enabling this feature disables digital I/O.
RA3/AN3/VREF+	RA3	0	0	DIG	LATA<3> data output; not affected by analog input.
		1	_	TTL	PORTA<3> data input; disabled when analog input enabled.
	AN3	1	I	ANA	A/D input channel 3 and Comparator C1+ input. Default input configuration on POR.
	VREF+	1	ı	ANA	A/D and comparator voltage reference high input.
RA5/AN4/SS1/	RA5	0	0	DIG	LATA<5> data output; not affected by analog input.
C2OUT		1	ı	TTL	PORTA<5> data input; disabled when analog input enabled.
	AN4	1	1	ANA	A/D input channel 4. Default configuration on POR.
	SS1	1	I	TTL	Slave select input for MSSP1 (MSSP1 module).
	C2OUT	0	0	DIG	Comparator 2 output; takes priority over port data.
OSC2/CLKO	OSC2	х	0	ANA	Main oscillator feedback output connection (HS mode).
	CLKO	х	0	DIG	System cycle clock output (Fosc/4) in RC and EC Oscillator modes.
OSC1/CLKI	OSC1	х	ı	ANA	Main oscillator input connection.
	CLKI	х	I	ANA	Main clock input connection.

Legend: DIG = Digital level output; TTL = TTL input buffer; ST = Schmitt Trigger input buffer; ANA = Analog level input/output; x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

TABLE 9-4: SUMMARY OF REGISTERS ASSOCIATED WITH PORTA

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page	
PORTA	_	_	RA5	_	RA3	RA2	RA1	RA0	46	
LATA	_	_	PORTA Da	PORTA Data Latch Register (Read and Write to Data Latch)						
TRISA	_	_	TRISA5	_	TRISA3	TRISA2	TRISA1	TRISA0	46	
ADCON1	_	_	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0	44	
CMCON	C2OUT	C1OUT	C2INV	C1INV	CIS	CM2	CM1	CM0	45	
CVRCON	CVREN	CVROE	CVRR	CVRSS	CVR3	CVR2	CVR1	CVR0	45	

Legend: — = unimplemented, read as '0'. Shaded cells are not used by PORTA.

9.3 PORTB, TRISB and LATB Registers

PORTB is an 8-bit wide, bidirectional port. The corresponding data direction register is TRISB. Setting a TRISB bit (= 1) will make the corresponding PORTB pin an input (i.e., put the corresponding output driver in a high-impedance mode). Clearing a TRISB bit (= 0) will make the corresponding PORTB pin an output (i.e., put the contents of the output latch on the selected pin).

The Data Latch register (LATB) is also memory mapped. Read-modify-write operations on the LATB register read and write the latched output value for PORTB.

EXAMPLE 9-3: INITIALIZING PORTB

```
CLRF
       PORTB
               ; Initialize PORTB by
               ; clearing output
               ; data latches
CLRF
      LATE
               ; Alternate method
               ; to clear output
               ; data latches
MOVIW OFh
               ; Set RB<4:0> as
MOVWF ADCON1
               ; digital I/O pins
               ; (required if config bit
               ; PBADEN is set)
MOVLW 0CFh
               : Value used to
               ; initialize data
               : direction
MOVWF TRISB
               ; Set RB<3:0> as inputs
               ; RB<5:4> as outputs
               ; RB<7:6> as inputs
```

Each of the PORTB pins has a weak internal pull-up. A single control bit can turn on all the pull-ups. This is performed by clearing bit, RBPU (INTCON2<7>). The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on a Power-on Reset.

Note: On a Power-on Reset, RB4:RB0 are configured as analog inputs by default and read as '0'; RB7:RB5 are configured as digital inputs.

By programming the configuration bit, PBADEN, RB4:RB0 will alternatively be configured as digital inputs on POR.

Four of the PORTB pins (RB7:RB4) have an interrupton-change feature. Only pins configured as inputs can cause this interrupt to occur (i.e., any RB7:RB4 pin configured as an output is excluded from the interrupton-change comparison). The input pins (of RB7:RB4) are compared with the old value latched on the last read of PORTB. The "mismatch" outputs of RB7:RB4 are ORed together to generate the RB Port Change Interrupt with Flag bit, RBIF (INTCON<0>).

This interrupt can wake the device from Sleep mode or any of the Idle modes. The user, in the Interrupt Service Routine, can clear the interrupt in the following manner:

- a) Any read or write of PORTB (except with the MOVFF (ANY), PORTB instruction).
- b) Clear flag bit, RBIF.

A mismatch condition will continue to set flag bit, RBIF. Reading PORTB will end the mismatch condition and allow flag bit, RBIF, to be cleared.

The interrupt-on-change feature is recommended for wake-up on key depression operation and operations where PORTB is only used for the interrupt-on-change feature. Polling of PORTB is not recommended while using the interrupt-on-change feature.

RB3 can be configured by the configuration bit, CCP2MX, as the alternate peripheral pin for the CCP2 module (CCP2MX = 0).

The RB5 pin is multiplexed with the Timer0 module clock input and one of the comparator outputs to become the RB5/KBI1/T0CKI/C1OUT pin.

TABLE 9-5: PORTB I/O SUMMARY

IADLL 3-3.	FORIBI	- COIN	1417-1111		T
Pin	Function	TRIS Setting	I/O	I/O Type	Description
RB0/INT0/FLT0/	RB0	0	0	DIG	LATB<0> data output; not affected by analog input.
AN12		1	I	TTL	PORTB<0> data input; weak pull-up when RBPU bit is cleared. Disabled when analog input enabled. (1)
	INT0	1	ı	ST	External interrupt 0 input.
	FLT0	1	ı	ST	PWM Fault input (ECCP1/CCP1 module); enabled in
					software.
	AN12	1	I	ANA	A/D input channel 12. ⁽¹⁾
RB1/INT1/AN10	RB1	0	0	DIG	LATB<1> data output; not affected by analog input.
		1	-	TTL	PORTB<1> data input; weak pull-up when RBPU bit is cleared. Disabled when analog input enabled. (1)
	INT1	1		ST	External interrupt 1 input.
	AN10	1		ANA	A/D input channel 10. ⁽¹⁾
RB2/INT2/AN8	RB2	0	0	DIG	LATB<2> data output; not affected by analog input.
		1	Ι	TTL	PORTB<2> data input; weak pull-up when RBPU bit is cleared. Disabled when analog input enabled. (1)
	INT2	1	ı	ST	External interrupt 2 input.
	AN8	1	I	ANA	A/D input channel 8. ⁽¹⁾
RB3/AN9/CCP2	RB3	0	0	DIG	LATB<3> data output; not affected by analog input.
		1	Ţ	TTL	PORTB<3> data input; weak pull-up when RBPU bit is cleared. Disabled when analog input enabled. (1)
	AN9	1	ı	ANA	A/D input channel 9. ⁽¹⁾
	CCP2 ⁽²⁾	0	0	DIG	CCP2 compare and PWM output.
		1	I	ST	CCP2 capture input
RB4/KBI0/AN11	RB4	0	0	DIG	LATB<4> data output; not affected by analog input.
		1	I	TTL	PORTB<4> data input; weak pull-up when RBPU bit is cleared. Disabled when analog input enabled.(1)
	KBI0	1	ı	TTL	Interrupt-on-change pin.
	AN11	1	I	ANA	A/D input channel 11. ⁽¹⁾
RB5/KBI1/T0CKI/	RB5	0	0	DIG	LATB<5> data output.
C1OUT		1	I	TTL	PORTB<5> data input; weak pull-up when RBPU bit is cleared.
	KBI1	1	ı	TTL	Interrupt-on-change pin.
	T0CKI	1	I	ST	Timer0 clock input.
	C10UT	0	0	DIG	Comparator 1 output; takes priority over port data.
RB6/KBI2/PGC	RB6	0	0	DIG	LATB<6> data output.
		1	ı	TTL	PORTB<6> data input; weak pull-up when RBPU bit is cleared.
	KBI2	1	ı	TTL	Interrupt-on-change pin.
	PGC	х	ı	ST	Serial execution (ICSPTM) clock input for ICSP and ICD operation. (3)
RB7/KBI3/PGD	RB7	0	0	DIG	LATB<7> data output.
		1	I	TTL	PORTB<7> data input; weak pull-up when RBPU bit is cleared.
	KBI3	1	I	TTL	Interrupt-on-change pin.
	PGD	х	0	DIG	Serial execution data output for ICSP and ICD operation. (3)
		х	ı	ST	Serial execution data input for ICSP and ICD operation. (3)

Legend: DIG = Digital level output; TTL = TTL input buffer; ST = Schmitt Trigger input buffer; ANA = Analog level input/output; x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

- 2: Alternate assignment for CCP2 when the CCP2MX configuration bit is '0'. Default assignment is RC1.
- 3: All other pin functions are disabled when ICSP or ICD are enabled.

Note 1: Configuration on POR is determined by the PBADEN configuration bit. Pins are configured as analog inputs by default when PBADEN is set and digital inputs when PBADEN is cleared.

TABLE 9-6: SUMMARY OF REGISTERS ASSOCIATED WITH PORTB

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	46
LATB	PORTB Data Latch Register (Read and Write to Data Latch)								46
TRISB	PORTB Dat	a Direction C	ontrol Regi	ster					46
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	43
INTCON2	RBPU	INTEDG0	INTEDG1	INTEDG2	-	TMR0IP	-	RBIP	43
INTCON3	INT2IP	INT1IP	_	INT2IE	INT1IE	_	INT2IF	INT1IF	43
ADCON1	_	_	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0	44

Legend: — = unimplemented, read as '0'. Shaded cells are not used by PORTB.

9.4 PORTC, TRISC and LATC Registers

PORTC is an 8-bit wide, bidirectional port. The corresponding data direction register is TRISC. Setting a TRISC bit (= 1) will make the corresponding PORTC pin an input (i.e., put the corresponding output driver in a high-impedance mode). Clearing a TRISC bit (= 0) will make the corresponding PORTC pin an output (i.e., put the contents of the output latch on the selected pin).

The Data Latch register (LATC) is also memory mapped. Read-modify-write operations on the LATC register read and write the latched output value for PORTC.

PORTC is multiplexed with several peripheral functions (Table 9-7). The pins have Schmitt Trigger input buffers. RC1 is normally configured by configuration bit, CCP2MX, as the default peripheral pin of the CCP2 module (default/erased state, CCP2MX = 1).

When enabling peripheral functions, care should be taken in defining TRIS bits for each PORTC pin. Some peripherals override the TRIS bit to make a pin an output, while other peripherals override the TRIS bit to make a pin an input. The user should refer to the corresponding peripheral section for additional information.

Note: On a Power-on Reset, these pins are configured as digital inputs.

The contents of the TRISC register are affected by peripheral overrides. Reading TRISC always returns the current contents, even though a peripheral device may be overriding one or more of the pins.

EXAMPLE 9-4: INITIALIZING PORTC

CLRF	PORTC	; Initialize PORTC by ; clearing output
		; data latches
CLRF	LATC	; Alternate method
		; to clear output
		; data latches
MOVLW	0CFh	; Value used to
		; initialize data
		; direction
MOVWF	TRISC	; Set RC<3:0> as inputs
		; RC<5:4> as outputs
		; RC<7:6> as inputs

TABLE 9-7: PORTC I/O SUMMARY

Pin	Function	TRIS Setting	I/O	I/O Type	Description
RC0/T1OSO/	RC0	0	0	DIG	LATC<0> data output.
T1CKI		1	ı	ST	PORTC<0> data input.
	T1OSO	х	0	ANA	Timer1 oscillator output; enabled when Timer1 oscillator enabled. Disables digital I/O.
	T1CKI	1	ı	ST	Timer1 counter input.
RC1/T1OSI/CCP2	RC1	0	0	DIG	LATC<1> data output.
		1	ı	ST	PORTC<1> data input.
	T1OSI	х	I	ANA	Timer1 oscillator input; enabled when Timer1 oscillator enabled. Disables digital I/O.
	CCP2 ⁽¹⁾	0	0	DIG	CCP2 compare and PWM output; takes priority over port data.
		1	1	ST	CCP2 capture input.
RC2/CCP1/P1A	RC2	0	0	DIG	LATC<2> data output.
		1	ı	ST	PORTC<2> data input.
ļ	CCP1	0	0	DIG	ECCP1/CCP1 compare or PWM output; takes priority over port data.
ļ		1		ST	ECCP1/CCP1 capture input.
	P1A ⁽²⁾	0	0	DIG	ECCP1 Enhanced PWM output, channel A. May be configured for tri-state during Enhanced PWM shutdown events. Takes priority over port data.
RC3/SCK1/SCL1	RC3	0	0	DIG	LATC<3> data output.
		1	ı	ST	PORTC<3> data input.
	SCK1	0	0	DIG	SPI™ clock output (MSSP1 module); takes priority over port data.
		1	ı	ST	SPI clock input (MSSP1 module).
	SCL1	0	0	DIG	I ² C™ clock output (MSSP1 module); takes priority over port data.
		1	ı	I ² C/SMB	I ² C clock input (MSSP1 module); input type depends on module setting.
RC4/SDI1/SDA1	RC4	0	0	DIG	LATC<4> data output.
		1	ı	ST	PORTC<4> data input.
	SDI1	1	ı	ST	SPI data input (MSSP1 module).
	SDA1	1	0	DIG	I ² C data output (MSSP1 module); takes priority over port data.
		1	ı	I ² C/SMB	I ² C data input (MSSP1 module); input type depends on module setting.
RC5/SDO1	RC5	0	0	DIG	LATC<5> data output.
		1	ı	ST	PORTC<5> data input.
	SDO1	0	0	DIG	SPI data output (MSSP1 module); takes priority over port data.
RC6/TX/CK	RC6	0	0	DIG	LATC<6> data output.
		1	ı	ST	PORTC<6> data input.
	TX	1	0	DIG	Asynchronous serial transmit data output (EUSART module); takes priority over port data. User must configure as output.
	СК	1	0	DIG	Synchronous serial clock output (EUSART module); takes priority over port data.
		1	ı	ST	Synchronous serial clock input (EUSART module).
RC7/RX/DT	RC7	0	0	DIG	LATC<7> data output.
		1		ST	PORTC<7> data input.
	RX	1		ST	Asynchronous serial receive data input (EUSART module).
	DT	1	0	DIG	Synchronous serial data output (EUSART module); takes priority over port data.
		1	I	ST	Synchronous serial data input (EUSART module). User must configure as an input.

Legend: DIG = Digital level output; TTL = TTL input buffer; ST = Schmitt Trigger input buffer; ANA = Analog level input/output; I²C/SMB = I²C/SMBus input buffer; x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

Note 1: Default assignment for CCP2 when the CCP2MX configuration bit is set. Alternate assignment is RB3.

2: Enhanced PWM output is available only on PIC18F44J10/45J10 devices.

TABLE 9-8: SUMMARY OF REGISTERS ASSOCIATED WITH PORTC

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
PORTC	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0	46
LATC	PORTC Data Latch Register (Read and Write to Data Latch)								46
TRISC	PORTC Da	ata Direction	n Control Re	egister					46

9.5 PORTD, TRISD and LATD Registers

Note: PORTD is only available in 40/44-pin devices.

PORTD is an 8-bit wide, bidirectional port. The corresponding data direction register is TRISD. Setting a TRISD bit (= 1) will make the corresponding PORTD pin an input (i.e., put the corresponding output driver in a high-impedance mode). Clearing a TRISD bit (= 0) will make the corresponding PORTD pin an output (i.e., put the contents of the output latch on the selected pin).

The Data Latch register (LATD) is also memory mapped. Read-modify-write operations on the LATD register read and write the latched output value for PORTD.

All pins on PORTD are implemented with Schmitt Trigger input buffers. Each pin is individually configurable as an input or output.

Three of the PORTD pins are multiplexed with outputs P1B, P1C and P1D of the Enhanced CCP module. The operation of these additional PWM output pins is covered in greater detail in **Section 14.0 "Enhanced Capture/Compare/PWM (ECCP) Module"**.

Note: On a Power-on Reset, these pins are configured as digital inputs.

PORTD can also be configured as an 8-bit wide microprocessor port (Parallel Slave Port) by setting control bit, PSPMODE (TRISE<4>). In this mode, the input buffers are TTL. See **Section 9.7** "**Parallel Slave Port**" for additional information on the Parallel Slave Port (PSP).

Note: When the Enhanced PWM mode is used with either dual or quad outputs, the PSP functions of PORTD are automatically disabled.

EXAMPLE 9-5: INITIALIZING PORTD

CLRF	PORTD	; Initialize PORTD by ; clearing output
CLRF	LATD	<pre>; data latches ; Alternate method ; to clear output</pre>
MOVLW	0CFh	; data latches ; Value used to
	TD T CD	; initialize data ; direction
MOVWF	TRISD	; Set RD<3:0> as inputs ; RD<5:4> as outputs ; RD<7:6> as inputs

TABLE 9-9: PORTD I/O SUMMARY

Pin	Function	TRIS Setting	I/O	I/O Type	Description
RD0/PSP0/SCK2/	RD0	0	0	DIG	LATD<0> data output.
SCL2		1	ı	ST	PORTD<0> data input.
	PSP0 x O DIG PSP read data output (LATD<0>); takes priority over p		PSP read data output (LATD<0>); takes priority over port data.		
		х	ı	TTL	PSP write data input.
	SCK2	0	0	DIG	SPI™ clock output (MSSP2 module); takes priority over port data.
		1	I	ST	SPI clock input (MSSP2 module).
	SCL2	0	0	DIG	I ² C™ clock output (MSSP2 module); takes priority over port data.
		1	I	I ² C/SMB	I ² C clock input (MSSP2 module); input type depends on module setting.
RD1/PSP1/SDI2/	RD1	0	0	DIG	LATD<1> data output.
SDA2		1	I	ST	PORTD<1> data input.
	PSP1	х	0	DIG	PSP read data output (LATD<1>); takes priority over port data.
		х	I	TTL	PSP write data input.
	SDI2	1	I	ST	SPI data input (MSSP2 module).
	SDA2	1	0	DIG	I ² C data output (MSSP2 module); takes priority over port data.
		1	I	I ² C/SMB	I ² C data input (MSSP2 module); input type depends on module setting.
RD2/PSP2/SDO2	RD2	0	0	DIG	LATD<2> data output.
		1	I	ST	PORTD<2> data input.
	PSP2	х	0	DIG	PSP read data output (LATD<2>); takes priority over port data.
		х	ı	TTL	PSP write data input.
	SDO2	0	0	DIG	SPI data output (MSSP2 module); takes priority over port data.
RD3/PSP3/SS2	RD3	0	0	DIG	LATD<3> data output.
		1	I	ST	PORTD<3> data input.
	PSP3	х	0	DIG	PSP read data output (LATD<3>); takes priority over port data.
		х	I	TTL	PSP write data input.
	SS2	1	I	TTL	Slave select input for MSSP2 (MSSP2 module).
RD4/PSP4	RD4	0	0	DIG	LATD<4> data output.
		1	I	ST	PORTD<4> data input.
	PSP4	х	0	DIG	PSP read data output (LATD<4>); takes priority over port data.
		х	I	TTL	PSP write data input.
RD5/PSP5/P1B	RD5	0	0	DIG	LATD<5> data output.
		1	I	ST	PORTD<5> data input.
	PSP5	х	0	DIG	PSP read data output (LATD<5>); takes priority over port data.
		х	I	TTL	PSP write data input.
	P1B	0	0	DIG	ECCP1 Enhanced PWM output, channel B; takes priority over port and PSP data. May be configured for tri-state during Enhanced PWM shutdown events.
RD6/PSP6/P1C	RD6	0	0	DIG	LATD<6> data output.
		1	I	ST	PORTD<6> data input.
	PSP6	х	0	DIG	PSP read data output (LATD<6>); takes priority over port data.
		х	-	TTL	PSP write data input.
	P1C	0	0	DIG	ECCP1 Enhanced PWM output, channel C; takes priority over port and PSP data. May be configured for tri-state during Enhanced PWM shutdown events.
RD7/PSP7/P1D	RD7	0	0	DIG	LATD<7> data output.
		1	I	ST	PORTD<7> data input.
	PSP7	х	0	DIG	PSP read data output (LATD<7>); takes priority over port data.
		х	I	TTL	PSP write data input.
	P1D	0	0	DIG	ECCP1 Enhanced PWM output, channel D; takes priority over port and PSP data. May be configured for tri-state during Enhanced PWM shutdown events.

Legend: DIG = Digital level output; TTL = TTL input buffer; ST = Schmitt Trigger input buffer; $I^2C/SMB = I^2C/SMB$ us input buffer; x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

TABLE 9-10: SUMMARY OF REGISTERS ASSOCIATED WITH PORTD

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
PORTD ⁽¹⁾	RD7	RD6	RD5	RD4	RD3	RD2	RD1	RD0	46
LATD ⁽¹⁾	PORTD Data Latch Register (Read and Write to Data Latch)								
TRISD ⁽¹⁾	PORTD Data Direction Control Register								
TRISE ⁽¹⁾	IBF	OBF	IBOV	PSPMODE	_	TRISE2	TRISE1	TRISE0	46
CCP1CON	P1M1	P1M0	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0	45

Legend: — = unimplemented, read as '0'. Shaded cells are not used by PORTD.

Note 1: These registers are not available in 28-pin devices.

9.6 PORTE, TRISE and LATE Registers

Note: PORTE is only available in 40/44-pin devices.

Depending on the particular PIC18F45J10 family device selected, PORTE is implemented in two different ways.

For 40/44-pin devices, PORTE is a 4-bit wide port. Three pins (RE0/RD/AN5, RE1/WR/AN6 and RE2/CS/AN7) are individually configurable as inputs or outputs. These pins have Schmitt Trigger input buffers. When selected as analog inputs, these pins will read as '0's.

The corresponding data direction register is TRISE. Setting a TRISE bit (= 1) will make the corresponding PORTE pin an input (i.e., put the corresponding output driver in a high-impedance mode). Clearing a TRISE bit (= 0) will make the corresponding PORTE pin an output (i.e., put the contents of the output latch on the selected pin).

TRISE controls the direction of the RE pins, even when they are being used as analog inputs. The user must make sure to keep the pins configured as inputs when using them as analog inputs.

Note: On a Power-on Reset, RE2:RE0 are configured as analog inputs.

The upper four bits of the TRISE register also control the operation of the Parallel Slave Port. Their operation is explained in Register 9-1.

The Data Latch register (LATE) is also memory mapped. Read-modify-write operations on the LATE register read and write the latched output value for PORTE.

EXAMPLE 9-6: INITIALIZING PORTE

CLRF	PORTE	; Initialize PORTE by ; clearing output
CLRF	LATE	<pre>; data latches ; Alternate method ; to clear output : data latches</pre>
MOVLW	0Ah	; Configure A/D
MOVWF	ADCON1	; for digital inputs
MOVLW	03h	; Value used to
		; initialize data
		; direction
MOVWF	TRISE	; Set RE<0> as inputs
		; RE<1> as outputs
		; RE<2> as inputs

REGISTER 9-1: TRISE REGISTER (40/44-PIN DEVICES ONLY)

R-0	R-0	R/W-0	R/W-0	U-0	R/W-1	R/W-1	R/W-1
IBF	OBF	IBOV	PSPMODE	_	TRISE2	TRISE1	TRISE0
bit 7							bit 0

bit 0

bit 7 IBF: Input Buffer Full Status bit

1 = A word has been received and waiting to be read by the CPU

0 = No word has been received

bit 6 **OBF:** Output Buffer Full Status bit

1 = The output buffer still holds a previously written word

0 = The output buffer has been read

bit 5 **IBOV:** Input Buffer Overflow Detect bit (in Microprocessor mode)

1 = A write occurred when a previously input word has not been read (must be cleared in software)

0 = No overflow occurred

bit 4 **PSPMODE:** Parallel Slave Port Mode Select bit

> 1 = Parallel Slave Port mode 0 = General purpose I/O mode

bit 3 Unimplemented: Read as '0'

bit 2 TRISE2: RE2 Direction Control bit

> 1 = Input 0 = Output

bit 1 TRISE1: RE1 Direction Control bit

> 1 = Input 0 = Output

bit 0 TRISE0: RE0 Direction Control bit

> 1 = Input0 = Output

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

TABLE 9-11: PORTE I/O SUMMARY

Pin	Function	TRIS Setting	I/O	I/O Type	Description
RE0/RD/AN5	RE0	0	0	DIG	LATE<0> data output; not affected by analog input.
		1	1 I ST PORTE<0> data input; disabled when an		PORTE<0> data input; disabled when analog input enabled.
	RD	1	-	TTL	PSP read enable input (PSP enabled).
	AN5	1	I ANA A/D input channel 5; default input configuration		A/D input channel 5; default input configuration on POR.
RE1/WR/AN6	RE1	0	0	DIG	LATE<1> data output; not affected by analog input.
		1	I	ST	PORTE<1> data input; disabled when analog input enabled.
	WR	1	I	TTL	PSP write enable input (PSP enabled).
	AN6	1	I	ANA	A/D input channel 6; default input configuration on POR.
RE2/CS/AN7	RE2	0	0	DIG	LATE<2> data output; not affected by analog input.
		1	I	ST	PORTE<2> data input; disabled when analog input enabled.
	CS	TTL PSP write enable input (PSP enabled).		PSP write enable input (PSP enabled).	
	AN7	1	I	ANA	A/D input channel 7; default input configuration on POR.

Legend: DIG = Digital level output; TTL = TTL input buffer; ST = Schmitt Trigger input buffer; ANA = Analog level input/output; x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

TABLE 9-12: SUMMARY OF REGISTERS ASSOCIATED WITH PORTE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
PORTE ⁽¹⁾	_	_		_	_	RE2	RE1	RE0	46
LATE ⁽¹⁾	-	-	_	_	_	PORTE Data Latch Register (Read and Write to Data Latch)			46
TRISE ⁽¹⁾	IBF	OBF	IBOV	PSPMODE	_	TRISE2	TRISE1	TRISE0	46
ADCON1	_	_	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0	44

Legend: — = unimplemented, read as '0'. Shaded cells are not used by PORTE.

Note 1: These registers are not available in 28-pin devices.

9.7 Parallel Slave Port

Note: The Parallel Slave Port is only available in 40/44-pin devices.

In addition to its function as a general I/O port, PORTD can also operate as an 8-bit wide Parallel Slave Port (PSP) or microprocessor port. PSP operation is controlled by the 4 upper bits of the TRISE register (Register 9-1). Setting control bit, PSPMODE (TRISE<4>), enables PSP operation as long as the Enhanced CCP module is not operating in dual output or quad output PWM mode. In Slave mode, the port is asynchronously readable and writable by the external world.

The PSP can directly interface to an 8-bit microprocessor data bus. The external microprocessor can read or write the PORTD latch as an 8-bit latch. Setting the control bit, PSPMODE, enables the PORTE I/O pins to become control inputs for the microprocessor port. When set, port pin RE0 is the RD input, RE1 is the WR input and RE2 is the CS (Chip Select) input. For this functionality, the corresponding data direction bits of the TRISE register (TRISE<2:0>) must be configured as inputs (set). The A/D port configuration bits, PFCG3:PFCG0 (ADCON1<3:0>), must also be set to a value in the range of '1010' through '1111'.

A write to the PSP occurs when both the \overline{CS} and \overline{WR} lines are first detected low and ends when either are detected high. The PSPIF and IBF flag bits are both set when the write ends.

A read from the PSP occurs when both the \overline{CS} and \overline{RD} lines are first detected low. The data in PORTD is read out and the OBF bit is clear. If the user writes new data to PORTD to set OBF, the data is immediately read out; however, the OBF bit is not set.

When either the $\overline{\text{CS}}$ or $\overline{\text{RD}}$ lines are detected high, the PORTD pins return to the input state and the PSPIF bit is set. User applications should wait for PSPIF to be set before servicing the PSP; when this happens, the IBF and OBF bits can be polled and the appropriate action taken.

The timing for the control signals in Write and Read modes is shown in Figure 9-4 and Figure 9-5, respectively.

FIGURE 9-3: PORTD AND PORTE
BLOCK DIAGRAM
(PARALLEL SLAVE PORT)

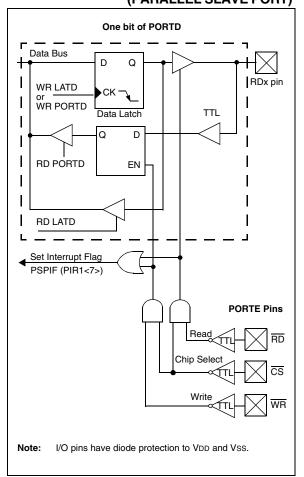


FIGURE 9-4: PARALLEL SLAVE PORT WRITE WAVEFORMS

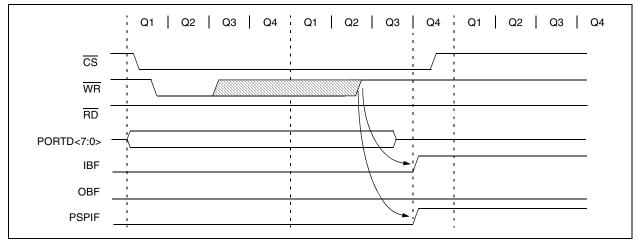


FIGURE 9-5: PARALLEL SLAVE PORT READ WAVEFORMS

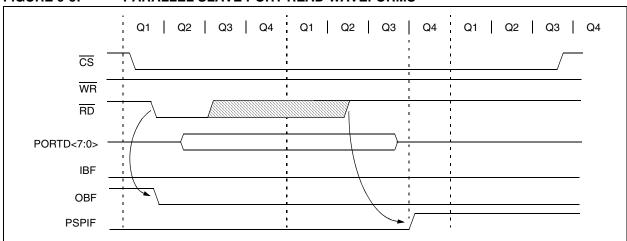


TABLE 9-13: REGISTERS ASSOCIATED WITH PARALLEL SLAVE PORT

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
PORTD ⁽¹⁾	RD7	RD6	RD5	RD4	RD3	RD2	RD1	RD0	46
LATD ⁽¹⁾	PORTD Da	ıta Latch Reg	jister (Read	and Write to	Data Latch))			
TRISD ⁽¹⁾	PORTD Da	ta Direction (Control Reg	jister					46
PORTE ⁽¹⁾	_	_	_	_	_	RE2	RE1	RE0	46
LATE ⁽¹⁾	_	_	_	_	_	PORTE Data Latch Register (Read and Write to Data Latch)			46
TRISE ⁽¹⁾	IBF	OBF	IBOV	PSPMODE	_	TRISE2	TRISE1	TRISE0	46
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	43
PIR1	PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	45
PIE1	PSPIE ⁽¹⁾	ADIE	RCIE	TXIE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	45
IPR1	PSPIP ⁽¹⁾	ADIP	RCIP	TXIP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	45
ADCON1	_	_	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0	44

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the Parallel Slave Port.

Note 1: These registers and/or bits are not implemented on 28-pin devices and should be read as '0'.

10.0 TIMERO MODULE

The Timer0 module incorporates the following features:

- Software selectable operation as a timer or counter in both 8-bit or 16-bit modes
- · Readable and writable registers
- Dedicated 8-bit, software programmable prescaler
- Selectable clock source (internal or external)
- · Edge select for external clock
- Interrupt-on-overflow

The T0CON register (Register 10-1) controls all aspects of the module's operation, including the prescale selection. It is both readable and writable.

A simplified block diagram of the Timer0 module in 8-bit mode is shown in Figure 10-1. Figure 10-2 shows a simplified block diagram of the Timer0 module in 16-bit mode.

REGISTER 10-1: TOCON: TIMERO CONTROL REGISTER

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
TMR00N	T08BIT	T0CS	T0SE	PSA	T0PS2	T0PS1	T0PS0
bit 7							bit 0

- bit 7 TMR0ON: Timer0 On/Off Control bit
 - 1 = Enables Timer0
 - 0 = Stops Timer0
- bit 6 T08BIT: Timer0 8-Bit/16-Bit Control bit
 - 1 = Timer0 is configured as an 8-bit timer/counter
 - 0 = Timer0 is configured as a 16-bit timer/counter
- bit 5 TOCS: Timer0 Clock Source Select bit
 - 1 = Transition on T0CKI pin
 - 0 = Internal instruction cycle clock (CLKO)
- bit 4 T0SE: Timer0 Source Edge Select bit
 - 1 = Increment on high-to-low transition on T0CKI pin
 - 0 = Increment on low-to-high transition on T0CKI pin
- bit 3 **PSA**: Timer0 Prescaler Assignment bit
 - 1 = Tlmer0 prescaler is not assigned. Timer0 clock input bypasses prescaler.
 - 0 = Timer0 prescaler is assigned. Timer0 clock input comes from prescaler output.
- bit 2-0 TOPS2:TOPS0: Timer0 Prescaler Select bits
 - 111 = 1:256 Prescale value
 - 110 = 1:128 Prescale value
 - 101 = 1:64 Prescale value
 - 100 = 1:32 Prescale value
 - 011 = 1:16 Prescale value
 - 010 = 1:8 Prescale value
 - 001 = 1:4 Prescale value
 - 000 = 1:2 Prescale value

Legend:

R = Readable bit W = Writable bit		U = Unimplemented	bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

10.1 Timer0 Operation

Timer0 can operate as either a timer or a counter; the mode is selected with the ToCS bit (ToCON<5>). In Timer mode (ToCS = 0), the module increments on every clock by default unless a different prescaler value is selected (see **Section 10.3 "Prescaler"**). If the TMR0 register is written to, the increment is inhibited for the following two instruction cycles. The user can work around this by writing an adjusted value to the TMR0 register.

The Counter mode is selected by setting the T0CS bit (= 1). In this mode, Timer0 increments either on every rising or falling edge of pin RB5/T0CKI. The incrementing edge is determined by the Timer0 Source Edge Select bit, T0SE (T0CON<4>); clearing this bit selects the rising edge. Restrictions on the external clock input are discussed below.

An external clock source can be used to drive Timer0; however, it must meet certain requirements to ensure that the external clock can be synchronized with the

internal phase clock (Tosc). There is a delay between synchronization and the onset of incrementing the timer/counter.

10.2 Timer0 Reads and Writes in 16-Bit Mode

TMR0H is not the actual high byte of Timer0 in 16-bit mode. It is actually a buffered version of the real high byte of Timer0 which is not directly readable nor writable (refer to Figure 10-2). TMR0H is updated with the contents of the high byte of Timer0 during a read of TMR0L. This provides the ability to read all 16 bits of Timer0 without having to verify that the read of the high and low byte were valid, due to a rollover between successive reads of the high and low byte.

Similarly, a write to the high byte of Timer0 must also take place through the TMR0H Buffer register. The high byte is updated with the contents of TMR0H when a write occurs to TMR0L. This allows all 16 bits of Timer0 to be updated at once.

FIGURE 10-1: TIMERO BLOCK DIAGRAM (8-BIT MODE)

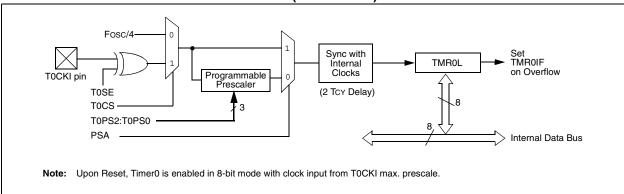
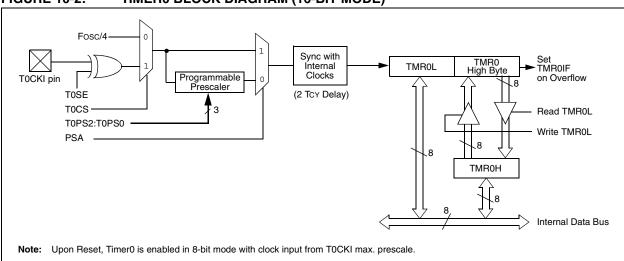


FIGURE 10-2: TIMERO BLOCK DIAGRAM (16-BIT MODE)



10.3 Prescaler

An 8-bit counter is available as a prescaler for the Timer0 module. The prescaler is not directly readable or writable. Its value is set by the PSA and T0PS2:T0PS0 bits (T0CON<3:0>) which determine the prescaler assignment and prescale ratio.

Clearing the PSA bit assigns the prescaler to the Timer0 module. When it is assigned, prescale values from 1:2 through 1:256 in power-of-2 increments are selectable.

When assigned to the Timer0 module, all instructions writing to the TMR0 register (e.g., CLRF TMR0, MOVWF TMR0, BSF TMR0, etc.) clear the prescaler count.

Note: Writing to TMR0 when the prescaler is assigned to Timer0 will clear the prescaler count but will not change the prescaler assignment.

10.3.1 SWITCHING PRESCALER ASSIGNMENT

The prescaler assignment is fully under software control and can be changed "on-the-fly" during program execution.

10.4 Timer0 Interrupt

The TMR0 interrupt is generated when the TMR0 register overflows from FFh to 00h in 8-bit mode, or from FFFFh to 0000h in 16-bit mode. This overflow sets the TMR0IF flag bit. The interrupt can be masked by clearing the TMR0IE bit (INTCON<5>). Before re-enabling the interrupt, the TMR0IF bit must be cleared in software by the Interrupt Service Routine.

Since Timer0 is shut down in Sleep mode, the TMR0 interrupt cannot awaken the processor from Sleep.

TABLE 10-1: REGISTERS ASSOCIATED WITH TIMERO

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page		
TMR0L	Timer0 Reg	ïmer0 Register Low Byte									
TMR0H	Timer0 Reg	ister High By	/te						44		
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	43		
T0CON	TMR0ON T08BIT T0CS T0SE PSA T0PS2 T0PS1 T0PS0							44			
TRISA	_	_	TRISA5	_	TRISA3	TRISA2	TRISA1	TRISA0	46		

Legend: — = unimplemented, read as '0'. Shaded cells are not used by Timer0.

NOTES:

11.0 TIMER1 MODULE

The Timer1 timer/counter module incorporates these features:

- Software selectable operation as a 16-bit timer or counter
- Readable and writable 8-bit registers (TMR1H and TMR1L)
- Selectable clock source (internal or external) with device clock or Timer1 oscillator internal options
- Interrupt-on-overflow
- · Reset on CCP Special Event Trigger
- Device clock status flag (T1RUN)

A simplified block diagram of the Timer1 module is shown in Figure 11-1. A block diagram of the module's operation in Read/Write mode is shown in Figure 11-2.

The module incorporates its own low-power oscillator to provide an additional clocking option. The Timer1 oscillator can also be used as a low-power clock source for the microcontroller in power-managed operation.

Timer1 can also be used to provide Real-Time Clock (RTC) functionality to applications with only a minimal addition of external components and code overhead.

Timer1 is controlled through the T1CON Control register (Register 11-1). It also contains the Timer1 Oscillator Enable bit (T1OSCEN). Timer1 can be enabled or disabled by setting or clearing control bit, TMR1ON (T1CON<0>).

REGISTER 11-1: T1CON: TIMER1 CONTROL REGISTER

R/W-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
RD16	T1RUN	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N
bit 7							bit 0

- bit 7 RD16: 16-Bit Read/Write Mode Enable bit
 - 1 = Enables register read/write of Tlmer1 in one 16-bit operation
 - 0 = Enables register read/write of Timer1 in two 8-bit operations
- bit 6 T1RUN: Timer1 System Clock Status bit
 - 1 = Device clock is derived from Timer1 oscillator
 - 0 = Device clock is derived from another source
- bit 5-4 T1CKPS1:T1CKPS0: Timer1 Input Clock Prescale Select bits
 - 11 = 1:8 Prescale value
 - 10 = 1:4 Prescale value
 - 01 = 1:2 Prescale value
 - 00 = 1:1 Prescale value
- bit 3 T10SCEN: Timer1 Oscillator Enable bit
 - 1 = Timer1 oscillator is enabled
 - 0 = Timer1 oscillator is shut off

The oscillator inverter and feedback resistor are turned off to eliminate power drain.

bit 2 T1SYNC: Timer1 External Clock Input Synchronization Select bit

When TMR1CS = 1:

- 1 = Do not synchronize external clock input
- 0 = Synchronize external clock input

When TMR1CS = $\underline{0}$:

This bit is ignored. Timer1 uses the internal clock when TMR1CS = 0.

- bit 1 TMR1CS: Timer1 Clock Source Select bit
 - 1 = External clock from pin RC0/T1OSO/T1CKI (on the rising edge)
 - 0 = Internal clock (Fosc/4)
- bit 0 TMR10N: Timer1 On bit
 - 1 = Enables Timer1
 - 0 = Stops Timer1

_		_	 _	١.
	a	ρ	а	

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

11.1 Timer1 Operation

Timer1 can operate in one of these modes:

- Timer
- · Synchronous Counter
- · Asynchronous Counter

The operating mode is determined by the clock select bit, TMR1CS (T1CON<1>). When TMR1CS is cleared (= 0), Timer1 increments on every internal instruction

cycle (Fosc/4). When the bit is set, Timer1 increments on every rising edge of the Timer1 external clock input or the Timer1 oscillator, if enabled.

When Timer1 is enabled, the RC1/T1OSI and RC0/T1OSO/T1CKI pins become inputs. This means the values of TRISC<1:0> are ignored and the pins are read as '0'.

FIGURE 11-1: TIMER1 BLOCK DIAGRAM

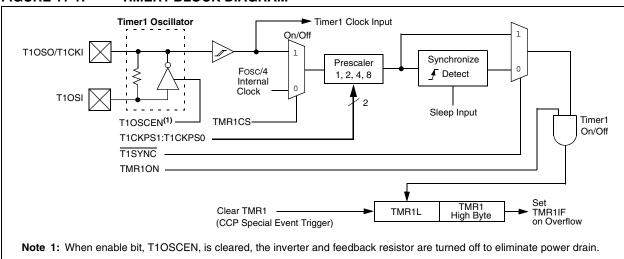
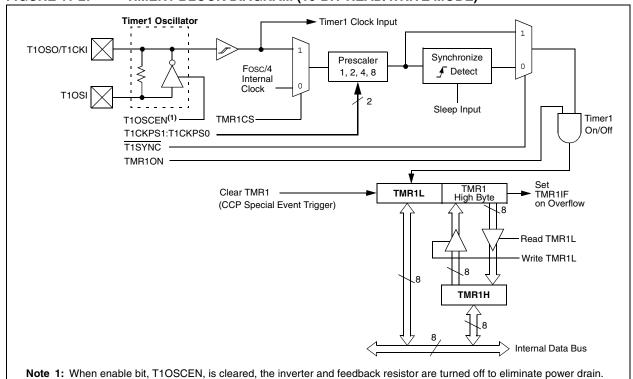


FIGURE 11-2: TIMER1 BLOCK DIAGRAM (16-BIT READ/WRITE MODE)



11.2 Timer1 16-Bit Read/Write Mode

Timer1 can be configured for 16-bit reads and writes (see Figure 11-2). When the RD16 control bit (T1CON<7>) is set, the address for TMR1H is mapped to a buffer register for the high byte of Timer1. A read from TMR1L will load the contents of the high byte of Timer1 into the Timer1 High Byte Buffer register. This provides the user with the ability to accurately read all 16 bits of Timer1 without having to determine whether a read of the high byte, followed by a read of the low byte, has become invalid due to a rollover between reads.

A write to the high byte of Timer1 must also take place through the TMR1H Buffer register. The Timer1 high byte is updated with the contents of TMR1H when a write occurs to TMR1L. This allows a user to write all 16 bits to both the high and low bytes of Timer1 at once.

The high byte of Timer1 is not directly readable or writable in this mode. All reads and writes must take place through the Timer1 High Byte Buffer register. Writes to TMR1H do not clear the Timer1 prescaler. The prescaler is only cleared on writes to TMR1L.

11.3 Timer1 Oscillator

An on-chip crystal oscillator circuit is incorporated between pins T1OSI (input) and T1OSO (amplifier output). It is enabled by setting the Timer1 Oscillator Enable bit, T1OSCEN (T1CON<3>). The oscillator is a low-power circuit rated for 32 kHz crystals. It will continue to run during all power-managed modes. The circuit for a typical oscillator is shown in Figure 11-3. Table 11-1 shows the capacitor selection for the Timer1 oscillator.

The user must provide a software time delay to ensure proper start-up of the Timer1 oscillator.

FIGURE 11-3: EXTERNAL COMPONENTS FOR THE TIMER1 OSCILLATOR

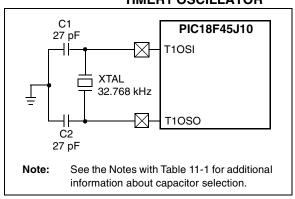


TABLE 11-1: CAPACITOR SELECTION FOR THETIMEROSCILLATOR^(2,3,4)

Oscillator Type	Freq.	C1	C2
LP	32 kHz	27 pF ⁽¹⁾	27 pF ⁽¹⁾

- **Note 1:** Microchip suggests these values as a starting point in validating the oscillator circuit.
 - 2: Higher capacitance increases the stability of the oscillator but also increases the start-up time.
 - 3: Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components.
 - **4:** Capacitor values are for design guidance only.

11.3.1 USING TIMER1 AS A CLOCK SOURCE

The Timer1 oscillator is also available as a clock source in power-managed modes. By setting the clock select bits, SCS1:SCS0 (OSCCON<1:0>), to '01', the device switches to SEC_RUN mode; both the CPU and peripherals are clocked from the Timer1 oscillator. If the IDLEN bit (OSCCON<7>) is cleared and a SLEEP instruction is executed, the device enters SEC_IDLE mode. Additional details are available in **Section 3.0** "Power-Managed Modes".

Whenever the Timer1 oscillator is providing the clock source, the Timer1 system clock status flag, T1RUN (T1CON<6>), is set. This can be used to determine the controller's current clocking mode. It can also indicate the clock source being currently used by the Fail-Safe Clock Monitor. If the Clock Monitor is enabled and the Timer1 oscillator fails while providing the clock, polling the T1RUN bit will indicate whether the clock is being provided by the Timer1 oscillator or another source.

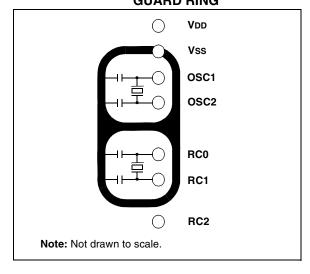
11.3.2 TIMER1 OSCILLATOR LAYOUT CONSIDERATIONS

The Timer1 oscillator circuit draws very little power during operation. Due to the low-power nature of the oscillator, it may also be sensitive to rapidly changing signals in close proximity.

The oscillator circuit, shown in Figure 11-3, should be located as close as possible to the microcontroller. There should be no circuits passing within the oscillator circuit boundaries other than Vss or VDD.

If a high-speed circuit must be located near the oscillator (such as the CCP1 pin in Output Compare or PWM mode, or the primary oscillator using the OSC2 pin), a grounded guard ring around the oscillator circuit, as shown in Figure 11-4, may be helpful when used on a single-sided PCB or in addition to a ground plane.

FIGURE 11-4: OSCILLATOR CIRCUIT WITH GROUNDED GUARD RING



11.4 Timer1 Interrupt

The TMR1 register pair (TMR1H:TMR1L) increments from 0000h to FFFFh and rolls over to 0000h. The Timer1 interrupt, if enabled, is generated on overflow which is latched in interrupt flag bit, TMR1IF (PIR1<0>). This interrupt can be enabled or disabled by setting or clearing the Timer1 Interrupt Enable bit, TMR1IE (PIE1<0>).

11.5 Resetting Timer1 Using the ECCP/CCP Special Event Trigger

If ECCP1/CCP1 or CCP2 are configured to generate a Special Event Trigger in Compare mode (CCPxM3:CCPxM0 = 1011), this signal will reset Timer1. The trigger from CCP2 will also start an A/D conversion if the A/D module is enabled (see Section 14.2.1 "Special Event Trigger" for more information).

The module must be configured as either a timer or a synchronous counter to take advantage of this feature. When used this way, the CCPRH:CCPRL register pair effectively becomes a period register for Timer1.

If Timer1 is running in Asynchronous Counter mode, this Reset operation may not work.

In the event that a write to Timer1 coincides with a Special Event Trigger, the write operation will take precedence.

Note: The Special Event Triggers from the ECCP1/CCPx module will not set the TMR1IF interrupt flag bit (PIR1<0>).

11.6 Using Timer1 as a Real-Time Clock

Adding an external LP oscillator to Timer1 (such as the one described in **Section 11.3** "Timer1 Oscillator" above) gives users the option to include RTC functionality to their applications. This is accomplished with an inexpensive watch crystal to provide an accurate time base and several lines of application code to calculate the time. When operating in Sleep mode and using a battery or supercapacitor as a power source, it can completely eliminate the need for a separate RTC device and battery backup.

The application code routine, RTCisr, shown in Example 11-1, demonstrates a simple method to increment a counter at one-second intervals using an Interrupt Service Routine. Incrementing the TMR1 register pair to overflow triggers the interrupt and calls the routine which increments the seconds counter by one. Additional counters for minutes and hours are incremented as the previous counter overflows.

Since the register pair is 16 bits wide, counting up to overflow the register directly from a 32.768 kHz clock would take 2 seconds. To force the overflow at the required one-second intervals, it is necessary to preload it. The simplest method is to set the MSb of TMR1H with a BSF instruction. Note that the TMR1L register is never preloaded or altered; doing so may introduce cumulative error over many cycles.

For this method to be accurate, Timer1 must operate in Asynchronous mode and the Timer1 overflow interrupt must be enabled (PIE1<0> = 1) as shown in the routine, RTCinit. The Timer1 oscillator must also be enabled and running at all times.

EXAMPLE 11-1: IMPLEMENTING A REAL-TIME CLOCK USING A TIMER1 INTERRUPT SERVICE

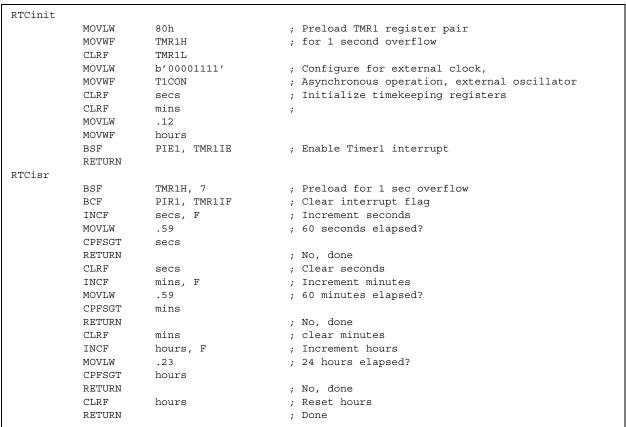


TABLE 11-2: REGISTERS ASSOCIATED WITH TIMER1 AS A TIMER/COUNTER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	43
PIR1	PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	45
PIE1	PSPIE ⁽¹⁾	ADIE	RCIE	TXIE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	45
IPR1	PSPIP ⁽¹⁾	ADIP	RCIP	RCIP TXIP SSP1IP CCP1IP				TMR1IP	45
TMR1L	Timer1 Reg	gister Low By	/te						44
TMR1H	Timer1 Reg	Fimer1 Register High Byte							
T1CON	RD16	T1RUN	T1CKPS1	T1CKPS0	T10SCEN	T1SYNC	TMR1CS	TMR10N	44

Legend: Shaded cells are not used by the Timer1 module.

Note 1: These bits are not implemented on 28-pin devices and should be read as '0'.

NOTES:

12.0 TIMER2 MODULE

The Timer2 timer module incorporates the following features:

- 8-bit timer and period registers (TMR2 and PR2, respectively)
- · Readable and writable (both registers)
- Software programmable prescaler (1:1, 1:4 and 1:16)
- Software programmable postscaler (1:1 through 1:16)
- Interrupt on TMR2-to-PR2 match
- Optional use as the shift clock for the MSSP module

The module is controlled through the T2CON register (Register 12-1) which enables or disables the timer and configures the prescaler and postscaler. Timer2 can be shut off by clearing control bit, TMR2ON (T2CON<2>), to minimize power consumption.

A simplified block diagram of the module is shown in Figure 12-1.

12.1 Timer2 Operation

In normal operation, TMR2 is incremented from 00h on each clock (Fosc/4). A 4-bit counter/prescaler on the clock input gives direct input, divide-by-4 and divide-by-16 prescale options; these are selected by the prescaler control bits, T2CKPS1:T2CKPS0 (T2CON<1:0>). The value of TMR2 is compared to that of the period register, PR2, on each clock cycle. When the two values match, the comparator generates a match signal as the timer output. This signal also resets the value of TMR2 to 00h on the next cycle and drives the output counter/postscaler (see Section 12.2 "Timer2 Interrupt").

The TMR2 and PR2 registers are both directly readable and writable. The TMR2 register is cleared on any device Reset, while the PR2 register initializes at FFh. Both the prescaler and postscaler counters are cleared on the following events:

- a write to the TMR2 register
- · a write to the T2CON register
- any device Reset (Power-on Reset, MCLR Reset, Watchdog Timer Reset or Brown-out Reset)

TMR2 is not cleared when T2CON is written.

REGISTER 12-1: T2CON: TIMER2 CONTROL REGISTER

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	T2OUTPS3	T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0
bit 7							bit 0

bit 7 Unimplemented: Read as '0'

bit 6-3 T20UTPS3:T20UTPS0: Timer2 Output Postscale Select bits

0000 = 1:1 Postscale 0001 = 1:2 Postscale

•

1111 = 1:16 Postscale

bit 2 TMR2ON: Timer2 On bit

1 = Timer2 is on 0 = Timer2 is off

bit 1-0 T2CKPS1:T2CKPS0: Timer2 Clock Prescale Select bits

00 =Prescaler is 1 01 =Prescaler is 4 1x =Prescaler is 16

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

12.2 Timer2 Interrupt

Timer2 can also generate an optional device interrupt. The Timer2 output signal (TMR2-to-PR2 match) provides the input for the 4-bit output counter/postscaler. This counter generates the TMR2 match interrupt flag which is latched in TMR2IF (PIR1<1>). The interrupt is enabled by setting the TMR2 Match Interrupt Enable bit, TMR2IE (PIE1<1>).

A range of 16 postscale options (from 1:1 through 1:16 inclusive) can be selected with the postscaler control bits, T2OUTPS3:T2OUTPS0 (T2CON<6:3>).

12.3 Timer2 Output

The unscaled output of TMR2 is available primarily to the CCP modules, where it is used as a time base for operations in PWM mode.

Timer2 can be optionally used as the shift clock source for the MSSP module operating in SPI mode. Additional information is provided in Section 15.0 "Master Synchronous Serial Port (MSSP) Module".

FIGURE 12-1: TIMER2 BLOCK DIAGRAM

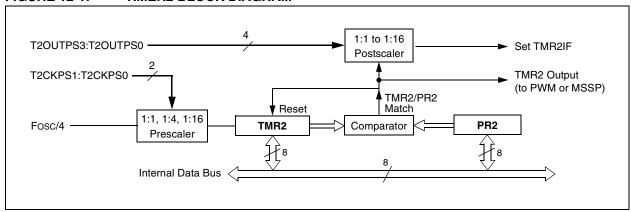


TABLE 12-1: REGISTERS ASSOCIATED WITH TIMER2 AS A TIMER/COUNTER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	43
PIR1	PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	45
PIE1	PSPIE ⁽¹⁾	ADIE	RCIE	TXIE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	45
IPR1	PSPIP ⁽¹⁾	ADIP	RCIP	TXIP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	45
TMR2	Timer2 Register								
T2CON	- T2OUTPS3 T2OUTPS2 T2OUTPS1 T2OUTPS0 TMR2ON T2CKPS1 T2CKPS0						44		
PR2	Timer2 Per	iod Register							44

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the Timer2 module.

Note 1: These bits are not implemented on 28-pin devices and should be read as '0'.

13.0 CAPTURE/COMPARE/PWM (CCP) MODULES

PIC18F45J10 family devices all have two CCP (Capture/Compare/PWM) modules. Each module contains a 16-bit register which can operate as a 16-bit Capture register, a 16-bit Compare register or a PWM Master/Slave Duty Cycle register.

In 28-pin devices, the two standard CCP modules (CCP1 and CCP2) operate as described in this chapter. In 40/44-pin devices, CCP1 is implemented as an Enhanced CCP module (ECCP1) with standard Capture and Compare modes and Enhanced PWM modes. The Enhanced CCP implementation is discussed in Section 14.0 "Enhanced Capture/Compare/PWM (ECCP) Module".

The Capture and Compare operations described in this chapter apply to all standard and Enhanced CCP modules.

Note: Throughout this section and Section 14.0 "Enhanced Capture/Compare/PWM (ECCP) Module", references to the register and bit names for CCP modules are referred to generically by the use of 'x' or 'y' in place of the specific module number. Thus, "CCPxCON" might refer to the control register for CCP1, CCP2 or ECCP1. "CCPxCON" is used throughout these sections to refer to the module control register regardless of whether the CCP module is a standard or Enhanced implementation.

REGISTER 13-1: CCPxCON REGISTER (CCP1, CCP2 MODULES IN 28-PIN DEVICES)

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	DCxB1	DCxB0	CCPxM3	CCPxM2	CCPxM1	CCPxM0
bit 7							bit 0

bit 7-6 Unimplemented: Read as '0'

bit 5-4 DCxB1:DCxB0: PWM Duty Cycle bit 1 and bit 0

Capture mode:

Unused.

Compare mode:

Unused.

PWM mode:

These bits are the two LSbs (bit 1 and bit 0) of the 10-bit PWM duty cycle. The eight MSbs (DCx9:DCx2) of the duty cycle are found in CCPRxL.

bit 3-0 CCPxM3:CCPxM0: CCPx Mode Select bits

0000 = Capture/Compare/PWM disabled (resets CCPx module)

0001 = Reserved

0010 = Compare mode, toggle output on match (CCPxIF bit is set)

0011 = Reserved

0100 = Capture mode, every falling edge

0101 = Capture mode, every rising edge

0110 = Capture mode, every 4th rising edge

0111 = Capture mode, every 16th rising edge

1000 = Compare mode: initialize CCPx pin low; on compare match, force CCPx pin high (CCPxIF bit is set)

1001 = Compare mode: initialize CCPx pin high; on compare match, force CCPx pin low (CCPxIF bit is set)

1010 = Compare mode: generate software interrupt on compare match (CCPxIF bit is set, CCPx pin reflects I/O state)

1011 = Compare mode: trigger special event, reset timer, start A/D conversion on CCPx match (CCPxIF bit is set)

11xx = PWM mode

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

13.1 CCP Module Configuration

Each Capture/Compare/PWM module is associated with a control register (generically, CCPxCON) and a data register (CCPRx). The data register, in turn, is comprised of two 8-bit registers: CCPRxL (low byte) and CCPRxH (high byte). All registers are both readable and writable.

13.1.1 CCP MODULES AND TIMER RESOURCES

The CCP modules utilize Timers 1 or 2, depending on the mode selected. Timer1 is available to modules in Capture or Compare modes, while Timer2 is available for modules in PWM mode.

TABLE 13-1: ECCP/CCP MODE – TIMER RESOURCE

ECCP/CCP Mode	Timer Resource		
Capture	Timer1		
Compare	Timer1		
PWM	Timer2		

Both modules may be active at any given time and may share the same timer resource if they are configured to operate in the same mode (Capture/Compare or PWM) at the same time. The interactions between the two modules are summarized in Figure 13-1 and Figure 13-2. In Timer1 in Asynchronous Counter mode, the capture operation will not work.

13.1.2 CCP2 PIN ASSIGNMENT

The pin assignment for CCP2 (Capture input, Compare and PWM output) can change, based on device configuration. The CCP2MX configuration bit determines which pin CCP2 is multiplexed to. By default, it is assigned to RC1 (CCP2MX = 1). If the configuration bit is cleared, CCP2 is multiplexed with RB3.

Changing the pin assignment of CCP2 does not automatically change any requirements for configuring the port pin. Users must always verify that the appropriate TRIS register is configured correctly for CCP2 operation regardless of where it is located.

TABLE 13-2: INTERACTIONS BETWEEN ECCP1/CCP1 AND CCP2 FOR TIMER RESOURCES

CCP1 Mode	CCP2 Mode	Interaction		
Capture	Capture	Each module uses TMR1 as the time base.		
Capture	Capture Compare CCP2 can be configured for the Special Event Trigger to reset TMR1. Automat conversions on the trigger event can also be done. Operation of ECCP1/CCP1 affected.			
Compare	Capture	ECCP1/CCP1 can be configured for the Special Event Trigger to reset TMR1. Operation of CCP2 will be affected.		
Compare	Compare	Either module can be configured for the Special Event Trigger to reset TMR1. Automatic A/D conversions on the CCP2 trigger event can be done.		
Capture	PWM ⁽¹⁾	None		
Compare	PWM ⁽¹⁾	None		
PWM ⁽¹⁾	Capture	None		
PWM ⁽¹⁾	Compare	None		
PWM ⁽¹⁾	PWM	Both PWMs will have the same frequency and update rate (TMR2 interrupt).		

Note 1: Includes standard and Enhanced PWM operation.

13.2 Capture Mode

In Capture mode, the CCPRxH:CCPRxL register pair captures the 16-bit value of the TMR1 register when an event occurs on the corresponding CCPx pin. An event is defined as one of the following:

- · every falling edge
- · every rising edge
- · every 4th rising edge
- · every 16th rising edge

The event is selected by the mode select bits, CCPxM3:CCPxM0 (CCPxCON<3:0>). When a capture is made, the interrupt request flag bit, CCPxIF, is set; it must be cleared in software. If another capture occurs before the value in register CCPRx is read, the old captured value is overwritten by the new captured value.

13.2.1 CCP PIN CONFIGURATION

In Capture mode, the appropriate CCPx pin should be configured as an input by setting the corresponding TRIS direction bit.

Note: If RB3/CCP2 or RC1/CCP2 is configured as an output, a write to the port can cause a capture condition.

13.2.2 SOFTWARE INTERRUPT

When the Capture mode is changed, a false capture interrupt may be generated. The user should keep the CCPxIE interrupt enable bit clear to avoid false interrupts. The interrupt flag bit, CCPxIF, should also be cleared following any such change in operating mode.

13.2.3 CCP PRESCALER

There are four prescaler settings in Capture mode; they are specified as part of the operating mode selected by the mode select bits (CCPxM3:CCPxM0). Whenever the CCP module is turned off or Capture mode is disabled, the prescaler counter is cleared. This means that any Reset will clear the prescaler counter.

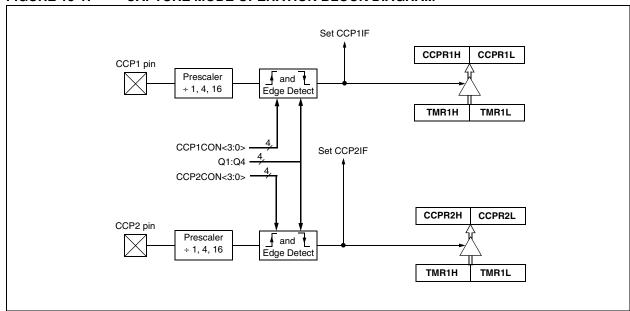
Switching from one capture prescaler to another may generate an interrupt. Also, the prescaler counter will not be cleared; therefore, the first capture may be from a non-zero prescaler. Example 13-1 shows the recommended method for switching between capture prescalers. This example also clears the prescaler counter and will not generate the "false" interrupt.

EXAMPLE 13-1: CHANGING BETWEEN CAPTURE PRESCALERS (CCP2 SHOWN)

```
CLRF CCP2CON ; Turn CCP module off

MOVLW NEW_CAPT_PS ; Load WREG with the
; new prescaler mode
; value and CCP ON
; Load CCP2CON with
; this value
```





13.3 Compare Mode

In Compare mode, the 16-bit CCPRx register value is constantly compared against the TMR1 register value. When a match occurs, the CCPx pin can be:

- · driven high
- · driven low
- toggled (high-to-low or low-to-high)
- remain unchanged (that is, reflects the state of the I/O latch)

The action on the pin is based on the value of the mode select bits (CCPxM3:CCPxM0). At the same time, the interrupt flag bit, CCPxIF, is set.

13.3.1 CCP PIN CONFIGURATION

The user must configure the CCPx pin as an output by clearing the appropriate TRIS bit.

Note:

Clearing the CCP2CON register will force the RB3 or RC1 compare output latch (depending on device configuration) to the default low level. This is not the PORTB or PORTC I/O data latch.

13.3.2 TIMER1 MODE SELECTION

Timer1 must be running in Timer mode or Synchronized Counter mode if the CCP module is using the compare feature. In Asynchronous Counter mode, the compare operation may not work.

13.3.3 SOFTWARE INTERRUPT MODE

When the Generate Software Interrupt mode is chosen (CCPxM3:CCPxM0 = 1010), the corresponding CCPx pin is not affected. Only a CCP interrupt is generated, if enabled and the CCPxIE bit is set.

13.3.4 SPECIAL EVENT TRIGGER

Both CCP modules are equipped with a Special Event Trigger. This is an internal hardware signal generated in Compare mode to trigger actions by other modules. The Special Event Trigger is enabled by selecting the Compare Special Event Trigger mode (CCPxM3:CCPxM0 = 1011).

For either CCP module, the Special Event Trigger resets the Timer register pair for whichever timer resource is currently assigned as the module's time base. This allows the CCPRx registers to serve as a programmable period register for either timer.

The Special Event Trigger for CCP2 can also start an A/D conversion. In order to do this, the A/D converter must already be enabled.

FIGURE 13-2: COMPARE MODE OPERATION BLOCK DIAGRAM

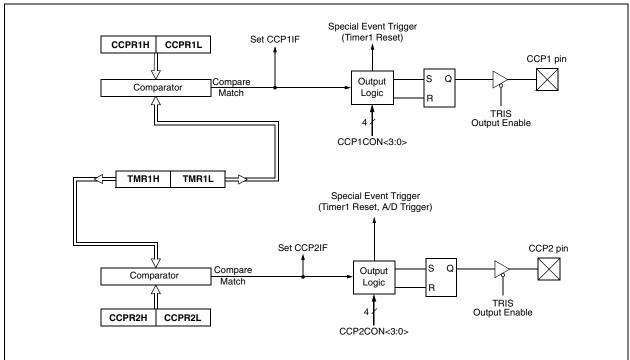


TABLE 13-3: REGISTERS ASSOCIATED WITH CAPTURE, COMPARE AND TIMER1

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	43
RCON	IPEN	_	_	RI	TO	PD	POR	BOR	42
PIR1	PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	45
PIE1	PSPIE ⁽¹⁾	ADIE	RCIE	TXIE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	45
IPR1	PSPIP ⁽¹⁾	ADIP	RCIP	TXIP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	45
PIR2	OSCFIF	CMIF	_	_	BCL1IF	_	_	CCP2IF	45
PIE2	OSCFIE	CMIE	_	_	BCL1IE	_	_	CCP2IE	45
IPR2	OSCFIP	CMIP	_	_	BCL1IP	_	_	CCP2IP	45
TRISB	PORTB Data Direction Control Register								
TRISC	PORTC Da	ıta Direction	Control Re	gister					46
TMR1L	Timer1 Req	gister Low B	yte						44
TMR1H	Timer1 Req	gister High E	Byte						44
T1CON	RD16	T1RUN	T1CKPS1	T1CKPS0	T10SCEN	T1SYNC	TMR1CS	TMR10N	44
CCPR1L	Capture/Co	mpare/PWI	M Register	1 Low Byte					45
CCPR1H	Capture/Co	mpare/PWI	M Register	1 High Byte					45
CCP1CON	P1M1 ⁽¹⁾	P1M1 ⁽¹⁾ P1M0 ⁽¹⁾ DC1B1 DC1B0 CCP1M3 CCP1M2 CCP1M1 CCP1M0							45
CCPR2L	Capture/Compare/PWM Register 2 Low Byte								45
CCPR2H	Capture/Co	mpare/PWI	M Register 2	2 High Byte		•	•		45
CCP2CON	_	_	DC2B1	DC2B0	CCP2M3	CCP2M2	CCP2M1	CCP2M0	45

Legend: — = unimplemented, read as '0'. Shaded cells are not used by Capture/Compare or Timer1.

Note 1: These bits are not implemented on 28-pin devices and should be read as '0'.

13.4 PWM Mode

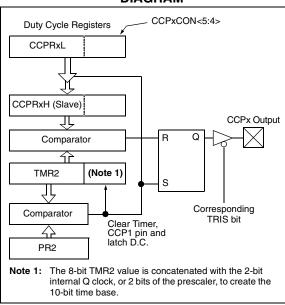
In Pulse-Width Modulation (PWM) mode, the CCPx pin produces up to a 10-bit resolution PWM output. Since the CCP2 pin is multiplexed with a PORTB or PORTC data latch, the appropriate TRIS bit must be cleared to make the CCP2 pin an output.

Note: Clearing the CCP2CON register will force the RB3 or RC1 output latch (depending on device configuration) to the default low level. This is not the PORTB or PORTC I/O data latch.

Figure 13-3 shows a simplified block diagram of the CCP module in PWM mode.

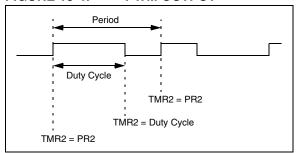
For a step-by-step procedure on how to set up the CCP module for PWM operation, see **Section 13.4.4** "Setup for PWM Operation".

FIGURE 13-3: SIMPLIFIED PWM BLOCK DIAGRAM



A PWM output (Figure 13-4) has a time base (period) and a time that the output stays high (duty cycle). The frequency of the PWM is the inverse of the period (1/period).

FIGURE 13-4: PWM OUTPUT



13.4.1 PWM PERIOD

The PWM period is specified by writing to the PR2 register. The PWM period can be calculated using the following formula:

EQUATION 13-1:

PWM Period = $[(PR2) + 1] \cdot 4 \cdot Tosc \cdot$ (TMR2 Prescale Value)

PWM frequency is defined as 1/[PWM period].

When TMR2 is equal to PR2, the following three events occur on the next increment cycle:

· TMR2 is cleared

Note:

- The CCPx pin is set (exception: if PWM duty cycle = 0%, the CCPx pin will not be set)
- The PWM duty cycle is latched from CCPRxL into CCPRxH

The Timer2 postscalers (see Section 12.0 "Timer2 Module") are not used in the determination of the PWM frequency. The postscaler could be used to have a servo update rate at a different frequency than the PWM output.

13.4.2 PWM DUTY CYCLE

The PWM duty cycle is specified by writing to the CCPRxL register and to the CCPxCON<5:4> bits. Up to 10-bit resolution is available. The CCPRxL contains the eight MSbs and the CCPxCON<5:4> contains the two LSbs. This 10-bit value is represented by CCPRxL:CCPxCON<5:4>. The following equation is used to calculate the PWM duty cycle in time:

EQUATION 13-2:

PWM Duty Cycle = (CCPRxL:CCPxCON<5:4>) • Tosc • (TMR2 Prescale Value)

CCPRxL and CCPxCON<5:4> can be written to at any time, but the duty cycle value is not latched into CCPRxH until after a match between PR2 and TMR2 occurs (i.e., the period is complete). In PWM mode, CCPRxH is a read-only register.

The CCPRxH register and a 2-bit internal latch are used to double-buffer the PWM duty cycle. This double-buffering is essential for glitchless PWM operation.

When the CCPRxH and 2-bit latch match TMR2, concatenated with an internal 2-bit Q clock or 2 bits of the TMR2 prescaler, the CCPx pin is cleared.

The maximum PWM resolution (bits) for a given PWM frequency is given by the equation:

EQUATION 13-3:

PWM Resolution (max) =
$$\frac{\log(\frac{FOSC}{FPWM})}{\log(2)}$$
 bits

Note: If the PWM duty cycle value is longer than the PWM period, the CCP2 pin will not be cleared.

TABLE 13-4: EXAMPLE PWM FREQUENCIES AND RESOLUTIONS AT 40 MHz

PWM Frequency	2.44 kHz	9.77 kHz	39.06 kHz	156.25 kHz	312.50 kHz	416.67 kHz
Timer Prescaler (1, 4, 16)	16	4	1	1	1	1
PR2 Value	FFh	FFh	FFh	3Fh	1Fh	17h
Maximum Resolution (bits)	10	10	10	8	7	6.58

13.4.3 PWM AUTO-SHUTDOWN (CCP1 ONLY)

The PWM auto-shutdown features of the Enhanced CCP module are also available to CCP1 in 28-pin devices. The operation of this feature is discussed in detail in **Section 14.4.7** "Enhanced PWM Auto-Shutdown".

Auto-shutdown features are not available for CCP2.

13.4.4 SETUP FOR PWM OPERATION

The following steps should be taken when configuring the CCP module for PWM operation:

- Set the PWM period by writing to the PR2 register.
- Set the PWM duty cycle by writing to the CCPRxL register and CCPxCON<5:4> bits.
- Make the CCPx pin an output by clearing the appropriate TRIS bit.
- 4. Set the TMR2 prescale value, then enable Timer2 by writing to T2CON.
- 5. Configure the CCPx module for PWM operation.

TABLE 13-5: REGISTERS ASSOCIATED WITH PWM AND TIMER2

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page	
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	43	
RCON	IPEN	_	_	RI	TO	PD	POR	BOR	42	
PIR1	PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	45	
PIE1	PSPIE ⁽¹⁾	ADIE	RCIE	TXIE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	45	
IPR1	PSPIP ⁽¹⁾	ADIP	RCIP	TXIP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	45	
TRISB	PORTB Da	PORTB Data Direction Control Register								
TRISC	PORTC Data Direction Control Register								46	
TMR2	Timer2 Register								44	
PR2	Timer2 Per	iod Register							44	
T2CON	_	T2OUTPS3	T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0	44	
CCPR1L	Capture/Co	mpare/PWM	/ Register 1	Low Byte					45	
CCPR1H	Capture/Co	mpare/PWN	/ Register 1	High Byte					45	
CCP1CON	P1M1 ⁽¹⁾	P1M0 ⁽¹⁾	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0	45	
CCPR2L	Capture/Co	mpare/PWM	1 Register 2	Low Byte					45	
CCPR2H	Capture/Co	Capture/Compare/PWM Register 2 High Byte							45	
CCP2CON		_	DC2B1	DC2B0	CCP2M3	CCP2M2	CCP2M1	CCP2M0	45	
ECCP1AS	ECCPASE	ECCPAS2	ECCPAS1	ECCPAS0	PSSAC1	PSSAC0	PSSBD1 ⁽¹⁾	PSSBD0 ⁽¹⁾	45	
ECCP1DEL	PRSEN	PDC6 ⁽¹⁾	PDC5 ⁽¹⁾	PDC4 ⁽¹⁾	PDC3 ⁽¹⁾	PDC2 ⁽¹⁾	PDC1 ⁽¹⁾	PDC0 ⁽¹⁾	45	

Legend: — = unimplemented, read as '0'. Shaded cells are not used by PWM or Timer2.

Note 1: These bits are not implemented on 28-pin devices and should be read as '0'.

14.0 ENHANCED CAPTURE/ COMPARE/PWM (ECCP) MODULE

Note: The ECCP module is implemented only in 40/44-pin devices.

In PIC18F44J10/45J10 devices, ECCP1 is implemented as a standard CCP module with Enhanced PWM capabilities. These include the provisions for 2 or 4 output channels, user-selectable polarity, dead-band control and automatic shutdown

and restart. The Enhanced features are discussed in detail in **Section 14.4 "Enhanced PWM Mode"**. Capture, Compare and single output PWM functions of the ECCP module are the same as described for the standard CCP module.

The control register for the Enhanced CCP module is shown in Register 14-1. It differs from the CCP1CON register in PIC18F24J10/25J10 devices in that the two Most Significant bits are implemented to control PWM functionality.

REGISTER 14-1: CCP1CON REGISTER (ECCP1 MODULE, 40/44-PIN DEVICES)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
P1M1	P1M0	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0
bit 7							bit 0

bit 7-6 P1M1:P1M0: Enhanced PWM Output Configuration bits

If CCP1M3:CCP1M2 = 00, 01, 10:

xx = P1A assigned as Capture/Compare input/output; P1B, P1C, P1D assigned as port pins If CCP1M3:CCP1M2 = 11:

00 = Single output: P1A modulated; P1B, P1C, P1D assigned as port pins

01 = Full-bridge output forward: P1D modulated; P1A active; P1B, P1C inactive

10 = Half-bridge output: P1A, P1B modulated with dead-band control; P1C, P1D assigned as port pins

11 = Full-bridge output reverse: P1B modulated; P1C active; P1A, P1D inactive

bit 5-4 DC1B1:DC1B0: PWM Duty Cycle bit 1 and bit 0

Capture mode:

Unused.

Compare mode:

Unused.

PWM mode:

These bits are the two LSbs of the 10-bit PWM duty cycle. The eight MSbs of the duty cycle are found in CCPR1L.

bit 3-0 CCP1M3:CCP1M0: Enhanced CCP Mode Select bits

0000 = Capture/Compare/PWM off (resets ECCP module)

0001 = Reserved

0010 = Compare mode, toggle output on match

0011 = Capture mode

0100 = Capture mode, every falling edge

0101 = Capture mode, every rising edge

0110 = Capture mode, every 4th rising edge

0111 = Capture mode, every 16th rising edge

1000 = Compare mode, initialize CCP1 pin low, set output on compare match (set CCP1IF)

1001 = Compare mode, initialize CCP1 pin high, clear output on compare match (set CCP1IF)

1010 = Compare mode, generate software interrupt only, CCP1 pin reverts to I/O state

1011 = Compare mode, trigger special event (ECCP resets TMR1, sets CCP1IF bit)

1100 = PWM mode; P1A, P1C active-high; P1B, P1D active-high

1101 = PWM mode; P1A, P1C active-high; P1B, P1D active-low

1110 = PWM mode: P1A. P1C active-low: P1B. P1D active-high

1111 = PWM mode; P1A, P1C active-low; P1B, P1D active-low

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

In addition to the expanded range of modes available through the CCP1CON register and ECCP1AS register, the ECCP module has an additional register associated with Enhanced PWM operation and auto-shutdown features. It is:

• ECCP1DEL (Dead-Band Delay)

14.1 ECCP Outputs and Configuration

The Enhanced CCP module may have up to four PWM outputs, depending on the selected operating mode. These outputs, designated P1A through P1D, are multiplexed with I/O pins on PORTC and PORTD. The outputs that are active depend on the ECCP operating mode selected. The pin assignments are summarized in Table 14-1.

To configure the I/O pins as PWM outputs, the proper PWM mode must be selected by setting the P1M1:P1M0 and CCP1M3:CCP1M0 bits. The appropriate TRISC and TRISD direction bits for the port pins must also be set as outputs.

14.1.1 ECCP MODULES AND TIMER RESOURCES

Like the standard CCP modules, the ECCP module can utilize Timers 1 or 2, depending on the mode selected. Timer1 is available for modules in Capture or Compare modes, while Timer2 is available for modules in PWM mode. Interactions between the standard and Enhanced CCP modules are identical to those described for standard CCP modules. Additional details on timer resources are provided in Section 13.1.1 "CCP Modules and Timer Resources".

14.2 Capture and Compare Modes

Except for the operation of the Special Event Trigger discussed below, the Capture and Compare modes of the ECCP module are identical in operation to that of CCP2. These are discussed in detail in **Section 13.2** "Capture Mode" and Section 13.3 "Compare Mode". No changes are required when moving between 28-pin and 40/44-pin devices.

14.2.1 SPECIAL EVENT TRIGGER

The Special Event Trigger output of ECCP1 resets the TMR1 register pair. This allows the CCPR1 register to effectively be a 16-bit programmable period register for Timer1.

14.3 Standard PWM Mode

When configured in Single Output mode, the ECCP module functions identically to the standard CCP module in PWM mode, as described in **Section 13.4** "**PWM Mode**". This is also sometimes referred to as "Compatible CCP" mode, as in Table 14-1.

Note: When setting up single output PWM operations, users are free to use either of the processes described in Section 13.4.4 "Setup for PWM Operation" or Section 14.4.9 "Setup for PWM Operation". The latter is more generic and will work for either single or multi-output PWM.

TABLE 14-1: PIN ASSIGNMENTS FOR VARIOUS ECCP1 MODES

ECCP Mode	CCP1CON Configuration	RC2	RD5	RD6	RD7				
All 40/44-pin Devices:									
Compatible CCP	00xx 11xx	CCP1	RD5/PSP5	RD6/PSP6	RD7/PSP7				
Dual PWM	10xx 11xx	P1A	P1B	RD6/PSP6	RD7/PSP7				
Quad PWM	x1xx 11xx	P1A	P1B	P1C	P1D				

Legend: x = Don't care. Shaded cells indicate pin assignments not used by ECCP1 in a given mode.

14.4 Enhanced PWM Mode

The Enhanced PWM mode provides additional PWM output options for a broader range of control applications. The module is a backward compatible version of the standard CCP module and offers up to four outputs, designated P1A through P1D. Users are also able to select the polarity of the signal (either active-high or active-low). The module's output mode and polarity are configured by setting the P1M1:P1M0 and CCP1M3:CCP1M0 bits of the CCP1CON register.

Figure 14-1 shows a simplified block diagram of PWM operation. All control registers are double-buffered and are loaded at the beginning of a new PWM cycle (the period boundary when Timer2 resets) in order to prevent glitches on any of the outputs. The exception is the PWM Delay register, ECCP1DEL, which is loaded at either the duty cycle boundary or the period boundary (whichever comes first). Because of the buffering, the module waits until the assigned timer resets instead of starting immediately. This means that Enhanced PWM waveforms do not exactly match the standard PWM waveforms, but are instead offset by one full instruction cycle (4 Tosc).

As before, the user must manually configure the appropriate TRIS bits for output.

14.4.1 PWM PERIOD

The PWM period is specified by writing to the PR2 register. The PWM period can be calculated using the following equation.

EQUATION 14-1:

PWM Period =
$$[(PR2) + 1] \cdot 4 \cdot TOSC \cdot$$

(TMR2 Prescale Value)

PWM frequency is defined as 1/[PWM period]. When TMR2 is equal to PR2, the following three events occur on the next increment cycle:

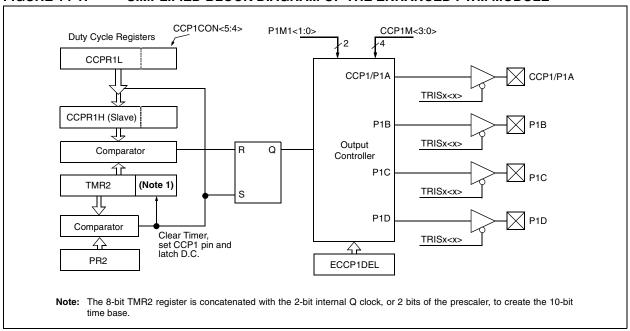
· TMR2 is cleared

Note:

- The CCP1 pin is set (if PWM duty cycle = 0%, the CCP1 pin will not be set)
- The PWM duty cycle is copied from CCPR1L into CCPR1H

The Timer2 postscaler (see Section 12.0 "Timer2 Module") is not used in the determination of the PWM frequency. The postscaler could be used to have a servo update rate at a different frequency than the PWM output.

FIGURE 14-1: SIMPLIFIED BLOCK DIAGRAM OF THE ENHANCED PWM MODULE



14.4.2 PWM DUTY CYCLE

The PWM duty cycle is specified by writing to the CCPR1L register and to the CCP1CON<5:4> bits. Up to 10-bit resolution is available. The CCPR1L register contains the eight MSbs and the CCP1CON<5:4> contains the two LSbs. This 10-bit value is represented by CCPR1L:CCP1CON<5:4>. The PWM duty cycle is calculated by the following equation:

EQUATION 14-2:

CCPR1L and CCP1CON<5:4> can be written to at any time, but the duty cycle value is not copied into CCPR1H until a match between PR2 and TMR2 occurs (i.e., the period is complete). In PWM mode, CCPR1H is a read-only register.

The CCPR1H register and a 2-bit internal latch are used to double-buffer the PWM duty cycle. This double-buffering is essential for glitchless PWM operation. When the CCPR1H and 2-bit latch match TMR2, concatenated with an internal 2-bit Q clock or two bits of the TMR2 prescaler, the CCP1 pin is cleared. The maximum PWM resolution (bits) for a given PWM frequency is given by the following equation:

EQUATION 14-3:

PWM Resolution (max) =
$$\frac{\log\left(\frac{FOSC}{FPWM}\right)}{\log(2)}$$
 bits

Note: If the PWM duty cycle value is longer than the PWM period, the CCP1 pin will not be cleared.

14.4.3 PWM OUTPUT CONFIGURATIONS

The P1M1:P1M0 bits in the CCP1CON register allow one of four configurations:

- Single Output
- · Half-Bridge Output
- Full-Bridge Output, Forward mode
- Full-Bridge Output, Reverse mode

The Single Output mode is the standard PWM mode discussed in **Section 14.4 "Enhanced PWM Mode"**. The Half-Bridge and Full-Bridge Output modes are covered in detail in the sections that follow.

The general relationship of the outputs in all configurations is summarized in Figure 14-2.

TABLE 14-2: EXAMPLE PWM FREQUENCIES AND RESOLUTIONS AT 40 MHz

PWM Frequency	2.44 kHz	9.77 kHz	39.06 kHz	156.25 kHz	312.50 kHz	416.67 kHz
Timer Prescaler (1, 4, 16)	16	4	1	1	1	1
PR2 Value	FFh	FFh	FFh	3Fh	1Fh	17h
Maximum Resolution (bits)	10	10	10	8	7	6.58

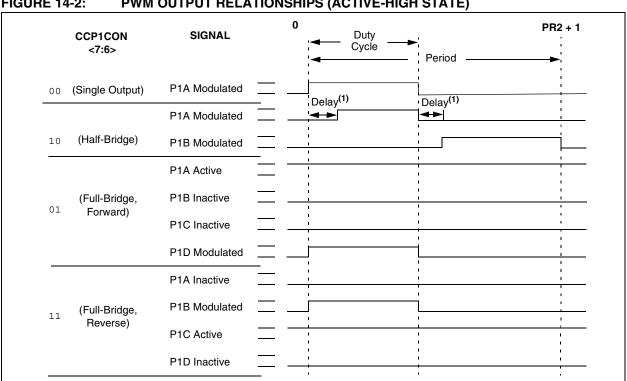
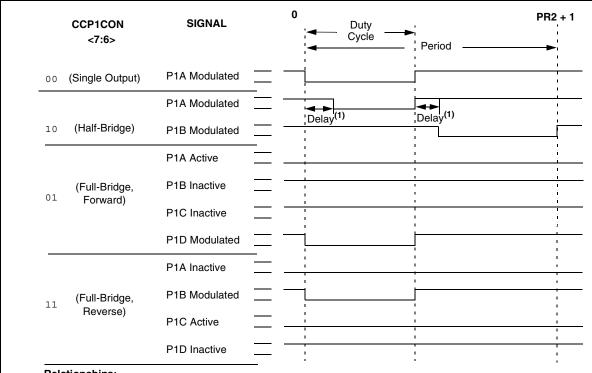


FIGURE 14-2: PWM OUTPUT RELATIONSHIPS (ACTIVE-HIGH STATE)

FIGURE 14-3: PWM OUTPUT RELATIONSHIPS (ACTIVE-LOW STATE)



Relationships:

- Period = 4 * Tosc * (PR2 + 1) * (TMR2 Prescale Value)
- Duty Cycle = Tosc * (CCPR1L<7:0>:CCP1CON<5:4>) * (TMR2 Prescale Value)
- Delay = 4 * Tosc * (ECCP1DEL<6:0>)

Note 1: Dead-band delay is programmed using the ECCP1DEL register (see Section 14.4.6 "Programmable Dead-Band Delay").

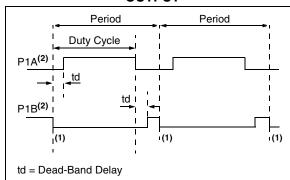
14.4.4 HALF-BRIDGE MODE

In the Half-Bridge Output mode, two pins are used as outputs to drive push-pull loads. The PWM output signal is output on the P1A pin, while the complementary PWM output signal is output on the P1B pin (Figure 14-4). This mode can be used for half-bridge applications, as shown in Figure 14-5, or for full-bridge applications where four power switches are being modulated with two PWM signals.

In Half-Bridge Output mode, the programmable deadband delay can be used to prevent shoot-through current in half-bridge power devices. The value of bits, PDC6:PDC0, sets the number of instruction cycles before the output is driven active. If the value is greater than the duty cycle, the corresponding output remains inactive during the entire cycle. See **Section 14.4.6** "**Programmable Dead-Band Delay**" for more details of the dead-band delay operations.

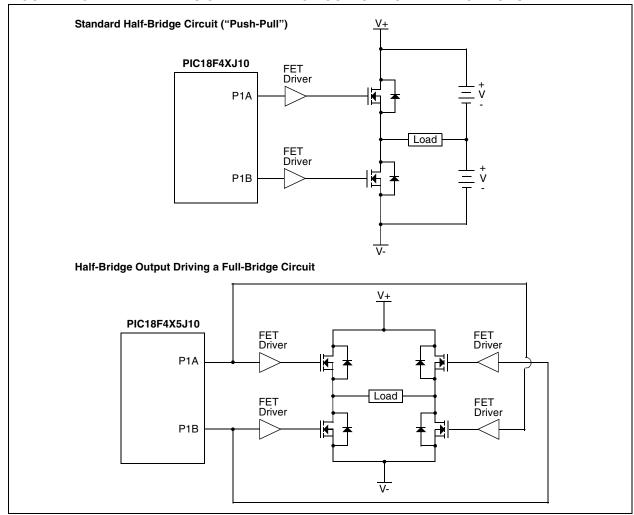
Since the P1A and P1B outputs are multiplexed with the PORTC<2> and PORTD<5> data latches, the TRISC<2> and TRISD<5> bits must be cleared to configure P1A and P1B as outputs.

FIGURE 14-4: HALF-BRIDGE PWM OUTPUT



- Note 1: At this time, the TMR2 register is equal to the PR2 register.
 - 2: Output signals are shown as active-high.

FIGURE 14-5: EXAMPLES OF HALF-BRIDGE OUTPUT MODE APPLICATIONS

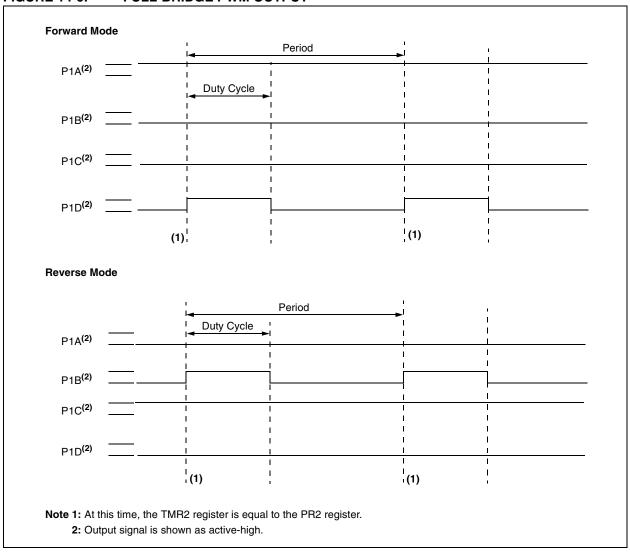


14.4.5 FULL-BRIDGE MODE

In Full-Bridge Output mode, four pins are used as outputs; however, only two outputs are active at a time. In the Forward mode, pin P1A is continuously active and pin P1D is modulated. In the Reverse mode, pin P1C is continuously active and pin P1B is modulated. These are illustrated in Figure 14-6.

P1A, P1B, P1C and P1D outputs are multiplexed with the PORTC<2> and PORTD<7:5> data latches. The TRISC<2> and TRISD<7:5> bits must be cleared to make the P1A, P1B, P1C and P1D pins outputs.

FIGURE 14-6: FULL-BRIDGE PWM OUTPUT



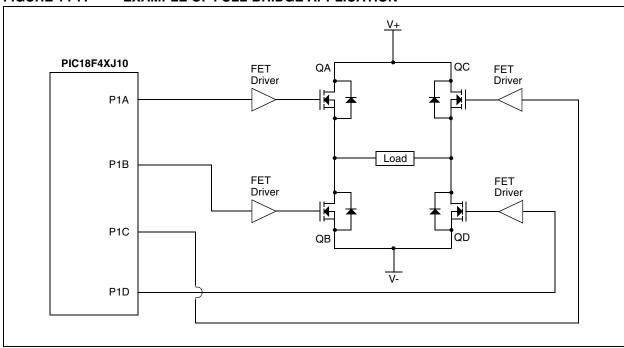


FIGURE 14-7: EXAMPLE OF FULL-BRIDGE APPLICATION

14.4.5.1 Direction Change in Full-Bridge Mode

In the Full-Bridge Output mode, the P1M1 bit in the CCP1CON register allows the user to control the forward/reverse direction. When the application firmware changes this direction control bit, the module will assume the new direction on the next PWM cycle.

Just before the end of the current PWM period, the modulated outputs (P1B and P1D) are placed in their inactive state, while the unmodulated outputs (P1A and P1C) are switched to drive in the opposite direction. This occurs in the time interval, 4 Tosc * (Timer2 Prescale Value), before the next PWM period begins. The Timer2 prescaler will be either 1, 4 or 16, depending on the value of the T2CKPS1:T2CKPS0 bits (T2CON<1:0>). During the interval from the switch of the unmodulated outputs to the beginning of the next period, the modulated outputs (P1B and P1D) remain inactive. This relationship is shown in Figure 14-8.

Note that in the Full-Bridge Output mode, the ECCP1 module does not provide any dead-band delay. In general, since only one output is modulated at all times, dead-band delay is not required. However, there is a situation where a dead-band delay might be required. This situation occurs when both of the following conditions are true:

- The direction of the PWM output changes when the duty cycle of the output is at or near 100%.
- The turn-off time of the power switch, including the power device and driver circuit, is greater than the turn-on time.

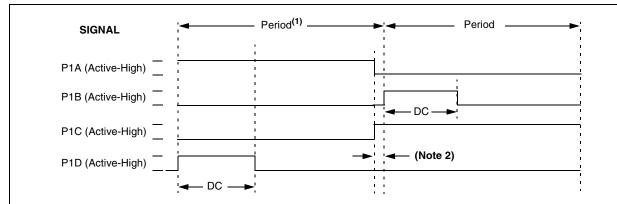
Figure 14-9 shows an example where the PWM direction changes from forward to reverse at a near 100% duty cycle. At time t1, the outputs P1A and P1D become inactive while output P1C becomes active. In this example, since the turn-off time of the power devices is longer than the turn-on time, a shoot-through current may flow through power devices, QC and QD (see Figure 14-7), for the duration of 't'. The same phenomenon will occur to power devices, QA and QB, for PWM direction change from reverse to forward.

If changing PWM direction at high duty cycle is required for an application, one of the following requirements must be met:

- 1. Reduce PWM for a PWM period before changing directions.
- Use switch drivers that can drive the switches off faster than they can drive them on.

Other options to prevent shoot-through current may exist.

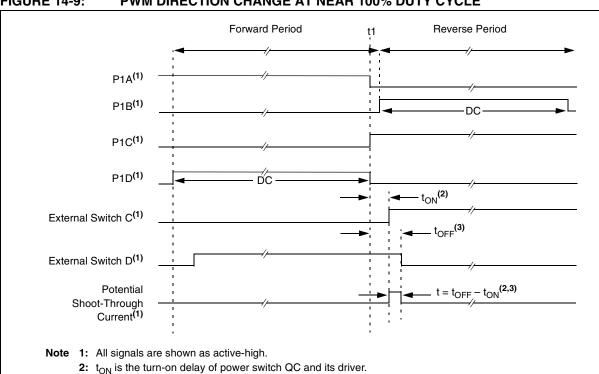
FIGURE 14-8: PWM DIRECTION CHANGE



Note 1: The direction bit in the ECCP1 Control register (CCP1CON<7>) is written any time during the PWM cycle.

2: When changing directions, the P1A and P1C signals switch before the end of the current PWM cycle at intervals of 4 Tosc, 16 Tosc or 64 Tosc, depending on the Timer2 prescaler value. The modulated P1B and P1D signals are inactive at this time.

FIGURE 14-9: PWM DIRECTION CHANGE AT NEAR 100% DUTY CYCLE



- **3:** t_{OFF} is the turn-off delay of power switch QD and its driver.

14.4.6 PROGRAMMABLE DEAD-BAND DELAY

Note: Programmable dead-band delay is not implemented in 28-pin devices with standard CCP modules.

In half-bridge applications, where all power switches are modulated at the PWM frequency at all times, the power switches normally require more time to turn off than to turn on. If both the upper and lower power switches are switched at the same time (one turned on and the other turned off), both switches may be on for a short period of time until one switch completely turns off. During this brief interval, a very high current (*shootthrough current*) may flow through both power switches, shorting the bridge supply. To avoid this potentially destructive shoot-through current from flowing during switching, turning on either of the power switches is normally delayed to allow the other switch to completely turn off.

In the Half-Bridge Output mode, a digitally programmable dead-band delay is available to avoid shoot-through current from destroying the bridge power switches. The delay occurs at the signal transition from the nonactive state to the active state. See Figure 14-4 for an illustration. Bits PDC6:PDC0 of the ECCP1DEL register (Register 14-2) set the delay period in terms of microcontroller instruction cycles (TCY or 4 TOSC). These bits are not available in 28-pin devices as the standard CCP module does not support half-bridge operation.

14.4.7 ENHANCED PWM AUTO-SHUTDOWN

When the ECCP1 is programmed for any of the Enhanced PWM modes, the active output pins may be configured for auto-shutdown. Auto-shutdown immediately places the Enhanced PWM output pins into a defined shutdown state when a shutdown event occurs.

A shutdown event can be caused by either of the comparator modules, a low level on the Fault input pin (FLT0) or any combination of these three sources. The comparators may be used to monitor a voltage input proportional to a current being monitored in the bridge circuit. If the voltage exceeds a threshold, the comparator switches state and triggers a shutdown. Alternatively, a low digital signal on FLT0 can also trigger a shutdown. The auto-shutdown feature can be disabled by not selecting any auto-shutdown sources. The auto-shutdown sources to be used are selected using the ECCPAS2:ECCPAS0 bits (bits<6:4> of the ECCP1AS register).

When a shutdown occurs, the output pins are asynchronously placed in their shutdown states, specified by the PSSAC1:PSSAC0 and PSSBD1:PSSBD0 bits (ECCPAS3:ECCPAS0). Each pin pair (P1A/P1C and P1B/P1D) may be set to drive high, drive low or be tri-stated (not driving). The ECCPASE bit (ECCP1AS<7>) is also set to hold the Enhanced PWM outputs in their shutdown states.

The ECCPASE bit is set by hardware when a shutdown event occurs. If automatic restarts are not enabled, the ECCPASE bit is cleared by firmware when the cause of the shutdown clears. If automatic restarts are enabled, the ECCPASE bit is automatically cleared when the cause of the auto-shutdown has cleared.

If the ECCPASE bit is set when a PWM period begins, the PWM outputs remain in their shutdown state for that entire PWM period. When the ECCPASE bit is cleared, the PWM outputs will return to normal operation at the beginning of the next PWM period.

Note: Writing to the ECCPASE bit is disabled while a shutdown condition is active.

REGISTER 14-2: ECCP1DEL: PWM DEAD-BAND DELAY REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PRSEN	PDC6 ⁽¹⁾	PDC5 ⁽¹⁾	PDC4 ⁽¹⁾	PDC3 ⁽¹⁾	PDC2 ⁽¹⁾	PDC1 ⁽¹⁾	PDC0 ⁽¹⁾
bit 7							bit 0

bit 7 PRSEN: PWM Restart Enable bit

- 1 = Upon auto-shutdown, the ECCPASE bit clears automatically once the shutdown event goes away; the PWM restarts automatically
- 0 = Upon auto-shutdown, ECCPASE must be cleared in software to restart the PWM

bit 6-0 PDC6:PDC0: PWM Delay Count bits⁽¹⁾

Delay time, in number of Fosc/4 (4 * Tosc) cycles, between the scheduled and actual time for a PWM signal to transition to active.

Note 1: Reserved on 28-pin devices; maintain these bits clear.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

REGISTER 14-3: ECCP1AS: ENHANCED CAPTURE/COMPARE/PWM AUTO-SHUTDOWN CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
ECCPASE	ECCPAS2	ECCPAS1	ECCPAS0	PSSAC1	PSSAC0	PSSBD1 ⁽¹⁾	PSSBD0 ⁽¹⁾	
bit 7								

bit 7 ECCPASE: ECCP Auto-Shutdown Event Status bit

1 = A shutdown event has occurred; ECCP outputs are in shutdown state

0 = ECCP outputs are operating

bit 6-4 ECCPAS2:ECCPAS0: ECCP Auto-Shutdown Source Select bits

111 = FLT0, Comparator 1 or Comparator 2

110 = FLT0 or Comparator 2

101 = FLT0 or Comparator 1

100 = FLT0

011 = Either Comparator 1 or 2

010 = Comparator 2 output

001 = Comparator 1 output

000 = Auto-shutdown is disabled

bit 3-2 **PSSAC1:PSSAC0:** Pins A and C Shutdown State Control bits

1x = Pins A and C are tri-state (40/44-pin devices);

PWM output is tri-state (28-pin devices)

01 = Drive Pins A and C to '1'

00 = Drive Pins A and C to '0'

bit 1-0 **PSSBD1:PSSBD0:** Pins B and D Shutdown State Control bits⁽¹⁾

1x = Pins B and D tri-state

01 = Drive Pins B and D to '1'

00 = Drive Pins B and D to '0'

Note 1: Reserved on 28-pin devices; maintain these bits clear.

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

14.4.7.1 Auto-Shutdown and Automatic Restart

The auto-shutdown feature can be configured to allow automatic restarts of the module following a shutdown event. This is enabled by setting the PRSEN bit of the ECCP1DEL register (ECCP1DEL<7>).

In Shutdown mode with PRSEN = 1 (Figure 14-10), the ECCPASE bit will remain set for as long as the cause of the shutdown continues. When the shutdown condition clears, the ECCPASE bit is cleared. If PRSEN = 0 (Figure 14-11), once a shutdown condition occurs, the ECCPASE bit will remain set until it is cleared by firmware. Once ECCPASE is cleared, the Enhanced PWM will resume at the beginning of the next PWM period.

Note: Writing to the ECCPASE bit is disabled while a shutdown condition is active.

Independent of the PRSEN bit setting, if the autoshutdown source is one of the comparators, the shutdown condition is a level. The ECCPASE bit cannot be cleared as long as the cause of the shutdown persists.

The Auto-Shutdown mode can be forced by writing a '1' to the ECCPASE bit.

14.4.8 START-UP CONSIDERATIONS

When the ECCP module is used in the PWM mode, the application hardware must use the proper external pull-up and/or pull-down resistors on the PWM output pins. When the microcontroller is released from Reset, all of the I/O pins are in the high-impedance state. The external circuits must keep the power switch devices in the OFF state until the microcontroller drives the I/O pins with the proper signal levels, or activates the PWM output(s).

The CCP1M1:CCP1M0 bits (CCP1CON<1:0>) allow the user to choose whether the PWM output signals are active-high or active-low for each pair of PWM output pins (P1A/P1C and P1B/P1D). The PWM output polarities must be selected before the PWM pins are configured as outputs. Changing the polarity configuration while the PWM pins are configured as outputs is not recommended, since it may result in damage to the application circuits.

The P1A, P1B, P1C and P1D output latches may not be in the proper states when the PWM module is initialized. Enabling the PWM pins for output at the same time as the ECCP module may cause damage to the application circuit. The ECCP module must be enabled in the proper output mode and complete a full PWM cycle before configuring the PWM pins as outputs. The completion of a full PWM cycle is indicated by the TMR2IF bit being set as the second PWM period begins.

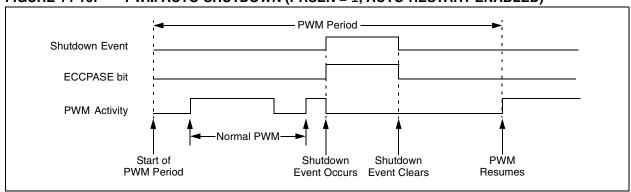
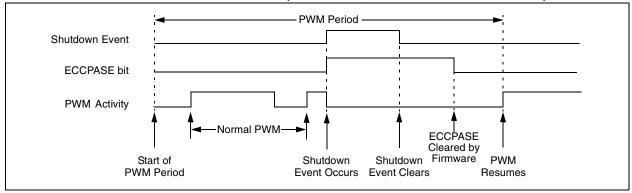


FIGURE 14-10: PWM AUTO-SHUTDOWN (PRSEN = 1, AUTO-RESTART ENABLED)





14.4.9 SETUP FOR PWM OPERATION

The following steps should be taken when configuring the ECCP module for PWM operation:

- Configure the PWM pins, P1A and P1B (and P1C and P1D, if used), as inputs by setting the corresponding TRIS bits.
- 2. Set the PWM period by loading the PR2 register.
- 3. If auto-shutdown is required:
 - Disable auto-shutdown (ECCPASE = 0)
 - Configure source (FLT0, Comparator 1 or Comparator 2)
 - · Wait for non-shutdown condition
- Configure the ECCP module for the desired PWM mode and configuration by loading the CCP1CON register with the appropriate values:
 - Select one of the available output configurations and direction with the P1M1:P1M0 bits.
 - Select the polarities of the PWM output signals with the CCP1M3:CCP1M0 bits.
- Set the PWM duty cycle by loading the CCPR1L register and CCP1CON<5:4> bits.
- For Half-Bridge Output mode, set the deadband delay by loading ECCP1DEL<6:0> with the appropriate value.
- If auto-shutdown operation is required, load the ECCP1AS register:
 - Select the auto-shutdown sources using the ECCPAS2:ECCPAS0 bits.
 - Select the shutdown states of the PWM output pins using the PSSAC1:PSSAC0 and PSSBD1:PSSBD0 bits.
 - Set the ECCPASE bit (ECCP1AS<7>).
 - Configure the comparators using the CMCON register.
 - Configure the comparator inputs as analog inputs.
- 8. If auto-restart operation is required, set the PRSEN bit (ECCP1DEL<7>).
- 9. Configure and start TMR2:
 - Clear the TMR2 interrupt flag bit by clearing the TMR2IF bit (PIR1<1>).
 - Set the TMR2 prescale value by loading the T2CKPS bits (T2CON<1:0>).
 - Enable Timer2 by setting the TMR2ON bit (T2CON<2>).
- Enable PWM outputs after a new PWM cycle has started:
 - Wait until TMRn overflows (TMRnIF bit is set).
 - Enable the CCP1/P1A, P1B, P1C and/or P1D pin outputs by clearing the respective TRIS bits.
 - Clear the ECCPASE bit (ECCP1AS<7>).

14.4.10 OPERATION IN POWER-MANAGED MODES

In Sleep mode, all clock sources are disabled. Timer2 will not increment and the state of the module will not change. If the CCP1 pin is driving a value, it will continue to drive that value. When the device wakes up, it will continue from this state. If Two-Speed Start-ups are enabled, the initial start-up frequency from INTOSC and the postscaler may not be stable immediately.

In PRI_IDLE mode, the primary clock will continue to clock the ECCP module without change. In all other power-managed modes, the selected power-managed mode clock will clock Timer2. Other power-managed mode clocks will most likely be different than the primary clock frequency.

14.4.10.1 Operation with Fail-Safe Clock Monitor

If the Fail-Safe Clock Monitor is enabled, a clock failure will force the device into the power-managed RC_RUN mode and the OSCFIF bit (PIR2<7>) will be set. The ECCP will then be clocked from the internal oscillator clock source, which may have a different clock frequency than the primary clock.

See the previous section for additional details.

14.4.11 EFFECTS OF A RESET

Both Power-on Reset and subsequent Resets will force all ports to Input mode and the CCP registers to their Reset states.

This forces the Enhanced CCP module to reset to a state compatible with the standard CCP module.

TABLE 14-3: REGISTERS ASSOCIATED WITH ECCP1 MODULE AND TIMER1

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	43
RCON	IPEN	_	_	RI	TO	PD	POR	BOR	42
PIR1	PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	45
PIE1	PSPIE ⁽¹⁾	ADIE	RCIE	TXIE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	45
IPR1	PSPIP ⁽¹⁾	ADIP	RCIP	TXIP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	45
PIR2	OSCFIF	CMIF		_	BCL1IF	_	_	CCP2IF	45
PIE2	OSCFIE	CMIE		_	BCL1IE	_	_	CCP2IE	45
IPR2	OSCFIP	CMIP	_	_	BCL1IP	_	_	CCP2IP	45
TRISB	PORTB Data Direction Control Register								46
TRISC	PORTC Da	PORTC Data Direction Control Register							46
TRISD ⁽¹⁾	PORTD Da	ta Direction C	ontrol Registe	er					46
TMR1L	Timer1 Reg	ister Low Byte	е						44
TMR1H	Timer1 Reg	ister High Byt	e						44
T1CON	RD16	T1RUN	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N	44
TMR2	Timer2 Reg	ister							44
T2CON	_	T2OUTPS3	T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0	44
PR2	Timer2 Peri	od Register							44
CCPR1L	Capture/Co	mpare/PWM	Register 1 Lo	w Byte					45
CCPR1H	Capture/Co	mpare/PWM	Register 1 Hi	gh Byte					45
CCP1CON	P1M1 ⁽¹⁾	P1M0 ⁽¹⁾	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0	45
ECCP1AS	ECCPASE	ECCPAS2	ECCPAS1	ECCPAS0	PSSAC1	PSSAC0	PSSBD1 ⁽¹⁾	PSSBD0 ⁽¹⁾	45
ECCP1DEL	PRSEN	PDC6 ⁽¹⁾	PDC5 ⁽¹⁾	PDC4 ⁽¹⁾	PDC3 ⁽¹⁾	PDC2 ⁽¹⁾	PDC1 ⁽¹⁾	PDC0 ⁽¹⁾	45

Legend: — = unimplemented, read as '0'. Shaded cells are not used during ECCP operation. **Note 1:** These registers and/or bits are not implemented on 28-pin devices and should be read as '0'.

15.0 MASTER SYNCHRONOUS SERIAL PORT (MSSP) MODULE

15.1 Master SSP (MSSP) Module Overview

The Master Synchronous Serial Port (MSSP) module is a serial interface, useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be serial EEPROMs, shift registers, display drivers, A/D converters, etc. The MSSP module can operate in one of two modes:

- Serial Peripheral Interface (SPI™)
- Inter-Integrated Circuit (I²C™)
 - Full Master mode
 - Slave mode (with general address call)

The I²C interface supports the following modes in hardware:

- · Master mode
- Multi-Master mode
- Slave mode

PIC18F24J10/25J10 (28-pin) devices have one MSSP module designated as MSSP1. PIC18F44J10/45J10 (40/44-pin) devices have two MSSP modules, designated as MSSP1 and MSSP2. Each module operates independently of the other.

Note: Throughout this section, generic references to an MSSP module in any of its operating modes may be interpreted as being equally applicable to MSSP1 or MSSP2. Register names and module I/O signals use the generic designator 'x' to indicate the use of a numeral to distinguish a particular module, when required. Control bit names are not individuated.

15.2 Control Registers

Each MSSP module has three associated control registers. These include a status register (SSPxSTAT) and two control registers (SSPxCON1 and SSPxCON2). The use of these registers and their individual configuration bits differ significantly depending on whether the MSSP module is operated in SPI or I²C mode.

Additional details are provided under the individual sections.

Note: In devices with more than one MSSP module, it is very important to pay close attention to SSPCON register names. SSP1CON1 and SSP1CON2 control different operational aspects of the same module, while SSP1CON1 and SSP2CON1 control the same features for

two different modules.

15.3 SPI Mode

The SPI mode allows 8 bits of data to be synchronously transmitted and received simultaneously. All four modes of SPI are supported. To accomplish communication, typically three pins are used:

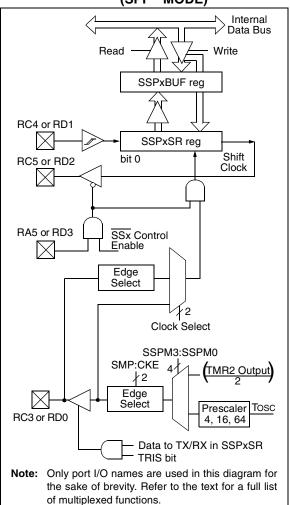
- Serial Data Out (SDOx) RC5/SDO1 or RD2/PSP2/SDO2
- Serial Data In (SDIx) RC4/SDI1/SDA1 or RD1/PSP1/SDI2/SDA2
- Serial Clock (SCKx) RC3/SCK1/SCL1 or RD0/PSP0/SCK2/SCL2

Additionally, a fourth pin may be used when in a Slave mode of operation:

 Slave Select (SSx) – RA5/AN4/SS1/C2OUT or RD3/PSP3/SS2

Figure 15-1 shows the block diagram of the MSSP module when operating in SPI mode.

FIGURE 15-1: MSSP BLOCK DIAGRAM (SPITM MODE)



15.3.1 REGISTERS

Each MSSP module has four registers for SPI mode operation. These are:

- MSSP Control Register 1 (SSPxCON1)
- MSSP Status Register (SSPxSTAT)
- Serial Receive/Transmit Buffer Register (SSPxBUF)
- MSSP Shift Register (SSPxSR) Not directly accessible

SSPxCON1 and SSPxSTAT are the control and status registers in SPI mode operation. The SSPxCON1 register is readable and writable. The lower 6 bits of the SSPxSTAT are read-only. The upper two bits of the SSPxSTAT are read/write.

SSPxSR is the shift register used for shifting data in or out. SSPxBUF is the buffer register to which data bytes are written to or read from.

In receive operations, SSPxSR and SSPxBUF together create a double-buffered receiver. When SSPxSR receives a complete byte, it is transferred to SSPxBUF and the SSPxIF interrupt is set.

During transmission, the SSPxBUF is not double-buffered. A write to SSPxBUF will write to both SSPxBUF and SSPxSR.

REGISTER 15-1: SSPxSTAT: MSSPx STATUS REGISTER (SPI™ MODE)

R/W-0	R/W-0	R-0	R-0	R-0	R-0	R-0	R-0
SMP	CKE	D/A	Р	S	R/W	UA	BF
bit 7							bit 0

bit 7 SMP: Sample bit

SPI Master mode:

- 1 = Input data sampled at end of data output time
- 0 = Input data sampled at middle of data output time

SPI Slave mode:

SMP must be cleared when SPI is used in Slave mode.

- bit 6 CKE: SPI Clock Select bit
 - 1 = Transmit occurs on transition from active to Idle clock state
 - 0 = Transmit occurs on transition from Idle to active clock state

Note: Polarity of clock state is set by the CKP bit (SSPxCON1<4>).

bit 5 D/A: Data/Address bit

Used in I²C mode only.

bit 4 P: Stop bit

Used in I²C mode only. This bit is cleared when the MSSP module is disabled, SSPEN is cleared.

bit 3 S: Start bit

Used in I²C mode only.

bit 2 R/W: Read/Write Information bit

Used in I²C mode only.

bit 1 UA: Update Address bit

Used in I²C mode only.

- bit 0 **BF:** Buffer Full Status bit (Receive mode only)
 - 1 = Receive complete, SSPxBUF is full
 - 0 = Receive not complete, SSPxBUF is empty

Leaena	

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

REGISTER 15-2: SSPxCON1: MSSPx CONTROL REGISTER 1 (SPI™ MODE)

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| WCOL | SSPOV | SSPEN | CKP | SSPM3 | SSPM2 | SSPM1 | SSPM0 |

bit 7

- bit 7 WCOL: Write Collision Detect bit (Transmit mode only)
 - 1 = The SSPxBUF register is written while it is still transmitting the previous word (must be cleared in software)
 - 0 = No collision
- bit 6 SSPOV: Receive Overflow Indicator bit

SPI Slave mode:

- 1 = A new byte is received while the SSPxBUF register is still holding the previous data. In case of overflow, the data in SSPxSR is lost. Overflow can only occur in Slave mode. The user must read the SSPxBUF, even if only transmitting data, to avoid setting overflow (must be cleared in software).
- 0 = No overflow

Note: In Master mode, the overflow bit is not set since each new reception (and transmission) is initiated by writing to the SSPxBUF register.

- bit 5 SSPEN: Master Synchronous Serial Port Enable bit
 - 1 = Enables serial port and configures SCKx, SDOx, SDIx and \overline{SSx} as serial port pins
 - 0 = Disables serial port and configures these pins as I/O port pins

Note: When enabled, these pins must be properly configured as input or output.

- bit 4 CKP: Clock Polarity Select bit
 - 1 = Idle state for clock is a high level
 - 0 = Idle state for clock is a low level
- bit 3-0 SSPM3:SSPM0: Master Synchronous Serial Port Mode Select bits
 - $0101 = SPI Slave mode, clock = SCKx pin, <math>\overline{SSx}$ pin control disabled, \overline{SSx} can be used as I/O pin
 - 0100 = SPI Slave mode, clock = SCKx pin, \overline{SSx} pin control enabled
 - 0011 = SPI Master mode, clock = TMR2 output/2
 - 0010 = SPI Master mode, clock = Fosc/64
 - 0001 = SPI Master mode, clock = Fosc/16
 - 0000 = SPI Master mode, clock = Fosc/4

Note: Bit combinations not specifically listed here are either reserved or implemented in I²C mode only.

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

15.3.2 OPERATION

When initializing the SPI, several options need to be specified. This is done by programming the appropriate control bits (SSPxCON1<5:0> and SSPxSTAT<7:6>). These control bits allow the following to be specified:

- Master mode (SCKx is the clock output)
- Slave mode (SCKx is the clock input)
- · Clock Polarity (Idle state of SCKx)
- Data Input Sample Phase (middle or end of data output time)
- Clock Edge (output data on rising/falling edge of SCKx)
- Clock Rate (Master mode only)
- Slave Select mode (Slave mode only)

Each MSSP consists of a transmit/receive shift register (SSPxSR) and a buffer register (SSPxBUF). The SSPxSR shifts the data in and out of the device, MSb first. The SSPxBUF holds the data that was written to the SSPxSR until the received data is ready. Once the 8 bits of data have been received, that byte is moved to the SSPxBUF register. Then, the Buffer Full detect bit BF (SSPxSTAT<0>) and the interrupt flag bit SSPxIF are set. This double-buffering of the received data (SSPxBUF) allows the next byte to start reception before reading the data that was just received. Any write to the

SSPxBUF register during transmission/reception of data will be ignored and the Write Collision detect bit, WCOL (SSPxCON1<7>), will be set. User software must clear the WCOL bit so that it can be determined if the following write(s) to the SSPxBUF register completed successfully.

When the application software is expecting to receive valid data, the SSPxBUF should be read before the next byte of data to transfer is written to the SSPxBUF. The Buffer Full bit, BF (SSPxSTAT<0>), indicates when SSPxBUF has been loaded with the received data (transmission is complete). When the SSPxBUF is read, the BF bit is cleared. This data may be irrelevant if the SPI is only a transmitter. Generally, the MSSP interrupt is used to determine when the transmission/reception has completed. The SSPxBUF must be read and/or written. If the interrupt method is not going to be used, then software polling can be done to ensure that a write collision does not occur. Example 15-1 shows the loading of the SSP1BUF (SSP1SR) for data transmission.

The SSPxSR is not directly readable or writable and can only be accessed by addressing the SSPxBUF register. Additionally, the SSPxSTAT register indicates the various status conditions.

EXAMPLE 15-1: LOADING THE SSP1BUF (SSP1SR) REGISTER

LOOP	BTFSS BRA MOVF	SSP1STAT, BF LOOP SSP1BUF, W	;Has data been received (transmit complete)? ;No ;WREG reg = contents of SSP1BUF
	MOVWF	RXDATA	;Save in user RAM, if data is meaningful
	MOVF MOVWF	TXDATA, W SSP1BUF	;W reg = contents of TXDATA ;New data to xmit

15.3.3 ENABLING SPI I/O

To enable the serial port, MSSP Enable bit, SSPEN (SSPxCON1<5>), must be set. To reset or reconfigure SPI mode, clear the SSPEN bit, reinitialize the SSPxCON registers and then set the SSPEN bit. This configures the SDIx, SDOx, SCKx and SSx pins as serial port pins. For the pins to behave as the serial port function, some must have their data direction bits (in the TRIS register) appropriately programmed as follows:

- SDIx is automatically controlled by the SPI module
- SDOx must have TRISC<5> (or TRISD<2>) bit cleared
- SCKx (Master mode) must have TRISC<3> (or TRISD<0>) bit cleared
- SCKx (Slave mode) must have TRISC<3> (or TRISD<0>) bit set
- SSx must have TRISA<5> (or TRISD<3>) bit set

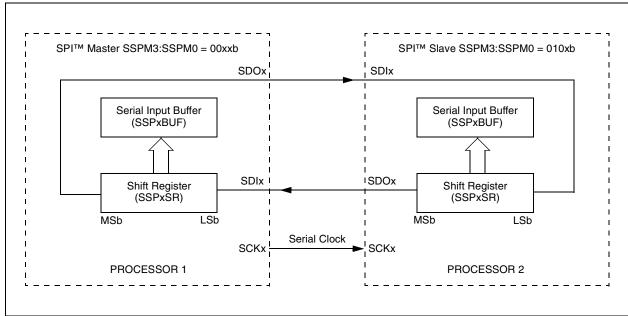
Any serial port function that is not desired may be overridden by programming the corresponding data direction (TRIS) register to the opposite value.

15.3.4 TYPICAL CONNECTION

Figure 15-2 shows a typical connection between two microcontrollers. The master controller (Processor 1) initiates the data transfer by sending the SCKx signal. Data is shifted out of both shift registers on their programmed clock edge and latched on the opposite edge of the clock. Both processors should be programmed to the same Clock Polarity (CKP), then both controllers would send and receive data at the same time. Whether the data is meaningful (or dummy data) depends on the application software. This leads to three scenarios for data transmission:

- Master sends data Slave sends dummy data
- · Master sends data Slave sends data
- Master sends dummy data Slave sends data

FIGURE 15-2: SPI™ MASTER/SLAVE CONNECTION



15.3.5 MASTER MODE

The master can initiate the data transfer at any time because it controls the SCKx. The master determines when the slave (Processor 2, Figure 15-2) will broadcast data by the software protocol.

In Master mode, the data is transmitted/received as soon as the SSPxBUF register is written to. If the SPI is only going to receive, the SDOx output could be disabled (programmed as an input). The SSPxSR register will continue to shift in the signal present on the SDIx pin at the programmed clock rate. As each byte is received, it will be loaded into the SSPxBUF register as if a normal received byte (interrupts and status bits appropriately set). This could be useful in receiver applications as a "Line Activity Monitor" mode.

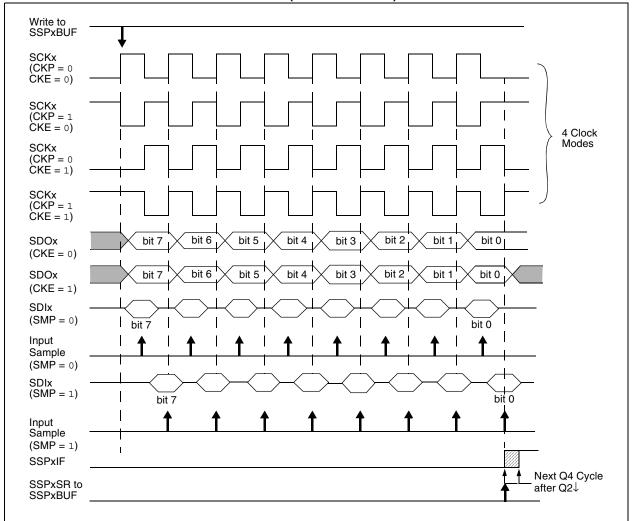
The clock polarity is selected by appropriately programming the CKP bit (SSPxCON1<4>). This then, would give waveforms for SPI communication as shown in Figure 15-3, Figure 15-5 and Figure 15-6, where the MSB is transmitted first. In Master mode, the SPI clock rate (bit rate) is user-programmable to be one of the following:

- Fosc/4 (or Tcy)
- Fosc/16 (or 4 Tcy)
- Fosc/64 (or 16 Tcy)
- Timer2 output/2

This allows a maximum data rate (at 40 MHz) of 10.00 Mbps.

Figure 15-3 shows the waveforms for Master mode. When the CKE bit is set, the SDOx data is valid before there is a clock edge on SCKx. The change of the input sample is shown based on the state of the SMP bit. The time when the SSPxBUF is loaded with the received data is shown.





15.3.6 SLAVE MODE

In Slave mode, the data is transmitted and received as the external clock pulses appear on SCKx. When the last bit is latched, the SSPxIF interrupt flag bit is set.

Before enabling the module in SPI Slave mode, the clock line must match the proper Idle state. The clock line can be observed by reading the SCKx pin. The Idle state is determined by the CKP bit (SSPxCON1<4>).

While in Slave mode, the external clock is supplied by the external clock source on the SCKx pin. This external clock must meet the minimum high and low times as specified in the electrical specifications.

While in Sleep mode, the slave can transmit/receive data. When a byte is received, the device will wake-up from Sleep.

15.3.7 SLAVE SELECT SYNCHRONIZATION

The SSx pin allows a Synchronous Slave mode. The SPI must be in Slave mode with SSx pin control enabled (SSPxCON1<3:0> = 04h). When the SSx pin is low, transmission and reception are enabled and the

SDOx pin is driven. When the SSx pin goes high, the SDOx pin is no longer driven, even if in the middle of a transmitted byte and becomes a floating output. External pull-up/pull-down resistors may be desirable depending on the application.

- Note 1: When the SPI is in Slave mode with \$\overline{SSx}\$ pin control enabled (\$SPxCON1<3:0> = 0100), the SPI module will reset if the \$\overline{SSx}\$ pin is set to VDD
 - 2: If the SPI is used in Slave mode with CKE set, then the SSx pin control must be enabled.

When the SPI module resets, the bit counte<u>r</u> is forced to '0'. This can be done by either forcing the <u>SSx</u> pin to a high level or clearing the <u>SSPEN</u> bit.

To emulate two-wire communication, the SDOx pin can be connected to the SDIx pin. When the SPI needs to operate as a receiver, the SDOx pin can be configured as an input. This disables transmissions from the SDOx. The SDIx can always be left as an input (SDIx function) since it cannot create a bus conflict.

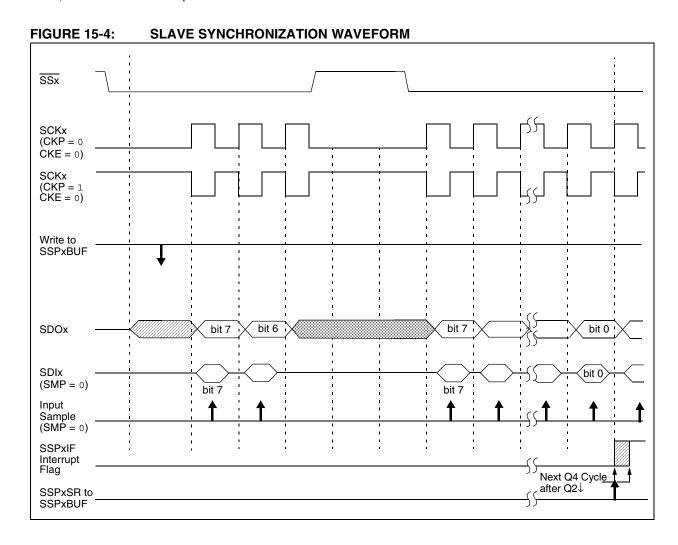


FIGURE 15-5: SPITM MODE WAVEFORM (SLAVE MODE WITH CKE = 0)

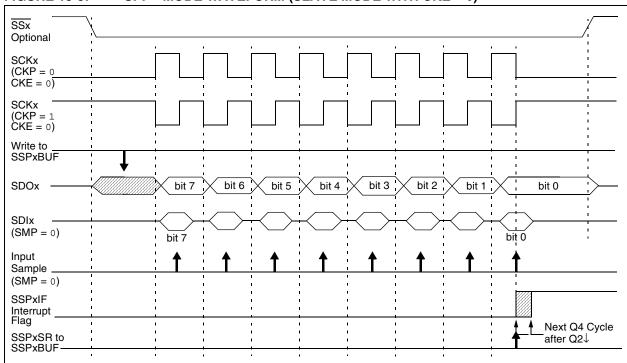
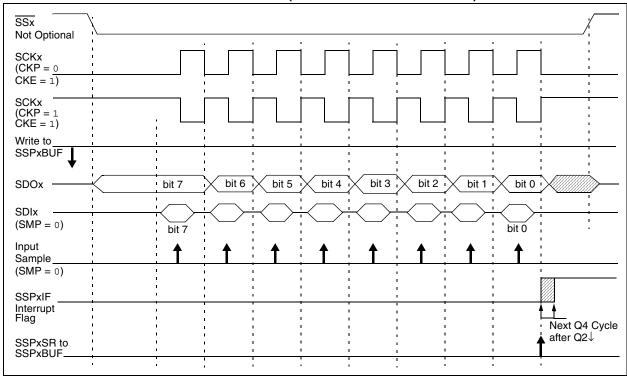


FIGURE 15-6: SPI™ MODE WAVEFORM (SLAVE MODE WITH CKE = 1)



15.3.8 OPERATION IN POWER-MANAGED MODES

In SPI Master mode, module clocks may be operating at a different speed than when in full power mode; in the case of Sleep mode, all clocks are halted.

In Idle modes, a clock is provided to the peripherals. That clock should be from the primary clock source, the secondary clock (Timer1 oscillator at 32.768 kHz) or the INTOSC source. See **Section 2.6 "Clock Sources and Oscillator Switching"** for additional information.

In most cases, the speed that the master clocks SPI data is not important; however, this should be evaluated for each system.

If MSSP interrupts are enabled, they can wake the controller from Sleep mode, or one of the Idle modes, when the master completes sending data. If an exit from Sleep or Idle mode is not desired, MSSP interrupts should be disabled.

If the Sleep mode is selected, all module clocks are halted and the transmission/reception will remain in that state until the devices wakes. After the device returns to Run mode, the module will resume transmitting and receiving data.

In SPI Slave mode, the SPI Transmit/Receive Shift register operates asynchronously to the device. This allows the device to be placed in any power-managed mode and data to be shifted into the SPI Transmit/Receive Shift register. When all 8 bits have been received, the MSSP interrupt flag bit will be set and if enabled, will wake the device.

15.3.9 EFFECTS OF A RESET

A Reset disables the MSSP module and terminates the current transfer.

15.3.10 BUS MODE COMPATIBILITY

Table 15-1 shows the compatibility between the standard SPI modes and the states of the CKP and CKE control bits.

TABLE 15-1: SPI™ BUS MODES

Standard SPI™ Mode	Control Bits State			
Terminology	СКР	CKE		
0, 0	0	1		
0, 1	0	0		
1, 0	1	1		
1, 1	1	0		

There is also an SMP bit which controls when the data is sampled.

15.3.11 SPI CLOCK SPEED AND MODULE INTERACTIONS

Because MSSP1 and MSSP2 are independent modules, they can operate simultaneously at different data rates. Setting the SSPM3:SSPM0 bits of the SSPxCON1 register determines the rate for the corresponding module.

An exception is when both modules use Timer2 as a time base in Master mode. In this instance, any changes to the Timer2 operation will affect both MSSP modules equally. If different bit rates are required for each module, the user should select one of the other three time base options for one of the modules.

TABLE 15-2: REGISTERS ASSOCIATED WITH SPI™ OPERATION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	43
PIR1	PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	45
PIE1	PSPIE ⁽¹⁾	ADIE	RCIE	TXIE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	45
IPR1	PSPIP ⁽¹⁾	ADIP	RCIP	TXIP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	45
PIR3	SSP2IF	BCL2IF	_	_	_	_	_	_	45
PIE3	SSP2IE	BCL2IE	_	_	_	_	_	_	45
IPR3	SSP2IP	BCL2IP	_	_	_	_	_	_	45
TRISA	_	_	TRISA5	_	TRISA3	TRISA2	TRISA1	TRISA0	46
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	46
TRISD ⁽¹⁾	TRISD7	TRISD6	TRISD5	TRISD4	TRISD3	TRISD2	TRISD1	TRISD0	46
SSP1BUF	MSSP1 Re	ceive Buffer	/Transmit R	egister					44
SSP1CON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	44
SSP1STAT	SMP	CKE	D/\overline{A}	Р	S	R/W	UA	BF	44
SSP2BUF	MSSP2 Receive Buffer/Transmit Register						46		
SSP2CON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	46
SSP2STAT	SMP	CKE	D/ A	Р	S	R/W	UA	BF	46

Legend: Shaded cells are not used by the MSSP module in SPI™ mode.

Note 1: These registers and/or bits are not implemented on 28-pin devices and should be read as '0'.

15.4 I²C Mode

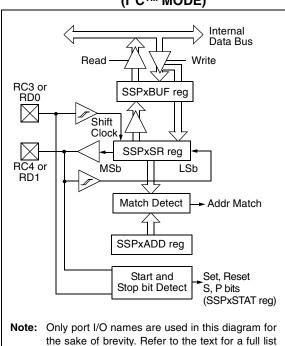
The MSSP module in I²C mode fully implements all master and slave functions (including general call support) and provides interrupts on Start and Stop bits in hardware to determine a free bus (multi-master function). The MSSP module implements the standard mode specifications as well as 7-bit and 10-bit addressing.

Two pins are used for data transfer:

- Serial clock (SCLx) RC3/SCK1/SCL1 or RD0/PSP0/SCK2/SCL2
- Serial data (SDAx) RC4/SDI1/SDA1 or RD1/PSP1/SDI2/SDA2

The user must configure these pins as inputs by setting the TRISC<4:3> or TRISD<1:0> bits.

FIGURE 15-7: MSSP BLOCK DIAGRAM (I²CTM MODE)



of multiplexed functions.

15.4.1 REGISTERS

The MSSP module has six registers for I²C operation. These are:

- MSSP Control Register 1 (SSPxCON1)
- MSSP Control Register 2 (SSPxCON2)
- · MSSP Status Register (SSPxSTAT)
- Serial Receive/Transmit Buffer Register (SSPxBUF)
- MSSP Shift Register (SSPxSR) Not directly accessible
- MSSP Address Register (SSPxADD)

SSPxCON1, SSPxCON2 and SSPxSTAT are the control and status registers in I^2C mode operation. The SSPxCON1 and SSPxCON2 registers are readable and writable. The lower 6 bits of the SSPxSTAT are read-only. The upper 2 bits of the SSPxSTAT are read/write.

SSPxSR is the shift register used for shifting data in or out. SSPxBUF is the buffer register to which data bytes are written to or read from.

SSPxADD register holds the slave device address when the MSSP is configured in I^2C Slave mode. When the MSSP is configured in Master mode, the lower seven bits of SSPxADD act as the Baud Rate Generator reload value.

In receive operations, SSPxSR and SSPxBUF together create a double-buffered receiver. When SSPxSR receives a complete byte, it is transferred to SSPxBUF and the SSPxIF interrupt is set.

During transmission, the SSPxBUF is not double-buffered. A write to SSPxBUF will write to both SSPxBUF and SSPxSR.

REGISTER 15-3: SSPxSTAT: MSSPx STATUS REGISTER (I²C™ MODE)

R/W-0	R/W-0	R-0	R-0	R-0	R-0	R-0	R-0
SMP	CKE	D/A	Р	S	R/W	UA	BF
hit 7							hit 0

bit 7 SMP: Slew Rate Control bit

In Master or Slave mode:

- 1 = Slew rate control disabled for Standard Speed mode (100 kHz and 1 MHz)
- 0 = Slew rate control enabled for High-Speed mode (400 kHz)
- bit 6 CKE: SMBus Select bit

In Master or Slave mode:

- 1 = Enable SMBus specific inputs
- 0 = Disable SMBus specific inputs
- bit 5 D/A: Data/Address bit

In Master mode:

Reserved.

In Slave mode:

- 1 = Indicates that the last byte received or transmitted was data
- 0 = Indicates that the last byte received or transmitted was address
- bit 4 P: Stop bit
 - 1 = Indicates that a Stop bit has been detected last
 - 0 = Stop bit was not detected last

Note: This bit is cleared on Reset and when SSPEN is cleared.

- bit 3 S: Start bit
 - 1 = Indicates that a Start bit has been detected last
 - 0 = Start bit was not detected last

Note: This bit is cleared on Reset and when SSPEN is cleared.

bit 2 R/W: Read/Write Information bit (I²C mode only)

In Slave mode:

- 1 = Read
- 0 = Write

Note: This bit holds the R/\overline{W} bit information following the last address match. This bit is only valid from the address match to the next Start bit, Stop bit or not \overline{ACK} bit.

In Master mode:

- 1 = Transmit is in progress
- 0 = Transmit is not in progress

Note: ORing this bit with SEN, RSEN, PEN, RCEN or ACKEN will indicate if the MSSP is in Active mode.

- bit 1 **UA:** Update Address bit (10-bit Slave mode only)
 - 1 = Indicates that the user needs to update the address in the SSPxADD register
 - 0 = Address does not need to be updated
- bit 0 BF: Buffer Full Status bit

In Transmit mode:

- 1 = SSPxBUF is full
- 0 = SSPxBUF is empty

In Receive mode:

- 1 = SSPxBUF is full (does not include the \overline{ACK} and Stop bits)
- 0 = SSPxBUF is empty (does not include the \overline{ACK} and Stop bits)

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

REGISTER 15-4: SSPxCON1: MSSPx CONTROL REGISTER 1 (I²C™ MODE)

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| WCOL | SSPOV | SSPEN | CKP | SSPM3 | SSPM2 | SSPM1 | SSPM0 |

bit 7 bit 0

bit 7 WCOL: Write Collision Detect bit

In Master Transmit mode:

- 1 = A write to the SSPxBUF register was attempted while the I²C conditions were not valid for a transmission to be started (must be cleared in software)
- 0 = No collision

In Slave Transmit mode:

- 1 = The SSPxBUF register is written while it is still transmitting the previous word (must be cleared in software)
- 0 = No collision

In Receive mode (Master or Slave modes):

This is a "don't care" bit.

bit 6 SSPOV: Receive Overflow Indicator bit

In Receive mode:

- 1 = A byte is received while the SSPxBUF register is still holding the previous byte (must be cleared in software)
- 0 = No overflow

In Transmit mode:

This is a "don't care" bit in Transmit mode.

- bit 5 SSPEN: Master Synchronous Serial Port Enable bit
 - 1 = Enables the serial port and configures the SDAx and SCLx pins as the serial port pins
 - 0 = Disables serial port and configures these pins as I/O port pins

Note: When enabled, the SDAx and SCLx pins must be properly configured as input or output.

bit 4 CKP: SCKx Release Control bit

In Slave mode:

- 1 = Release clock
- 0 = Holds clock low (clock stretch), used to ensure data setup time

In Master mode:

Unused in this mode.

bit 3-0 SSPM3:SSPM0: Master Synchronous Serial Port Mode Select bits

- $1111 = I^2C$ Slave mode, 10-bit address with Start and Stop bit interrupts enabled
- $1110 = I^2C$ Slave mode, 7-bit address with Start and Stop bit interrupts enabled
- 1011 = I²C Firmware Controlled Master mode (Slave Idle)
- $1000 = I^2C$ Master mode, clock = Fosc/(4 * (SSPxADD + 1))
- $0111 = I^2C$ Slave mode, 10-bit address
- $0110 = I^2C$ Slave mode, 7-bit address

Bit combinations not specifically listed here are either reserved or implemented in SPI mode only.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

REGISTER 15-5: SSPxCON2: MSSPx CONTROL REGISTER 2 (I²C™ MODE)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
GCEN	ACKSTAT	ACKDT	ACKEN ⁽¹⁾	RCEN ⁽¹⁾	PEN ⁽¹⁾	RSEN ⁽¹⁾	SEN ⁽¹⁾
bit 7							bit 0

- bit 7 GCEN: General Call Enable bit (Slave mode only)
 - 1 = Enable interrupt when a general call address (0000h) is received in the SSPxSR
 - 0 = General call address disabled
- bit 6 ACKSTAT: Acknowledge Status bit (Master Transmit mode only)
 - 1 = Acknowledge was not received from slave
 - 0 = Acknowledge was received from slave
- bit 5 ACKDT: Acknowledge Data bit (Master Receive mode only)
 - 1 = Not Acknowledge
 - 0 = Acknowledge

Note: Value that will be transmitted when the user initiates an Acknowledge sequence at the end of a receive.

- bit 4 ACKEN: Acknowledge Sequence Enable bit (Master Receive mode only)⁽¹⁾
 - 1 = Initiate Acknowledge sequence on SDAx and SCLx pins and transmit ACKDT data bit. Automatically cleared by hardware.
 - 0 = Acknowledge sequence Idle
- bit 3 RCEN: Receive Enable bit (Master mode only)⁽¹⁾
 - 1 = Enables Receive mode for I²C
 - 0 = Receive Idle
- bit 2 **PEN:** Stop Condition Enable bit (Master mode only)⁽¹⁾
 - 1 = Initiate Stop condition on SDAx and SCLx pins. Automatically cleared by hardware.
 - 0 = Stop condition Idle
- bit 1 RSEN: Repeated Start Condition Enable bit (Master mode only)(1)
 - 1 = Initiate Repeated Start condition on SDAx and SCLx pins. Automatically cleared by hardware.
 - 0 = Repeated Start condition Idle
- bit 0 SEN: Start Condition Enable/Stretch Enable bit(1)

In Master mode:

- 1 = Initiate Start condition on SDAx and SCLx pins. Automatically cleared by hardware.
- 0 = Start condition Idle

In Slave mode:

- 1 = Clock stretching is enabled for both slave transmit and slave receive (stretch enabled)
- 0 = Clock stretching is disabled

Note 1: For bits ACKEN, RCEN, PEN, RSEN, SEN: If the I²C module is not in the Idle mode, these bits may not be set (no spooling) and the SSPxBUF may not be written (or writes to the SSPxBUF are disabled).

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

15.4.2 OPERATION

The MSSP module functions are enabled by setting the MSSP Enable bit, SSPEN (SSPxCON1<5>).

The SSPxCON1 register allows control of the I²C operation. Four mode selection bits (SSPxCON1<3:0>) allow one of the following I²C modes to be selected:

- I²C Master mode, clock = (Fosc/4) x (SSPxADD + 1)
- I²C Slave mode (7-bit address)
- I²C Slave mode (10-bit address)
- I²C Slave mode (7-bit address) with Start and Stop bit interrupts enabled
- I²C Slave mode (10-bit address) with Start and Stop bit interrupts enabled
- I²C Firmware Controlled Master mode, slave is Idle

Selection of any I²C mode, with the SSPEN bit set, forces the SCLx and SDAx pins to be open-drain, provided these pins are programmed to inputs by setting the appropriate TRISC or TRISD bits. To ensure proper operation of the module, pull-up resistors must be provided externally to the SCLx and SDAx pins.

15.4.3 SLAVE MODE

In Slave mode, the SCLx and SDAx pins must be configured as inputs (TRISC<4:3> or TRISD<1:0> set). The MSSP module will override the input state with the output data when required (slave-transmitter).

The I²C Slave mode hardware will always generate an interrupt on an address match. Through the mode select bits, the user can also choose to interrupt on Start and Stop bits

When an address is matched, or the data transfer after an address match is received, the hardware automatically will generate the Acknowledge (\overline{ACK}) pulse and load the SSPxBUF register with the received value currently in the SSPxSR register.

Any combination of the following conditions will cause the MSSP module not to give this ACK pulse:

- The Buffer Full bit, BF (SSPxSTAT<0>), was set before the transfer was received.
- The overflow bit, SSPOV (SSPxCON1<6>), was set before the transfer was received.

In this case, the SSPxSR register value is not loaded into the SSPxBUF, but bit SSPxIF is set. The BF bit is cleared by reading the SSPxBUF register, while bit SSPOV is cleared through software.

The SCLx clock input must have a minimum high and low for proper operation. The high and low times of the I^2C specification, as well as the requirement of the MSSP module, are shown in timing parameter 100 and parameter 101.

15.4.3.1 Addressing

Once the MSSP module has been enabled, it waits for a Start condition to occur. Following the Start condition, the 8 bits are shifted into the SSPxSR register. All incoming bits are sampled with the rising edge of the clock (SCLx) line. The value of register SSPxSR<7:1> is compared to the value of the SSPxADD register. The address is compared on the falling edge of the eighth clock (SCLx) pulse. If the addresses match and the BF and SSPOV bits are clear, the following events occur:

- The SSPxSR register value is loaded into the SSPxBUF register.
- 2. The Buffer Full bit, BF, is set.
- 3. An ACK pulse is generated.
- 4. The MSSP Interrupt Flag bit, SSPxIF, is set (and interrupt is generated, if enabled) on the falling edge of the ninth SCLx pulse.

In 10-bit Address mode, two address bytes need to be received by the slave. The five Most Significant bits (MSbs) of the first address byte specify if this is a 10-bit address. Bit R/\overline{W} (SSPxSTAT<2>) must specify a write so the slave device will receive the second address byte. For a 10-bit address, the first byte would equal '11110 A9 A8 0', where 'A9' and 'A8' are the two MSbs of the address. The sequence of events for 10-bit address is as follows, with steps 7 through 9 for the slave-transmitter:

- Receive first (high) byte of address (bits SSPxIF, BF and UA (SSPxSTAT<1>) are set).
- Update the SSPxADD register with second (low) byte of address (clears bit UA and releases the SCLx line).
- 3. Read the SSPxBUF register (clears bit BF) and clear flag bit SSPxIF.
- 4. Receive second (low) byte of address (bits SSPxIF, BF and UA are set).
- Update the SSPxADD register with the first (high) byte of address. If match releases SCLx line, this will clear bit UA.
- 6. Read the SSPxBUF register (clears bit BF) and clear flag bit SSPxIF.
- 7. Receive Repeated Start condition.
- 8. Receive first (high) byte of address (bits SSPxIF and BF are set).
- Read the SSPxBUF register (clears bit BF) and clear flag bit SSPxIF.

15.4.3.2 Reception

When the R/\overline{W} bit of the address byte is clear and an address match occurs, the R/\overline{W} bit of the SSPxSTAT register is cleared. The received address is loaded into the SSPxBUF register and the SDAx line is held low (\overline{ACK}) .

When the address byte overflow condition exists, then the no Acknowledge (ACK) pulse is given. An overflow condition is defined as either bit BF (SSPxSTAT<0>) is set, or bit SSPOV (SSPxCON1<6>) is set.

An MSSP interrupt is generated for each data transfer byte. The interrupt flag bit, SSPxIF, must be cleared in software. The SSPxSTAT register is used to determine the status of the byte.

If SEN is enabled (SSPxCON2<0> = 1), SCKx/SCLx (RC3 or RD0) will be held low (clock stretch) following each data transfer. The clock must be released by setting bit, CKP (SSPxCON1<4>). See **Section 15.4.4** "Clock Stretching" for more details.

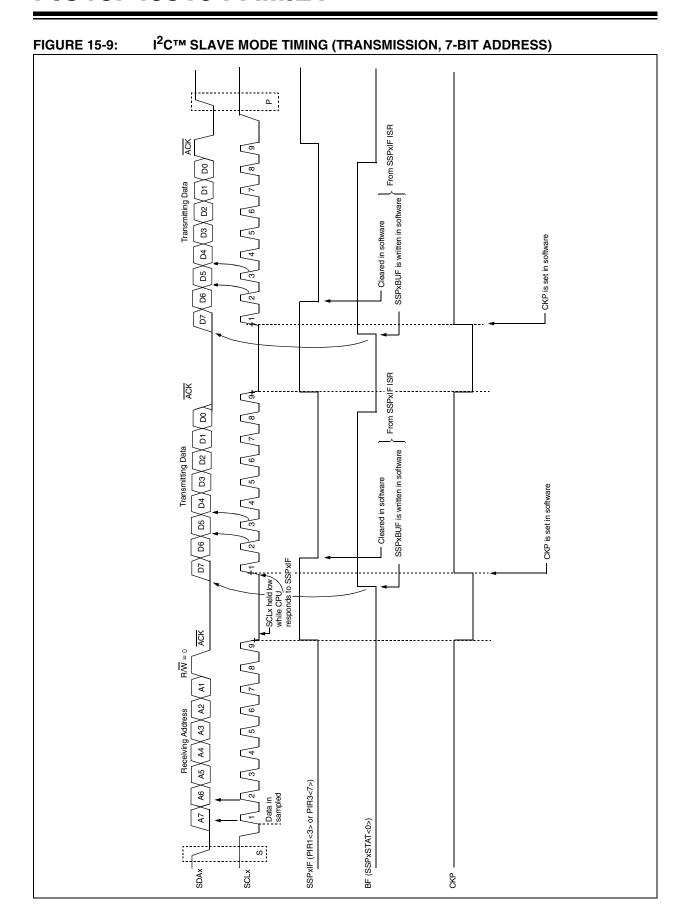
15.4.3.3 Transmission

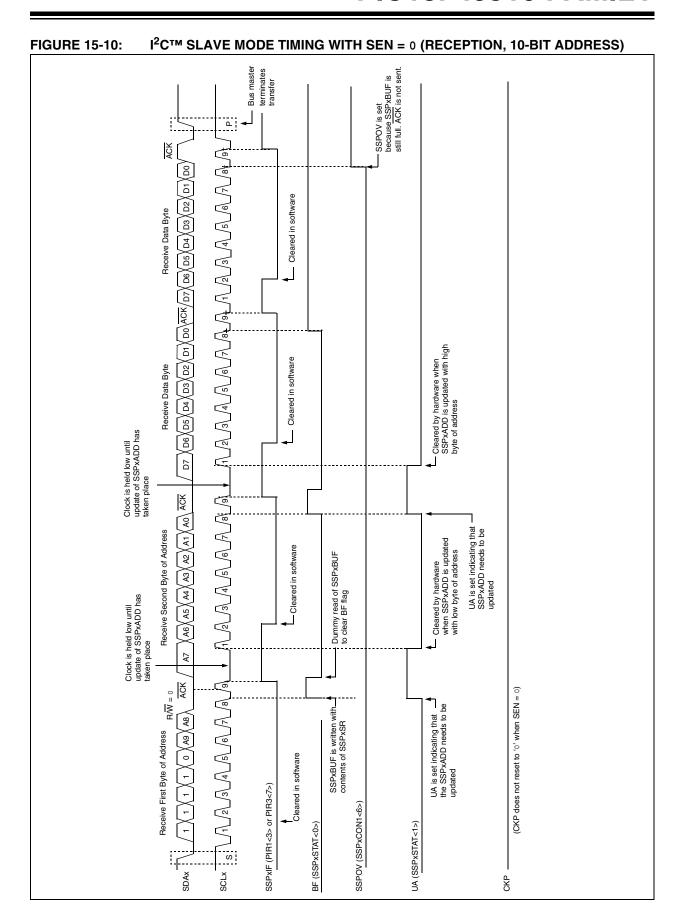
When the R/W bit of the incoming address byte is set and an address match occurs, the R/\overline{W} bit of the SSPxSTAT register is set. The received address is loaded into the SSPxBUF register. The ACK pulse will be sent on the ninth bit and pin RC3 or RD6 is held low, regardless of SEN (see Section 15.4.4 "Clock Stretching" for more details). By stretching the clock, the master will be unable to assert another clock pulse until the slave is done preparing the transmit data. The transmit data must be loaded into the SSPxBUF register which also loads the SSPxSR register. Then pin RC3 or RD0 should be enabled by setting bit, CKP (SSPxCON1<4>). The eight data bits are shifted out on the falling edge of the SCLx input. This ensures that the SDAx signal is valid during the SCLx high time (Figure 15-9).

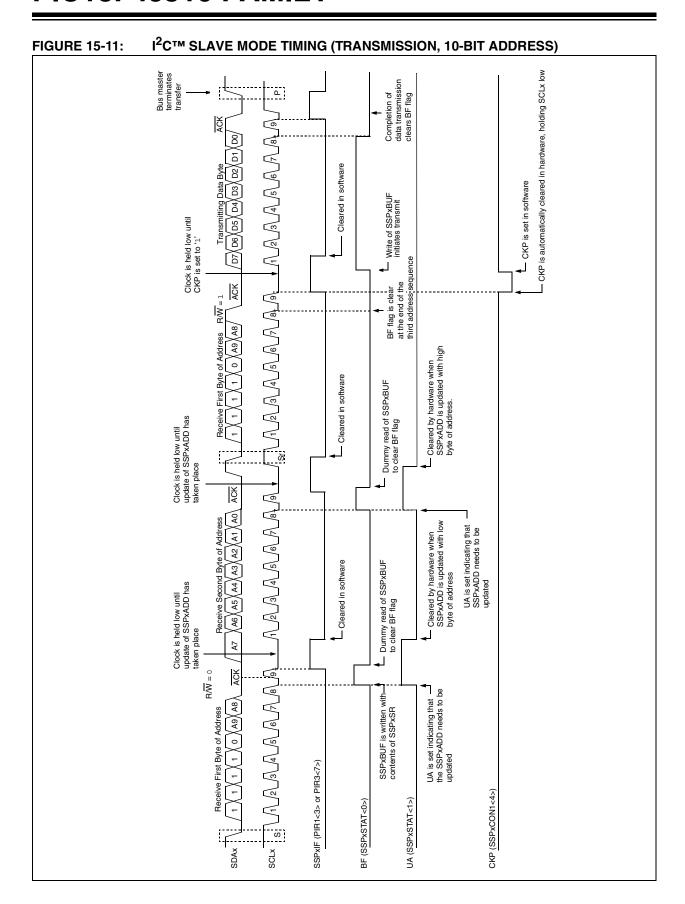
The ACK pulse from the master-receiver is latched on the rising edge of the ninth SCLx input pulse. If the SDAx line is high (not ACK), then the data transfer is complete. In this case, when the ACK is latched by the slave, the slave logic is reset (resets SSPxSTAT register) and the slave monitors for another occurrence of the Start bit. If the SDAx line was low (ACK), the next transmit data must be loaded into the SSPxBUF register. Again, pin RC3 or RD0 must be enabled by setting bit CKP.

An MSSP interrupt is generated for each data transfer byte. The SSPxIF bit must be cleared in software and the SSPxSTAT register is used to determine the status of the byte. The SSPxIF bit is set on the falling edge of the ninth clock pulse.

I²C™ SLAVE MODE TIMING WITH SEN = 0 (RECEPTION, 7-BIT ADDRESS) **FIGURE 15-8:** SSPOV is set because SSPxBUF is still full. ACK is not sent. Bus master terminates transfer D6 X D5 X D4 X D3 X D5 X D4 X D3 X Cleared in software SSPxBUF is read (CKP does not reset to '0' when SEN = 0) A5 X A4 X A3 X SSPxIF (PIR1<3> or PIR3<7>) SSPOV (SSPxCON1<6>) BF (SSPxSTAT<0>) CKP







15.4.4 CLOCK STRETCHING

Both 7-bit and 10-bit Slave modes implement automatic clock stretching during a transmit sequence.

The SEN bit (SSPxCON2<0>) allows clock stretching to be enabled during receives. Setting SEN will cause the SCLx pin to be held low at the end of each data receive sequence.

15.4.4.1 Clock Stretching for 7-bit Slave Receive Mode (SEN = 1)

In 7-bit Slave Receive mode, on the falling edge of the ninth clock at the end of the ACK sequence, if the BF bit is set, the CKP bit in the SSPxCON1 register is automatically cleared, forcing the SCLx output to be held low. The CKP being cleared to '0' will assert the SCLx line low. The CKP bit must be set in the user's ISR before reception is allowed to continue. By holding the SCLx line low, the user has time to service the ISR and read the contents of the SSPxBUF before the master device can initiate another receive sequence. This will prevent buffer overruns from occurring (see Figure 15-13).

- Note 1: If the user reads the contents of the SSPxBUF before the falling edge of the ninth clock, thus clearing the BF bit, the CKP bit will not be cleared and clock stretching will not occur.
 - 2: The CKP bit can be set in software regardless of the state of the BF bit. The user should be careful to clear the BF bit in the ISR before the next receive sequence in order to prevent an overflow condition.

15.4.4.2 Clock Stretching for 10-bit Slave Receive Mode (SEN = 1)

In 10-bit Slave Receive mode during the address sequence, clock stretching automatically takes place but CKP is not cleared. During this time, if the UA bit is set after the ninth clock, clock stretching is initiated. The UA bit is set after receiving the upper byte of the 10-bit address and following the receive of the second byte of the 10-bit address with the R/W bit cleared to '0'. The release of the clock line occurs upon updating SSPxADD. Clock stretching will occur on each data receive sequence as described in 7-bit mode.

Note: If the user polls the UA bit and clears it by updating the SSPxADD register before the falling edge of the ninth clock occurs and if the user hasn't cleared the BF bit by reading the SSPxBUF register before that time, then the CKP bit will still NOT be asserted low. Clock stretching on the basis of the state of the BF bit only occurs during a data sequence, not an address sequence.

15.4.4.3 Clock Stretching for 7-bit Slave Transmit Mode

The 7-bit Slave Transmit mode implements clock stretching by clearing the CKP bit after the falling edge of the ninth clock, if the BF bit is clear. This occurs regardless of the state of the SEN bit.

The user's ISR must set the CKP bit before transmission is allowed to continue. By holding the SCLx line low, the user has time to service the ISR and load the contents of the SSPxBUF before the master device can initiate another transmit sequence (see Figure 15-9).

- Note 1: If the user loads the contents of SSPxBUF, setting the BF bit before the falling edge of the ninth clock, the CKP bit will not be cleared and clock stretching will not occur.
 - **2:** The CKP bit can be set in software regardless of the state of the BF bit.

15.4.4.4 Clock Stretching for 10-bit Slave Transmit Mode

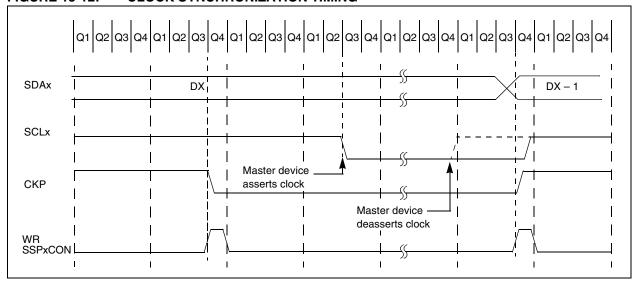
In 10-bit Slave Transmit mode, clock stretching is controlled during the first two address sequences by the state of the UA bit, just as it is in 10-bit Slave Receive mode. The first two addresses are followed by a third address sequence which contains the high-order bits of the 10-bit address and the R/\overline{W} bit set to '1'. After the third address sequence is performed, the UA bit is not set, the module is now configured in Transmit mode and clock stretching is controlled by the BF flag as in 7-bit Slave Transmit mode (see Figure 15-11).

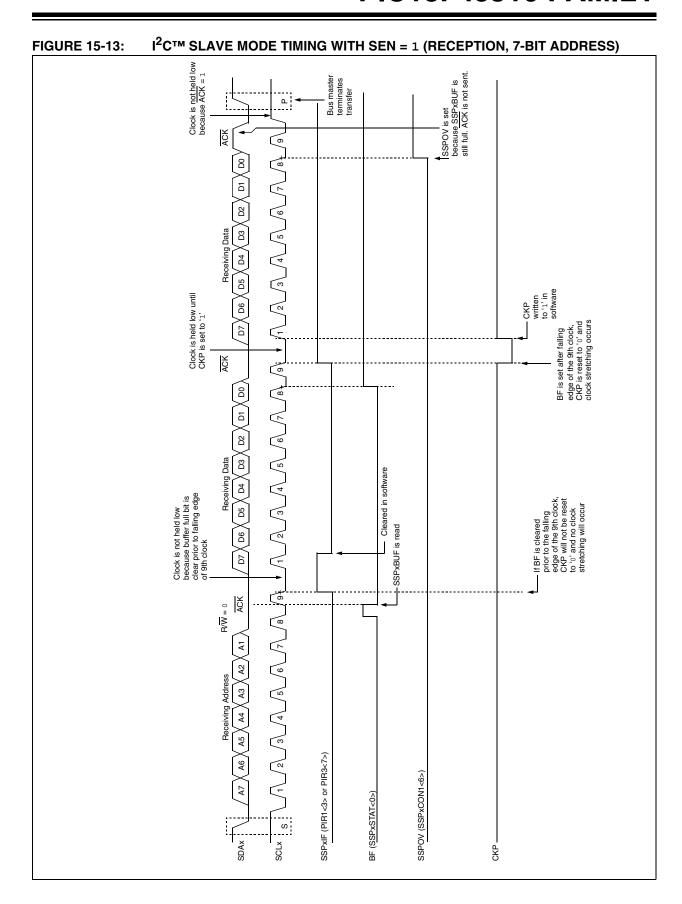
15.4.4.5 Clock Synchronization and the CKP bit

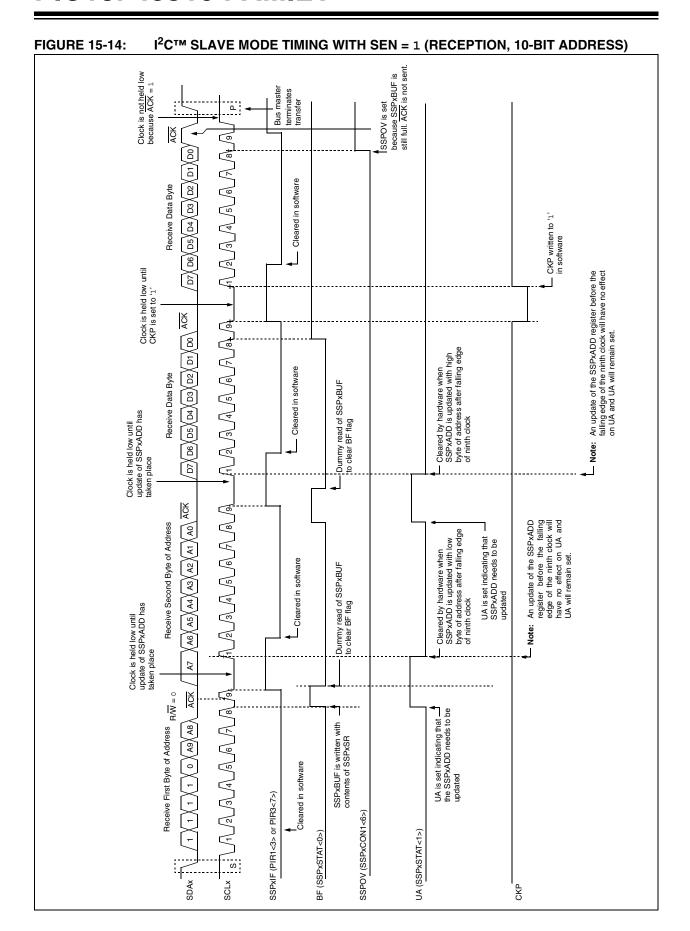
When the CKP bit is cleared, the SCLx output is forced to '0'. However, clearing the CKP bit will not assert the SCLx output low until the SCLx output is already sampled low. Therefore, the CKP bit will not assert the SCLx line until an external I²C master device has

already asserted the SCLx line. The SCLx output will remain low until the CKP bit is set and all other devices on the I²C bus have deasserted SCLx. This ensures that a write to the CKP bit will not violate the minimum high time requirement for SCLx (see Figure 15-12).

FIGURE 15-12: CLOCK SYNCHRONIZATION TIMING







15.4.5 GENERAL CALL ADDRESS SUPPORT

The addressing procedure for the I²C bus is such that the first byte after the Start condition usually determines which device will be the slave addressed by the master. The exception is the general call address which can address all devices. When this address is used, all devices should, in theory, respond with an Acknowledge.

The general call address is one of eight addresses reserved for specific purposes by the I^2C protocol. It consists of all '0's with $R/\overline{W} = 0$.

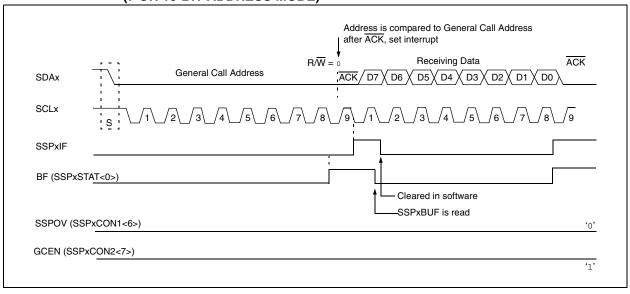
The general call address is recognized when the General Call Enable bit, GCEN, is enabled (SSPxCON2<7> set). Following a Start bit detect, 8 bits are shifted into the SSPxSR and the address is compared against the SSPxADD. It is also compared to the general call address and fixed in hardware.

If the general call address matches, the SSPxSR is transferred to the SSPxBUF, the BF flag bit is set (eighth bit) and on the falling edge of the ninth bit (ACK bit), the SSPxIF interrupt flag bit is set.

When the interrupt is serviced, the source for the interrupt can be checked by reading the contents of the SSPxBUF. The value can be used to determine if the address was device specific or a general call address.

In 10-bit mode, the SSPxADD is required to be updated for the second half of the address to match and the UA bit is set (SSPxSTAT<1>). If the general call address is sampled when the GCEN bit is set, while the slave is configured in 10-bit Address mode, then the second half of the address is not necessary, the UA bit will not be set and the slave will begin receiving data after the Acknowledge (Figure 15-15).

FIGURE 15-15: SLAVE MODE GENERAL CALL ADDRESS SEQUENCE (7 OR 10-BIT ADDRESS MODE)



15.4.6 MASTER MODE

Master mode is enabled by setting and clearing the appropriate SSPM bits in SSPxCON1 and by setting the SSPEN bit. In Master mode, the SCLx and SDAx lines are manipulated by the MSSP hardware.

Master mode of operation is supported by interrupt generation on the detection of the Start and Stop conditions. The Stop (P) and Start (S) bits are cleared from a Reset or when the MSSP module is disabled. Control of the I²C bus may be taken when the P bit is set, or the bus is Idle, with both the S and P bits clear.

In Firmware Controlled Master mode, user code conducts all $\rm I^2C$ bus operations based on Start and Stop bit conditions.

Once Master mode is enabled, the user has six options.

- 1. Assert a Start condition on SDAx and SCLx.
- Assert a Repeated Start condition on SDAx and SCLx.
- 3. Write to the SSPxBUF register initiating transmission of data/address.
- 4. Configure the I²C port to receive data.
- 5. Generate an Acknowledge condition at the end of a received byte of data.
- 6. Generate a Stop condition on SDAx and SCLx.

Note: The MSSP module, when configured in I²C Master mode, does not allow queueing of events. For instance, the user is not allowed to initiate a Start condition and immediately write the SSPxBUF register to initiate transmission before the Start condition is complete. In this case, the SSPxBUF will not be written to and the

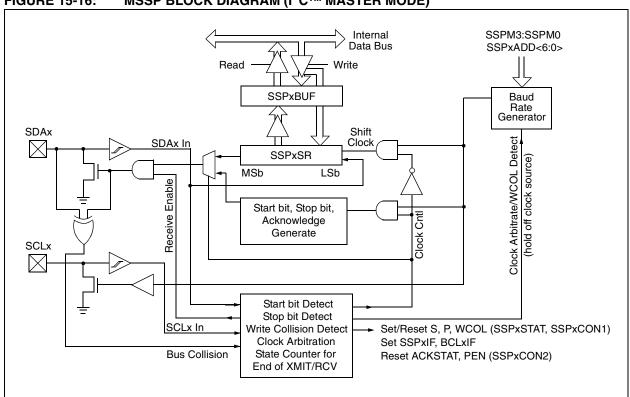
The following events will cause the MSSP Interrupt Flag bit, SSPxIF, to be set (and MSSP interrupt, if enabled):

to the SSPxBUF did not occur.

WCOL bit will be set, indicating that a write

- · Start condition
- · Stop condition
- Data transfer byte transmitted/received
- Acknowledge transmit
- Repeated Start

FIGURE 15-16: MSSP BLOCK DIAGRAM (I²C™ MASTER MODE)



15.4.6.1 I²C Master Mode Operation

The master device generates all of the serial clock pulses and the Start and Stop conditions. A transfer is ended with a Stop condition or with a Repeated Start condition. Since the Repeated Start condition is also the beginning of the next serial transfer, the I²C bus will not be released.

In Master Transmitter mode, serial data is output through SDAx, while SCLx outputs the serial clock. The first byte transmitted contains the slave <u>address</u> of the receiving device (7 bits) and the Read/Write (R/W) bit. In this case, the R/W bit will be logic '0'. Serial data is transmitted 8 bits at a time. After each byte is transmitted, an Acknowledge bit is received. Start and Stop conditions are output to indicate the beginning and the end of a serial transfer.

In Master Receive mode, the first byte transmitted contains the slave address of the transmitting device (7 bits) and the R/W bit. In this case, the R/W bit will be logic '1'. Thus, the first byte transmitted is a 7-bit slave address followed by a '1' to indicate the receive bit. Serial data is received via SDAx, while SCLx outputs the serial clock. Serial data is received 8 bits at a time. After each byte is received, an Acknowledge bit is transmitted. Start and Stop conditions indicate the beginning and end of transmission.

The Baud Rate Generator used for the SPI mode operation is used to set the SCLx clock frequency for either 100 kHz, 400 kHz or 1 MHz I²C operation. See **Section 15.4.7** "Baud Rate" for more detail.

A typical transmit sequence would go as follows:

- The user generates a Start condition by setting the Start Enable bit, SEN (SSPxCON2<0>).
- 2. SSPxIF is set. The MSSP module will wait the required start time before any other operation takes place.
- The user loads the SSPxBUF with the slave address to transmit.
- Address is shifted out the SDAx pin until all 8 bits are transmitted.
- 5. The MSSP module shifts in the ACK bit from the slave device and writes its value into the SSPxCON2 register (SSPxCON2<6>).
- The MSSP module generates an interrupt at the end of the ninth clock cycle by setting the SSPxIF bit.
- The user loads the SSPxBUF with eight bits of data.
- 8. Data is shifted out the SDAx pin until all 8 bits are transmitted.
- The MSSP module shifts in the ACK bit from the slave device and writes its value into the SSPxCON2 register (SSPxCON2<6>).
- The MSSP module generates an interrupt at the end of the ninth clock cycle by setting the SSPxIF bit.
- 11. The user generates a Stop condition by setting the Stop Enable bit, PEN (SSPxCON2<2>).
- 12. Interrupt is generated once the Stop condition is complete.

15.4.7 BAUD RATE

In I²C Master mode, the Baud Rate Generator (BRG) reload value is placed in the lower 7 bits of the SSPxADD register (Figure 15-17). When a write occurs to SSPxBUF, the Baud Rate Generator will automatically begin counting. The BRG counts down to '0' and stops until another reload has taken place. The BRG count is decremented twice per instruction cycle (TcY) on the Q2 and Q4 clocks. In I²C Master mode, the BRG is reloaded automatically.

Once the given operation is complete (i.e., transmission of the last data bit is followed by \overline{ACK}), the internal clock will automatically stop counting and the SCLx pin will remain in its last state.

Table 15-3 demonstrates clock rates based on instruction cycles and the BRG value loaded into SSPxADD.

15.4.7.1 Baud Rate and Module Interdependence

Because MSSP1 and MSSP2 are independent, they can operate simultaneously in I²C Master mode at different baud rates. This is done by using different BRG reload values for each module.

Because this mode derives its basic clock source from the system clock, any changes to the clock will affect both modules in the same proportion. It may be possible to change one or both baud rates back to a previous value by changing the BRG reload value.

FIGURE 15-17: BAUD RATE GENERATOR BLOCK DIAGRAM

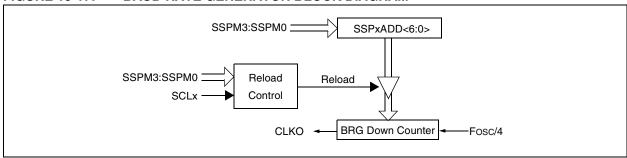


TABLE 15-3: I²C™ CLOCK RATE w/BRG

FcY	Fcy * 2	BRG Value	FSCL (2 Rollovers of BRG)
10 MHz	20 MHz	18h	400 kHz ⁽¹⁾
10 MHz	20 MHz	1Fh	312.5 kHz
10 MHz	20 MHz	63h	100 kHz
4 MHz	8 MHz	09h	400 kHz ⁽¹⁾
4 MHz	8 MHz	0Ch	308 kHz
4 MHz	8 MHz	27h	100 kHz
1 MHz	2 MHz	02h	333 kHz ⁽¹⁾
1 MHz	2 MHz	09h	100 kHz
1 MHz	2 MHz	00h	1 MHz ⁽¹⁾

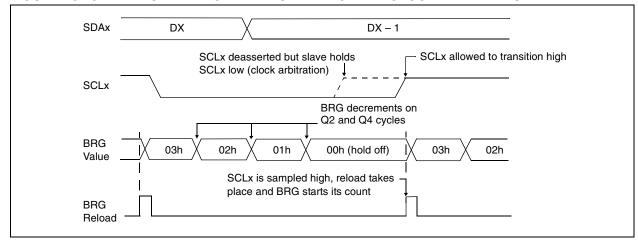
Note 1: The I²C[™] interface does not conform to the 400 kHz I²C specification (which applies to rates greater than 100 kHz) in all details, but may be used with care where higher rates are required by the application.

15.4.7.2 Clock Arbitration

Clock arbitration occurs when the master, during any receive, transmit or Repeated Start/Stop condition, deasserts the SCLx pin (SCLx allowed to float high). When the SCLx pin is allowed to float high, the Baud Rate Generator (BRG) is suspended from counting until the SCLx pin is actually sampled high. When the

SCLx pin is sampled high, the Baud Rate Generator is reloaded with the contents of SSPxADD<6:0> and begins counting. This ensures that the SCLx high time will always be at least one BRG rollover count in the event that the clock is held low by an external device (Figure 15-18).

FIGURE 15-18: BAUD RATE GENERATOR TIMING WITH CLOCK ARBITRATION



15.4.8 I²C MASTER MODE START CONDITION TIMING

To initiate a Start condition, the user sets the Start Enable bit, SEN (SSPxCON2<0>). If the SDAx and SCLx pins are sampled high, the Baud Rate Generator is reloaded with the contents of SSPxADD<6:0> and starts its count. If SCLx and SDAx are both sampled high when the Baud Rate Generator times out (TBRG), the SDAx pin is driven low. The action of the SDAx being driven low while SCLx is high is the Start condition and causes the S bit (SSPxSTAT<3>) to be set. Following this, the Baud Rate Generator is reloaded with the contents of SSPxADD<6:0> and resumes its count. When the Baud Rate Generator times out (TBRG), the SEN bit (SSPxCON2<0>) will be automatically cleared by hardware. The Baud Rate Generator is suspended, leaving the SDAx line held low and the Start condition is complete.

If at the beginning of the Start condition, the SDAx and SCLx pins are already sampled low, or if during the Start condition, the SCLx line is sampled low before the SDAx line is driven low, a bus collision occurs. The Bus Collision Interrupt Flag, BCLxIF, is set, the Start condition is aborted and the I²C module is reset into its Idle state.

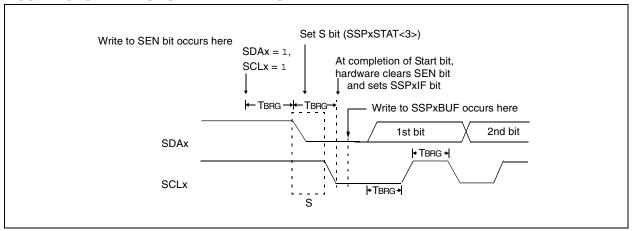
15.4.8.1 WCOL Status Flag

Note:

If the user writes the SSPxBUF when a Start sequence is in progress, the WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

Because queueing of events is not allowed, writing to the lower 5 bits of SSPxCON2 is disabled until the Start condition is complete.





15.4.9 I²C MASTER MODE REPEATED START CONDITION TIMING

A Repeated Start condition occurs when the RSEN bit (SSPxCON2<1>) is programmed high and the I²C logic module is in the Idle state. When the RSEN bit is set, the SCLx pin is asserted low. When the SCLx pin is sampled low, the Baud Rate Generator is loaded with the contents of SSPxADD<6:0> and begins counting. The SDAx pin is released (brought high) for one Baud Rate Generator count (TBRG). When the Baud Rate Generator times out, if SDAx is sampled high, the SCLx pin will be deasserted (brought high). When SCLx is sampled high, the Baud Rate Generator is reloaded with the contents of SSPxADD<6:0> and begins counting. SDAx and SCLx must be sampled high for one TBRG. This action is then followed by assertion of the SDAx pin (SDAx = 0) for one TBRG while SCLx is high. Following this, the RSEN bit (SSPxCON2<1>) will be automatically cleared and the Baud Rate Generator will not be reloaded, leaving the SDAx pin held low. As soon as a Start condition is detected on the SDAx and SCLx pins, the S bit (SSPxSTAT<3>) will be set. The SSPxIF bit will not be set until the Baud Rate Generator has timed out.

Note 1: If RSEN is programmed while any other event is in progress, it will not take effect.

- **2:** A bus collision during the Repeated Start condition occurs if:
 - SDAx is sampled low when SCLx goes from low-to-high.
 - SCLx goes low before SDAx is asserted low. This may indicate that another master is attempting to transmit a data '1'.

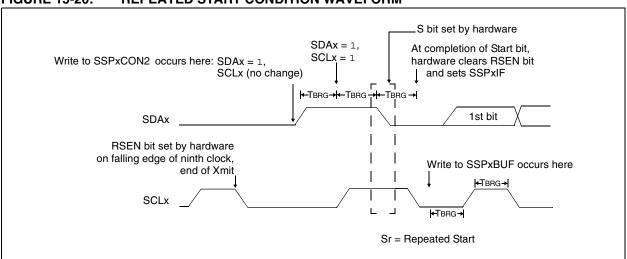
Immediately following the SSPxIF bit getting set, the user may write the SSPxBUF with the 7-bit address in 7-bit mode or the default first address in 10-bit mode. After the first eight bits are transmitted and an ACK is received, the user may then transmit an additional eight bits of address (10-bit mode) or eight bits of data (7-bit mode).

15.4.9.1 WCOL Status Flag

If the user writes the SSPxBUF when a Repeated Start sequence is in progress, the WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

Note: Because queueing of events is not allowed, writing of the lower 5 bits of SSPxCON2 is disabled until the Repeated Start condition is complete.





15.4.10 I²C MASTER MODE TRANSMISSION

Transmission of a data byte, a 7-bit address or the other half of a 10-bit address is accomplished by simply writing a value to the SSPxBUF register. This action will set the Buffer Full flag bit, BF and allow the Baud Rate Generator to begin counting and start the next transmission. Each bit of address/data will be shifted out onto the SDAx pin after the falling edge of SCLx is asserted (see data hold time specification parameter 106). SCLx is held low for one Baud Rate Generator rollover count (TBRG). Data should be valid before SCLx is released high (see data setup time specification parameter 107). When the SCLx pin is released high, it is held that way for TBRG. The data on the SDAx pin must remain stable for that duration and some hold time after the next falling edge of SCLx. After the eighth bit is shifted out (the falling edge of the eighth clock), the BF flag is cleared and the master releases SDAx. This allows the slave device being addressed to respond with an ACK bit during the ninth bit time if an address match occurred, or if data was received properly. The status of ACK is written into the ACKDT bit on the falling edge of the ninth clock. If the master receives an Acknowledge, the Acknowledge Status bit, ACKSTAT, is cleared; if not, the bit is set. After the ninth clock, the SSPxIF bit is set and the master clock (Baud Rate Generator) is suspended until the next data byte is loaded into the SSPxBUF, leaving SCLx low and SDAx unchanged (Figure 15-21).

After the write to the SSPxBUF, each bit of the address will be shifted out on the falling edge of SCLx until all seven address bits and the R/W bit are completed. On the falling edge of the eighth clock, the master will deassert the SDAx pin, allowing the slave to respond with an Acknowledge. On the falling edge of the ninth clock, the master will sample the SDAx pin to see if the address was recognized by a slave. The status of the ACK bit is loaded into the ACKSTAT status bit (SSPxCON2<6>). Following the falling edge of the ninth clock transmission of the address, the SSPxIF is set, the BF flag is cleared and the Baud Rate Generator is turned off until another write to the SSPxBUF takes place, holding SCLx low and allowing SDAx to float.

15.4.10.1 BF Status Flag

In Transmit mode, the BF bit (SSPxSTAT<0>) is set when the CPU writes to SSPxBUF and is cleared when all 8 bits are shifted out.

15.4.10.2 WCOL Status Flag

If the user writes to the SSPxBUF when a transmit is already in progress (i.e., SSPxSR is still shifting out a data byte), the WCOL is set and the contents of the buffer are unchanged (the write doesn't occur) after 2 Tcy after the SSPxBUF write. If SSPxBUF is rewritten within 2 Tcy, the WCOL bit is set and SSPxBUF is updated. This may result in a corrupted transfer.

The user should verify that the WCOL is clear after each write to SSPxBUF to ensure the transfer is correct. In all cases, WCOL must be cleared in software.

15.4.10.3 ACKSTAT Status Flag

In Transmit mode, the ACKSTAT bit (SSPxCON2<6>) is cleared when the slave has sent an Acknowledge $(\overline{ACK} = 0)$ and is set when the slave does not Acknowledge $(\overline{ACK} = 1)$. A slave sends an Acknowledge when it has recognized its address (including a general call), or when the slave has properly received its data.

15.4.11 I²C MASTER MODE RECEPTION

Master mode reception is enabled by programming the Receive Enable bit, RCEN (SSPxCON2<3>).

Note: The MSSP module must be in an Idle state before the RCEN bit is set or the RCEN bit will be disregarded.

The Baud Rate Generator begins counting and on each rollover, the state of the SCLx pin changes (high-to-low/low-to-high) and data is shifted into the SSPxSR. After the falling edge of the eighth clock, the receive enable flag is automatically cleared, the contents of the SSPxSR are loaded into the SSPxBUF, the BF flag bit is set, the SSPxIF flag bit is set and the Baud Rate Generator is suspended from counting, holding SCLx low. The MSSP is now in Idle state awaiting the next command. When the buffer is read by the CPU, the BF flag bit is automatically cleared. The user can then send an Acknowledge bit at the end of reception by setting the Acknowledge Sequence Enable bit, ACKEN (SSPxCON2<4>).

15.4.11.1 BF Status Flag

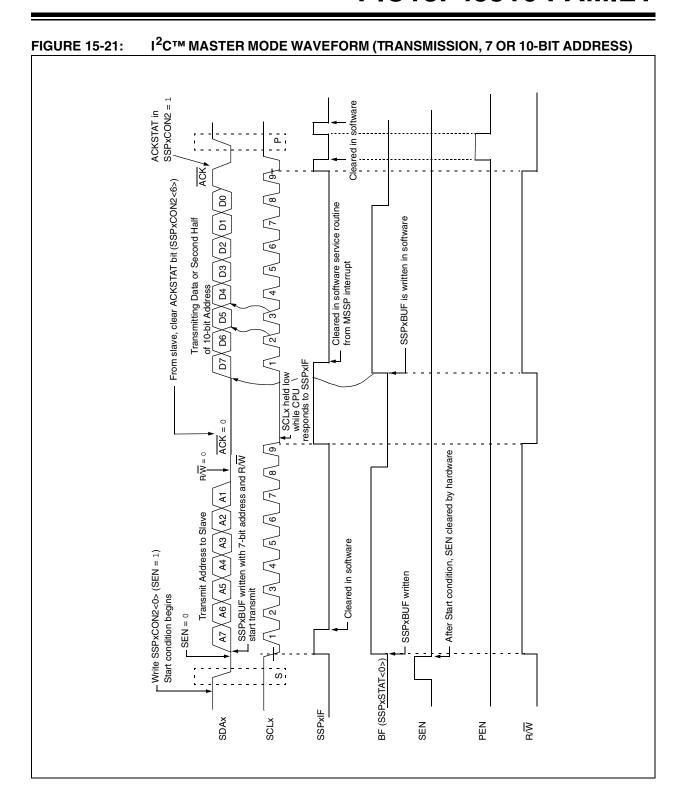
In receive operation, the BF bit is set when an address or data byte is loaded into SSPxBUF from SSPxSR. It is cleared when the SSPxBUF register is read.

15.4.11.2 SSPOV Status Flag

In receive operation, the SSPOV bit is set when 8 bits are received into the SSPxSR and the BF flag bit is already set from a previous reception.

15.4.11.3 WCOL Status Flag

If the user writes the SSPxBUF when a receive is already in progress (i.e., SSPxSR is still shifting in a data byte), the WCOL bit is set and the contents of the buffer are unchanged (the write doesn't occur).



I²C™ MASTER MODE WAVEFORM (RECEPTION, 7-BIT ADDRESS) FIGURE 15-22: Set SSPxIF interrupt at end of Acknow-ledge sequence Bus master terminates transfer Set P bit (SSPxSTAT<4>) and SSPxIF PEN bit = 1 written here Set ACKEN, start Acknowledge sequence SDAx = ACKDT = 1 ACK is not sent SSPOV is set because SSPxBUF is still full Set SSPxIF at end of receive 6 RCEN cleared automatically 71/2/3/4/45/6/7/8 D7\D6\D5\D4\D3\D2\D1 Data shifted in on falling edge of CLK Receiving Data from Slave Set SSPxIF interrupt at end of Acknowledge sequence Cleared in software Last bit is shifted into SSPxSR and contents are unloaded into SSPxBUF Write to SSPxCON2<4>
to start Acknowledge sequence
SDAx = ACKDT (SSPxCON2<5>) = 0 RCEN = 1, start next receive ACK from Master, SDAx = ACKDT = 0 6 Cleared in software RCEN cleared automatically 7\2\3\4\5\6\7\8\ Master configured as a receiver by programming SSPxCON2<3> (RCEN = 1) D6\D5\D4\D3\D2\D1\ Set SSPxIF interrupt at end of receive Cleared in software 24 ACK ACK from Slave 72/3/4/5/6/7/8/9 —Write to SSPxBUF occurs here, (A6)\A5)\A4)\A3\A2) Cleared in software Write to SSPxCON2<0> (SEN = 1), start XMIT begin Start condition SDAx = 0, SCLx = 1 while CPU responds to SSPxIF BF (SSPxSTAT<0>) S SSPOV ACKEN-SSPxIF SDAx SCLx

15.4.12 ACKNOWLEDGE SEQUENCE TIMING

An Acknowledge sequence is enabled by setting the Acknowledge Sequence Enable bit. **ACKEN** (SSPxCON2<4>). When this bit is set, the SCLx pin is pulled low and the contents of the Acknowledge data bit are presented on the SDAx pin. If the user wishes to generate an Acknowledge, then the ACKDT bit should be cleared. If not, the user should set the ACKDT bit before starting an Acknowledge sequence. The Baud Rate Generator then counts for one rollover period (TBRG) and the SCLx pin is deasserted (pulled high). When the SCLx pin is sampled high (clock arbitration), the Baud Rate Generator counts for TBRG. The SCLx pin is then pulled low. Following this, the ACKEN bit is automatically cleared, the Baud Rate Generator is turned off and the MSSP module then goes into Idle mode (Figure 15-23).

15.4.12.1 WCOL Status Flag

If the user writes the SSPxBUF when an Acknowledge sequence is in progress, then WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

15.4.13 STOP CONDITION TIMING

A Stop bit is asserted on the SDAx pin at the end of a receive/transmit by setting the Stop Sequence Enable bit, PEN (SSPxCON2<2>). At the end of a receive/transmit, the SCLx line is held low after the falling edge of the ninth clock. When the PEN bit is set, the master will assert the SDAx line low. When the SDAx line is sampled low, the Baud Rate Generator is reloaded and counts down to '0'. When the Baud Rate Generator times out, the SCLx pin will be brought high and one TBRG (Baud Rate Generator rollover count) later, the SDAx pin will be deasserted. When the SDAx pin is sampled high while SCLx is high, the P bit (SSPxSTAT<4>) is set. A TBRG later, the PEN bit is cleared and the SSPxIF bit is set (Figure 15-24).

15.4.13.1 WCOL Status Flag

If the user writes the SSPxBUF when a Stop sequence is in progress, then the WCOL bit is set and the contents of the buffer are unchanged (the write doesn't occur).



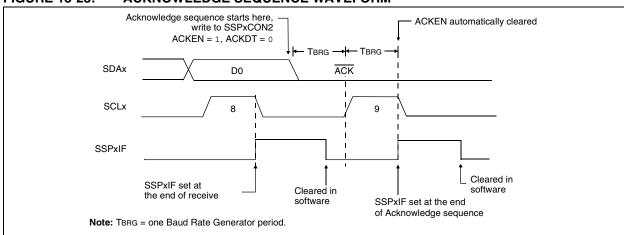
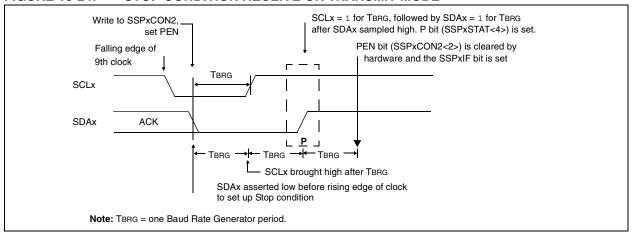


FIGURE 15-24: STOP CONDITION RECEIVE OR TRANSMIT MODE



15.4.14 SLEEP OPERATION

While in Sleep mode, the I²C module can receive addresses or data and when an address match or complete byte transfer occurs, wake the processor from Sleep (if the MSSP interrupt is enabled).

15.4.15 EFFECTS OF A RESET

A Reset disables the MSSP module and terminates the current transfer.

15.4.16 MULTI-MASTER MODE

In Multi-Master mode, the interrupt generation on the detection of the Start and Stop conditions allows the determination of when the bus is free. The Stop (P) and Start (S) bits are cleared from a Reset or when the MSSP module is disabled. Control of the I²C bus may be taken when the P bit (SSPxSTAT<4>) is set, or the bus is Idle, with both the S and P bits clear. When the bus is busy, enabling the MSSP interrupt will generate the interrupt when the Stop condition occurs.

In multi-master operation, the SDAx line must be monitored for arbitration to see if the signal level is the expected output level. This check is performed in hardware with the result placed in the BCLxIF bit.

The states where arbitration can be lost are:

- · Address Transfer
- Data Transfer
- · A Start Condition
- · A Repeated Start Condition
- · An Acknowledge Condition

15.4.17 MULTI -MASTER COMMUNICATION, BUS COLLISION AND BUS ARBITRATION

Multi-Master mode support is achieved by bus arbitration. When the master outputs address/data bits onto the SDAx pin, arbitration takes place when the master outputs a '1' on SDAx, by letting SDAx float high and another master asserts a '0'. When the SCLx pin floats high, data should be stable. If the expected data on SDAx is a '1' and the data sampled on the SDAx pin = 0, then a bus collision has taken place. The master will set the Bus Collision Interrupt Flag, BCLxIF and reset the I 2 C port to its Idle state (Figure 15-25).

If a transmit was in progress when the bus collision occurred, the transmission is halted, the BF flag is cleared, the SDAx and SCLx lines are deasserted and the SSPxBUF can be written to. When the user services the bus collision Interrupt Service Routine and if the $\rm I^2C$ bus is free, the user can resume communication by asserting a Start condition.

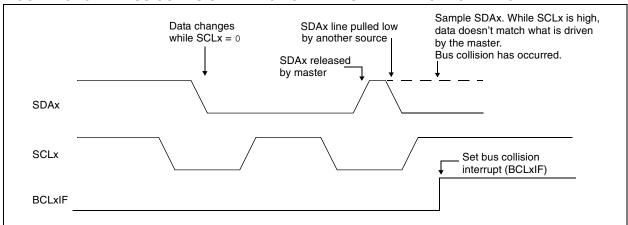
If a Start, Repeated Start, Stop or Acknowledge condition was in progress when the bus collision occurred, the condition is aborted, the SDAx and SCLx lines are deasserted and the respective control bits in the SSPxCON2 register are cleared. When the user services the bus collision Interrupt Service Routine and if the I²C bus is free, the user can resume communication by asserting a Start condition.

The master will continue to monitor the SDAx and SCLx pins. If a Stop condition occurs, the SSPxIF bit will be set.

A write to the SSPxBUF will start the transmission of data at the first data bit regardless of where the transmitter left off when the bus collision occurred.

In Multi-Master mode, the interrupt generation on the detection of Start and Stop conditions allows the determination of when the bus is free. Control of the I²C bus can be taken when the P bit is set in the SSPxSTAT register, or the bus is Idle and the S and P bits are cleared.





15.4.17.1 Bus Collision During a Start Condition

During a Start condition, a bus collision occurs if:

- a) SDAx or SCLx are sampled low at the beginning of the Start condition (Figure 15-26).
- b) SCLx is sampled low before SDAx is asserted low (Figure 15-27).

During a Start condition, both the SDAx and the SCLx pins are monitored.

If the SDAx pin is already low, or the SCLx pin is already low, then all of the following occur:

- the Start condition is aborted;
- · the BCLxIF flag is set; and
- the MSSP module is reset to its Idle state (Figure 15-26).

The Start condition begins with the SDAx and SCLx pins deasserted. When the SDAx pin is sampled high, the Baud Rate Generator is loaded from SSPxADD<6:0> and counts down to '0'. If the SCLx pin is sampled low while SDAx is high, a bus collision occurs, because it is assumed that another master is attempting to drive a data '1' during the Start condition.

If the SDAx pin is sampled low during this count, the BRG is reset and the SDAx line is asserted early (Figure 15-28). If, however, a '1' is sampled on the SDAx pin, the SDAx pin is asserted low at the end of the BRG count. The Baud Rate Generator is then reloaded and counts down to '0'. If the SCLx pin is sampled as '0' during this time, a bus collision does not occur. At the end of the BRG count, the SCLx pin is asserted low.

Note:

The reason that bus collision is not a factor during a Start condition is that no two bus masters can assert a Start condition at the exact same time. Therefore, one master will always assert SDAx before the other. This condition does not cause a bus collision because the two masters must be allowed to arbitrate the first address following the Start condition. If the address is the same, arbitration must be allowed to continue into the data portion, Repeated Start or Stop conditions.



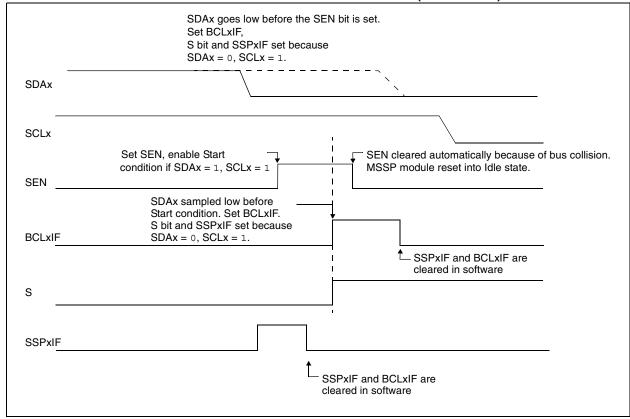


FIGURE 15-27: BUS COLLISION DURING START CONDITION (SCLx = 0)

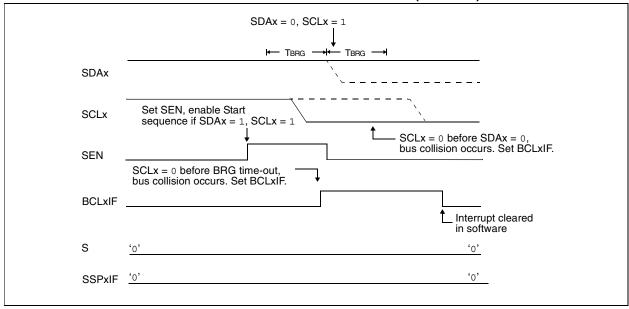
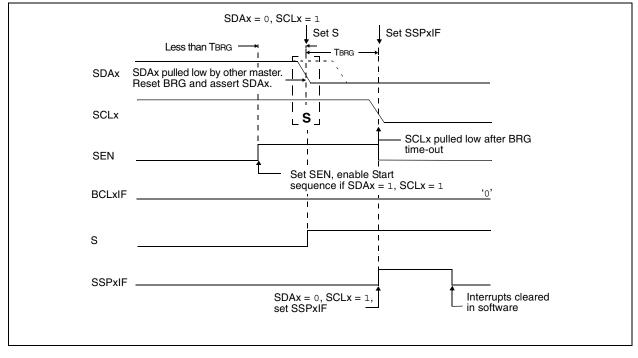


FIGURE 15-28: BRG RESET DUE TO SDAX ARBITRATION DURING START CONDITION



15.4.17.2 Bus Collision During a Repeated Start Condition

During a Repeated Start condition, a bus collision occurs if:

- a) A low level is sampled on SDAx when SCLx goes from low level to high level.
- SCLx goes low before SDAx is asserted low, indicating that another master is attempting to transmit a data '1'.

When the user deasserts SDAx and the pin is allowed to float high, the BRG is loaded with SSPxADD<6:0> and counts down to '0'. The SCLx pin is then deasserted and when sampled high, the SDAx pin is sampled.

If SDAx is low, a bus collision has occurred (i.e., another master is attempting to transmit a data '0', see Figure 15-29). If SDAx is sampled high, the BRG is reloaded and begins counting. If SDAx goes from high-to-low before the BRG times out, no bus collision occurs because no two masters can assert SDAx at exactly the same time.

If SCLx goes from high-to-low before the BRG times out and SDAx has not already been asserted, a bus collision occurs. In this case, another master is attempting to transmit a data '1' during the Repeated Start condition (see Figure 15-30).

If, at the end of the BRG time-out, both SCLx and SDAx are still high, the SDAx pin is driven low and the BRG is reloaded and begins counting. At the end of the count, regardless of the status of the SCLx pin, the SCLx pin is driven low and the Repeated Start condition is complete.

FIGURE 15-29: BUS COLLISION DURING A REPEATED START CONDITION (CASE 1)

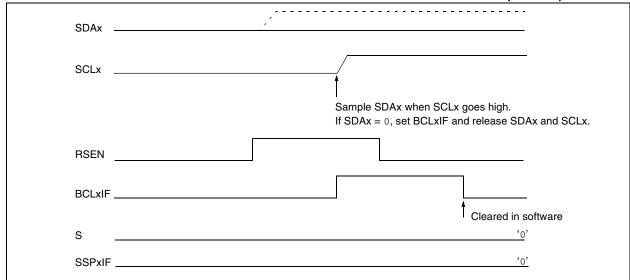
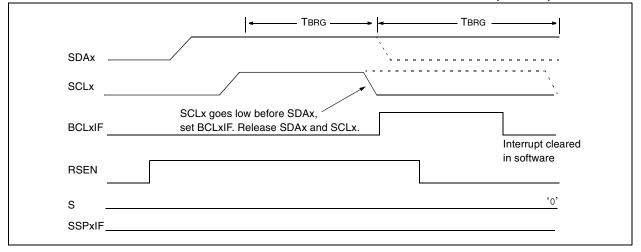


FIGURE 15-30: BUS COLLISION DURING REPEATED START CONDITION (CASE 2)



15.4.17.3 Bus Collision During a Stop Condition

Bus collision occurs during a Stop condition if:

- After the SDAx pin has been deasserted and allowed to float high, SDAx is sampled low after the BRG has timed out.
- b) After the SCLx pin is deasserted, SCLx is sampled low before SDAx goes high.

The Stop condition begins with SDAx asserted low. When SDAx is sampled low, the SCLx pin is allowed to float. When the pin is sampled high (clock arbitration), the Baud Rate Generator is loaded with SSPxADD<6:0> and counts down to '0'. After the BRG times out, SDAx is sampled. If SDAx is sampled low, a bus collision has occurred. This is due to another master attempting to drive a data '0' (Figure 15-31). If the SCLx pin is sampled low before SDAx is allowed to float high, a bus collision occurs. This is another case of another master attempting to drive a data '0' (Figure 15-32).

FIGURE 15-31: BUS COLLISION DURING A STOP CONDITION (CASE 1)

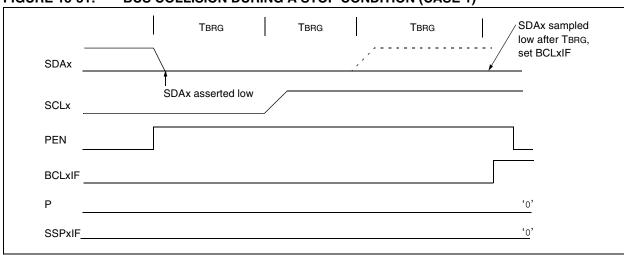


FIGURE 15-32: BUS COLLISION DURING A STOP CONDITION (CASE 2)

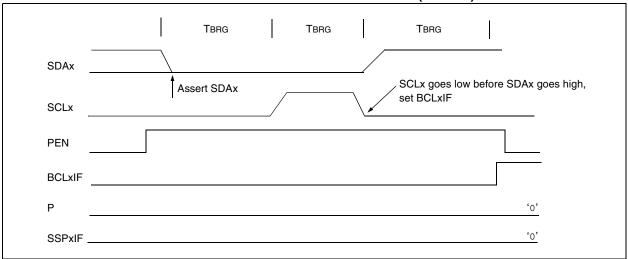


TABLE 15-4: REGISTERS ASSOCIATED WITH I²C™ OPERATION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page			
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	43			
PIR1	PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	45			
PIE1	PSPIE ⁽¹⁾	ADIE	RCIE	TXIE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	45			
IPR1	PSPIP ⁽¹⁾	ADIP	RCIP	TXIP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	45			
PIR2	OSCFIF	CMIF	_	_	BCL1IF	_	_	CCP2IF	45			
PIE2	OSCFIE	CMIE	_	_	BCL1IE	_	_	CCP2IE	45			
IPR2	OSCFIP	CMIP	_	_	BCL1IP	_	_	CCP2IP	45			
PIR3	SSP2IF	BCL2IF	_	_	_	_	_	_	45			
PIE3	SSP2IE	BCL2IE	_	_	_	_	_	_	45			
IPR3	SSP2IP	BCL2IP	_	_	_	_	_	_	45			
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	46			
TRISD ⁽¹⁾	TRISD7	TRISD6	TRISD5	TRISD4	TRISD3	TRISD2	TRISD1	TRISD0	46			
SSP1BUF	MSSP1 Re	ceive Buffer	Transmit R	egister					44			
SSP1ADD	MSSP1 Ad MSSP1 Ba	dress Regist ud Rate Rel	ter (I ² C™ S oad Registe	lave mode). er (l ² C Maste	er mode).				44			
SSP1CON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	44			
SSP1CON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	44			
SSP1STAT	SMP	CKE	D/A	Р	S	R/W	UA	BF	44			
SSP2BUF	MSSP2 Re	ceive Buffer	Transmit R	egister					46			
SSP2ADD		MSSP2 Address Register (I ² C Slave mode). MSSP2 Baud Rate Reload Register (I ² C Master mode).										
SSP2CON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	46			
SSP2CON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	46			
SSP2STAT	SMP	CKE	D/A	Р	S	R/W	UA	BF	46			

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the MSSP module in I^2C^{TM} mode.

NOTES:

16.0 ENHANCED UNIVERSAL SYNCHRONOUS ASYNCHRONOUS RECEIVER TRANSMITTER (EUSART)

The Enhanced Universal Synchronous Asynchronous Receiver Transmitter (EUSART) module is one of the two serial I/O modules. (Generically, the USART is also known as a Serial Communications Interface or SCI.) The EUSART can be configured as a full-duplex asynchronous system that can communicate with peripheral devices, such as CRT terminals and personal computers. It can also be configured as a half-duplex synchronous system that can communicate with peripheral devices, such as A/D or D/A integrated circuits, serial EEPROMs, etc.

The Enhanced USART module implements additional features, including automatic baud rate detection and calibration, automatic wake-up on Sync Break reception and 12-bit Break character transmit. These make it ideally suited for use in Local Interconnect Network bus (LIN bus) systems.

The EUSART can be configured in the following modes:

- Asynchronous (full duplex) with:
 - Auto-wake-up on character reception
 - Auto-baud calibration
 - 12-bit Break character transmission
- Synchronous Master (half duplex) with selectable clock polarity
- Synchronous Slave (half duplex) with selectable clock polarity

The pins of the Enhanced USART are multiplexed with PORTC. In order to configure RC6/TX/CK and RC7/RX/DT as an EUSART:

- bit SPEN (RCSTA<7>) must be set (= 1)
- bit TRISC<7> must be set (= 1)
- bit TRISC<6> must be set (= 1)

Note: The EUSART control will automatically reconfigure the pin from input to output as needed.

The operation of the Enhanced USART module is controlled through three registers:

- Transmit Status and Control (TXSTA)
- Receive Status and Control (RCSTA)
- Baud Rate Control (BAUDCON)

These are detailed on the following pages in Register 16-1, Register 16-2 and Register 16-3, respectively.

REGISTER 16-1: TXSTA: TRANSMIT STATUS AND CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-1	R/W-0
CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D

bit 7

bit 7 CSRC: Clock Source Select bit

Asynchronous mode:

Don't care.

Synchronous mode:

1 = Master mode (clock generated internally from BRG)

0 = Slave mode (clock from external source)

bit 6 TX9: 9-bit Transmit Enable bit

1 = Selects 9-bit transmission

0 = Selects 8-bit transmission

bit 5 **TXEN:** Transmit Enable bit

1 = Transmit enabled

0 = Transmit disabled

Note: SREN/CREN overrides TXEN in Sync mode.

bit 4 SYNC: EUSART Mode Select bit

1 = Synchronous mode

0 = Asynchronous mode

bit 3 SENDB: Send Break Character bit

Asynchronous mode:

1 = Send Sync Break on next transmission (cleared by hardware upon completion)

0 = Sync Break transmission completed

Synchronous mode:

Don't care.

bit 2 BRGH: High Baud Rate Select bit

Asynchronous mode:

1 = High speed

0 = Low speed

Synchronous mode:

Unused in this mode.

bit 1 TRMT: Transmit Shift Register Status bit

1 = TSR empty

0 = TSR full

bit 0 **TX9D:** 9th bit of Transmit Data

Can be address/data bit or a parity bit.

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

RCSTA: RECEIVE STATUS AND CONTROL REGISTER **REGISTER 16-2:**

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-0	R-0	R-x
SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D
bit 7							bit 0

bit 0

- bit 7 SPEN: Serial Port Enable bit
 - 1 = Serial port enabled (configures RX/DT and TX/CK pins as serial port pins)
 - 0 = Serial port disabled (held in Reset)
- bit 6 RX9: 9-bit Receive Enable bit
 - 1 = Selects 9-bit reception
 - 0 = Selects 8-bit reception
- SREN: Single Receive Enable bit bit 5

Asynchronous mode:

Don't care.

Synchronous mode - Master:

- 1 = Enables single receive
- 0 = Disables single receive

This bit is cleared after reception is complete.

Synchronous mode - Slave:

Don't care.

bit 4 **CREN:** Continuous Receive Enable bit

Asynchronous mode:

- 1 = Enables receiver
- 0 = Disables receiver

Synchronous mode:

- 1 = Enables continuous receive until enable bit CREN is cleared (CREN overrides SREN)
- 0 = Disables continuous receive
- bit 3 **ADDEN:** Address Detect Enable bit

Asynchronous mode 9-bit (RX9 = 1):

- 1 = Enables address detection, enables interrupt and loads the receive buffer when RSR<8> is set
- 0 = Disables address detection, all bytes are received and ninth bit can be used as parity bit

Asynchronous mode 9-bit (RX9 = 0): Don't care.

- bit 2 FERR: Framing Error bit
 - 1 = Framing error (can be updated by reading RCREG register and receiving next valid byte)
 - 0 = No framing error
- **OERR:** Overrun Error bit bit 1
 - 1 = Overrun error (can be cleared by clearing bit CREN)
 - 0 = No overrun error
- bit 0 RX9D: 9th bit of Received Data

This can be address/data bit or a parity bit and must be calculated by user firmware.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

REGISTER 16-3: **BAUDCON: BAUD RATE CONTROL REGISTER**

R/W-0	R-1	U-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0
ABDOVF	RCIDL	_	SCKP	BRG16	_	WUE	ABDEN
bit 7							bit 0

bit 0

bit 7 ABDOVF: Auto-Baud Acquisition Rollover Status bit

> 1 = A BRG rollover has occurred during Auto-Baud Rate Detect mode (must be cleared in software)

0 = No BRG rollover has occurred

bit 6

RCIDL: Receive Operation Idle Status bit

1 = Receive operation is Idle 0 = Receive operation is active

bit 5 Unimplemented: Read as '0'

bit 4 SCKP: Synchronous Clock Polarity Select bit

Asynchronous mode:

Unused in this mode.

Synchronous mode:

1 = Idle state for clock (CK) is a high level 0 = Idle state for clock (CK) is a low level

bit 3 BRG16: 16-bit Baud Rate Register Enable bit

1 = 16-bit Baud Rate Generator - SPBRGH and SPBRG

0 = 8-bit Baud Rate Generator - SPBRG only (Compatible mode), SPBRGH value ignored

bit 2 Unimplemented: Read as '0'

bit 1 WUE: Wake-up Enable bit

Asynchronous mode:

1 = EUSART will continue to sample the RX pin - interrupt generated on falling edge; bit cleared in hardware on following rising edge

0 = RX pin not monitored or rising edge detected

Synchronous mode:

Unused in this mode.

bit 0 **ABDEN:** Auto-Baud Detect Enable bit

Asynchronous mode:

1 = Enable baud rate measurement on the next character. Requires reception of a Sync field (55h); cleared in hardware upon completion

0 = Baud rate measurement disabled or completed

Synchronous mode:

Unused in this mode.

Lea	eı	nd	:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

16.1 Baud Rate Generator (BRG)

The BRG is a dedicated 8-bit or 16-bit generator that supports both the Asynchronous and Synchronous modes of the EUSART. By default, the BRG operates in 8-bit mode; setting the BRG16 bit (BAUDCON<3>) selects 16-bit mode.

The SPBRGH:SPBRG register pair controls the period of a free running timer. In Asynchronous mode, bits BRGH (TXSTA<2>) and BRG16 (BAUDCON<3>) also control the baud rate. In Synchronous mode, BRGH is ignored. Table 16-1 shows the formula for computation of the baud rate for different EUSART modes which only apply in Master mode (internally generated clock).

Given the desired baud rate and Fosc, the nearest integer value for the SPBRGH:SPBRG registers can be calculated using the formulas in Table 16-1. From this, the error in baud rate can be determined. An example calculation is shown in Example 16-1. Typical baud rates and error values for the various Asynchronous modes are shown in Table 16-2. It may be advan-

tageous to use the high baud rate (BRGH = 1) or the 16-bit BRG to reduce the baud rate error, or achieve a slow baud rate for a fast oscillator frequency.

Writing a new value to the SPBRGH:SPBRG registers causes the BRG timer to be reset (or cleared). This ensures the BRG does not wait for a timer overflow before outputting the new baud rate.

16.1.1 OPERATION IN POWER-MANAGED MODES

The device clock is used to generate the desired baud rate. When one of the power-managed modes is entered, the new clock source may be operating at a different frequency. This may require an adjustment to the value in the SPBRG register pair.

16.1.2 SAMPLING

The data on the RX pin is sampled three times by a majority detect circuit to determine if a high or a low level is present at the RX pin.

TABLE 16-1: BAUD RATE FORMULAS

C	onfiguration B	its	BRG/EUSART Mode	Baud Rate Formula		
SYNC	BRG16	BRGH	BRG/EUSART Mode	Dauu nate Formula		
0	0	0	8-bit/Asynchronous	Fosc/[64 (n + 1)]		
0	0	1	8-bit/Asynchronous	F000/[16 (n + 1)]		
0	1	0	16-bit/Asynchronous	Fosc/[16 (n + 1)]		
0	1	1	16-bit/Asynchronous			
1	0 x		8-bit/Synchronous	Fosc/[4 (n + 1)]		
1	1 1 x		16-bit/Synchronous			

Legend: x = Don't care, n = value of SPBRGH:SPBRG register pair

EXAMPLE 16-1: CALCULATING BAUD RATE ERROR

For a device with Fosc of 16 MHz, desired baud rate of 9600, Asynchronous mode, 8-bit BRG:

= Fosc/(64 ([SPBRGH:SPBRG] + 1))Desired Baud Rate

Solving for SPBRGH:SPBRG:

= ((Fosc/Desired Baud Rate)/64) - 1

= ((16000000/9600)/64) - 1

= [25.042] = 25

Calculated Baud Rate = 16000000/(64 (25 + 1))

= 9615

Error = (Calculated Baud Rate – Desired Baud Rate)/Desired Baud Rate

= (9615 - 9600)/9600 = 0.16%

REGISTERS ASSOCIATED WITH BAUD RATE GENERATOR **TABLE 16-2:**

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
TXSTA	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	45
RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	45
BAUDCON	ABDOVF	RCIDL	_	SCKP	BRG16	_	WUE	ABDEN	45
SPBRGH	EUSART B		45						
SPBRG	EUSART B	aud Rate G	enerator R	egister Low	Byte				45

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the BRG.

TABLE 16-3: BAUD RATES FOR ASYNCHRONOUS MODES

					SYNC	= 0, BRGH	d = 0, BRG	316 = 0				
BAUD RATE	Fosc	= 40.000) MHz	Fosc = 20.000 MHz			Fosc	= 10.000) MHz	Fosc = 8.000 MHz		
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	Rate From v		Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)
0.3	_		_	_	_	_	_		_	_	_	_
1.2	_	_	_	1.221	1.73	255	1.202	0.16	129	1201	-0.16	103
2.4	2.441	1.73	255	2.404	0.16	129	2.404	0.16	64	2403	-0.16	51
9.6	9.615	0.16	64	9.766	1.73	31	9.766	1.73	15	9615	-0.16	12
19.2	19.531	1.73	31	19.531	1.73	15	19.531	1.73	7	_	_	_
57.6	56.818	-1.36	10	62.500	8.51	4	52.083	-9.58	2	_	_	_
115.2	125.000	8.51	4	104.167	-9.58	2	78.125	-32.18	1	_		_

		SYNC = 0, BRGH = 0, BRG16 = 0											
BAUD	Fos	c = 4.000	MHz	Fos	c = 2.000	MHz	Fos	Fosc = 1.000 MHz					
RATE (K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)				
0.3	0.300	0.16	207	300	-0.16	103	300	-0.16	51				
1.2	1.202	0.16	51	1201	-0.16	25	1201	-0.16	12				
2.4	2.404	0.16	25	2403	-0.16	12	_	_	_				
9.6	8.929	-6.99	6	_	_	_	_	_	_				
19.2	20.833	8.51	2	_	_	_	_	_	_				
57.6	62.500	8.51	0	_	_	_	_	_	_				
115.2	62.500	-45.75	0	_	_	_	_	_	_				

		SYNC = 0, BRGH = 1, BRG16 = 0													
BAUD	Fosc	= 40.000) MHz	Fosc = 20.000 MHz			Fosc = 10.000 MHz			Fosc = 8.000 MHz					
RATE (K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)			
0.3	_	_	_	_	_	_	_	_	_	_	_	_			
1.2	_	_	_	_	_	_	_	_	_	_	_	_			
2.4	_	_	_	_	_	_	2.441	1.73	255	2403	-0.16	207			
9.6	9.766	1.73	255	9.615	0.16	129	9.615	0.16	64	9615	-0.16	51			
19.2	19.231	0.16	129	19.231	0.16	64	19.531	1.73	31	19230	-0.16	25			
57.6	58.140	0.94	42	56.818	-1.36	21	56.818	-1.36	10	55555	3.55	8			
115.2	113.636	-1.36	21	113.636	-1.36	10	125.000	8.51	4	_	_	_			

			s	YNC = 0, E	BRGH = 1	, BRG16 =	0		
BAUD RATE	Fosc	= 4.000	MHz	Fos	c = 2.000	MHz	Fosc = 1.000 MHz		
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	Rate Frror		Actual Rate (K)	% Error	SPBRG value (decimal)
0.3	_	_	_		_	_	300	-0.16	207
1.2	1.202	0.16	207	1201	-0.16	103	1201	-0.16	51
2.4	2.404	0.16	103	2403	-0.16	51	2403	-0.16	25
9.6	9.615	0.16	25	9615	-0.16	12	_	_	_
19.2	19.231	0.16	12	_	_	_	_	_	_
57.6	62.500	8.51	3	_	_	_	_	_	_
115.2	125.000	8.51	1	_	_	_	_	_	_

TABLE 16-3: BAUD RATES FOR ASYNCHRONOUS MODES (CONTINUED)

					SYNC	= 0, BRG	l = 0, BRG	16 = 1				
BAUD RATE	Fosc	= 40.000) MHz	Fosc = 20.000 MHz			Fosc	= 10.000) MHz	Fosc = 8.000 MHz		
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)									
0.3	0.300	0.00	8332	0.300	0.02	4165	0.300	0.02	2082	300	-0.04	1665
1.2	1.200	0.02	2082	1.200	-0.03	1041	1.200	-0.03	520	1201	-0.16	415
2.4	2.402	0.06	1040	2.399	-0.03	520	2.404	0.16	259	2403	-0.16	207
9.6	9.615	0.16	259	9.615	0.16	129	9.615	0.16	64	9615	-0.16	51
19.2	19.231	0.16	129	19.231	0.16	64	19.531	1.73	31	19230	-0.16	25
57.6	58.140	0.94	42	56.818	-1.36	21	56.818	-1.36	10	55555	3.55	8
115.2	113.636	-1.36	21	113.636	-1.36	10	125.000	8.51	4	_	_	_

			s	/NC = 0, E	BRGH = 0	, BRG16 =	1			
BAUD	Fosc	= 4.000	MHz	Fos	c = 2.000	MHz	Fosc = 1.000 MHz			
RATE (K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	
0.3	0.300	0.04	832	300	-0.16	415	300	-0.16	207	
1.2	1.202	0.16	207	1201	-0.16	103	1201	-0.16	51	
2.4	2.404	0.16	103	2403	-0.16	51	2403	-0.16	25	
9.6	9.615	0.16	25	9615	-0.16	12	_	_	_	
19.2	19.231	0.16	12	_	_	_	_	_	_	
57.6	62.500	8.51	3	_	_	_	_	_	_	
115.2	125.000	8.51	1	_	_	_	_	_	_	

		SYNC = 0, BRGH = 1, BRG16 = 1 or SYNC = 1, BRG16 = 1													
BAUD	Fosc	= 40.000) MHz	Fosc = 20.000 MHz			Fosc	= 10.000) MHz	Fosc = 8.000 MHz					
RATE (K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)			
0.3	0.300	0.00	33332	0.300	0.00	16665	0.300	0.00	8332	300	-0.01	6665			
1.2	1.200	0.00	8332	1.200	0.02	4165	1.200	0.02	2082	1200	-0.04	1665			
2.4	2.400	0.02	4165	2.400	0.02	2082	2.402	0.06	1040	2400	-0.04	832			
9.6	9.606	0.06	1040	9.596	-0.03	520	9.615	0.16	259	9615	-0.16	207			
19.2	19.193	-0.03	520	19.231	0.16	259	19.231	0.16	129	19230	-0.16	103			
57.6	57.803	0.35	172	57.471	-0.22	86	58.140	0.94	42	57142	0.79	34			
115.2	114.943	-0.22	86	116.279	0.94	42	113.636	-1.36	21	117647	-2.12	16			

		SYN	IC = 0, BR	GH = 1, BF	RG16 = 1	or SYNC =	1, BRG1	6 = 1		
BAUD RATE	Fos	c = 4.000	MHz	Fos	c = 2.000	MHz	Fosc = 1.000 MHz			
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	
0.3	0.300	0.01	3332	300	-0.04	1665	300	-0.04	832	
1.2	1.200	0.04	832	1201	-0.16	415	1201	-0.16	207	
2.4	2.404	0.16	415	2403	-0.16	207	2403	-0.16	103	
9.6	9.615	0.16	103	9615	-0.16	51	9615	-0.16	25	
19.2	19.231	0.16	51	19230	-0.16	25	19230	-0.16	12	
57.6	58.824	2.12	16	55555	3.55	8	_	_	_	
115.2	111.111	-3.55	8	_	_	_	_	_	_	

16.1.3 AUTO-BAUD RATE DETECT

The Enhanced USART module supports the automatic detection and calibration of baud rate. This feature is active only in Asynchronous mode and while the WUE bit is clear.

The automatic baud rate measurement sequence (Figure 16-1) begins whenever a Start bit is received and the ABDEN bit is set. The calculation is self-averaging.

In the Auto-Baud Rate Detect (ABD) mode, the clock to the BRG is reversed. Rather than the BRG clocking the incoming RX signal, the RX signal is timing the BRG. In ABD mode, the internal Baud Rate Generator is used as a counter to time the bit period of the incoming serial byte stream.

Once the ABDEN bit is set, the state machine will clear the BRG and look for a Start bit. The Auto-Baud Rate Detect must receive a byte with the value 55h (ASCII "U", which is also the LIN bus Sync character) in order to calculate the proper bit rate. The measurement is taken over both a low and a high bit time in order to minimize any effects caused by asymmetry of the incoming signal. After a Start bit, the SPBRG begins counting up, using the preselected clock source on the first rising edge of RX. After eight bits on the RX pin or the fifth rising edge, an accumulated value totalling the proper BRG period is left in the SPBRGH:SPBRG register pair. Once the 5th edge is seen (this should correspond to the Stop bit), the ABDEN bit is automatically cleared.

If a rollover of the BRG occurs (an overflow from FFFFh to 0000h), the event is trapped by the ABDOVF status bit (BAUDCON<7>). It is set in hardware by BRG rollovers and can be set or cleared by the user in software. ABD mode remains active after rollover events and the ABDEN bit remains set (Figure 16-2).

While calibrating the baud rate period, the BRG registers are clocked at 1/8th the preconfigured clock rate. Note that the BRG clock will be configured by the BRG16 and BRGH bits. Independent of the BRG16 bit setting, both the SPBRG and SPBRGH will be used as a 16-bit counter. This allows the user to verify that no carry occurred for 8-bit modes by checking for 00h in the SPBRGH register. Refer to Table 16-4 for counter clock rates to the BRG.

While the ABD sequence takes place, the EUSART state machine is held in Idle. The RCIF interrupt is set once the fifth rising edge on RX is detected. The value in the RCREG needs to be read to clear the RCIF interrupt. The contents of RCREG should be discarded.

- Note 1: If the WUE bit is set with the ABDEN bit, Auto-Baud Rate Detection will occur on the byte *following* the Break character.
 - 2: It is up to the user to determine that the incoming character baud rate is within the range of the selected BRG clock source. Some combinations of oscillator frequency and EUSART baud rates are not possible due to bit error rates. Overall system timing and communication baud rates must be taken into consideration when using the Auto-Baud Rate Detection feature.

TABLE 16-4: BRG COUNTER CLOCK RATES

BRG16	BRGH	BRG Counter Clock
0	0	Fosc/512
0	1	Fosc/128
1	0	Fosc/128
1	1	Fosc/32

Note: During the ABD sequence, SPBRG and SPBRGH are both used as a 16-bit counter, independent of BRG16 setting.

16.1.3.1 ABD and EUSART Transmission

Since the BRG clock is reversed during ABD acquisition, the EUSART transmitter cannot be used during ABD. This means that whenever the ABDEN bit is set, TXREG cannot be written to. Users should also ensure that ABDEN does not become set during a transmit sequence. Failing to do this may result in unpredictable EUSART operation.

FIGURE 16-1: AUTOMATIC BAUD RATE CALCULATION

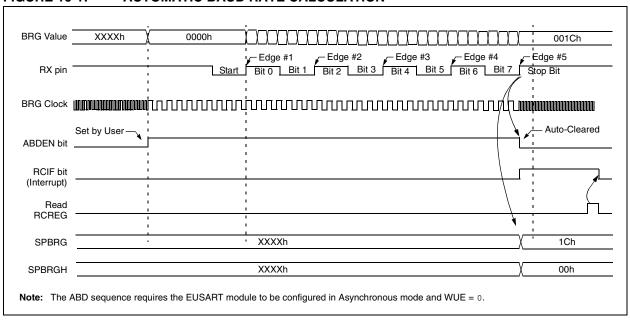
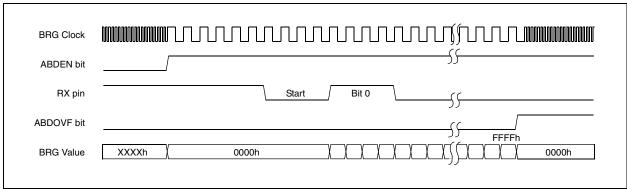


FIGURE 16-2: BRG OVERFLOW SEQUENCE



16.2 EUSART Asynchronous Mode

The Asynchronous mode of operation is selected by clearing the SYNC bit (TXSTA<4>). In this mode, the EUSART uses standard Non-Return-to-Zero (NRZ) format (one Start bit, eight or nine data bits and one Stop bit). The most common data format is 8 bits. An on-chip dedicated 8-bit/16-bit Baud Rate Generator can be used to derive standard baud rate frequencies from the oscillator.

The EUSART transmits and receives the LSb first. The EUSART's transmitter and receiver are functionally independent but use the same data format and baud rate. The Baud Rate Generator produces a clock, either x16 or x64 of the bit shift rate depending on the BRGH and BRG16 bits (TXSTA<2> and BAUDCON<3>). Parity is not supported by the hardware but can be implemented in software and stored as the 9th data bit.

When operating in Asynchronous mode, the EUSART module consists of the following important elements:

- · Baud Rate Generator
- Sampling Circuit
- Asynchronous Transmitter
- · Asynchronous Receiver
- · Auto-Wake-up on Sync Break Character
- 12-bit Break Character Transmit
- Auto-Baud Rate Detection

16.2.1 EUSART ASYNCHRONOUS TRANSMITTER

The EUSART transmitter block diagram is shown in Figure 16-3. The heart of the transmitter is the Transmit (Serial) Shift Register (TSR). The Shift register obtains its data from the Read/Write Transmit Buffer register, TXREG. The TXREG register is loaded with data in software. The TSR register is not loaded until the Stop bit has been transmitted from the previous load. As soon as the Stop bit is transmitted, the TSR is loaded with new data from the TXREG register (if available).

Once the TXREG register transfers the data to the TSR register (occurs in one Tcy), the TXREG register is empty and the TXIF flag bit (PIR1<4>) is set. This interrupt can be enabled or disabled by setting or clearing the interrupt enable bit, TXIE (PIE1<4>). TXIF will be set regardless of the state of TXIE; it cannot be cleared in software. TXIF is also not cleared immediately upon loading TXREG, but becomes valid in the second instruction cycle following the load instruction. Polling TXIF immediately following a load of TXREG will return invalid results.

While TXIF indicates the status of the TXREG register, another bit, TRMT (TXSTA<1>), shows the status of the TSR register. TRMT is a read-only bit which is set when the TSR register is empty. No interrupt logic is tied to this bit so the user has to poll this bit in order to determine if the TSR register is empty.

- **Note 1:** The TSR register is not mapped in data memory so it is not available to the user.
 - 2: Flag bit TXIF is set when enable bit TXEN is set.

To set up an Asynchronous Transmission:

- Initialize the SPBRGH:SPBRG registers for the appropriate baud rate. Set or clear the BRGH and BRG16 bits, as required, to achieve the desired baud rate.
- Enable the asynchronous serial port by clearing bit SYNC and setting bit SPEN.
- 3. If interrupts are desired, set enable bit TXIE.
- If 9-bit transmission is desired, set transmit bit TX9. Can be used as address/data bit.
- 5. Enable the transmission by setting bit TXEN which will also set bit TXIF.
- If 9-bit transmission is selected, the ninth bit should be loaded in bit TX9D.
- Load data to the TXREG register (starts transmission).
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set



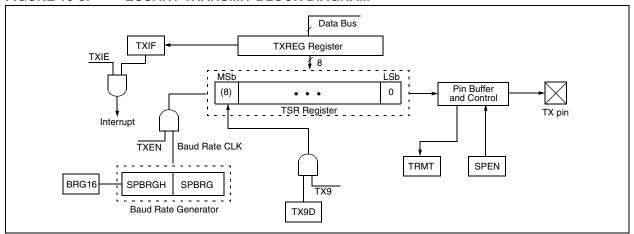


FIGURE 16-4: ASYNCHRONOUS TRANSMISSION

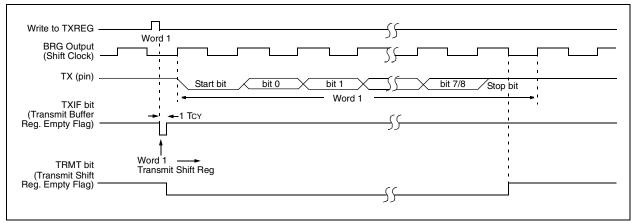


FIGURE 16-5: ASYNCHRONOUS TRANSMISSION (BACK TO BACK)

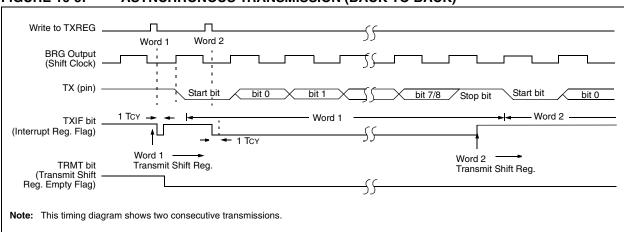


TABLE 16-5: REGISTERS ASSOCIATED WITH ASYNCHRONOUS TRANSMISSION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page	
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	43	
PIR1	PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	45	
PIE1	PSPIE ⁽¹⁾	ADIE	RCIE	TXIE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	45	
IPR1	PSPIP ⁽¹⁾	ADIP	RCIP	TXIP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	45	
RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	45	
TXREG	EUSART T	ransmit Reg	ister						45	
TXSTA	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	45	
BAUDCON	ABDOVF	RCIDL		SCKP	BRG16	_	WUE	ABDEN	45	
SPBRGH	EUSART E	USART Baud Rate Generator Register High Byte							45	
SPBRG	EUSART E	SART Baud Rate Generator Register Low Byte								

Legend: — = unimplemented locations read as '0'. Shaded cells are not used for asynchronous transmission.

16.2.2 EUSART ASYNCHRONOUS RECEIVER

The receiver block diagram is shown in Figure 16-6. The data is received on the RX pin and drives the data recovery block. The data recovery block is actually a high-speed shifter operating at x16 times the baud rate, whereas the main receive serial shifter operates at the bit rate or at Fosc. This mode would typically be used in RS-232 systems.

To set up an Asynchronous Reception:

- Initialize the SPBRGH:SPBRG registers for the appropriate baud rate. Set or clear the BRGH and BRG16 bits, as required, to achieve the desired baud rate.
- Enable the asynchronous serial port by clearing bit SYNC and setting bit SPEN.
- 3. If interrupts are desired, set enable bit RCIE.
- 4. If 9-bit reception is desired, set bit RX9.
- 5. Enable the reception by setting bit CREN.
- Flag bit, RCIF, will be set when reception is complete and an interrupt will be generated if enable bit, RCIE, was set.
- Read the RCSTA register to get the 9th bit (if enabled) and determine if any error occurred during reception.
- Read the 8-bit received data by reading the RCREG register.
- If any error occurred, clear the error by clearing enable bit CREN.
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

16.2.3 SETTING UP 9-BIT MODE WITH ADDRESS DETECT

This mode would typically be used in RS-485 systems. To set up an Asynchronous Reception with Address Detect Enable:

- Initialize the SPBRGH:SPBRG registers for the appropriate baud rate. Set or clear the BRGH and BRG16 bits, as required, to achieve the desired baud rate.
- Enable the asynchronous serial port by clearing the SYNC bit and setting the SPEN bit.
- If interrupts are required, set the RCEN bit and select the desired priority level with the RCIP bit.
- 4. Set the RX9 bit to enable 9-bit reception.
- 5. Set the ADDEN bit to enable address detect.
- 6. Enable reception by setting the CREN bit.
- The RCIF bit will be set when reception is complete. The interrupt will be Acknowledged if the RCIE and GIE bits are set.
- 8. Read the RCSTA register to determine if any error occurred during reception, as well as read bit 9 of data (if applicable).
- Read RCREG to determine if the device is being addressed.
- 10. If any error occurred, clear the CREN bit.
- 11. If the device has been addressed, clear the ADDEN bit to allow all received data into the receive buffer and interrupt the CPU.

FIGURE 16-6: EUSART RECEIVE BLOCK DIAGRAM

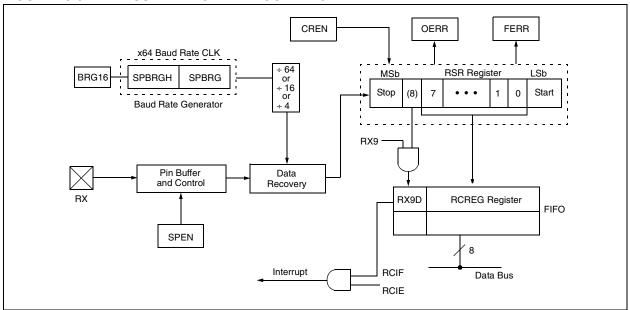


FIGURE 16-7: ASYNCHRONOUS RECEPTION

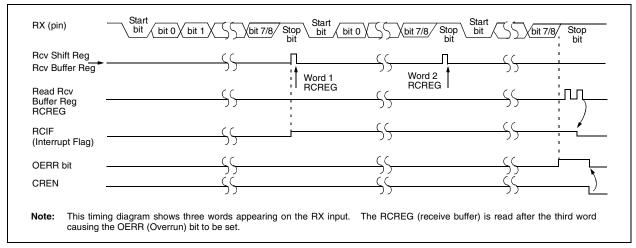


TABLE 16-6: REGISTERS ASSOCIATED WITH ASYNCHRONOUS RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	43
PIR1	PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	45
PIE1	PSPIE ⁽¹⁾	ADIE	RCIE	TXIE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	45
IPR1	PSPIP ⁽¹⁾	ADIP	RCIP	TXIP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	45
RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	45
RCREG	EUSART F	Receive Regis	ster						45
TXSTA	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	45
BAUDCON	ABDOVF	RCIDL	_	SCKP	BRG16	_	WUE	ABDEN	45
SPBRGH	EUSART E	USART Baud Rate Generator Register High Byte							
SPBRG	EUSART E	Baud Rate Ge	enerator Re	gister Low E	Byte				45

Legend: — = unimplemented locations read as '0'. Shaded cells are not used for asynchronous reception.

Note 1: These bits are not implemented on 28-pin devices and should be read as '0'.

16.2.4 AUTO-WAKE-UP ON SYNC BREAK CHARACTER

During Sleep mode, all clocks to the EUSART are suspended. Because of this, the Baud Rate Generator is inactive and a proper byte reception cannot be performed. The auto-wake-up feature allows the controller to wake-up due to activity on the RX/DT line while the EUSART is operating in Asynchronous mode.

The auto-wake-up feature is enabled by setting the WUE bit (BAUDCON<1>). Once set, the typical receive sequence on RX/DT is disabled and the EUSART remains in an Idle state, monitoring for a wake-up event independent of the CPU mode. A wake-up event consists of a high-to-low transition on the RX/DT line. (This coincides with the start of a Sync Break or a Wake-up Signal character for the LIN protocol.)

Following a wake-up event, the module generates an RCIF interrupt. The interrupt is generated synchronously to the Q clocks in normal operating modes (Figure 16-8) and asynchronously, if the device is in Sleep mode (Figure 16-9). The interrupt condition is cleared by reading the RCREG register.

The WUE bit is automatically cleared once a low-tohigh transition is observed on the RX line following the wake-up event. At this point, the EUSART module is in Idle mode and returns to normal operation. This signals to the user that the Sync Break event is over.

16.2.4.1 Special Considerations Using Auto-Wake-up

Since auto-wake-up functions by sensing rising edge transitions on RX/DT, information with any state changes before the Stop bit may signal a false end-of-character and cause data or framing errors. To work properly, therefore, the initial character in the transmission must be all '0's. This can be 00h (8 bytes) for standard RS-232 devices or 000h (12 bits) for LIN bus.

Oscillator start-up time must also be considered, especially in applications using oscillators with longer start-up intervals (i.e., HS mode). The Sync Break (or Wake-up Signal) character must be of sufficient length and be followed by a sufficient interval to allow enough time for the selected oscillator to start and provide proper initialization of the EUSART.

16.2.4.2 Special Considerations Using the WUE Bit

The timing of WUE and RCIF events may cause some confusion when it comes to determining the validity of received data. As noted, setting the WUE bit places the EUSART in an Idle mode. The wake-up event causes a receive interrupt by setting the RCIF bit. The WUE bit is cleared after this when a rising edge is seen on RX/DT. The interrupt condition is then cleared by reading the RCREG register. Ordinarily, the data in RCREG will be dummy data and should be discarded.

The fact that the WUE bit has been cleared (or is still set) and the RCIF flag is set should not be used as an indicator of the integrity of the data in RCREG. Users should consider implementing a parallel method in firmware to verify received data integrity.

To assure that no actual data is lost, check the RCIDL bit to verify that a receive operation is not in process. If a receive operation is not occurring, the WUE bit may then be set just prior to entering the Sleep mode.

FIGURE 16-8: AUTO-WAKE-UP BIT (WUE) TIMINGS DURING NORMAL OPERATION

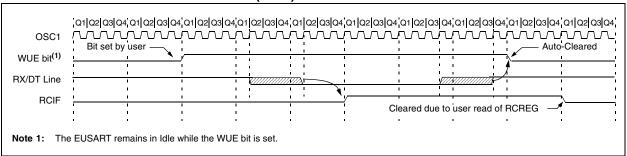
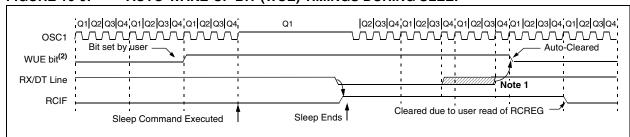


FIGURE 16-9: AUTO-WAKE-UP BIT (WUE) TIMINGS DURING SLEEP



Note 1: If the wake-up event requires long oscillator warm-up time, the auto-clear of the WUE bit can occur before the oscillator is ready. This sequence should not depend on the presence of Q clocks.

2: The EUSART remains in Idle while the WUE bit is set.

16.2.5 BREAK CHARACTER SEQUENCE

The EUSART module has the capability of sending the special Break character sequences that are required by the LIN bus standard. The Break character transmit consists of a Start bit, followed by twelve '0' bits and a Stop bit. The frame Break character is sent whenever the SENDB and TXEN bits (TXSTA<3> and TXSTA<5>) are set while the Transmit Shift register is loaded with data. Note that the value of data written to TXREG will be ignored and all '0's will be transmitted.

The SENDB bit is automatically reset by hardware after the corresponding Stop bit is sent. This allows the user to preload the transmit FIFO with the next transmit byte following the Break character (typically, the Sync character in the LIN specification).

Note that the data value written to the TXREG for the Break character is ignored. The write simply serves the purpose of initiating the proper sequence.

The TRMT bit indicates when the transmit operation is active or Idle, just as it does during normal transmission. See Figure 16-10 for the timing of the Break character sequence.

16.2.5.1 Break and Sync Transmit Sequence

The following sequence will send a message frame header made up of a Break, followed by an Auto-Baud Sync byte. This sequence is typical of a LIN bus master.

- 1. Configure the EUSART for the desired mode.
- Set the TXEN and SENDB bits to set up the Break character.
- 3. Load the TXREG with a dummy character to initiate transmission (the value is ignored).
- Write '55h' to TXREG to load the Sync character into the transmit FIFO buffer.
- After the Break has been sent, the SENDB bit is reset by hardware. The Sync character now transmits in the preconfigured mode.

When the TXREG becomes empty, as indicated by the TXIF, the next data byte can be written to TXREG.

16.2.6 RECEIVING A BREAK CHARACTER

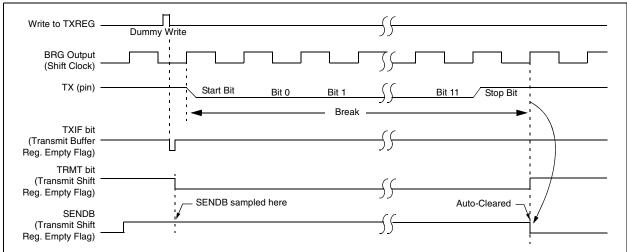
The Enhanced USART module can receive a Break character in two ways.

The first method forces configuration of the baud rate at a frequency of 9/13 the typical speed. This allows for the Stop bit transition to be at the correct sampling location (13 bits for Break versus Start bit and 8 data bits for typical data).

The second method uses the auto-wake-up feature described in **Section 16.2.4** "**Auto-Wake-up on Sync Break Character**". By enabling this feature, the EUSART will sample the next two transitions on RX/DT, cause an RCIF interrupt and receive the next data byte followed by another interrupt.

Note that following a Break character, the user will typically want to enable the Auto-Baud Rate Detect feature. For both methods, the user can set the ABD bit once the TXIF interrupt is observed.





16.3 EUSART Synchronous Master Mode

The Synchronous Master mode is entered by setting the CSRC bit (TXSTA<7>). In this mode, the data is transmitted in a half-duplex manner (i.e., transmission and reception do not occur at the same time). When transmitting data, the reception is inhibited and vice versa. Synchronous mode is entered by setting bit SYNC (TXSTA<4>). In addition, enable bit SPEN (RCSTA<7>) is set in order to configure the TX and RX pins to CK (clock) and DT (data) lines, respectively.

The Master mode indicates that the processor transmits the master clock on the CK line. Clock polarity is selected with the SCKP bit (BAUDCON<4>). Setting SCKP sets the Idle state on CK as high, while clearing the bit sets the Idle state as low. This option is provided to support Microwire devices with this module.

16.3.1 EUSART SYNCHRONOUS MASTER TRANSMISSION

The EUSART transmitter block diagram is shown in Figure 16-3. The heart of the transmitter is the Transmit (Serial) Shift Register (TSR). The Shift register obtains its data from the Read/Write Transmit Buffer register, TXREG. The TXREG register is loaded with data in software. The TSR register is not loaded until the last bit has been transmitted from the previous load. As soon as the last bit is transmitted, the TSR is loaded with new data from the TXREG (if available).

Once the TXREG register transfers the data to the TSR register (occurs in one TCY), the TXREG is empty and the TXIF flag bit (PIR1<4>) is set. The interrupt can be enabled or disabled by setting or clearing the interrupt enable bit, TXIE (PIE1<4>). TXIF is set regardless of the state of enable bit TXIE; it cannot be cleared in software. It will reset only when new data is loaded into the TXREG register.

While flag bit TXIF indicates the status of the TXREG register, another bit, TRMT (TXSTA<1>), shows the status of the TSR register. TRMT is a read-only bit which is set when the TSR is empty. No interrupt logic is tied to this bit so the user has to poll this bit in order to determine if the TSR register is empty. The TSR is not mapped in data memory so it is not available to the user.

To set up a Synchronous Master Transmission:

- Initialize the SPBRGH:SPBRG registers for the appropriate baud rate. Set or clear the BRG16 bit, as required, to achieve the desired baud rate.
- 2. Enable the synchronous master serial port by setting bits SYNC, SPEN and CSRC.
- 3. If interrupts are desired, set enable bit TXIE.
- 4. If 9-bit transmission is desired, set bit TX9.
- Enable the transmission by setting bit TXEN.
- If 9-bit transmission is selected, the ninth bit should be loaded in bit TX9D.
- Start transmission by loading data to the TXREG register.
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set



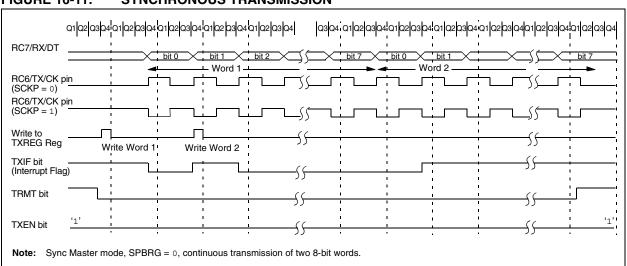


FIGURE 16-12: SYNCHRONOUS TRANSMISSION (THROUGH TXEN)

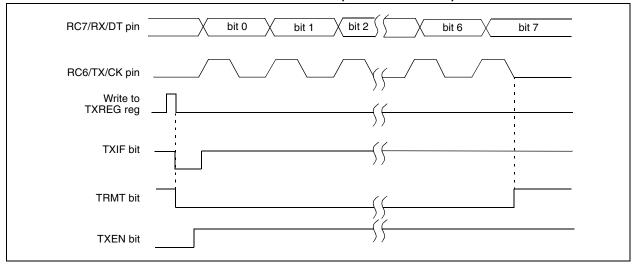


TABLE 16-7: REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER TRANSMISSION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page	
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	43	
PIR1	PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	45	
PIE1	PSPIE ⁽¹⁾	ADIE	RCIE	TXIE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	45	
IPR1	PSPIP ⁽¹⁾	ADIP	RCIP	TXIP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	45	
RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	45	
TXREG	EUSART T	ransmit Reg	ister						45	
TXSTA	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	45	
BAUDCON	ABDOVF	RCIDL	-	SCKP	BRG16	_	WUE	ABDEN	45	
SPBRGH	EUSART E	USART Baud Rate Generator Register High Byte								
SPBRG	EUSART E	SART Baud Rate Generator Register Low Byte								

Legend: — = unimplemented, read as '0'. Shaded cells are not used for synchronous master transmission.

16.3.2 EUSART SYNCHRONOUS MASTER RECEPTION

Once Synchronous mode is selected, reception is enabled by setting either the Single Receive Enable bit, SREN (RCSTA<5>), or the Continuous Receive Enable bit, CREN (RCSTA<4>). Data is sampled on the RX pin on the falling edge of the clock.

If enable bit SREN is set, only a single word is received. If enable bit CREN is set, the reception is continuous until CREN is cleared. If both bits are set, then CREN takes precedence.

To set up a Synchronous Master Reception:

- Initialize the SPBRGH:SPBRG registers for the appropriate baud rate. Set or clear the BRG16 bit, as required, to achieve the desired baud rate.
- Enable the synchronous master serial port by setting bits SYNC, SPEN and CSRC.

- Ensure bits CREN and SREN are clear.
- 4. If interrupts are desired, set enable bit RCIE.
- 5. If 9-bit reception is desired, set bit RX9.
- 6. If a single reception is required, set bit SREN. For continuous reception, set bit CREN.
- Interrupt flag bit, RCIF, will be set when reception is complete and an interrupt will be generated if the enable bit, RCIE, was set.
- Read the RCSTA register to get the 9th bit (if enabled) and determine if any error occurred during reception.
- Read the 8-bit received data by reading the RCREG register.
- If any error occurred, clear the error by clearing bit CREN.
- 11. If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

FIGURE 16-13: SYNCHRONOUS RECEPTION (MASTER MODE, SREN)

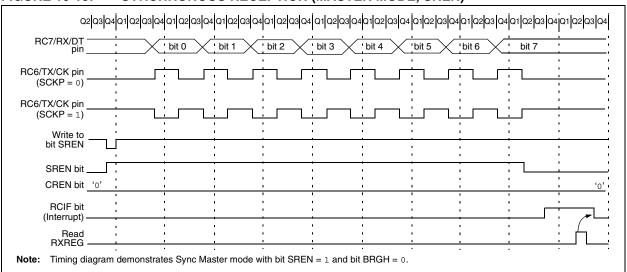


TABLE 16-8: REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	43
PIR1	PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	45
PIE1	PSPIE ⁽¹⁾	ADIE	RCIE	TXIE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	45
IPR1	PSPIP ⁽¹⁾	ADIP	RCIP	TXIP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	45
RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	45
RCREG	EUSART R	eceive Regi	ster						45
TXSTA	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	45
BAUDCON	ABDOVF	RCIDL		SCKP	BRG16	_	WUE	ABDEN	45
SPBRGH	EUSART B	USART Baud Rate Generator Register High Byte							
SPBRG	EUSART B	aud Rate Ge	enerator Re	gister Low B	Syte	·	·	·	45

Legend: — = unimplemented, read as '0'. Shaded cells are not used for synchronous master reception.

16.4 EUSART Synchronous Slave Mode

Synchronous Slave mode is entered by clearing bit, CSRC (TXSTA<7>). This mode differs from the Synchronous Master mode in that the shift clock is supplied externally at the CK pin (instead of being supplied internally in Master mode). This allows the device to transfer or receive data while in any low-power mode.

16.4.1 EUSART SYNCHRONOUS SLAVE TRANSMISSION

The operation of the Synchronous Master and Slave modes is identical, except in the case of the Sleep mode.

If two words are written to the TXREG and then the SLEEP instruction is executed, the following will occur:

- a) The first word will immediately transfer to the TSR register and transmit.
- The second word will remain in the TXREG register.
- c) Flag bit, TXIF, will not be set.
- d) When the first word has been shifted out of TSR, the TXREG register will transfer the second word to the TSR and flag bit, TXIF, will now be set.
- If enable bit TXIE is set, the interrupt will wake the chip from Sleep. If the global interrupt is enabled, the program will branch to the interrupt vector.

To set up a Synchronous Slave Transmission:

- Enable the synchronous slave serial port by setting bits SYNC and SPEN and clearing bit CSRC.
- 2. Clear bits CREN and SREN.
- 3. If interrupts are desired, set enable bit TXIE.
- 4. If 9-bit transmission is desired, set bit TX9.
- Enable the transmission by setting enable bit TXEN.
- If 9-bit transmission is selected, the ninth bit should be loaded in bit TX9D.
- Start transmission by loading data to the TXREG register.
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

TABLE 16-9: REGISTERS ASSOCIATED WITH SYNCHRONOUS SLAVE TRANSMISSION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page	
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	43	
PIR1	PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	45	
PIE1	PSPIE ⁽¹⁾	ADIE	RCIE	TXIE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	45	
IPR1	PSPIP ⁽¹⁾	ADIP	RCIP	TXIP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	45	
RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	45	
TXREG	EUSART T	ransmit Reg	ister						45	
TXSTA	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	45	
BAUDCON	ABDOVF	RCIDL		SCKP	BRG16	_	WUE	ABDEN	45	
SPBRGH	EUSART B	USART Baud Rate Generator Register High Byte								
SPBRG	EUSART B	JSART Baud Rate Generator Register Low Byte								

Legend: — = unimplemented, read as '0'. Shaded cells are not used for synchronous slave transmission.

16.4.2 EUSART SYNCHRONOUS SLAVE RECEPTION

The operation of the Synchronous Master and Slave modes is identical, except in the case of Sleep, or any Idle mode and bit SREN, which is a "don't care" in Slave mode.

If receive is enabled by setting the CREN bit prior to entering Sleep or any Idle mode, then a word may be received while in this low-power mode. Once the word is received, the RSR register will transfer the data to the RCREG register; if the RCIE enable bit is set, the interrupt generated will wake the chip from the low-power mode. If the global interrupt is enabled, the program will branch to the interrupt vector.

To set up a Synchronous Slave Reception:

- Enable the synchronous master serial port by setting bits SYNC and SPEN and clearing bit CSRC.
- 2. If interrupts are desired, set enable bit RCIE.
- 3. If 9-bit reception is desired, set bit RX9.
- 4. To enable reception, set enable bit CREN.
- Flag bit, RCIF, will be set when reception is complete. An interrupt will be generated if enable bit, RCIE, was set.
- Read the RCSTA register to get the 9th bit (if enabled) and determine if any error occurred during reception.
- 7. Read the 8-bit received data by reading the RCREG register.
- 8. If any error occurred, clear the error by clearing bit CREN.
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set

TABLE 16-10: REGISTERS ASSOCIATED WITH SYNCHRONOUS SLAVE RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page	
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	43	
PIR1	PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	45	
PIE1	PSPIE ⁽¹⁾	ADIE	RCIE	TXIE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	45	
IPR1	PSPIP ⁽¹⁾	ADIP	RCIP	TXIP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	45	
RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	45	
RCREG	EUSART F	Receive Regi	ster						45	
TXSTA	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	45	
BAUDCON	ABDOVF	RCIDL	_	SCKP	BRG16	_	WUE	ABDEN	45	
SPBRGH	EUSART E	USART Baud Rate Generator Register High Byte								
SPBRG	EUSART E	JSART Baud Rate Generator Register Low Byte								

Legend: — = unimplemented, read as '0'. Shaded cells are not used for synchronous slave reception.

NOTES:

17.0 10-BIT ANALOG-TO-DIGITAL CONVERTER (A/D) MODULE

The Analog-to-Digital (A/D) converter module has 10 inputs for the 28-pin devices and 13 for the 40/44-pin devices. This module allows conversion of an analog input signal to a corresponding 10-bit digital number.

The module has five registers:

- A/D Result High Register (ADRESH)
- A/D Result Low Register (ADRESL)
- A/D Control Register 0 (ADCON0)
- A/D Control Register 1 (ADCON1)
- A/D Control Register 2 (ADCON2)

The ADCON0 register, shown in Register 17-1, controls the operation of the A/D module. The ADCON1 register, shown in Register 17-2, configures the functions of the port pins. The ADCON2 register, shown in Register 17-3, configures the A/D clock source, programmed acquisition time and justification.

REGISTER 17-1: ADCON0: A/D CONTROL REGISTER 0

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ADCAL	_	CHS3	CHS2	CHS1	CHS0	GO/DONE	ADON
bit 7							bit 0

bit 7 ADCAL: A/D Calibration bit

1 = Calibration is performed on next A/D conversion

0 = Normal A/D converter operation

bit 6 Unimplemented: Read as '0'

bit 5-2 CHS3:CHS0: Analog Channel Select bits

0000 = Channel 0 (AN0)

0001 = Channel 1 (AN1)

0010 = Channel 2 (AN2)

0011 = Channel 3 (AN3)

0100 = Channel 4 (AN4)

0101 = Channel 5 (AN5)(1,2)

0110 = Channel 6 (AN6)(1,2)

0111 = Channel 7 $(AN7)^{(1,2)}$

1000 = Channel 8 (AN8)

1001 = Channel 9 (AN9)

1010 = Channel 10 (AN10)

1011 = Channel 11 (AN11)

1100 = Channel 12 (AN12

1101 = Unimplemented⁽²⁾

1110 = Unimplemented⁽²⁾

1111 = Unimplemented(2)

Note 1: These channels are not implemented on 28-pin devices.

2: Performing a conversion on unimplemented channels will return a floating input measurement.

bit 1 GO/DONE: A/D Conversion Status bit

When ADON = 1:

1 = A/D conversion in progress

0 = A/D Idle

bit 0 ADON: A/D On bit

1 = A/D converter module is enabled

0 = A/D converter module is disabled

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

REGISTER 17-2: ADCON1: A/D CONTROL REGISTER 1

	U-0	U-0	R/W-0	R/W-0	R/W-0 ⁽¹⁾	R/W ⁽¹⁾	R/W ⁽¹⁾	R/W ⁽¹⁾
	_	_	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0
Ī	bit 7							bit 0

bit 0

bit 7-6 Unimplemented: Read as '0'

bit 5 VCFG1: Voltage Reference Configuration bit (VREF- source)

1 = VREF- (AN2)

0 = Vss

bit 4 **VCFG0:** Voltage Reference Configuration bit (VREF+ source)

1 = VREF+ (AN3)

0 = VDD

bit 3-0 **PCFG3:PCFG0:** A/D Port Configuration Control bits:

PCFG3: PCFG0	AN12	AN11	AN10	AN9	AN8	AN7 ⁽²⁾	AN6 ⁽²⁾	AN5 ⁽²⁾	AN4	AN3	AN2	AN1	ANO
0000(1)	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α
0001	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α
0010	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α
0011	D	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α
0100	D	D	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α
0101	D	D	D	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α
0110	D	D	D	D	Α	Α	Α	Α	Α	Α	Α	Α	Α
0111(1)	D	D	D	D	D	Α	Α	Α	Α	Α	Α	Α	Α
1000	D	D	D	D	D	D	Α	Α	Α	Α	Α	Α	Α
1001	D	D	D	D	D	D	D	Α	Α	Α	Α	Α	Α
1010	D	D	D	D	D	D	D	D	Α	Α	Α	Α	Α
1011	D	D	D	D	D	D	D	D	D	Α	Α	Α	Α
1100	D	D	D	D	D	D	D	D	D	D	Α	Α	Α
1101	D	D	D	D	D	D	D	D	D	D	D	Α	Α
1110	D	D	D	D	D	D	D	D	D	D	D	D	Α
1111	D	D	D	D	D	D	D	D	D	D	D	D	D

A = Analog input

D = Digital I/O

Note 1: The POR value of the PCFG bits depends on the value of the PBADEN configuration bit. When PBADEN = 1, PCFG<3:0> = 0000; when PBADEN = 0, PCFG<3:0> = 0111.

2: AN5 through AN7 are available only on 40/44-pin devices.

Legend:						
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'				
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

REGISTER 17-3: ADCON2: A/D CONTROL REGISTER 2

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ADFM	_	ACQT2	ACQT1	ACQT0	ADCS2	ADCS1	ADCS0

bit 7

bit 7 ADFM: A/D Result Format Select bit

1 = Right justified0 = Left justified

bit 6 Unimplemented: Read as '0'

bit 5-3 ACQT2:ACQT0: A/D Acquisition Time Select bits

111 = 20 TAD 110 = 16 TAD 101 = 12 TAD 100 = 8 TAD 011 = 6 TAD 010 = 4 TAD 001 = 2 TAD 000 = 0 TAD⁽¹⁾

bit 2-0 ADCS2:ADCS0: A/D Conversion Clock Select bits

111 = FRC (clock derived from A/D RC oscillator)(1)

110 = Fosc/64

101 = Fosc/16

100 = Fosc/4

011 = FRC (clock derived from A/D RC oscillator)⁽¹⁾

010 = Fosc/32

001 = Fosc/8

000 = Fosc/2

Note 1: If the A/D FRC clock source is selected, a delay of one TCY (instruction cycle) is added before the A/D clock starts. This allows the SLEEP instruction to be executed before starting a conversion.

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

The analog reference voltage is software selectable to either the device's positive and negative supply voltage (VDD and Vss), or the voltage level on the RA3/AN3/ VREF+ and RA2/AN2/VREF-/CVREF pins.

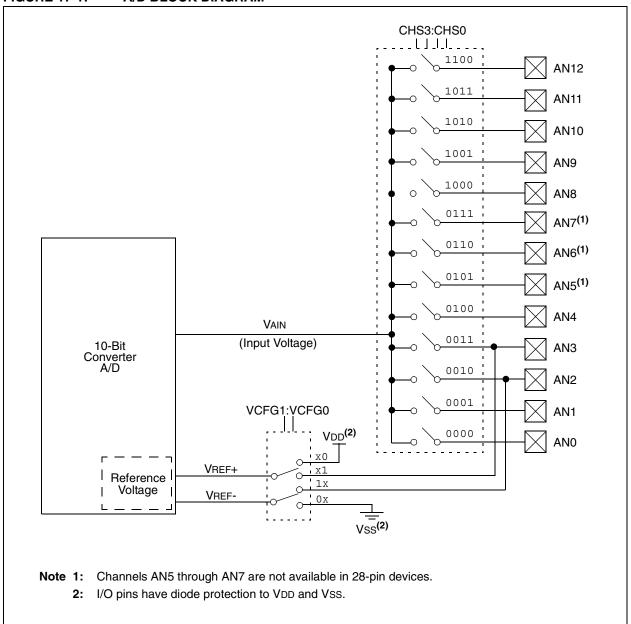
The A/D converter has a unique feature of being able to operate while the device is in Sleep mode. To operate in Sleep, the A/D conversion clock must be derived from the A/D's internal RC oscillator.

The output of the sample and hold is the input into the converter, which generates the result via successive approximation.

A device Reset forces all registers to their Reset state. This forces the A/D module to be turned off and any conversion in progress is aborted.

Each port pin associated with the A/D converter can be configured as an analog input, or as a digital I/O. The ADRESH and ADRESL registers contain the result of the A/D conversion. When the A/D conversion is complete, the result is loaded into the ADRESH:ADRESL register pair, the GO/DONE bit (ADCON0 register) is cleared and A/D Interrupt Flag bit, ADIF, is set. The block diagram of the A/D module is shown in Figure 17-1.

FIGURE 17-1: A/D BLOCK DIAGRAM



The value in the ADRESH:ADRESL registers is not modified for a Power-on Reset. The ADRESH:ADRESL registers will contain unknown data after a Power-on Reset.

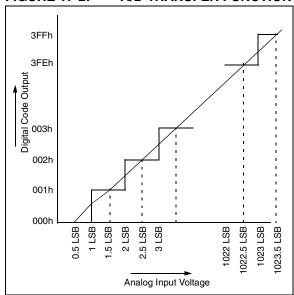
After the A/D module has been configured as desired, the selected channel must be acquired before the conversion is started. The analog input channels must have their corresponding TRIS bits selected as an input. To determine acquisition time, see **Section 17.1** "A/D Acquisition Requirements". After this acquisition time has elapsed, the A/D conversion can be started. An acquisition time can be programmed to occur between setting the GO/DONE bit and the actual start of the conversion.

The following steps should be followed to perform an A/D conversion:

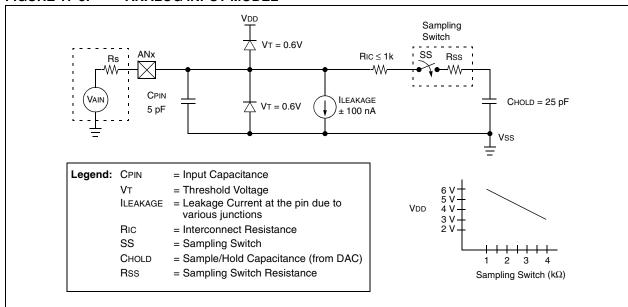
- 1. Configure the A/D module:
 - Configure analog pins, voltage reference and digital I/O (ADCON1)
 - Select A/D input channel (ADCON0)
 - Select A/D acquisition time (ADCON2)
 - Select A/D conversion clock (ADCON2)
 - Turn on A/D module (ADCON0)
- 2. Configure A/D interrupt (if desired):
 - · Clear ADIF bit
 - Set ADIE bit
 - · Set GIE bit
- 3. Wait the required acquisition time (if required).
- 4. Start conversion:
 - Set GO/DONE bit (ADCON0 register)

- 5. Wait for A/D conversion to complete, by either:
 - Polling for the GO/DONE bit to be cleared
 - Waiting for the A/D interrupt
- Read A/D Result registers (ADRESH:ADRESL); clear bit ADIF, if required.
- For next conversion, go to step 1 or step 2, as required. The A/D conversion time per bit is defined as TAD. A minimum wait of 2 TAD is required before the next acquisition starts.









17.1 A/D Acquisition Requirements

For the A/D converter to meet its specified accuracy, the charge holding capacitor (Chold) must be allowed to fully charge to the input channel voltage level. The analog input model is shown in Figure 17-3. The source impedance (Rs) and the internal sampling switch (Rss) impedance directly affect the time required to charge the capacitor Chold. The sampling switch (Rss) impedance varies over the device voltage (VDD). The source impedance affects the offset voltage at the analog input (due to pin leakage current). The maximum recommended impedance for analog sources is 2.5 k Ω . After the analog input channel is selected (changed), the channel must be sampled for at least the minimum acquisition time before starting a conversion.

Note: When the conversion is started, the holding capacitor is disconnected from the input pin.

To calculate the minimum acquisition time, Equation 17-1 may be used. This equation assumes that 1/2 LSb error is used (1024 steps for the A/D). The 1/2 LSb error is the maximum error allowed for the A/D to meet its specified resolution.

Example 17-3 shows the calculation of the minimum required acquisition time TACQ. This calculation is based on the following application system assumptions:

 $\begin{array}{lll} \text{CHOLD} & = & 25 \text{ pF} \\ \text{Rs} & = & 2.5 \text{ k}\Omega \\ \text{Conversion Error} & \leq & 1/2 \text{ LSb} \end{array}$

VDD = $5V \rightarrow Rss = 2 k\Omega$ Temperature = $85^{\circ}C$ (system max.)

EQUATION 17-1: ACQUISITION TIME

TACQ = Amplifier Settling Time + Holding Capacitor Charging Time + Temperature Coefficient
= TAMP + TC + TCOFF

EQUATION 17-2: A/D MINIMUM CHARGING TIME

```
\begin{array}{lll} V_{HOLD} & = & (V_{REF} - (V_{REF}/2048)) \bullet (1 - e^{(-T_C/C_{HOLD}(R_{IC} + R_{SS} + R_S))}) \\ or \\ T_C & = & -(C_{HOLD})(R_{IC} + R_{SS} + R_S) \ln(1/2048) \end{array}
```

EQUATION 17-3: CALCULATING THE MINIMUM REQUIRED ACQUISITION TIME

```
TACO
                     TAMP + TC + TCOFF
TAMP
                     0.2 \mu s
TCOFF
                     (Temp - 25^{\circ}C)(0.02 \mu s/^{\circ}C)
                     (85^{\circ}C - 25^{\circ}C)(0.02 \ \mu s/^{\circ}C)
                     1.2 \mu s
Temperature coefficient is only required for temperatures > 25°C. Below 25°C, TCOFF = 0 ms.
TC
                     -(CHOLD)(RIC + RSS + RS) ln(1/2047) \mu s
                     -(25 \text{ pF}) (1 \text{ k}\Omega + 2 \text{ k}\Omega + 2.5 \text{ k}\Omega) \ln(0.0004883) \text{ }\mu\text{s}
                     1.05 \mu s
TACQ
                     0.2 \mu s + 1 \mu s + 1.2 \mu s
                     2.4 \mu s
```

17.2 Selecting and Configuring Acquisition Time

The ADCON2 register allows the user to select an acquisition time that occurs each time the GO/DONE bit is set. It also gives users the option to use an automatically determined acquisition time.

Acquisition time may be set with the ACQT2:ACQT0 bits (ADCON2<5:3>), which provides a range of 2 to 20 TAD. When the GO/DONE bit is set, the A/D module continues to sample the input for the selected acquisition time, then automatically begins a conversion. Since the acquisition time is programmed, there may be no need to wait for an acquisition time between selecting a channel and setting the GO/DONE bit.

Manual acquisition is selected when ACQT2:ACQT0 = 000. When the GO/DONE bit is set, sampling is stopped and a conversion begins. The user is responsible for ensuring the required acquisition time has passed between selecting the desired input channel and setting the GO/DONE bit. This option is also the default Reset state of the ACQT2:ACQT0 bits and is compatible with devices that do not offer programmable acquisition times.

In either case, when the conversion is completed, the GO/DONE bit is cleared, the ADIF flag is set and the A/D begins sampling the currently selected channel again. If an acquisition time is programmed, there is nothing to indicate if the acquisition time has ended or if the conversion has begun.

17.3 Selecting the A/D Conversion Clock

The A/D conversion time per bit is defined as TAD. The A/D conversion requires 11 TAD per 10-bit conversion. The source of the A/D conversion clock is software selectable. There are seven possible options for TAD:

- 2 Tosc
- 4 Tosc
- 8 Tosc
- 16 Tosc
- 32 Tosc
- 64 Tosc
- · Internal RC Oscillator

For correct A/D conversions, the A/D conversion clock (TAD) must be as short as possible, but greater than the minimum TAD (see parameter 130 for more information).

Table 17-1 shows the resultant TAD times derived from the device operating frequencies and the A/D clock source selected.

TABLE 17-1: TAD vs. DEVICE OPERATING FREQUENCIES

AD Clock S	ource (TAD)	Maximum Device Frequency					
Operation	ADCS2:ADCS0	PIC18F2XJ10/4XJ10	PIC18LF2XJ10/4XJ10 ⁽⁴⁾				
2 Tosc	000	2.86 MHz	1.43 MHz				
4 Tosc	100	5.71 MHz	2.86 MHz				
8 Tosc	001	11.43 MHz	5.72 MHz				
16 Tosc	101	22.86 MHz	11.43 MHz				
32 Tosc	010	40.0 MHz	22.86 MHz				
64 Tosc	110	40.0 MHz	40.0 MHz				
RC ⁽³⁾	x11	1.00 MHz ⁽¹⁾	1.00 MHz ⁽²⁾				

- **Note 1:** The RC source has a typical TAD time of 1.2 μ s.
 - 2: The RC source has a typical TAD time of $2.5 \mu s$.
 - 3: For device frequencies above 1 MHz, the device must be in Sleep for the entire conversion or the A/D accuracy may be out of specification.
 - 4: Low-power (PIC18LF2XJ10/4XJ10) devices only.

17.4 Operation in Power-Managed Modes

The selection of the automatic acquisition time and A/D conversion clock is determined in part by the clock source and frequency while in a power-managed mode.

If the A/D is expected to operate while the device is in a power-managed mode, the ACQT2:ACQT0 and ADCS2:ADCS0 bits in ADCON2 should be updated in accordance with the clock source to be used in that mode. After entering the mode, an A/D acquisition or conversion may be started. Once started, the device should continue to be clocked by the same clock source until the conversion has been completed.

If desired, the device may be placed into the corresponding Idle mode during the conversion. If the device clock frequency is less than 1 MHz, the A/D RC clock source should be selected.

Operation in the Sleep mode requires the A/D FRC clock to be selected. If bits ACQT2:ACQT0 are set to '000' and a conversion is started, the conversion will be delayed one instruction cycle to allow execution of the SLEEP instruction and entry to Sleep mode. The IDLEN bit (OSCCON<7>) must have already been cleared prior to starting the conversion.

17.5 A/D Converter Calibration

The A/D converter in the PIC18F45J10 family of devices includes a self-calibration feature which compensates for any offset generated within the module. The calibration process is automated and is initiated by setting the ADCAL bit (ADCON0<7>). The next time the GO/DONE bit is set, the module will perform a "dummy" conversion (that is, with reading none of the input channels) and store the resulting value internally to compensate for offset. Thus, subsequent offsets will be compensated.

The calibration process assumes that the device is in a relatively steady-state operating condition. If A/D calibration is used, it should be performed after each device Reset, or if there are other major changes in operating conditions.

17.6 Configuring Analog Port Pins

The ADCON1, TRISA, TRISB and TRISE registers all configure the A/D port pins. The port pins needed as analog inputs must have their corresponding TRIS bits set (input). If the TRIS bit is cleared (output), the digital output level (VOH or VOL) will be converted.

The A/D operation is independent of the state of the CHS3:CHS0 bits and the TRIS bits.

- Note 1: When reading the Port register, all pins configured as analog input channels will read as cleared (a low level). Pins configured as digital inputs will convert as analog inputs. Analog levels on a digitally configured input will be accurately converted.
 - 2: Analog levels on any pin defined as a digital input may cause the digital input buffer to consume current out of the device's specification limits.
 - 3: The PBADEN bit in Configuration Register 3H configures PORTB pins to reset as analog or digital pins by controlling how the PCFG0 bits in ADCON1 are reset.

17.7 A/D Conversions

Figure 17-4 shows the operation of the A/D converter after the GO/DONE bit has been set and the ACQT2:ACQT0 bits are cleared. A conversion is started after the following instruction to allow entry into Sleep mode before the conversion begins.

Figure 17-5 shows the operation of the A/D converter after the GO/DONE bit has been set and the ACQT2:ACQT0 bits are set to '010' and selecting a 4 TAD acquisition time before the conversion starts.

Clearing the GO/DONE bit during a conversion will abort the current conversion. The A/D Result register pair will NOT be updated with the partially completed A/D conversion sample. This means the ADRESH:ADRESL registers will continue to contain the value of the last completed conversion (or the last value written to the ADRESH:ADRESL registers).

After the A/D conversion is completed or aborted, a 2 TAD wait is required before the next acquisition can be started. After this wait, acquisition on the selected channel is automatically started.

Note: The GO/DONE bit should NOT be set in the same instruction that turns on the A/D.

FIGURE 17-4: A/D CONVERSION TAD CYCLES (ACQT<2:0> = 000, TACQ = 0)

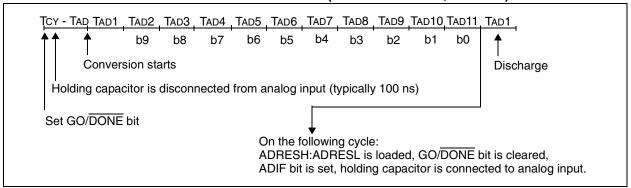
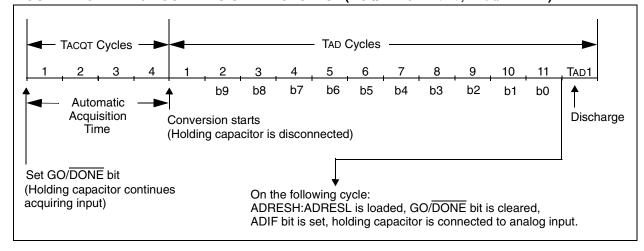


FIGURE 17-5: A/D CONVERSION TAD CYCLES (ACQT<2:0> = 010, TACQ = 4 TAD)



17.8 Use of the CCP2 Trigger

An A/D conversion can be started by the Special Event Trigger of the CCP2 module. This requires that the CCP2M3:CCP2M0 bits (CCP2CON<3:0>) be programmed as '1011' and that the A/D module is enabled (ADON bit is set). When the trigger occurs, the GO/DONE bit will be set, starting the A/D acquisition and conversion and the Timer1 counter will be reset to zero. Timer1 is reset to automatically repeat the A/D acquisition period with minimal software overhead

(moving ADRESH:ADRESL to the desired location). The appropriate analog input channel must be selected and the minimum acquisition period is either timed by the user, or an appropriate Tacq time selected before the Special Event Trigger sets the GO/DONE bit (starts a conversion).

If the A/D module is not enabled (ADON is cleared), the Special Event Trigger will be ignored by the A/D module, but will still reset the Timer1 counter.

TABLE 17-2: REGISTERS ASSOCIATED WITH A/D OPERATION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	43
PIR1	PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	45
PIE1	PSPIE ⁽¹⁾	ADIE	RCIE	TXIE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	45
IPR1	PSPIP ⁽¹⁾	ADIP	RCIP	TXIP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	45
PIR2	OSCFIF	CMIF	_	_	BCL1IF	_	_	CCP2IF	45
PIE2	OSCFIE	CMIE	_	_	BCL1IE	_	_	CCP2IE	45
IPR2	OSCFIP	CMIP	_	_	BCL1IP	_	_	CCP2IP	45
ADRESH	A/D Result	Register Hig	h Byte						44
ADRESL	A/D Result	A/D Result Register Low Byte							
ADCON0	ADCAL	_	CHS3	CHS2	CHS1	CHS0	GO/DONE	ADON	44
ADCON1	_	_	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0	44
ADCON2	ADFM	_	ACQT2	ACQT1	ACQT0	ADCS2	ADCS1	ADCS0	44
PORTA	_	_	RA5	_	RA3	RA2	RA1	RA0	46
TRISA	_	_	TRISA5	_	TRISA3	TRISA2	TRISA1	TRISA0	46
PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	46
TRISB	PORTB Dat	a Direction C	Control Regi	ister					46
LATB	PORTB Dat	a Latch Reg	ister (Read	and Write to	Data Latch))			46
PORTE ⁽¹⁾	_	RE2 RE1 RE0							46
TRISE ⁽¹⁾	IBF	OBF	IBOV	PSPMODE		TRISE2	TRISE1	TRISE0	46
LATE ⁽¹⁾	_	_		_			ita Latch Re Write to Dat	•	46

Legend: — = unimplemented, read as '0'. Shaded cells are not used for A/D conversion.

Note 1: These registers and/or bits are not implemented on 28-pin devices and should be read as '0'.

18.0 COMPARATOR MODULE

The analog comparator module contains two comparators that can be configured in a variety of ways. The inputs can be selected from the analog inputs multiplexed with pins RA0 through RA5, as well as the on-chip voltage reference (see **Section 19.0** "Comparator Voltage Reference Module"). The digital outputs (normal or inverted) are available at the pin level and can also be read through the control register.

The CMCON register (Register 18-1) selects the comparator input and output configuration. Block diagrams of the various comparator configurations are shown in Figure 18-1.

REGISTER 18-1: CMCON: COMPARATOR CONTROL REGISTER

R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-1	R/W-1	R/W-1
C2OUT	C10UT	C2INV	C1INV	CIS	CM2	CM1	CM0
bit 7							bit 0

bit 7 C2OUT: Comparator 2 Output bit

When C2INV = 0:

1 = C2 VIN+ > C2 VIN-

0 = C2 VIN+ < C2 VIN-

When C2INV = 1:

1 = C2 VIN+ < C2 VIN-

0 = C2 VIN+ > C2 VIN-

bit 6 C10UT: Comparator 1 Output bit

When C1INV = 0:

1 = C1 Vin+ > C1 Vin-

0 = C1 Vin+ < C1 Vin-

When C1INV = 1:

1 = C1 VIN+ < C1 VIN-

0 = C1 Vin+ > C1 Vin-

bit 5 C2INV: Comparator 2 Output Inversion bit

1 = C2 output inverted

0 = C2 output not inverted

bit 4 C1INV: Comparator 1 Output Inversion bit

1 = C1 output inverted

0 = C1 output not inverted

bit 3 CIS: Comparator Input Switch bit

When CM2:CM0 = 110:

1 = C1 VIN- connects to RA3/AN3/VREF+

C2 VIN- connects to RA2/AN2/VREF-/CVREF

0 = C1 VIN- connects to RA0/AN0

C2 VIN- connects to RA1/AN1

bit 2-0 CM2:CM0: Comparator Mode bits

Figure 18-1 shows the Comparator modes and the CM2:CM0 bit settings.

			_1	_
മവ	Δ	n		

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

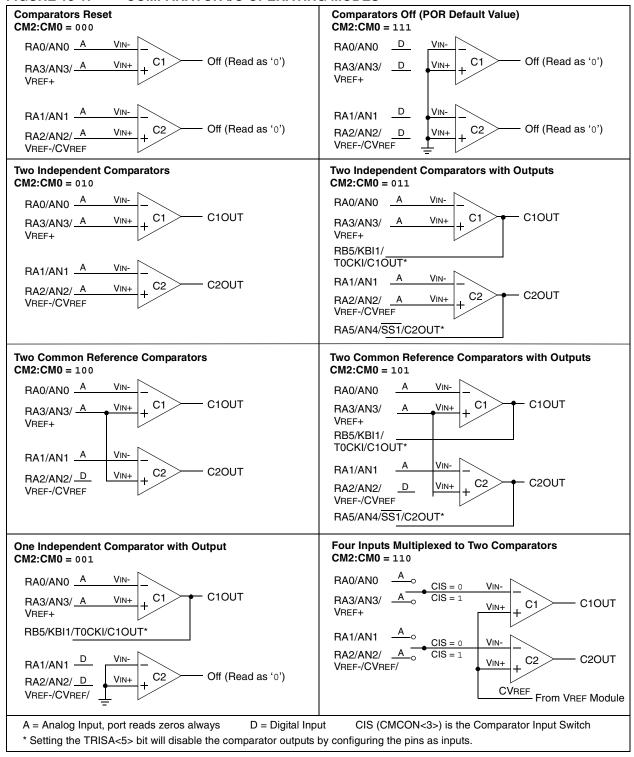
18.1 Comparator Configuration

There are eight modes of operation for the comparators, shown in Figure 18-1. Bits CM2:CM0 of the CMCON register are used to select these modes. The TRISA register controls the data direction of the comparator pins for each mode. If the Comparator mode is

changed, the comparator output level may not be valid for the specified mode change delay shown in **Section 23.0 "Electrical Characteristics"**.

Note: Comparator interrupts should be disabled during a Comparator mode change; otherwise, a false interrupt may occur.

FIGURE 18-1: COMPARATOR I/O OPERATING MODES



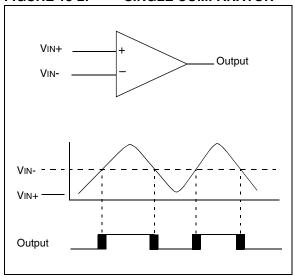
18.2 Comparator Operation

A single comparator is shown in Figure 18-2, along with the relationship between the analog input levels and the digital output. When the analog input at VIN+ is less than the analog input VIN-, the output of the comparator is a digital low level. When the analog input at VIN+ is greater than the analog input VIN-, the output of the comparator is a digital high level. The shaded areas of the output of the comparator in Figure 18-2 represent the uncertainty, due to input offsets and response time.

18.3 Comparator Reference

Depending on the comparator operating mode, either an external or internal voltage reference may be used. The analog signal present at VIN- is compared to the signal at VIN+ and the digital output of the comparator is adjusted accordingly (Figure 18-2).

FIGURE 18-2: SINGLE COMPARATOR



18.3.1 EXTERNAL REFERENCE SIGNAL

When external voltage references are used, the comparator module can be configured to have the comparators operate from the same or different reference sources. However, threshold detector applications may require the same reference. The reference signal must be between Vss and VDD and can be applied to either pin of the comparator(s).

18.3.2 INTERNAL REFERENCE SIGNAL

The comparator module also allows the selection of an internally generated voltage reference from the comparator voltage reference module. This module is described in more detail in **Section 19.0 "Comparator Voltage Reference Module"**.

The internal reference is only available in the mode where four inputs are multiplexed to two comparators (CM2:CM0 = 110). In this mode, the internal voltage reference is applied to the VIN+ pin of both comparators.

18.4 Comparator Response Time

Response time is the minimum time, after selecting a new reference voltage or input source, before the comparator output has a valid level. If the internal reference is changed, the maximum delay of the internal voltage reference must be considered when using the comparator outputs. Otherwise, the maximum delay of the comparators should be used (see **Section 23.0** "**Electrical Characteristics**").

18.5 Comparator Outputs

The comparator outputs are read through the CMCON register. These bits are read-only. The comparator outputs may also be directly output to the RB5 and RA5 I/O pins. When enabled, multiplexors in the output path of the RB5 and RA5 pins will switch and the output of each pin will be the unsynchronized output of the comparator. The uncertainty of each of the comparators is related to the input offset voltage and the response time given in the specifications. Figure 18-3 shows the comparator output block diagram.

The TRISA bits will still function as an output enable/ disable for the RB5 and RA5 pins while in this mode.

The polarity of the comparator outputs can be changed using the C2INV and C1INV bits (CMCON<5:4>).

- Note 1: When reading the Port register, all pins configured as analog inputs will read as a '0'. Pins configured as digital inputs will convert an analog input according to the Schmitt Trigger input specification.
 - 2: Analog levels on any pin defined as a digital input may cause the input buffer to consume more current than is specified.

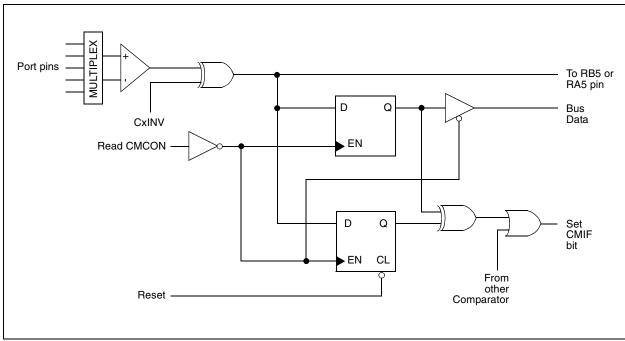


FIGURE 18-3: COMPARATOR OUTPUT BLOCK DIAGRAM

18.6 Comparator Interrupts

The comparator interrupt flag is set whenever there is a change in the output value of either comparator. Software will need to maintain information about the status of the output bits, as read from CMCON<7:6>, to determine the actual change that occurred. The CMIF bit (PIR2<6>) is the Comparator Interrupt Flag. The CMIF bit must be reset by clearing it. Since it is also possible to write a '1' to this register, a simulated interrupt may be initiated.

Both the CMIE bit (PIE2<6>) and the PEIE bit (INTCON<6>) must be set to enable the interrupt. In addition, the GIE bit (INTCON<7>) must also be set. If any of these bits are clear, the interrupt is not enabled, though the CMIF bit will still be set if an interrupt condition occurs.

Note: If a change in the CMCON register (C1OUT or C2OUT) should occur when a read operation is being executed (start of the Q2 cycle), then the CMIF (PIR2 register) interrupt flag may not get set.

The user, in the Interrupt Service Routine, can clear the interrupt in the following manner:

- Any read or write of CMCON will end the mismatch condition.
- b) Clear flag bit CMIF.

A mismatch condition will continue to set flag bit CMIF. Reading CMCON will end the mismatch condition and allow flag bit CMIF to be cleared.

18.7 Comparator Operation During Sleep

When a comparator is active and the device is placed in Sleep mode, the comparator remains active and the interrupt is functional if enabled. This interrupt will wake-up the device from Sleep mode, when enabled. Each operational comparator will consume additional current, as shown in the comparator specifications. To minimize power consumption while in Sleep mode, turn off the comparators (CM2:CM0 = 111) before entering Sleep. If the device wakes up from Sleep, the contents of the CMCON register are not affected.

18.8 Effects of a Reset

A device Reset forces the CMCON register to its Reset state, causing the comparator modules to be turned off (CM2:CM0 = 111) . However, the input pins (RA0 through RA3) are configured as analog inputs by default on device Reset. The I/O configuration for these pins is determined by the setting of the PCFG3:PCFG0 bits (ADCON1<3:0>). Therefore, device current is minimized when analog inputs are present at Reset time

18.9 Analog Input Connection Considerations

A simplified circuit for an analog input is shown in Figure 18-4. Since the analog pins are connected to a digital output, they have reverse biased diodes to VDD and VSS. The analog input, therefore, must be between VSS and VDD. If the input voltage deviates from this

range by more than 0.6V in either direction, one of the diodes is forward biased and a latch-up condition may occur. A maximum source impedance of 10 $k\Omega$ is recommended for the analog sources. Any external component connected to an analog input pin, such as a capacitor or a Zener diode, should have very little leakage current.

FIGURE 18-4: COMPARATOR ANALOG INPUT MODEL

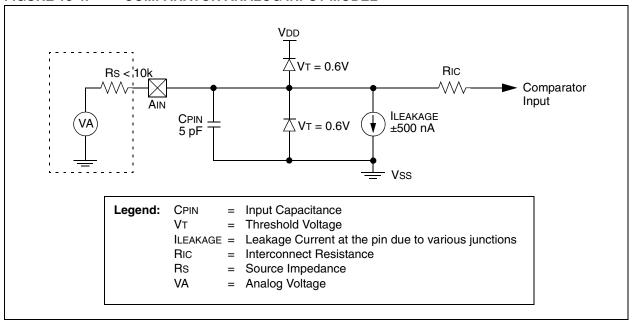


TABLE 18-1: REGISTERS ASSOCIATED WITH COMPARATOR MODULE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
CMCON	C2OUT	C1OUT	C2INV	C1INV	CIS	CM2	CM1	CM0	45
CVRCON	CVREN	CVROE	CVRR	CVRSS	CVR3	CVR2	CVR1	CVR0	45
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	46
PIR2	OSCFIF	CMIF	_	_	BCL1IF	_	_	CCP2IF	45
PIE2	OSCFIE	CMIE	-	_	BCL1IE	1	1	CCP2IE	45
IPR2	OSCFIP	CMIP	_	_	BCL1IP	_	_	CCP2IP	45
PORTA	_	_	RA5	_	RA3	RA2	RA1	RA0	46
LATA	_	_	PORTA Data Latch Register (Read and Write to Data Latch)					46	
TRISA	_	_	TRISA5	_	TRISA3	TRISA2	TRISA1	TRISA0	46

Legend: — = unimplemented, read as '0'. Shaded cells are unused by the comparator module.

NOTES:

19.0 COMPARATOR VOLTAGE REFERENCE MODULE

The comparator voltage reference is a 16-tap resistor ladder network that provides a selectable reference voltage. Although its primary purpose is to provide a reference for the analog comparators, it may also be used independently of them.

A block diagram of the module is shown in Figure 19-1. The resistor ladder is segmented to provide two ranges of CVREF values and has a power-down function to conserve power when the reference is not being used. The module's supply reference can be provided from either device VDD/VSS or an external voltage reference.

19.1 Configuring the Comparator Voltage Reference

The voltage reference module is controlled through the CVRCON register (Register 19-1). The comparator voltage reference provides two ranges of output voltage, each with 16 distinct levels. The range to be

used is selected by the CVRR bit (CVRCON<5>). The primary difference between the ranges is the size of the steps selected by the CVREF Selection bits (CVR3:CVR0), with one range offering finer resolution. The equations used to calculate the output of the comparator voltage reference are as follows:

If CVRR = 1:

CVREF = ((CVR3:CVR0)/24) x CVRSRC

If CVRR = 0:

CVREF = (CVRSRC x 1/4) + (((CVR3:CVR0)/32) x CVRSRC)

The comparator reference supply voltage can come from either VDD and Vss, or the external VREF+ and VREF- that are multiplexed with RA2 and RA3. The voltage source is selected by the CVRSS bit (CVRCON<4>).

The settling time of the comparator voltage reference must be considered when changing the CVREF output (see Table 23-3 in Section 23.0 "Electrical Characteristics").

REGISTER 19-1: CVRCON: COMPARATOR VOLTAGE REFERENCE CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CVREN	CVROE ⁽¹⁾	CVRR	CVRSS	CVR3	CVR2	CVR1	CVR0
bit 7							bit 0

bit 7 CVREN: Comparator Voltage Reference Enable bit

1 = CVREF circuit powered on

0 = CVREF circuit powered down

bit 6 **CVROE**: Comparator VREF Output Enable bit⁽¹⁾

1 = CVREF voltage level is also output on the RA2/AN2/VREF-/CVREF pin

0 = CVREF voltage is disconnected from the RA2/AN2/VREF-/CVREF pin

Note 1: CVROE overrides the TRISA<2> bit setting.

bit 5 CVRR: Comparator VREF Range Selection bit

1 = 0 to 0.667 CVRSRC, with CVRSRC/24 step size (low range)

0 = 0.25 CVRSRC to 0.75 CVRSRC, with CVRSRC/32 step size (high range)

bit 4 CVRSS: Comparator VREF Source Selection bit

1 = Comparator reference source. CVRSRC = (VREF+) - (VREF-)

0 = Comparator reference source, CVRSRC = VDD - VSS

bit 3-0 **CVR3:CVR0:** Comparator VREF Value Selection bits $(0 \le (CVR3:CVR0) \le 15)$

When CVRR = 1:

CVREF = ((CVR3:CVR0)/24) • (CVRSRC)

When CVRR = 0:

CVREF = (CVRSRC/4) + ((CVR3:CVR0)/32) • (CVRSRC)

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	l bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

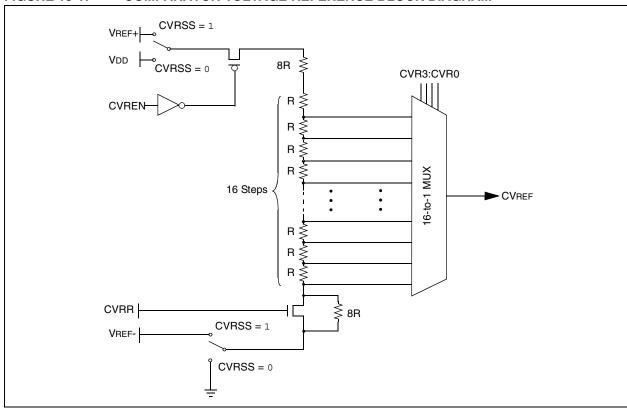


FIGURE 19-1: COMPARATOR VOLTAGE REFERENCE BLOCK DIAGRAM

19.2 Voltage Reference Accuracy/Error

The full range of voltage reference cannot be realized due to the construction of the module. The transistors on the top and bottom of the resistor ladder network (Figure 19-1) keep CVREF from approaching the reference source rails. The voltage reference is derived from the reference source; therefore, the CVREF output changes with fluctuations in that source. The tested absolute accuracy of the voltage reference can be found in **Section 23.0** "Electrical Characteristics".

19.3 Operation During Sleep

When the device wakes up from Sleep through an interrupt or a Watchdog Timer time-out, the contents of the CVRCON register are not affected. To minimize current consumption in Sleep mode, the voltage reference should be disabled.

19.4 Effects of a Reset

A device Reset disables the voltage reference by clearing bit, CVREN (CVRCON<7>). This Reset also disconnects the reference from the RA2 pin by clearing bit, CVROE (CVRCON<6>) and selects the high-voltage range by clearing bit, CVRR (CVRCON<5>). The CVR value select bits are also cleared.

19.5 Connection Considerations

The voltage reference module operates independently of the comparator module. The output of the reference generator may be connected to the RA2 pin if the CVROE bit is set. Enabling the voltage reference output onto RA2 when it is configured as a digital input will increase current consumption. Connecting RA2 as a digital output with CVRSS enabled will also increase current consumption.

The RA2 pin can be used as a simple D/A output with limited drive capability. Due to the limited current drive capability, a buffer must be used on the voltage reference output for external connections to VREF. Figure 19-2 shows an example buffering technique.

FIGURE 19-2: COMPARATOR VOLTAGE REFERENCE OUTPUT BUFFER EXAMPLE

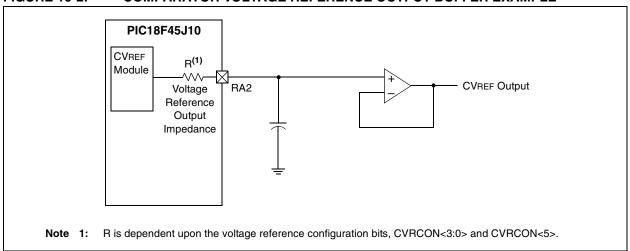


TABLE 19-1: REGISTERS ASSOCIATED WITH COMPARATOR VOLTAGE REFERENCE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
CVRCON	CVREN	CVROE	CVRR	CVRSS	CVR3	CVR2	CVR1	CVR0	45
CMCON	C2OUT	C10UT	C2INV	C1INV	CIS	CM2	CM1	CM0	45
TRISA	_	_	TRISA5	_	TRISA3	TRISA2	TRISA1	TRISA0	46

Legend: Shaded cells are not used with the comparator voltage reference.

NOTES:

20.0 SPECIAL FEATURES OF THE CPU

PIC18F45J10 family devices include several features intended to maximize reliability and minimize cost through elimination of external components. These are:

- · Oscillator Selection
- Resets:
 - Power-on Reset (POR)
 - Power-up Timer (PWRT)
 - Oscillator Start-up Timer (OST)
 - Brown-out Reset (BOR)
- Interrupts
- Watchdog Timer (WDT)
- · Fail-Safe Clock Monitor
- Two-Speed Start-up
- · Code Protection
- In-Circuit Serial Programming

The oscillator can be configured for the application depending on frequency, power, accuracy and cost. All of the options are discussed in detail in **Section 2.0** "Oscillator Configurations".

A complete discussion of device Resets and interrupts is available in previous sections of this data sheet.

In addition to their Power-up and Oscillator Start-up Timers provided for Resets, the PIC18F45J10 family of devices have a configurable Watchdog Timer which is controlled in software.

The inclusion of an internal RC oscillator also provides the additional benefits of a Fail-Safe Clock Monitor (FSCM) and Two-Speed Start-up. FSCM provides for background monitoring of the peripheral clock and automatic switchover in the event of its failure. Two-Speed Start-up enables code to be executed almost immediately on start-up, while the primary clock source completes its start-up delays.

All of these features are enabled and configured by setting the appropriate Configuration register bits.

20.1 Configuration Bits

The configuration bits can be programmed (read as 'o') or left unprogrammed (read as '1') to select various device configurations. These bits are mapped starting at program memory location 300000h. A complete list is shown in Table 20-1. A detailed explanation of the various bit functions is provided in Register 20-1 through Register 20-6.

Note that address 300000h is beyond the user program memory space. In fact, it belongs to the configuration memory space (300000h-3FFFFFh) which can only be accessed using table reads and table writes.

20.1.1 CONSIDERATIONS FOR CONFIGURING THE PIC18F45J10 FAMILY DEVICES

Unlike most PIC18 microcontrollers, devices of the PIC18F45J10 family do not use persistent memory registers to store configuration information. The configuration bytes are implemented as volatile memory which means that configuration data must be programmed each time the device is powered up.

Configuration data is stored in the four words at the top of the on-chip program memory space, known as the Flash Configuration Words. It is stored in program memory in the same order shown in Table 20-1, with CONFIG1L at the lowest address and CONFIG3H at the highest. The data is automatically loaded in the proper Configuration registers during device power-up.

When creating applications for these devices, users should always specifically allocate the location of the Flash Configuration Word for configuration data; this is to make certain that program code is not stored in this address when the code is compiled.

The volatile memory cells used for the configuration bits always reset to '1' on Power-on Resets. For all other type of Reset events, the previously programmed values are maintained and used without reloading from program memory.

The four Most Significant bits of CONFIG1H, CONFIG2H and CONFIG3H in program memory should also be '1111'. This makes these Configuration Words appear to be NOP instructions in the remote event that their locations are ever executed by accident. Since configuration bits are not implemented in the corresponding locations, writing '1's to these locations has no effect on device operation.

To prevent inadvertent configuration changes during code execution, all programmable configuration bits are write-once. After a bit is initially programmed during a power cycle, it cannot be written to again. Changing a device configuration requires a device Reset.

TABLE 20-1: CONFIGURATION BITS AND DEVICE IDs

File	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default/ Unprogrammed Value ⁽¹⁾
300000h	CONFIG1L	DEBUG	XINST	STVREN	_	_	_	_	WDTEN	1111
300001h	CONFIG1H	(2)	(2)	(2)	(2)	(3)	CP0	_	_	x1
300002h	CONFIG2L	IESO	FCMEN	_		_	FOSC2	FOSC1	FOSC0	11111
300003h	CONFIG2H	(2)	(2)	(2)	(2)	WDTPS3	WDTPS2	WDTPS1	WDTPS0	1111
300004h	CONFIG3L	_	_	-	-	_	_	_	_	
300005h	CONFIG3H	(2)	(2)	(2)	(2)	_	_	_	CCP2MX	1
3FFFFEh	DEVID1	DEV2	DEV1	DEV0	REV4	REV3	REV2	REV1	REV0	xxxx xxxx ⁽⁴⁾
3FFFFFh	DEVID2	DEV10	DEV9	DEV8	DEV7	DEV6	DEV5	DEV4	DEV3	0001 110x ⁽⁴⁾

Legend: x = unknown, u = unchanged, - = unimplemented. Shaded cells are unimplemented, read as '0'.

- 2: The value of these bits in program memory should always be '1'. This ensures that the location is executed as a NOP if it is accidentally executed.
- 3: This bit should always be maintained as '0'.
- 4: See Register 20-7 and Register 20-8 for DEVID values. These registers are read-only and cannot be programmed by the user.

Note 1: Values reflect the unprogrammed state as received from the factory and following Power-on Resets. In all other Reset states, the configuration bytes maintain their previously programmed states.

REGISTER 20-1: CONFIG1L: CONFIGURATION REGISTER 1 LOW (BYTE ADDRESS 300000h)

R/WO-1	R/WO-1	R/WO-1	U-0	U-0	U-0	U-0	R/WO-1
DEBUG	XINST	STVREN	1	_	_	_	WDTEN

bit 7 bit 0

bit 7 **DEBUG:** Background Debugger Enable bit

1 = Background debugger disabled; RB6 and RB7 configured as general purpose I/O pins

0 = Background debugger enabled; RB6 and RB7 are dedicated to In-Circuit Debug

bit 6 XINST: Extended Instruction Set Enable bit

1 = Instruction set extension and Indexed Addressing mode enabled

0 = Instruction set extension and Indexed Addressing mode disabled (Legacy mode)

bit 5 STVREN: Stack Overflow/Underflow Reset Enable bit

1 = Reset on stack overflow/underflow enabled

0 = Reset on stack overflow/underflow disabled

bit 4-1 Unimplemented: Read as '0'

bit 0 WDTEN: Watchdog Timer Enable bit

1 = WDT enabled

0 = WDT disabled (control is placed on SWDTEN bit)

Legend:

R = Readable bit WO = Write-once bit U = Unimplemented bit, read as '0'
-n = Value when device is unprogrammed '1' = Bit is set '0' = Bit is cleared

REGISTER 20-2: CONFIG1H: CONFIGURATION REGISTER 1 HIGH (BYTE ADDRESS 300001h)

U-0	U-0	U-0	U-0	U-0	R/WO-1	U-0	U-0
_	_	_	_	_(1)	CP0	1	_
bit 7							bit 0

bit 7-3 Unimplemented: Read as '0'

bit 2 CP0: Code Protection bit

1 = Program memory is not code-protected

0 = Program memory is code-protected

bit 1-0 Unimplemented: Read as '0'

Note 1: This bit should always be maintained as '0'.

Legend:

R = Readable bit WO = Write-once bit U = Unimplemented bit, read as '0'
-n = Value when device is unprogrammed '1' = Bit is set '0' = Bit is cleared

REGISTER 20-3: CONFIG2L: CONFIGURATION REGISTER 2 LOW (BYTE ADDRESS 300002h)

R/WO-1	R/WO-1	U-0	U-0	U-0	R/WO-1	R/WO-1	R/WO-1
IESO	FCMEN	_	_	_	FOSC2	FOSC1	FOSC0
bit 7							bit 0

bit 0

- bit 7 IESO: Two-Speed Start-up (Internal/External Oscillator Switchover) Control bit
 - 1 = Two-Speed Start-up enabled
 - 0 = Two-Speed Start-up disabled
- FCMEN: Fail-Safe Clock Monitor Enable bit bit 6
 - 1 = Fail-Safe Clock Monitor enabled
 - 0 = Fail-Safe Clock Monitor disabled
- bit 5-3 Unimplemented: Read as '0'
- bit 2 FOSC2: Default/Reset System Clock Select bit
 - 1 = Clock selected by FOSC1:FOSC0 as system clock is enabled when OSCCON<1:0> = 00
 - 0 = INTRC enabled as system clock when OSCCON<1:0> = 00
- bit 1-0 FOSC1:FOSC0: Oscillator Selection bits
 - 11 = EC oscillator, PLL enabled and under software control, CLKO function on OSC2
 - 10 = EC oscillator, CLKO function on OSC2
 - 01 = HS oscillator, PLL enabled and under software control
 - 00 = HS oscillator

Legend:

R = Readable bit WO = Write-once bit U = Unimplemented bit, read as '0'

-n = Value when device is unprogrammed '1' = Bit is set '0' = Bit is cleared

REGISTER 20-4: CONFIG2H: CONFIGURATION REGISTER 2 HIGH (BYTE ADDRESS 300003h)

U-0	U-0	U-0	U-0	R/WO-1	R/WO-1	R/WO-1	R/WO-1
_	_	_	_	WDTPS3	WDTPS2	WDTPS1	WDTPS0
bit 7							bit 0

bit 7-4 Unimplemented: Read as '0'

bit 3-0 WDTPS3:WDTPS0: Watchdog Timer Postscale Select bits

1111 = 1:32,768

1110 = 1:16,384

1101 = 1:8,192

1100 = 1:4,096

1011 = 1:2,048

1010 = 1:1,024

1001 = 1:512

1000 = 1:256

0111 = 1:128

0110 = 1:64

0101 = 1:32

0100 = 1:16

0011 = 1:8

0010 = 1:4

0001 = 1:2

0000 = 1:1

Legend:

WO = Write-once bit U = Unimplemented bit, read as '0' R = Readable bit -n = Value when device is unprogrammed '1' = Bit is set '0' = Bit is cleared

REGISTER 20-5: CONFIG3L: CONFIGURATION REGISTER 3 LOW (BYTE ADDRESS 300004h)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
hit 7							hit 0

bit 7-0 Unimplemented: Read as '0'

Legend:

R = Readable bit U = Unimplemented bit, read as '0'

-n = Value when device is unprogrammed '1' = Bit is set '0' = Bit is cleared

REGISTER 20-6: CONFIG3H: CONFIGURATION REGISTER 3 HIGH (BYTE ADDRESS 300005h)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/WO-1
_	_	_	_	_	_	_	CCP2MX
bit 7							hit 0

bit 7-1 **Unimplemented:** Read as '0' bit 0 **CCP2MX:** CCP2 Mux bit

1 = CCP2 is multiplexed with RC1

0 = CCP2 is multiplexed with RB3

Legend:

R = Readable bit WO = Write-once bit U = Unimplemented bit, read as '0' -n = Value when device is unprogrammed '1' = Bit is set '0' = Bit is cleared

REGISTER 20-7: **DEVICE ID REGISTER 1 FOR PIC18F45J10 FAMILY DEVICES**

R	R	R	R	R	R	R	R
DEV2	DEV1	DEV0	REV4	REV3	REV2	REV1	REV0
bit 7							bit 0

bit 0

bit 7-5 **DEV2:DEV0:** Device ID bits

011 = PIC18F4XJ10 010 = PIC18F2XJ10 001 = PIC18F4XJ10 000 = PIC18F2XJ10

> Where values for DEV2:DEV0 are shared by more than one device number, the specific device is always identified by using the entire DEV10:DEV0 bit sequence.

bit 4-0 REV4:REV0: Revision ID bits

These bits are used to indicate the device revision.

Legend:

R = Read-only bit U = Unimplemented bit, read as '0' -n = Value when device is unprogrammed u = Unchanged from programmed state

REGISTER 20-8: **DEVICE ID REGISTER 2 FOR PIC18F45J10 FAMILY DEVICES**

R	R	R	R	R	R	R	R
DEV10	DEV9	DEV8	DEV7	DEV6	DEV5	DEV4	DEV3
bit 7							bit 0

bit 7-0 **DEV10:DEV3:** Device ID bits

These bits are used with the DEV2:DEV0 bits in the Device ID Register 1 to identify the part number.

0001 1100 = PIC18FX5J10 devices 0001 1101 = PIC18FX4J10 devices

The values for DEV10:DEV3 may be shared with other device families. The specific Note: device is always identified by using the entire DEV10:DEV0 bit sequence.

Legend:

R = Read-only bit U = Unimplemented bit, read as '0' -n = Value when device is unprogrammed u = Unchanged from programmed state

20.2 Watchdog Timer (WDT)

For PIC18F45J10 family devices, the WDT is driven by the INTRC oscillator. When the WDT is enabled, the clock source is also enabled. The nominal WDT period is 4 ms and has the same stability as the INTRC oscillator.

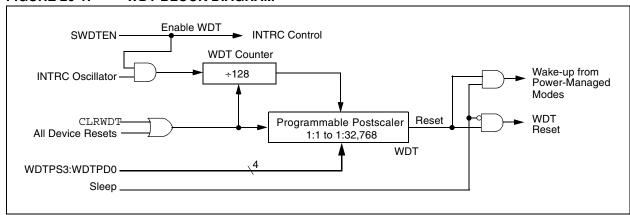
The 4 ms period of the WDT is multiplied by a 16-bit postscaler. Any output of the WDT postscaler is selected by a multiplexor, controlled by the WDTPS bits in Configuration Register 2H. Available periods range from 4 ms to 131.072 seconds (2.18 minutes). The WDT and postscaler are cleared whenever a SLEEP or CLRWDT instruction is executed, or a clock failure (primary or Timer1 oscillator) has occurred.

- Note 1: The CLRWDT and SLEEP instructions clear the WDT and postscaler counts when executed.
 - **2:** When a CLRWDT instruction is executed, the postscaler count will be cleared.

20.2.1 CONTROL REGISTER

The WDTCON register (Register 20-9) is a readable and writable register. The SWDTEN bit enables or disables WDT operation.

FIGURE 20-1: WDT BLOCK DIAGRAM



REGISTER 20-9: WDTCON: WATCHDOG TIMER CONTROL REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
_	_	_	_	_	_	_	SWDTEN ⁽¹⁾
bit 7							bit 0

bit 7-1 Unimplemented: Read as '0'

bit 0 **SWDTEN:** Software Controlled Watchdog Timer Enable bit⁽¹⁾

- 1 = Watchdog Timer is on
- 0 = Watchdog Timer is off

Note 1: This bit has no effect if the configuration bit, WDTEN, is enabled.

L	egend:			
R	R = Readable bit	W = Writable bit	U = Unimplemented	bit, read as '0'
-r	n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

TABLE 20-2: SUMMARY OF WATCHDOG TIMER REGISTERS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
RCON	IPEN	_	_	RI	TO	PD	POR	BOR	44
WDTCON	_							SWDTEN	44

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the Watchdog Timer.

20.3 On-Chip Voltage Regulator

Note: The on-chip voltage regulator is only available in parts designated with an "F", such as PIC18**F**45J10.

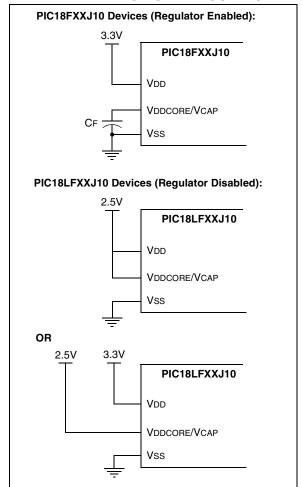
In parts designated "LF", the microcontroller core can be powered from an external source that is separate from VDD, or it can be powered from an on-chip regulator which derives power from VDD. Both sources use the common VDDCORE/VCAP pin.

In "F" devices, a low ESR capacitor must be connected to the VDDCORE/VCAP pin for proper device operation. In parts designated with an "LF" part number (i.e., PIC18LF45J10), power to the core must be supplied on VDDCORE/VCAP. It is always good design practice to have sufficient capacitance on all supply pins. Examples are shown in Figure 20-2.

Note: In parts designated with an "LF", such as PIC18LF45J10, VDDCORE must never exceed VDD.

The specifications for core voltage and capacitance are listed in Section 23.4 "AC (Timing) Characteristics".

FIGURE 20-2: CONNECTIONS FOR THE ON-CHIP REGULATOR



20.3.1 ON-CHIP REGULATOR AND BOR

PIC18F45J10 family devices (designated with an "F" part number) also have a simple brown-out capability. If the voltage supplied to the regulator is inadequate to maintain a regulated level, the regulator Reset circuitry will generate a BOR Reset. This event is captured by the BOR flag bit (RCON<0>).

The operation of the BOR is described in more detail in Section 4.4 "Brown-out Reset (BOR) (PIC18F2XJ10/4XJ10 Devices Only)" and Section 4.4.1 "Detecting BOR". The brown-out voltage levels are specific in Section 23.1 "DC Characteristics".

20.3.2 POWER-UP REQUIREMENTS

The on-chip regulator is designed to meet the power-up requirements for the device. While powering up, VDDCORE must never exceed VDD by 0.3 volts.

20.4 Two-Speed Start-up

The Two-Speed Start-up feature helps to minimize the latency period, from oscillator start-up to code execution, by allowing the microcontroller to use the INTRC oscillator as a clock source until the primary clock source is available. It is enabled by setting the IESO configuration bit.

Two-Speed Start-up should be enabled only if the primary oscillator mode is HS (Crystal-based) modes. Since the EC mode does not require an OST start-up delay, Two-Speed Start-up should be disabled.

When enabled, Resets and wake-ups from Sleep mode cause the device to configure itself to run from the internal oscillator block as the clock source, following the time-out of the Power-up Timer after a POR Reset is enabled. This allows almost immediate code execution while the primary oscillator starts and the OST is running. Once the OST times out, the device automatically switches to PRI_RUN mode.

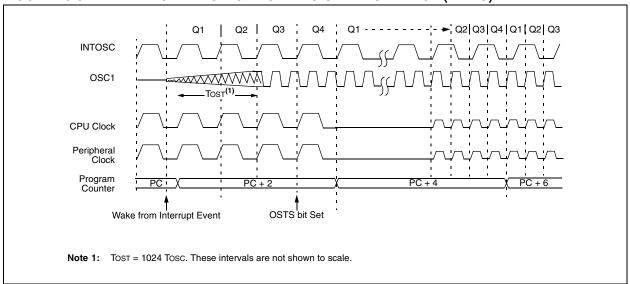
In all other power-managed modes, Two-Speed Start-up is not used. The device will be clocked by the currently selected clock source until the primary clock source becomes available. The setting of the IESO bit is ignored.

20.4.1 SPECIAL CONSIDERATIONS FOR USING TWO-SPEED START-UP

While using the INTRC oscillator in Two-Speed Start-up, the device still obeys the normal command sequences for entering power-managed modes, including serial SLEEP instructions (refer to Section 3.1.4 "Multiple Sleep Commands"). In practice, this means that user code can change the SCS1:SCS0 bit settings or issue SLEEP instructions before the OST times out. This would allow an application to briefly wake-up, perform routine "housekeeping" tasks and return to Sleep before the device starts to operate from the primary oscillator.

User code can also check if the primary clock source is currently providing the device clocking by checking the status of the OSTS bit (OSCCON<3>). If the bit is set, the primary oscillator is providing the clock. Otherwise, the internal oscillator block is providing the clock during wake-up from Reset or Sleep mode.



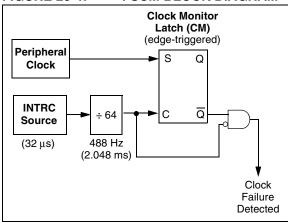


20.5 Fail-Safe Clock Monitor

The Fail-Safe Clock Monitor (FSCM) allows the microcontroller to continue operation in the event of an external oscillator failure by automatically switching the device clock to the internal oscillator block. The FSCM function is enabled by setting the FCMEN configuration bit.

When FSCM is enabled, the INTRC oscillator runs at all times to monitor clocks to peripherals and provide a backup clock in the event of a clock failure. Clock monitoring (shown in Figure 20-4) is accomplished by creating a sample clock signal which is the INTRC output divided by 64. This allows ample time between FSCM sample clocks for a peripheral clock edge to occur. The peripheral device clock and the sample clock are presented as inputs to the Clock Monitor latch (CM). The CM is set on the falling edge of the device clock source but cleared on the rising edge of the sample clock.

FIGURE 20-4: FSCM BLOCK DIAGRAM



Clock failure is tested for on the falling edge of the sample clock. If a sample clock falling edge occurs while CM is still set, a clock failure has been detected (Figure 20-5). This causes the following:

- the FSCM generates an oscillator fail interrupt by setting bit OSCFIF (PIR2<7>);
- the device clock source is switched to the internal oscillator block (OSCCON is not updated to show the current clock source – this is the fail-safe condition); and
- the WDT is reset.

During switchover, the postscaler frequency from the internal oscillator block may not be sufficiently stable for timing sensitive applications. In these cases, it may be desirable to select another clock configuration and enter an alternate power-managed mode. This can be done to attempt a partial recovery or execute a controlled shutdown. See Section 3.1.4 "Multiple Sleep Commands" and Section 20.4.1 "Special Considerations for Using Two-Speed Start-up" for more details.

To use a higher clock speed on wake-up, the INTOSC or postscaler clock sources can be selected to provide a higher clock speed by setting bits IRCF2:IRCF0 immediately after Reset. For wake-ups from Sleep, the INTOSC or postscaler clock sources can be selected by setting IRCF2:IRCF0 prior to entering Sleep mode.

The FSCM will detect failures of the primary or secondary clock sources only. If the internal oscillator block fails, no failure would be detected, nor would any action be possible.

20.5.1 FSCM AND THE WATCHDOG TIMER

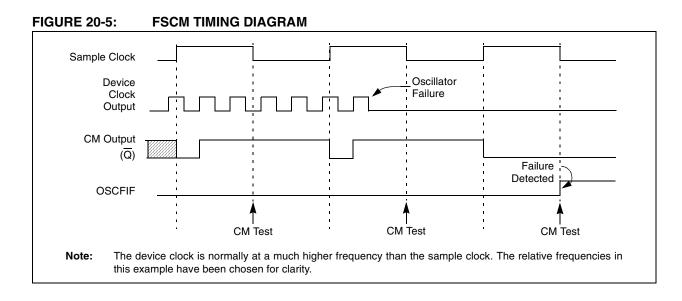
Both the FSCM and the WDT are clocked by the INTRC oscillator. Since the WDT operates with a separate divider and counter, disabling the WDT has no effect on the operation of the INTRC oscillator when the FSCM is enabled.

As already noted, the clock source is switched to the INTRC clock when a clock failure is detected; this may mean a substantial change in the speed of code execution. If the WDT is enabled with a small prescale value, a decrease in clock speed allows a WDT time-out to occur and a subsequent device Reset. For this reason, Fail-Safe Clock Monitor events also reset the WDT and postscaler, allowing it to start timing from when execution speed was changed and decreasing the likelihood of an erroneous time-out.

20.5.2 EXITING FAIL-SAFE OPERATION

The fail-safe condition is terminated by either a device Reset or by entering a power-managed mode. On Reset, the controller starts the primary clock source specified in Configuration Register 2H (with the OST oscillator, start-up delays if running in HS mode). The INTRC oscillator provides the device clock until the primary clock source becomes ready (similar to a Two-Speed Start-up). The clock source is then switched to the primary clock (indicated by the OSTS bit in the OSCCON register becoming set). The Fail-Safe Clock Monitor then resumes monitoring the peripheral clock.

The primary clock source may never become ready during start-up. In this case, operation is clocked by the INTRC oscillator. The OSCCON register will remain in its Reset state until a power-managed mode is entered.



20.5.3 FSCM INTERRUPTS IN POWER-MANAGED MODES

By entering a power-managed mode, the clock multiplexor selects the clock source selected by the OSCCON register. Fail-Safe Monitoring of the power-managed clock source resumes in the power-managed mode.

If an oscillator failure occurs during power-managed operation, the subsequent events depend on whether or not the oscillator failure interrupt is enabled. If enabled (OSCFIF = 1), code execution will be clocked by the INTOSC multiplexor. An automatic transition back to the failed clock source will not occur.

If the interrupt is disabled, subsequent interrupts while in Idle mode will cause the CPU to begin executing instructions while being clocked by the INTOSC source.

20.5.4 POR OR WAKE-UP FROM SLEEP

The FSCM is designed to detect oscillator failure at any point after the device has exited Power-on Reset (POR) or low-power Sleep mode. When the primary device clock is either EC or INTRC modes, monitoring can begin immediately following these events.

For HS mode, the situation is somewhat different. Since the oscillator may require a start-up time considerably longer than the FSCM sample clock time, a false clock failure may be detected. To prevent this, the internal oscillator block is automatically configured as the device clock and functions until the primary clock is stable (the OST timer has timed out). This is identical to Two-Speed Start-up mode. Once the primary clock is stable, the INTRC returns to its role as the FSCM source.

Note: The same logic that prevents false oscillator failure interrupts on POR, or wake from Sleep, will also prevent the detection of the oscillator's failure to start at all following these events. This can be avoided by monitoring the OSTS bit and using a timing routine to determine if the oscillator is taking too long to start. Even so, no oscillator failure interrupt will be flagged.

As noted in Section 20.4.1 "Special Considerations for Using Two-Speed Start-up", it is also possible to select another clock configuration and enter an alternate power-managed mode while waiting for the primary clock to become stable. When the new power-managed mode is selected, the primary clock is disabled.

20.6 Program Verification and Code Protection

For all devices in the PIC18F45J10 family of devices, the on-chip program memory space is treated as a single block. Code protection for this block is controlled by one configuration bit, CP0. This bit inhibits external reads and writes to the program memory space. It has no direct effect in normal execution mode.

20.6.1 CONFIGURATION REGISTER PROTECTION

The Configuration registers are protected against untoward changes or reads in two ways. The primary protection is the write-once feature of the configuration bits which prevents reconfiguration once the bit has been programmed during a power cycle. To safeguard against unpredictable events, configuration bit changes resulting from individual cell-level disruptions (such as ESD events) will cause a parity error and trigger a device Reset.

The data for the Configuration registers is derived from the Flash Configuration Words in program memory. When the CP0 bit is set, the source data for device configuration is also protected as a consequence.

20.7 In-Circuit Serial Programming

PIC18F45J10 family microcontrollers can be serially programmed while in the end application circuit. This is simply done with two lines for clock and data and three other lines for power, ground and the programming voltage. This allows customers to manufacture boards with unprogrammed devices and then program the microcontroller just before shipping the product. This also allows the most recent firmware or a custom firmware to be programmed.

20.8 In-Circuit Debugger

When the DEBUG configuration bit is programmed to a '0', the In-Circuit Debugger functionality is enabled. This function allows simple debugging functions when used with MPLAB® IDE. When the microcontroller has this feature enabled, some resources are not available for general use. Table 20-3 shows which resources are required by the background debugger.

TABLE 20-3: DEBUGGER RESOURCES

I/O pins:	RB6, RB7
Stack:	2 levels
Program Memory:	512 bytes
Data Memory:	32 bytes

21.0 INSTRUCTION SET SUMMARY

PIC18F45J10 family devices incorporate the standard set of 75 PIC18 core instructions, as well as an extended set of 8 new instructions, for the optimization of code that is recursive or that utilizes a software stack. The extended set is discussed later in this section.

21.1 Standard Instruction Set

The standard PIC18 instruction set adds many enhancements to the previous PICmicro® instruction sets, while maintaining an easy migration from these PICmicro instruction sets. Most instructions are a single program memory word (16 bits), but there are four instructions that require two program memory locations.

Each single-word instruction is a 16-bit word divided into an opcode, which specifies the instruction type and one or more operands, which further specify the operation of the instruction.

The instruction set is highly orthogonal and is grouped into four basic categories:

- · Byte-oriented operations
- · Bit-oriented operations
- · Literal operations
- · Control operations

The PIC18 instruction set summary in Table 21-2 lists **byte-oriented**, **bit-oriented**, **literal** and **control** operations. Table 21-1 shows the opcode field descriptions.

Most **byte-oriented** instructions have three operands:

- 1. The file register (specified by 'f')
- 2. The destination of the result (specified by 'd')
- 3. The accessed memory (specified by 'a')

The file register designator 'f' specifies which file register is to be used by the instruction. The destination designator 'd' specifies where the result of the operation is to be placed. If 'd' is zero, the result is placed in the WREG register. If 'd' is one, the result is placed in the file register specified in the instruction.

All bit-oriented instructions have three operands:

- 1. The file register (specified by 'f')
- 2. The bit in the file register (specified by 'b')
- 3. The accessed memory (specified by 'a')

The bit field designator 'b' selects the number of the bit affected by the operation, while the file register designator 'f' represents the number of the file in which the bit is located.

The **literal** instructions may use some of the following operands:

- A literal value to be loaded into a file register (specified by 'k')
- The desired FSR register to load the literal value into (specified by 'f')
- No operand required (specified by '—')

The **control** instructions may use some of the following operands:

- A program memory address (specified by 'n')
- The mode of the CALL or RETURN instructions (specified by 's')
- The mode of the table read and table write instructions (specified by 'm')
- No operand required (specified by '—')

All instructions are a single word, except for four double-word instructions. These instructions were made double-word to contain the required information in 32 bits. In the second word, the 4 MSbs are '1's. If this second word is executed as an instruction (by itself), it will execute as a NOP.

All single-word instructions are executed in a single instruction cycle, unless a conditional test is true or the program counter is changed as a result of the instruction. In these cases, the execution takes two instruction cycles, with the additional instruction cycle(s) executed as a NOP.

The double-word instructions execute in two instruction cycles.

One instruction cycle consists of four oscillator periods. Thus, for an oscillator frequency of 4 MHz, the normal instruction execution time is 1 μ s. If a conditional test is true, or the program counter is changed as a result of an instruction, the instruction execution time is 2 μ s. Two-word branch instructions (if true) would take 3 μ s.

Figure 21-1 shows the general formats that the instructions can have. All examples use the convention 'nnh' to represent a hexadecimal number.

The Instruction Set Summary, shown in Table 21-2, lists the standard instructions recognized by the Microchip Assembler (MPASM TM).

Section 21.1.1 "Standard Instruction Set" provides a description of each instruction.

TABLE 21-1: OPCODE FIELD DESCRIPTIONS

Field	CODE FIELD DESCRIPTIONS Description
	RAM access bit
	a = 0: RAM location in Access RAM (BSR register is ignored)
	a = 1: RAM bank is specified by BSR register
bbb	Bit address within an 8-bit file register (0 to 7).
	Bank Select Register. Used to select the current RAM bank.
	ALU Status bits: Carry, Digit Carry, Zero, Overflow, Negative.
	Destination select bit
(d = 0: store result in WREG
(d = 1: store result in file register f
dest [Destination: either the WREG register or the specified register file location.
	8-bit Register file address (00h to FFh) or 2-bit FSR designator (0h to 3h).
-	12-bit Register file address (000h to FFFh). This is the source address.
f _d	12-bit Register file address (000h to FFFh). This is the destination address.
GIE (Global Interrupt Enable bit.
k l	Literal field, constant data or label (may be either an 8-bit, 12-bit or a 20-bit value).
label	Label name.
	The mode of the TBLPTR register for the table read and table write instructions.
	Only used with table read and table write instructions:
*	No change to register (such as TBLPTR with table reads and writes)
*+	Post-Increment register (such as TBLPTR with table reads and writes)
* -	Post-Decrement register (such as TBLPTR with table reads and writes)
+*	Pre-Increment register (such as TBLPTR with table reads and writes)
(The relative address (2's complement number) for relative branch instructions or the direct address for Call/Branch and Return instructions.
PC F	Program Counter.
PCL F	Program Counter Low Byte.
PCH F	Program Counter High Byte.
PCLATH F	Program Counter High Byte Latch.
PCLATU F	Program Counter Upper Byte Latch.
PD F	Power-down bit.
	Product of Multiply High Byte.
	Product of Multiply Low Byte.
	Fast Call/Return mode select bit
	s = 0: do not update into/from shadow registers s = 1: certain registers loaded into/from shadow registers (Fast mode)
	21-bit Table Pointer (points to a Program Memory location).
	8-bit Table Latch.
	Time-out bit.
	Top-of-Stack.
	Unused or unchanged.
	Watchdog Timer.
	Working register (accumulator).
	Don't care ('0' or '1'). The assembler will generate code with x = 0. It is the recommended form of use for
	compatibility with all Microchip software tools.
	7-bit offset value for indirect addressing of register files (source).
5	7-bit offset value for indirect addressing of register files (destination).
u .	Optional argument.
	Indicates an indexed address.
(+ 077+)	The contents of text.
(text)	The contents of text.
	Specifies bit n of the register indicated by the pointer expr.
[expr] <n></n>	
[expr] < n >	Specifies bit ${\tt n}$ of the register indicated by the pointer ${\tt expr.}$
[expr] <n></n>	Specifies bit ${\tt n}$ of the register indicated by the pointer ${\tt expr.}$ Assigned to.

FIGURE 21-1: GENERAL FORMAT FOR INSTRUCTIONS

Byte-oriented file register operations **Example Instruction** 10 OPCODE f (FILE #) ADDWF MYREG, W, B d а d = 0 for result destination to be WREG register d = 1 for result destination to be file register (f) a = 0 to force Access Bank a = 1 for BSR to select bank f = 8-bit file register address Byte to Byte move operations (2-word) 12 11 OPCODE f (Source FILE #) MOVFF MYREG1, MYREG2 15 12 11 0 f (Destination FILE #) 1111 f = 12-bit file register address Bit-oriented file register operations OPCODE b (BIT #) a f (FILE #) BSF MYREG, bit, B b = 3-bit position of bit in file register (f) a = 0 to force Access Bank a = 1 for BSR to select bank f = 8-bit file register address Literal operations 15 8 7 0 **OPCODE** k (literal) MOVLW 7Fh k = 8-bit immediate value **Control** operations CALL, GOTO and Branch operations 15 0 OPCODE n<7:0> (literal) GOTO Label 15 12 11 0 1111 n<19:8> (literal) n = 20-bit immediate value 15 CALL MYFUNC **OPCODE** n<7:0> (literal) 15 12 11 0 n<19:8> (literal) 1111 S = Fast bit 11 10 BRA MYFUNC **OPCODE** n<10:0> (literal) 15 8 7 OPCODE n<7:0> (literal) BC MYFUNC

TABLE 21-2: PIC18FXXXX INSTRUCTION SET

Mnemo	nic,	Description	Ouslas	16-	Bit Instr	uction W	ord	Status	Natas
Opera	nds	Description	Cycles	MSb			LSb	Affected	Notes
BYTE-ORIE	ENTED (PERATIONS							
ADDWF	f, d, a	Add WREG and f	1	0010	01da	ffff	ffff	C, DC, Z, OV, N	1, 2
ADDWFC	f, d, a	Add WREG and CARRY bit to f	1	0010	00da	ffff	ffff	C, DC, Z, OV, N	1, 2
ANDWF	f, d, a	AND WREG with f	1	0001	01da	ffff	ffff	Z, N	1,2
CLRF	f, a	Clear f	1	0110	101a	ffff	ffff	Z	2
COMF	f, d, a	Complement f	1	0001	11da	ffff	ffff	Z, N	1, 2
CPFSEQ	f, a	Compare f with WREG, skip =	1 (2 or 3)	0110	001a	ffff	ffff	None	4
CPFSGT	f, a	Compare f with WREG, skip >	1 (2 or 3)	0110	010a	ffff	ffff	None	4
CPFSLT	f, a	Compare f with WREG, skip <	1 (2 or 3)	0110	000a	ffff	ffff	None	1, 2
DECF	f, d, a	Decrement f	1 ′	0000	01da	ffff	ffff	C, DC, Z, OV, N	1, 2, 3, 4
DECFSZ	f, d, a	Decrement f, Skip if 0	1 (2 or 3)	0010	11da	ffff	ffff	None	1, 2, 3, 4
DCFSNZ	f, d, a	Decrement f, Skip if Not 0	1 (2 or 3)	0100	11da	ffff	ffff	None	1, 2
INCF	f, d, a	Increment f	1 ` ′	0010	10da	ffff	ffff	C, DC, Z, OV, N	1, 2, 3, 4
INCFSZ	f, d, a	Increment f, Skip if 0	1 (2 or 3)	0011	11da	ffff	ffff	None	4
INFSNZ	f, d, a	Increment f, Skip if Not 0	1 (2 or 3)	0100	10da	ffff	ffff	None	1, 2
IORWF	f, d, a	Inclusive OR WREG with f	1 ′	0001	00da	ffff	ffff	Z, N	1, 2
MOVF	f, d, a	Move f	1	0101	00da	ffff	ffff	Z, N	1
MOVFF	f_s, f_d	Move f _s (source) to 1st word	2	1100	ffff	ffff	ffff	None	
	3, u	f _d (destination) 2nd word		1111	ffff	ffff	ffff		
MOVWF	f, a	Move WREG to f	1	0110	111a	ffff	ffff	None	
MULWF	f, a	Multiply WREG with f	1	0000	001a	ffff	ffff	None	1, 2
NEGF	f, a	Negate f	1	0110	110a	ffff	ffff	C, DC, Z, OV, N	,
RLCF	f, d, a	Rotate Left f through Carry	1	0011	01da	ffff	ffff	C, Z, N	1, 2
RLNCF	f, d, a	Rotate Left f (No Carry)	1	0100	01da	ffff	ffff	Z, N	
RRCF	f, d, a	Rotate Right f through Carry	1	0011	00da	ffff	ffff	C, Z, N	
RRNCF	f, d, a	Rotate Right f (No Carry)	1	0100	00da	ffff	ffff	Z, N	
SETF	f, a	Set f	1	0110	100a	ffff	ffff	None	1, 2
SUBFWB	f, d, a	Subtract f from WREG with	1	0101	01da	ffff	ffff	C, DC, Z, OV, N	,
	, ,	borrow						' ' ' '	
SUBWF	f, d, a	Subtract WREG from f	1	0101	11da	ffff	ffff	C, DC, Z, OV, N	1, 2
SUBWFB	f, d, a	Subtract WREG from f with	1	0101	10da	ffff	ffff	C, DC, Z, OV, N	
		borrow							
SWAPF	f, d, a	Swap nibbles in f	1	0011	10da	ffff	ffff	None	4
TSTFSZ	f, a	Test f, skip if 0	1 (2 or 3)	0110	011a	ffff	ffff	None	1, 2
XORWF	f, d, a	Exclusive OR WREG with f	1 ′	0001	10da	ffff	ffff	Z, N	

Note 1: When a Port register is modified as a function of itself (e.g., MOVF PORTB, 1, 0), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

^{2:} If this instruction is executed on the TMR0 register (and where applicable, 'd' = 1), the prescaler will be cleared if assigned.

^{3:} If Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

^{4:} Some instructions are two-word instructions. The second word of these instructions will be executed as a NOP unless the first word of the instruction retrieves the information embedded in these 16 bits. This ensures that all program memory locations have a valid instruction.

TABLE 21-2: PIC18FXXXX INSTRUCTION SET (CONTINUED)

Mnemo	onic,	Description	Ovelee	16-	Bit Instr	uction W	ord	Status	Notes
Opera	nds	Description	Cycles	MSb			LSb	Affected	Notes
BIT-ORIEN	TED OP	ERATIONS							
BCF	f, b, a	Bit Clear f	1	1001	bbba	ffff	ffff	None	1, 2
BSF	f, b, a	Bit Set f	1	1000	bbba	ffff	ffff	None	1, 2
BTFSC	f, b, a	Bit Test f, Skip if Clear	1 (2 or 3)	1011	bbba	ffff	ffff	None	3, 4
BTFSS	f, b, a	Bit Test f, Skip if Set	1 (2 or 3)	1010	bbba	ffff	ffff	None	3, 4
BTG	f, d, a	Bit Toggle f	1	0111	bbba	ffff	ffff	None	1, 2
CONTROL	OPERA	TIONS							
ВС	n	Branch if Carry	1 (2)	1110	0010	nnnn	nnnn	None	
BN	n	Branch if Negative	1 (2)	1110	0110	nnnn	nnnn	None	
BNC	n	Branch if Not Carry	1 (2)	1110	0011	nnnn	nnnn	None	
BNN	n	Branch if Not Negative	1 (2)	1110	0111	nnnn	nnnn	None	
BNOV	n	Branch if Not Overflow	1 (2)	1110	0101	nnnn	nnnn	None	
BNZ	n	Branch if Not Zero	1 (2)	1110	0001	nnnn	nnnn	None	
BOV	n	Branch if Overflow	1 (2)	1110	0100	nnnn	nnnn	None	
BRA	n	Branch Unconditionally	2	1101	0nnn	nnnn	nnnn	None	
BZ	n	Branch if Zero	1 (2)	1110	0000	nnnn	nnnn	None	
CALL	n, s	Call subroutine 1st word	2	1110	110s	kkkk	kkkk	None	
		2nd word		1111	kkkk	kkkk	kkkk		
CLRWDT	_	Clear Watchdog Timer	1	0000	0000	0000	0100	TO, PD	
DAW	_	Decimal Adjust WREG	1	0000	0000	0000	0111	С	
GOTO	n	Go to address 1st word	2	1110	1111	kkkk	kkkk	None	
		2nd word		1111	kkkk	kkkk	kkkk		
NOP	_	No Operation	1	0000	0000	0000	0000	None	
NOP	_	No Operation	1	1111	xxxx	XXXX	xxxx	None	4
POP	_	Pop top of return stack (TOS)	1	0000	0000	0000	0110	None	
PUSH	_	Push top of return stack (TOS)	1	0000	0000	0000	0101	None	
RCALL	n	Relative Call	2	1101	1nnn	nnnn	nnnn	None	
RESET		Software device Reset	1	0000	0000	1111	1111	All	
RETFIE	S	Return from interrupt enable	2	0000	0000	0001	000s	GIE/GIEH,	
								PEIE/GIEL	
RETLW	k	Return with literal in WREG	2	0000	1100	kkkk	kkkk	None	
RETURN	S	Return from Subroutine	2	0000	0000	0001	001s	None_	
SLEEP	_	Go into Standby mode	1	0000	0000	0000	0011	TO, PD	

Note 1: When a Port register is modified as a function of itself (e.g., MOVF PORTB, 1, 0), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

^{2:} If this instruction is executed on the TMR0 register (and where applicable, 'd' = 1), the prescaler will be cleared if assigned.

^{3:} If Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

^{4:} Some instructions are two-word instructions. The second word of these instructions will be executed as a NOP unless the first word of the instruction retrieves the information embedded in these 16 bits. This ensures that all program memory locations have a valid instruction.

TABLE 21-2: PIC18FXXXX INSTRUCTION SET (CONTINUED)

Mnemonic,		Description	Oveles	16-Bit Instruction Word			Status		
Opera	ınds	Description	Cycles	MSb			LSb	Affected	Notes
LITERAL (OPERAT	ONS							
ADDLW	k	Add literal and WREG	1	0000	1111	kkkk	kkkk	C, DC, Z, OV, N	
ANDLW	k	AND literal with WREG	1	0000	1011	kkkk	kkkk	Z, N	
IORLW	k	Inclusive OR literal with WREG	1	0000	1001	kkkk	kkkk	Z, N	
LFSR	f, k	Move literal (12-bit) 2nd word	2	1110	1110	OOff	kkkk	None	
		to FSR(f) 1st word		1111	0000	kkkk	kkkk		
MOVLB	k	Move literal to BSR<3:0>	1	0000	0001	0000	kkkk	None	
MOVLW	k	Move literal to WREG	1	0000	1110	kkkk	kkkk	None	
MULLW	k	Multiply literal with WREG	1	0000	1101	kkkk	kkkk	None	
RETLW	k	Return with literal in WREG	2	0000	1100	kkkk	kkkk	None	
SUBLW	k	Subtract WREG from literal	1	0000	1000	kkkk	kkkk	C, DC, Z, OV, N	
XORLW	k	Exclusive OR literal with WREG	1	0000	1010	kkkk	kkkk	Z, N	
DATA MEN	MORY ↔	PROGRAM MEMORY OPERATION	IS						
TBLRD*		Table Read	2	0000	0000	0000	1000	None	
TBLRD*+		Table Read with post-increment		0000	0000	0000	1001	None	
TBLRD*-		Table Read with post-decrement		0000	0000	0000	1010	None	
TBLRD+*		Table Read with pre-increment		0000	0000	0000	1011	None	
TBLWT*		Table Write	2	0000	0000	0000	1100	None	
TBLWT*+		Table Write with post-increment		0000	0000	0000	1101	None	
TBLWT*-		Table Write with post-decrement		0000	0000	0000	1110	None	
TBLWT+*		Table Write with pre-increment		0000	0000	0000	1111	None	

Note 1: When a Port register is modified as a function of itself (e.g., MOVF PORTB, 1, 0), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

^{2:} If this instruction is executed on the TMR0 register (and where applicable, 'd' = 1), the prescaler will be cleared if assigned.

^{3:} If Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

^{4:} Some instructions are two-word instructions. The second word of these instructions will be executed as a NOP unless the first word of the instruction retrieves the information embedded in these 16 bits. This ensures that all program memory locations have a valid instruction.

21.1.1 STANDARD INSTRUCTION SET

ADD	LW	ADD Literal to W				
Synta	ax:	ADDLW	k			
Oper	ands:	$0 \le k \le 255$	5			
Oper	ation:	$(W)+k\rightarrow$	W			
Statu	s Affected:	N, OV, C, I	DC, Z			
Enco	ding:	0000	1111	kkkk	kkkk	
Description:		The conter 8-bit literal W.				
Word	ls:	1	1			
Cycle	es:	1	1			
QC	ycle Activity:					
	Q1	Q2	Q3	3	Q4	
	Decode	Read literal 'k'	Proce Data		rite to W	

Example: ADDLW 15h

> Before Instruction W = 10h After Instruction W = 25h

ADDWF	ADD W to f				
Syntax:	ADDWF f {,d {,a}}				
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$				
Operation:	$(W)+(f)\todest$				
Status Affected:	N, OV, C, DC, Z				
Encoding:	0010 01da ffff ffff				
Description:	Add W to register 'f'. If 'd' is 'o', the result is stored in W. If 'd' is '1', the result is stored back in register 'f' (default). If 'a' is 'o', the Access Bank is selected. If 'a' is 'o', the BSR is used to select the GPR bank (default). If 'a' is 'o' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 21.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
Words:	1				
Cycles:	1				

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination

Example: ADDWF REG, 0, 0

Before Instruction

17h REG 0C2h

After Instruction

W 0D9h REG 0C2h

Note: All PIC18 instructions may take an optional label argument preceding the instruction mnemonic for use in symbolic addressing. If a label is used, the instruction format then becomes: {label} instruction argument(s).

ADDWFC	ADD W and Carry bit to f					
Syntax:	ADDWFC	f {,d {,a	}}			
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$	d ∈ [0,1]				
Operation:	(W) + (f) +	$(C) \rightarrow des$	st			
Status Affected:	N,OV, C, D	C, Z				
Encoding:	0010	00da	ffff	ffff		
Description:	location 'f'. placed in W placed in d If 'a' is '0', t If 'a' is '1', t GPR bank If 'a' is '0' a set is enabl in Indexed mode wher Section 21 Bit-Oriente	Add W, the Carry flag and data memory location 'f'. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed in data memory location 'f'. If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 21.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details				
Words:	1					
Cycles:	1	1				
Q Cycle Activity:	:					
Q1	Q2	Q3		Q4		
Decode	Read register 'f'	Proces Data		Vrite to stination		

	Booodo		jister 'f'	Data		des
Exan	nple:	ΑĽ	DWFC	REG,	0,	1
	Before Instruc Carry bit REG W After Instructio	= =				
	Carry bit REG W	= =	0 02h 50h			

AND Literal with W				
ANDLW	k			
$0 \le k \le 255$				
(W) .AND.	$k \rightarrow W$			
N, Z				
0000	1011	1011 kkkk		
1				
1				
Q2	Q3	}	Q4	
Read literal 'k'			rite to W	
	ANDLW 0 ≤ k ≤ 255 (W) .AND. N, Z 0000 The content 8-bit literal 1 1 Q2 Read literal	ANDLW k $0 \le k \le 255$ (W) .AND. $k \to W$ N, Z 0000 1011 The contents of W a 8-bit literal 'k'. The r 1 1 Q2 Q3 Read literal Proce	ANDLW k $0 \le k \le 255$ (W) .AND. $k \to W$ N, Z 0000 1011 kkkkk The contents of W are ANDec 8-bit literal 'k'. The result is plated at the second sec	

ANDWF AND W with f ANDWF Syntax: f {,d {,a}} Operands: $0 \le f \le 255$ $d\in \left[0,1\right]$ $a\in \left[0,1\right]$ Operation: (W) .AND. (f) \rightarrow dest Status Affected: Encoding: 0001 ffff ffff 01da The contents of W are ANDed with Description: register 'f'. If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f' (default). If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 21.2.3 "Byte-Oriented and **Bit-Oriented Instructions in Indexed** Literal Offset Mode" for details. Words: 1 1 Cycles: Q Cycle Activity: Q1 Q2 Q3 Q4 Read **Process** Write to Decode

Example:	Αl	ANDWF		0,	0
Before Instr	uction				
W	=	17h			
REG	=	C2h			
After Instruc	ction				
W	=	02h			
REG	=	C2h			

register 'f'

Data

destination

вс		Branch if	Carry			
Synta	ax:	BC n				
Oper	ands:	-128 ≤ n ≤ 1	127			
Oper	ation:	•	if Carry bit is '1' $(PC) + 2 + 2n \rightarrow PC$			
Statu	s Affected:	None				
Enco	ding:	1110	0010	nnnn	nnnn	
Desc	ription:	If the Carry will branch. The 2's con added to the incremente instruction, PC + 2 + 2r two-cycle ir	nplement e PC. Sir d to fetch the new n. This in	t numbe nce the F n the net address struction	r '2n' is PC will have xt s will be	
Word	ls:	1	1			
Cycle	es:	1(2)	1(2)			
Q C If Ju	ycle Activity: mp:					
	Q1	Q2	Q3		Q4	
	Decode	Read literal 'n'	Proce Data		Write to PC	
	No	No	No		No	
	operation	operation	opera	tion	operation	
If No	o Jump:					
	Q1	Q2	Q3		Q4	

Example:	HERE	вс	5
Before Instruction PC After Instruction	=	address	(HERE)
If Carry PC If Carry PC	= = = =	0;	(HERE + 12)

Read literal

'n'

Process

Data

No

operation

Decode

BCF	Bit Clear f			
Syntax:	BCF f, b {,a}			
Operands:	$0 \le f \le 255$ $0 \le b \le 7$ $a \in [0,1]$			
Operation:	$0 \rightarrow f < b >$			
Status Affected:	None			
Encoding:	1001 bbba ffff ffff			
Description: Bit 'b' in register 'f' is cleared. If 'a' is '0', the Access Bank is select If 'a' is '1', the BSR is used to select GPR bank (default). If 'a' is '0' and the extended instructi				

set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f \leq 95 (5Fh). See Section 21.2.3 "Byte-Oriented and **Bit-Oriented Instructions in Indexed** Literal Offset Mode" for details.

Words: Cycles:

Q Cycle Activity:

	Q1	Q2	Q3	Q4
ĺ	Decode	Read	Process	Write
		register 'f'	Data	register 'f'

Example: BCF FLAG REG, 7, 0

Before Instruction

FLAG_REG = C7h

After Instruction

FLAG_REG = 47h

BN **Branch if Negative**

Syntax: BN n

Operands: $-128 \le n \le 127$

Operation: if Negative bit is '1' $(PC) + 2 + 2n \rightarrow PC$

Status Affected: None

Encoding: 1110 0110 nnnn nnnn If the Negative bit is '1', then the Description:

program will branch.

The 2's complement number '2n' is added to the PC. Since the PC will have

incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a

two-cycle instruction.

Words: 1 Cycles: 1(2)

Q Cycle Activity:

If Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	Write to PC
	ʻn'	Data	
No	No	No	No
operation	operation	operation	operation

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	No
	ʻn'	Data	operation

Example: HERE BNJump

Before Instruction

PC address (HERE)

After Instruction

If Negative PC

address (Jump)

If Negative PC

address (HERE + 2)

BNC	Branch if Not Carry			
Syntax:	BNC n			
Operands:	$-128 \le n \le 127$			
Operation:	if Carry bit is '0' $(PC) + 2 + 2n \rightarrow PC$			
Status Affected:	None			
Encoding:	1110 0011 nnnn nnnn			
Description:	If the Carry bit is '0', then the program will branch. The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be			

PC + 2 + 2n. This instruction is then a two-cycle instruction.

Words: 1 Cycles: 1(2)

Q Cycle Activity:

If Jump:

Q1	Q2	Q3	Q4	
Decode	Read literal	Process	Write to PC	
	ʻn'	Data		
No	No	No	No	
operation	operation	operation	operation	

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	No
	ʻn'	Data	operation

Example: HERE BNC Jump

Before Instruction

PC address (HERE)

After Instruction

If Carry

address (Jump)

= address (HERE + 2) **BNN Branch if Not Negative** BNN n

Operands: $-128 \le n \le 127$ Operation: if Negative bit is '0' $(PC) + 2 + 2n \rightarrow PC$

Status Affected: None

Encoding: 1110 0111 nnnn nnnn

Description: If the Negative bit is '0', then the

program will branch.

1(2)

The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a

two-cycle instruction.

Words: 1

Q Cycle Activity:

If Jump:

Cycles:

Syntax:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	Write to PC
	ʻn'	Data	
No	No	No	No
operation	operation	operation	operation

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	No
	ʻn'	Data	operation

Example: HERE BNN Jump

Before Instruction

PC address (HERE)

After Instruction

If Negative PC

address (Jump) =

If Negative PC address (HERE + 2)

BNOV	Branch if Not Overflow			
Syntax:	BNOV n			
Operands:	$-128 \le n \le 127$			
Operation:	if Overflow bit is '0' $(PC) + 2 + 2n \rightarrow PC$			
Status Affected:	None			
Encoding:	1110 0101 nnnn nnnn			
Description:	If the Overflow bit is '0', then the program will branch. The 2's complement number '2n' is added to the PC. Since the PC will have			

incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a

two-cycle instruction.

Words: 1 Cycles: 1(2)

Q Cycle Activity: If Jump:

Q1	Q2	Q2 Q3	
Decode	Read literal	Process	Write to PC
	ʻn'	Data	
No	No	No	No
operation	operation	operation	operation

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	No
	ʻn'	Data	operation

Example: HERE BNOV Jump

Before Instruction

PC address (HERE)

After Instruction

If Overflow

address (Jump)

If Overflow PC address (HERE + 2) **BNZ Branch if Not Zero**

BNZ n

Operands: $-128 \le n \le 127$ Operation: if Zero bit is '0' $(PC) + 2 + 2n \rightarrow PC$

Status Affected: None

Encoding: 1110 0001 nnnn nnnn

Description: If the Zero bit is '0', then the program

will branch.

The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be

PC + 2 + 2n. This instruction is then a two-cycle instruction.

Words: 1 Cycles: 1(2)

Q Cycle Activity:

If Jump:

Syntax:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	Write to PC
	ʻn'	Data	
No	No	No	No
operation	operation	operation	operation

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	No
	'n'	Data	operation

Example: HERE BNZ Jump

Before Instruction

PC address (HERE)

After Instruction

If Zero

address (Jump)

If Zero PC

address (HERE + 2)

BRA Unconditional Branch

Syntax: BRA n

Operands: $-1024 \le n \le 1023$ Operation: $(PC) + 2 + 2n \rightarrow PC$

Status Affected: None

Encoding: 1101 0nnn nnnn nnnn

Description: Add the 2's complement number '2n' to

the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This

instruction is a two-cycle instruction.

Words: 1 2 Cycles: Q Cycle Activity:

Q1	Q2 Q3		Q4	
Decode	Read	literal	Process	Write to PC
	'n	,	Data	
No	No	0	No	No
operatio	n opera	ation	operation	operation

Example: HERE BRA Jump

Before Instruction

PC address (HERE)

After Instruction

PC address (Jump)

BSF	Bit Set f			
Syntax:	BSF f, b	{,a}		
Operands:	$0 \le f \le 255$ $0 \le b \le 7$ $a \in [0,1]$	•		
Operation:	$1 \to f {<} b {>}$			
Status Affected:	None			
Encoding:	1000	bbba	ffff	ffff
Description:	Bit 'b' in re	gister 'f' i	s set.	

If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the

GPR bank (default).

If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 21.2.3 "Byte-Oriented and **Bit-Oriented Instructions in Indexed** Literal Offset Mode" for details.

Words: Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write
	register 'f'	Data	register 'f'

Example: FLAG REG, 7, 1 BSF

Before Instruction

FLAG_REG 0Ah

After Instruction

FLAG_REG 8Ah

BTFSC	Bit Test Fi	le, Skip if Cl	ear	BTFSS	Bit Test File	e, Skip if Se	t
Syntax:	BTFSC f, b	{,a}		Syntax:	BTFSS f, b	{,a}	
Operands:	Operands: $0 \le f \le 255$ Operands: $0 \le f \le 255$ $0 \le b \le 7$ $0 \le b < 7$ $a \in [0,1]$ $a \in [0,1]$						
Operation:	skip if (f)	= 0		Operation:	skip if (f)	= 1	
Status Affected:	None			Status Affected:	None		
Encoding:	1011	bbba ff	ff ffff	Encoding:	1010	bbba fff	ff ffff
Description:	instruction is the next instruction and a NOP is this a two-cy If 'a' is '0', the 'a' is '1', the GPR bank (of If 'a' is '0' and set is enabled Indexed Lited mode where See Section Bit-Oriented	gister 'f' is 'o', is skipped. If bit ruction fetched uction executions executed instruction. The Access Bank BSR is used to default). In the extended the extended of this instruction of the extended of th	'b' is '0', then during the in is discarded lead, making as selected. If the select the dinstruction on operates in essing h). Oriented and in Indexed	Description:			'b' is '1', then during the in is discarded ead, making is selected. If e select the l instruction on operates dressing i). Oriented and in Indexed
Words:	1			Words:	1		
Cycles:	•	cles if skip and 2-word instruc		Cycles:	1(2) Note: 3 cycles if skip and followed by a 2-word instruction.		
Q Cycle Activity:	_		_	Q Cycle Activity:			
Q1	Q2	Q3	Q4	Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	No operation	Decode	Read register 'f'	Process Data	No operation
If skip:	Togicioi i	Duiu	operation	If skip:	1 oglotor 1	Data	operation
Q1	Q2	Q3	Q4	Q1	Q2	Q3	Q4
No	No	No	No	No	No	No	No
operation	operation	operation	operation	operation	operation	operation	operation
If skip and followe	•			If skip and follow	,		
Q1	Q2	Q3	Q4	Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation	No operation	No operation	No operation	No operation
No	No	No	No	No	No	No	No
operation	operation	operation	operation	operation	operation	operation	operation
Example: Before Instru PC After Instruct If FLAG PC If FLAG	FALSE : TRUE : ction = add ion <1> = 0; = add		3, 1, 0	Example: Before Instru PC After Instruct If FLAG PC If FLAG	FALSE : TRUE : ction = ad ion <1> = 0; = ad		

вто	à	Bit Toggle f					
Synta	ax:	BTG f, b {,	a}			_	
Oper	rands:	$0 \le f \le 255$ $0 \le b < 7$ $a \in [0,1]$					
Oper	ration:	$(\overline{f < b >}) \rightarrow f < \overline{f}$					
Statu	is Affected:	None					
Enco	oding:	0111	bbba	ff:	ff	ffff	
	ription:	Bit 'b' in da inverted. If 'a' is '0', If 'a' is '1', GPR bank If 'a' is '0' a set is enab in Indexed mode whe Section 2' Bit-Orient Literal Off	the Acces the BSR is (default). and the ex bled, this ir Literal Off never f \le \mathbb{S} 1.2.3 "Byt ed Instruct	s Bar s used tendenstruct fset A 95 (5F e-Ori	nk is a d to s ed insetion ddre Fh). S ente s in l	selected. select the struction operates ssing See d and Indexed	
Word	ds:	1					
Cycle	es:	1	1				
QC	ycle Activity:						
	Q1	Q2	Q3			Q4	
	Decode	Read register 'f'	Proce Data			Write gister 'f'	

Example: PORTC, 4, 0

Before Instruction:

PORTC = 0111 0101 **[75h]**

After Instruction:

PORTC = 0110 0101 **[65h]** **BOV Branch if Overflow**

BOV n

Syntax: Operands: $-128 \le n \le 127$

Operation: if Overflow bit is '1' $(PC) + 2 + 2n \rightarrow PC$

Status Affected: None

Encoding: 1110 0100 nnnn nnnn

Description: If the Overflow bit is '1', then the

program will branch.

The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a

two-cycle instruction.

Words: 1 Cycles: 1(2)

Q Cycle Activity:

If Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	Write to PC
	ʻn'	Data	
No	No	No	No
operation	operation	operation	operation

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	No
	ʻn'	Data	operation

Example: HERE BOV Jump

Before Instruction

PC address (HERE)

After Instruction

If Overflow

1; address (Jump) PC

If Overflow PC =

address (HERE + 2)

BZ Branch if Zero

Syntax: BZ n $-128 \le n \le 127$ Operation: if Zero bit is '1' $(PC) + 2 + 2n \rightarrow PC$

Status Affected: None

 Encoding:
 1110
 0000
 nnnn
 nnnn

Description: If the Zero bit is '1', then the program

will branch.

The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a

two-cycle instruction.

Words: 1
Cycles: 1(2)

Q Cycle Activity: If Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	Write to PC
	ʻn'	Data	
No	No	No	No
operation	operation	operation	operation

If No Jump:

_	Q1	Q2	Q3	Q4
	Decode	Read literal	Process	No
		ʻn'	Data	operation

Example: HERE BZ Jump

Before Instruction

PC = address (HERE)

After Instruction

If Zero = 1

 $\begin{array}{ccccc} PC & = & address & (\texttt{Jump}) \\ \text{If Zero} & = & 0; \end{array}$

PC = address (HERE + 2)

Syntax:	CALL k {,s}	
Operands:	$0 \le k \le 1048575$ s $\in [0,1]$	
Operation:	$(PC) + 4 \rightarrow TOS,$ $k \rightarrow PC < 20:1>,$ if s = 1	

Subroutine Call

 $(W) \rightarrow WS$, $(STATUS) \rightarrow STATU$

 $(STATUS) \rightarrow STATUSS,$ $(BSR) \rightarrow BSRS$

(DOI1) → L

Status Affected: None

Encoding: 1st word (k<7:0>) 2nd word(k<19:8>)

CALL

1110 | 110s | k₇kkk | kkkk₀ 1111 | k₁₉kkk | kkkk | kkkk₈

Description: Subroutine call of entire 2-Mbyte memory range. First, return address

memory range. First, return address (PC + 4) is pushed onto the return stack. If 's' = 1, the W, STATUS and BSR registers are also pushed into their respective shadow registers, WS, STATUSS and BSRS. If 's' = 0, no update occurs (default). Then, the 20-bit value 'k' is loaded into PC<20:1>. CALL is a two-cycle instruction.

Words: 2 Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal	PUSH PC to	Read literal
	'k'<7:0>,	stack	'k'<19:8>,
			Write to PC
No	No	No	No
operation	operation	operation	operation
	No	Decode Read literal 'k'<7:0>, No No	Decode Read literal 'k'<7:0>, PUSH PC to stack

Example: HERE CALL THERE, 1

Before Instruction

PC = address (HERE)

After Instruction

PC = address (THERE) TOS = address (HERE + 4)

WS = W BSRS = BSR STATUSS = STATUS

CLRF	Clear f			
Syntax:	CLRF f {	,a}		
Operands:	$0 \le f \le 255$ $a \in [0,1]$	i		
Operation:	$\begin{array}{c} 000h \rightarrow f \\ 1 \rightarrow Z \end{array}$			
Status Affected:	Z			
Encoding:	0110	101a	ffff	ffff
Description:	Clears the contents of the specified register. If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 21.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.			
Words:	1			
Cycles:	1			
Q Cycle Activity:				
Q1	Q2	Q3	3	Q4

	Q1	Q2	Q3	Q4
	Decode	Read register 'f'	Process Data	Write register 'f'
_				

Example: CLRF FLAG_REG, 1

Before Instruction

FLAG_REG 5Ah

After Instruction

FLAG_REG 00h

CLRWDT	Clear Watchdog Timer				
Syntax:	CLRWDT				
Operands:	None				
Operation:	000h → WDT, 000h → WDT postscaler, 1 → \overline{TO} , 1 → \overline{PD}				
Status Affected:	$\overline{TO}, \overline{PD}$				
Encoding:	0000	0000	0000	0100	
Description: Words:	CLRWDT in Watchdog postscaler and PD, a	Timer. It a	also resets		

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	No	Process	No
	operation	Data	operation

Example: CLRWDT

Before Instruction

WDT Counter ?

After Instruction

WDT Counter 00h 0

WDT Postscaler TO PD 1 1

CON	ЛF	Complement f					
Synta	ax:	COMF f	{,d {,a}}				
Oper	ands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$					
Oper	ation:	$(\overline{f}) \rightarrow dest$					
Statu	s Affected:	N, Z					
Enco	ding:	0001	11da	ffff	ffff		
Desc	ription:	The contents of register 'f' are complemented. If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f' (default). If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 21.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.					
Word	ls:	1	1				
Cycle	es:	1					
QC	ycle Activity:						
	Q1	Q2	Q3	3	Q4		
	Decode	Read register 'f'	Proce Dat		Write to estination		

Example:	C	COMF		Ο,	0
Before Instru	ction				
REG	=	13h			
After Instruct	ion				
REG	=	13h			
W	_	ECh.			

CPFSEC	2	Compare	f with V	V, Ski _l	p if f = W	
Syntax:		CPFSEQ	f {,a}			
Operands	::	0 ≤ f ≤ 255 a ∈ [0,1]				
Operation	:	(f) - (W), skip if (f) = (W) (unsigned comparison)				
Status Aff	ected:	None				
Encoding		0110 001a ffff ffff				
Description: Compares the contents of data mem location 'f' to the contents of W by performing an unsigned subtraction. If 'f' = W, then the fetched instruction discarded and a NOP is executed instead, making this a two-cycle instruction. If 'a' is '0', the Access Bank is select If 'a' is '1', the BSR is used to select GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction opera in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 21.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed."			of W by btraction. Instruction is ecuted cycle is selected to select the dinstruction ion operates dressing in). See inted and in Indexed			
Words:		Literal Off	set Mode	'' for d	etails.	
Cycles: 1(2)				fall accord		
			ycles if sl a 2-word			
Q Cycle	Activity:					
-	Q1	Q2	Q3		Q4	
D	ecode	Read	Proce	ss	No	
		register 'f'	Data	a	operation	
If skip:						
	Q1	Q2	Q3		Q4	
	No	No	No		No	
	eration	operation	operat		operation	
If skip an		d by 2-word ir			0.4	
	Q1	Q2	Q3		Q4	
	No	No	No		No	
ομ	eration	operation No	operat No		operation	
on	No eration	operation	operat		No operation	
Example:	eration	HERE NEQUAL EQUAL	CPFSEQ:			
Befo	re Instruc	tion				
2010	PC Addre		ERE			
	W	= ?				
	REG	= ?				
After	Instruction	n				
	If REG	= W				
	PC	= A	ddress (I	: TAIJOE)	

If REG

Address (NEQUAL)

CPFSGT Compare f with W, Skip if f > W

Syntax: CPFSGT f {,a} Operands: $0 \le f \le 255$ $a \in [0,1]$

Operation: (f) - (W),skip if (f) > (W)

(unsigned comparison)

Status Affected: None

Encoding: 0110 010a ffff ffff

Compares the contents of data memory Description: location 'f' to the contents of the W by performing an unsigned subtraction. If the contents of 'f' are greater than the contents of WREG, then the fetched instruction is discarded and a NOP is executed instead, making this a

two-cycle instruction.

If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the

GPR bank (default).

If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 21.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed

Words: Cycles: 1(2)

Note: 3 cycles if skip and followed

Literal Offset Mode" for details.

by a 2-word instruction.

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	No
	register 'f'	Data	operation

If skip:

Q1	Q2	Q3	Q4
No	No	No	No
operation	operation	operation	operation

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No	No	No	No
operation	operation	operation	operation
No	No	No	No
operation	operation	operation	operation

CPFSGT REG, 0 Example: HERE

NGREATER

GREATER

Before Instruction

PC Address (HERE)

W 2 =

After Instruction

If REG W:

PC = Address (GREATER)

If REG W: ≤

PC Address (NGREATER)

CPFSLT Compare f with W, Skip if f < W

Syntax: CPFSLT f {,a} Operands: $0 \le f \le 255$

 $a \in [0,1]$

(f) - (W),Operation: skip if (f) < (W)

(unsigned comparison)

Status Affected: None

Description:

Encoding: ffff ffff 0110 000a

> Compares the contents of data memory location 'f' to the contents of W by performing an unsigned subtraction. If the contents of 'f' are less than the contents of W, then the fetched instruction is discarded and a NOP is executed instead, making this a

two-cycle instruction.

If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the

GPR bank (default).

Words: 1

Cycles: 1(2)

> Note: 3 cycles if skip and followed

by a 2-word instruction.

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	No
	register 'f'	Data	operation

If skip:

Q1	Q2	Q3	Q4
No	No	No	No
operation	operation	operation	operation

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No	No	No	No
operation	operation	operation	operation
No	No	No	No
operation	operation	operation	operation

Example: HERE CPFSLT REG, 1

> NLESS LESS

Before Instruction

PC Address (HERE) =

w

After Instruction

If REG Address (LESS) If REG ≥

DAV	V	Decimal A	Adjust \	N Re	gist	er
Synta	ax:	DAW				
Oper	ands:	None				
Oper	ation:	If [W<3:0> > 9] or [DC = 1] then (W<3:0>) + 6 \rightarrow W<3:0>; else (W<3:0>) \rightarrow W<3:0>			en	
		If [W<7:4> + DC > 9] or [C = 1] then $(W<7:4>) + 6 + DC \rightarrow W<7:4>$; else $(W<7:4>) + DC \rightarrow W<7:4>$				
Status Affected: C						
Enco	ding:	0000	0000	000	0	0111
Desc	ription:	DAW adjusts resulting fro variables (e and produc result.	om the ea	arlier a acked	idditi BC[on of two D format)
Word	ls:	1				
Cycle	es:	1				
Q Cycle Activity:						
	Q1	Q2	Q3	1		Q4
	Decode	Read	Proce			Write
		register W	Dat	a		W
<u>Exan</u>	<u>nple 1:</u>					

DAW

Before Instruction

W A5h C 0 After Instruction

> W 05h C DC 1 0

Example 2:

Before Instruction

W CEh C DC 0 After Instruction

> W 34h C DC

DECF	Decrement f			
Syntax:	DECF f{	DECF f {,d {,a}}		
Operands:	0 ≤ f ≤ 255 d ∈ [0,1] a ∈ [0,1] (f) − 1 → dest C, DC, N, OV, Z			
Operation:				
Status Affected:				
Encoding:	0000	01da	ffff	ffff
Description:				', the r 'f' selected. select the

set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 21.2.3 "Byte-Oriented and **Bit-Oriented Instructions in Indexed** Literal Offset Mode" for details.

Words: Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	register 'f'	Data	destination

Example: DECF CNT, 1, 0

Before Instruction

CNT Z 01h After Instruction CNT Z 00h 1

DEC	FSZ	Decremen	nt f, Skip if ()	DCF	SNZ	Decreme	nt f, Skip if r	not 0
Synta	ax:	DECFSZ f	{,d {,a}}		Synta	ax:	DCFSNZ	f {,d {,a}}	
Oper	Operands: $ 0 \le f \le 255 $		Oper	ands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$				
Oper	ation:	(f) $-1 \rightarrow de$ skip if result	-		Oper	ation:	(f) $-1 \rightarrow de$ skip if resul	•	
Statu	s Affected:	None			Statu	s Affected:	None		
Enco	ding:	0010	11da fff	f ffff	Enco	ding:	0100	11da fff	f ffff
Desc	ription:	The contents of register 'f' are decremented. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f' (default). If the result is '0', the next instruction, which is already fetched, is discarded and a NOP is executed instead, making it a two-cycle instruction. If 'a' is '0', the Access Bank is selected. If 'a' is '0', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 21.2.3 "Byte-Oriented Instructions in Indexed Literal Offset Mode" for details. Description: The contents of register 'f' and decremented. If 'd' is '0', the placed in W. If 'd' is '0', the placed in W. If 'd' is '1', the placed in W. If 'd' is '1', the next in register 'f' and the result is placed in W. If 'd' is '1', the next in register 'f' and in the case of the placed in the placed in W. If 'd' is '1', the next in register 'f' and the case of the placed in W. If 'd' is '1', the next in register 'f' and the result is not '0', the next in struction. If 'a' is '0', the Access Bank is ready discarded and a NOP is exection 1 instruction. If 'a' is '0', the Access Bank is selected. If 'a' is '0', the Access Bank is selected. If 'a' is '0', the Access Bank is selected. If 'a' is '0', the Access Bank is selected. If 'a' is '0', the Access Bank is selected. If 'a' is '0' and the extended instruction in Indexed Literal Offset Addressing in Indexed Literal Offset Addressing in Indexed Menower of ≤ 95 (5Fh). See in Indexed Literal Offset Addressing in Indexed Literal Offset Ad		the result is the result is the result is (default). The strict of the s					
Word	ls:	1			14/	1.		set Mode" for	details.
Cycle Q Cy	es: ycle Activity:		rcles if skip an a 2-word instru		Word Cycle			cycles if skip a a 2-word instr	
_	Q1	Q2	Q3	Q4	QC	ycle Activity:			
	Decode	Read register 'f'	Process Data	Write to destination		Q1 Decode	Q2 Read	Q3 Process	Q4 Write to
If sk	ip:	-	•		•		register 'f'	Data	destination
	Q1	Q2	Q3	Q4	lf sk	ip:			
	No	No	No	No		Q1	Q2	Q3	Q4
	operation	operation	operation	operation		No operation	No operation	No operation	No operation
If SK		d by 2-word in:		0.4	lf sk		d by 2-word in		operation
ſ	Q1 No	Q2 No	Q3 No	Q4 No	1	Q1	Q2	Q3	Q4
	operation	operation	operation	operation		No	No	No	No
	No	No	No	No		operation	operation	operation	operation
	operation	operation	operation	operation		No operation	No operation	No operation	No operation
Exam	nple:	HERE CONTINUE	DECFSZ GOTO	CNT, 1, 1 LOOP	<u>Exan</u>		HERE I	DCFSNZ TEM	IP, 1, 0
	Before Instruc	tion						:	
	PC After Instruction CNT If CNT PC If CNT PC	on = CNT - 1 = 0; = Address ≠ 0;	G (HERE) G (CONTINUE G (HERE + 2			Before Instruction TEMP After Instruction TEMP If TEMP PC If TEMP	= on = = = = #	? TEMP – 1, 0; Address (20);	
	FU	- Addiess	, (115K5 + 2	1		PC	<i>∓</i> =	O, Address (1	NZERO

GOTO	Uncondi	tional B	ranch	
Syntax:	GOTO k			
Operands:	$0 \le k \le 10^4$	48575		
Operation:	$k \rightarrow PC < 20:1 >$			
Status Affected:	None			
Encoding: 1st word (k<7:0>) 2nd word(k<19:8>)	1110 1111	1111 k ₁₉ kkk	k ₇ kkk kkkk	kkkk ₀ kkkk ₈
Description:	GOTO allows an unconditional branch anywhere within entire 2-Mbyte memory range. The 20-bit value 'k' is loaded into PC<20:1>. GOTO			

Words: 2 Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k'<7:0>,	No operation	Read literal 'k'<19:8>, Write to PC
No operation	No operation	No operation	No operation

is always a two-cycle instruction.

Example: GOTO THERE

After Instruction

PC = Address (THERE)

INCI	F	Incremen	t f				
Synta	ax:	INCF f {,c	l {,a}}				
Oper	ands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$	d ∈ [0,1]				
Oper	ation:	$(f) + 1 \rightarrow de$	est				
Statu	s Affected:	C, DC, N,	OV, Z				
Enco	ding:	0010	10da	ffff	ffff		
Desc	ription:	The contents of register 'f' are incremented. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f' (default). If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 21.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.					
Word	ls:	1	1				
Cycle	es:	1					
QC	ycle Activity:						
	Q1	Q2	Q3		Q4		
	Decode	Read register 'f'	Proce Data		Write to destination		

Example:	II	NCF	CNT,	1,	0
Before Instru CNT Z C DC After Instruct	= = = =	FFh 0 ?			
CNT Z C DC	= = =	00h 1 1 1			

INCFSZ	Increment f, S	kip if 0		INF	SNZ	Incremen	t f, Skip if n	ot 0
Syntax:	INCFSZ f {,d {,	,a}}		Syn	tax:	INFSNZ f	{,d {,a}}	
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$			Оре	erands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$		
Operation:	(f) + 1 \rightarrow dest, skip if result = 0			Оре	eration:	(f) + 1 \rightarrow deskip if resul	-	
Status Affected:	None			Stat	us Affected:	None		
Encoding:	0011 11d	a fff	f ffff	Enc	oding:	0100	10da ffi	ff ffff
Description:	The contents of incremented. If 'placed in W. If 'c placed back in ref the result is '0' which is already and a NOP is exe it a two-cycle ins If 'a' is '0', the Ad If 'a' is '1', the BS GPR bank (defa If 'a' is '0' and th set is enabled, the in Indexed Literal mode whenever Section 21.2.3 'Bit-Oriented Ins Literal Offset M	d' is '0', the egister 'f' is '1', the egister 'f' i, the next fetched, if ecuted instruction. It is extended in the extended	ne result is e result is (default). It instruction, is discarded stead, making that is selected. It is select the ed instruction operates addressing the is selected and is in Indexed	Des	cription:	The contents of register 'f' are incremented. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f' (default). If the result is not '0', the next instruction, which is already fetched, is discarded and a NOP is executed instead, making it a two-cycle instruction. If 'a' is '0', the Access Bank is selected if 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operate in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 21.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.		ne result is e result is (default). next dy fetched, is eccuted ycle nk is selected. d to select the ed instruction otion operates addressing Fh). See iented and in Indexed
Words:	1			Wor	rds:	1	oct mode 101	dotailo.
Cycles:	1(2) Note: 3 cycles i by a 2-wo			Сус		1(2) Note: 3 (cycles if skip a a 2-word instr	
Q Cycle Activity:	•			Q	Cycle Activity:	ĺ		
Q1	Q2	Q3	Q4		Q1	Q2	Q3	Q4
Decode	Read P	rocess	Write to		Decode	Read	Process	Write to
	register 'f'	Data	destination			register 'f'	Data	destination
If skip:				If s	kip:			
Q1	Q2	Q3	Q4		Q1	Q2	Q3	Q4
No	No operation op	No	No		No	No	No	No
operation If skip and follower	d by 2-word instruct		operation	If c	kip and follower	operation	operation:	operation
Q1	Q2	Q3	Q4	11 3	Q1	Q2	Q3	Q4
No	No	No	No		No	No	No	No No
operation	operation op	eration	operation		operation	operation	operation	operation
No	No	No	No		No	No	No	No
operation	operation op	eration	operation		operation	operation	operation	operation
Example:	HERE INCF NZERO : ZERO :	SZ CN	T, 1, 0	<u>Exa</u>	mple:	HERE ZERO NZERO	INFSNZ REG	, 1, 0
Before Instruction PC After Instruction CNT If CNT PC	= Address (H) on = CNT + 1 = 0; = Address (Z)				PC After Instruction REG If REG PC	= Address on = REG + ≠ 0; = Address	(HERE) (NZERO)	
If CNT PC	≠ 0; = Address (N	ZERO)			If REG PC	= 0; = Address	S (ZERO)	

IORI	LW	Inclusive	Inclusive OR Literal with W				
Synta	ax:	IORLW k					
Oper	ands:	$0 \le k \le 255$	5				
Oper	ation:	(W) .OR. $k \rightarrow W$					
Status Affected:		N, Z					
Encoding:		0000	1001	kkkk	kkkk		
Desc	ription:	The contereight-bit lite					
Word	ls:	1	1				
Cycle	es:	1					
Q Cycle Activity:							
	Q1	Q2	Q3		Q4		
	Decode	Read	Proce	ss W	rite to W		

Example: IORLW 35h

literal 'k'

Data

Before Instruction

W = 9Ah

After Instruction

W = BFh

IORV	WF	Inclusive OR W with f					
Synta	ıx:	IORWF f	{,d {,a}}				
Opera	ands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$	d ∈ [0,1]				
Opera	ation:	(W) .OR. (f)	\rightarrow dest				
Statu	s Affected:	N, Z					
Enco	ding:	0001	00da i	ffff	ffff		
Desc	ription:	'0', the result is (default). If 'a' is '0', t If 'a' is '1', t GPR bank If 'a' is '0' a set is enabl in Indexed mode wher Section 21 Bit-Oriente	R W with re ult is placed placed bac he Access I he BSR is u (default). nd the exter led, this inst Literal Offse hever f ≤ 95 2.3 "Byte- d Instructi set Mode" f	in W. It is k in reg Bank is sed to a nded in ruction et Addre (5Fh). Oriente ons in	f 'd' is '1', gister 'f' selected. select the struction operates essing See ed and Indexed		
Word	s:	1					
Cycles:		1					
Q Cy	cle Activity:						
	Q1	Q2	Q3		Q4		
	Decode	Read	Process	٧	Vrite to		

Example: IORWF RESULT, 0, 1

register 'f'

Data

destination

Before Instruction

RESULT = 13hW = 91h

After Instruction

RESULT = 13h W = 93h

LFSR Load FSR Syntax: LFSR f, k $0 \le f \le 2$ Operands: $0 \le k \le 4095$ Operation: $k \to \mathsf{FSRf}$ Status Affected: None Encoding: 1110 00ff 1110 k₁₁kkk 1111 0000 k₇kkk kkkk The 12-bit literal 'k' is loaded into the Description: File Select Register pointed to by 'f'.

Words: 2 Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	Write
	'k' MSB	Data	literal 'k'
			MSB to
			FSRfH
Decode	Read literal	Process	Write literal
	'k' LSB	Data	'k' to FSRfL

Example: LFSR 2, 3ABh

After Instruction

FSR2H = 03h FSR2L = ABh

MOVF	Move f				
Syntax:	MOVF f	{,d {,a}}			
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$				
Operation:	$f \to \text{dest}$				
Status Affected:	N, Z				
Encoding:	0101	00da	ffff	ffff	
Description:	The contents of register 'f' are moved to a destination dependent upon the status of 'd'. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f' (default). Location 'f' can be anywhere in the 256-byte bank. If 'a' is '0', the Access Bank is selected				

GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 21.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed

If 'a' is '1', the BSR is used to select the

Literal Offset Mode" for details.

Words: 1 Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write W
	register 'f'	Data	

Example: MOVF REG, 0, 0

Before Instruction

 $\begin{array}{lll} \mathsf{REG} & = & 22\mathsf{h} \\ \mathsf{W} & = & \mathsf{FFh} \end{array}$

After Instruction

REG = 22h W = 22h

MOVFF	Move f to	o f		
Syntax:	MOVFF f	s,f _d		
Operands:	$0 \le f_s \le 4095$ $0 \le f_d \le 4095$			
Operation:	$(f_s) \to f_d$			
Status Affected:	None			
Encoding: 1st word (source) 2nd word (destin.)	1100 1111	ffff ffff	ffff ffff	ffff _s
Description:	The contents of source register 'f _s ' are moved to destination register 'f _d '.			

Description: The contents of source register 'f_s' are moved to destination register 'f_d'.

Location of source 'f_s' can be anywhere in the 4096-byte data space (000h to FFFh) and location of destination 'f_d' can also be anywhere from 000h to

Either source or destination can be W (a useful special situation).

MOVFF is particularly useful for transferring a data memory location to a peripheral register (such as the transmit buffer or an I/O port).

The ${\tt MOVFF}$ instruction cannot use the PCL, TOSU, TOSH or TOSL as the

destination register.

Words: 2 Cycles: 2 (3)

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f' (src)	Process Data	No operation
Decode	No operation No dummy read	No operation	Write register 'f' (dest)

Example: MOVFF REG1, REG2

Before Instruction

REG1 = 33h REG2 = 11h

After Instruction

 $\begin{array}{lll} \mathsf{REG1} & = & 33\mathsf{h} \\ \mathsf{REG2} & = & 33\mathsf{h} \end{array}$

MOVLB	Move Literal to Low Nibble in BSR			
Syntax:	MOVLW	k		
Operands:	$0 \le k \le 25$	5		
Operation:	$k\to BSR$			
Status Affected:	None			
Encoding:	0000	0001	kkkk	kkkk
Description:	The eight-bit literal 'k' is loaded into the Bank Select Register (BSR). The value of BSR<7:4> always remains '0', regardless of the value of k ₇ :k ₄ .			
Words:	1			
Cycles:	1			
Q Cycle Activity:				
Q1	Q2	Q3	}	Q4

Write literal

'k' to BSR

Process

Data

Example: MOVLB 5

Read

literal 'k'

Before Instruction

Decode

BSR Register = 02h After Instruction BSR Register = 05h

MOVLW Move Literal to W

Status Affected: None

Encoding: 0000 1110 kkkk kkkk

Description: The eight-bit literal 'k' is loaded into W.

Words: 1
Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to W
	literal 'k'	Data	

Example: MOVLW 5Ah

After Instruction

W = 5Ah

MOVWF	Move W to f		
Syntax:	MOVWF f {,a	}	
Operands:	$0 \le f \le 255$ $a \in [0,1]$		
Operation:	$(W) \rightarrow f$		
Status Affected:	None		
Encoding:	0110 111	la ffff	ffff
Description:	Move data from Location 'f' can	Ū	

256-byte bank.

If 'a' is '0', the Access Bank is selected.

If 'a' is '1' the BSB is used to select the

If 'a' is '1', the BSR is used to select the GPR bank (default).

If 'a' is 'o' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 21.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.

Words: 1
Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write
	register 'f'	Data	register 'f'

Example: MOVWF REG, 0

Before Instruction

W = 4FhREG = FFh

After Instruction

W = 4FhREG = 4Fh

MULLW	Multiply Literal with W		
Syntax:	MULLW k		
Operands:	$0 \leq k \leq 255$		
Operation:	(W) $x k \rightarrow PRODH:PRODL$		
Status Affected:	None		
Encoding:	0000 1101 kkkk kkkk		
Description:	An unsigned multiplication is carried out between the contents of W and the 8-bit literal 'k'. The 16-bit result is placed in the PRODH:PRODL register pair. PRODH contains the high byte. W is unchanged. None of the Status flags are affected. Note that neither overflow nor carry is possible in this operation. A zero result is possible but not detected.		
Words:	1		
Cycles:	1		

Q1	Q2	Q3	Q4
Decode	Read literal 'k'	Process Data	Write registers PRODH: PRODL

Example: MULLW 0C4h

Before Instruction

Q Cycle Activity:

E2h PRODH **PRODL** After Instruction

E2h = PRODH

ADh **PRODL** 08h

MULWF Multiply W with f

Syntax: MULWF f {,a} $0 \le f \le 255$ Operands:

 $a \in [0,1]$

(W) $x(f) \rightarrow PRODH:PRODL$ Operation:

Status Affected: None

Description:

Encodina: 0000 001a ffff ffff

> An unsigned multiplication is carried out between the contents of W and the register file location 'f'. The 16-bit result is stored in the PRODH:PRODL register pair. PRODH contains the high byte. Both W and 'f' are

unchanged.

None of the Status flags are affected. Note that neither overflow nor carry is possible in this operation. A zero result is possible but not detected. If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction

operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See **Section 21.2.3** "Byte-Oriented and Bit-Oriented

Instructions in Indexed Literal Offset

Mode" for details.

Words: 1 Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write
	register 'f'	Data	registers
			PRODH:
			PRODL

Example: MULWF REG, 1

Before Instruction

C4h REG B5h PRODH **PRODL**

After Instruction

W C4h REG B5h PRODH 8Ah PRODL 94h

NEGF Negate f Syntax: NEGF f {,a} $0 \le f \le 255$ Operands: $a\in \left[0,1\right]$ $(\overline{f}) + 1 \rightarrow f$ Operation: N, OV, C, DC, Z Status Affected: ffff Encoding: 0110 110a ffff Description: Location 'f' is negated using two's complement. The result is placed in the data memory location 'f'. If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See

Words: 1 Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write
	register 'f'	Data	register 'f'

Section 21.2.3 "Byte-Oriented and

Literal Offset Mode" for details.

Bit-Oriented Instructions in Indexed

Example: NEGF REG, 1

Before Instruction

REG = 0011 1010 [3Ah]

After Instruction

REG = 1100 0110 [C6h]

NOF	•	No Operation				
Synta	ax:	NOP	NOP			
Oper	ands:	None				
Oper	ation:	No operati	on			
Statu	s Affected:	None				
Enco	ding:	0000	0000	000	0	0000
		1111	XXXX	XXX	X	XXXX
Desc	ription:	No operati	on.			
Word	ls:	1				
Cycle	es:	1				
QC	ycle Activity:					
	Q1	Q2	Q	3		Q4
	Decode	No	No)		No
		operation	opera	tion	lo l	peration

Example:

None.

POP	Pop Top of Return Stack
-----	-------------------------

Syntax: POP
Operands: None

Operation: $(TOS) \rightarrow bit bucket$

Status Affected: None

Encoding: 0000 0000 0000 0110

The TOS value is pulled off the return stack and is discarded. The TOS value then becomes the previous value that was pushed onto the return stack. This instruction is provided to enable the user to properly manage the return stack to incorporate a software stack.

Words: 1 Cycles: 1

Q Cycle Activity:

Description:

Q1	Q2	Q3	Q4
Decode	No	POP TOS	No
	operation	value	operation

Example: POP

GOTO NEW

Before Instruction

TOS = 0031A2hStack (1 level down) = 014332h

After Instruction

TOS = 014332h PC = NEW PUSH Push Top of Return Stack

Syntax: PUSH Operands: None

Operation: $(PC + 2) \rightarrow TOS$

Status Affected: None

Encoding: 0000 0000 0000 0101

Description:

The PC + 2 is pushed onto the top of the return stack. The previous TOS value is pushed down on the stack.

This instruction allows implementing a software stack by modifying TOS and then pushing it onto the return stack.

Words: 1
Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	PUSH	No	No
	PC + 2 onto	operation	operation
	return stack		

Example: PUSH

Before Instruction

TOS = 345Ah PC = 0124h

After Instruction

PC = 0126h TOS = 0126h Stack (1 level down) = 345Ah

RCALL	Relative Call			
Syntax:	RCALL r	า		
Operands:	$-1024 \le n \le 1023$			
Operation:	$ (PC) + 2 \rightarrow TOS, $ $ (PC) + 2 + 2n \rightarrow PC $			
Status Affected:	None			
Encoding:	1101	1nnn	nnnn	nnnn
Description:	Subroutine call with a jump up to 1K from the current location. First, return address (PC + 2) is pushed onto the stack. Then, add the 2's complement number '2n' to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is a two-cycle instruction.			
Words:	1			

Words: 1 Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	Write to PC
	PUSH PC to stack		
No	No	No	No
operation	operation	operation	operation

Example: HERE RCALL Jump

Before Instruction

PC = Address (HERE)

After Instruction

PC = Address (Jump) TOS = Address (HERE + 2)

RES	ET	Reset				
Synta	ax:	RESET				
Oper	ands:	None				
Oper	ation:	Reset all re affected by	<u> </u>		_	nat are
Statu	s Affected:	All				
Enco	ding:	0000	0000	111	L1	1111
Desc	ription:	This instruction				•
Word	ls:	1				
Cycles:		1	1			
Q Cycle Activity:						
	Q1	Q2	Q3	3		Q4
	Decode	Start	No)		No

Example: RESET

After Instruction

Registers = Reset Value Flags* = Reset Value

Reset

operation

operation

RETFIE Return from Interrupt

 $\begin{array}{lll} \mbox{Syntax:} & \mbox{RETFIE } \{s\} \\ \mbox{Operands:} & \mbox{$s \in [0,1]$} \\ \mbox{Operation:} & (\mbox{TOS}) \rightarrow \mbox{PC}, \end{array}$

 $1 \rightarrow GIE/GIEH$ or PEIE/GIEL,

 $if s = 1 \\ (WS) \rightarrow W;$

 $(\text{STATUSS}) \to \text{STATUS};$

(BSRS) → BSR;

PCLATU, PCLATH are unchanged

Status Affected: GIE/GIEH, PEIE/GIEL.

Encoding: 0000 0000 0001 000s

Description:

Return from interrupt. Stack is popped and Top-of-Stack (TOS) is loaded into the PC. Interrupts are enabled by setting either the high or low priority global interrupt enable bit. If 's' = 1, the contents of the shadow registers, WS,

STATUSS and BSRS, are loaded into their corresponding registers, W, STATUS and BSR. If 's' = 0, no update of these registers occurs (default).

Words: 1
Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	No	No	POP PC
	operation	operation	from stack
			Set GIEH or GIEL
No	No	No	No
operation	operation	operation	operation

Example: RETFIE 1

After Interrupt

RETLW Return Literal to W

Syntax: RETLW k
Operands: $0 \le k \le 255$ Operation: $k \to W$, $(TOS) \to PC$,

PCLATU, PCLATH are unchanged

Status Affected: None

Encoding: 0000 1100 kkkk kkkk

Description: W is loaded with the eight-bit literal 'k'.

The program counter is loaded from the top of the stack (the return address).
The high address latch (PCLATH)

remains unchanged.

Words: 1 Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	POP PC
	literal 'k'	Data	from stack,
			Write to W
No	No	No	No
operation	operation	operation	operation

Example:

```
CALL TABLE ; W contains table ; offset value ; W now has ; table value
```

TABLE

ADDWF PCL ; W = offset
RETLW k0 ; Begin table
RETLW k1 :

:

RETLW kn ; End of table

Before Instruction

W = 07h

After Instruction

W = value of kn

RETURN Return from Subroutine Syntax: RETURN {s} Operands: $s \in [0,1]$ Operation: $(TOS) \rightarrow PC$, if s = 1 $(WS) \rightarrow W;$ (STATUSS) → STATUS; (BSRS) \rightarrow BSR; PCLATU, PCLATH are unchanged Status Affected: None 0000 Encoding: 0000 0001 001s Description: Return from subroutine. The stack is popped and the top of the stack (TOS) is loaded into the program counter. If 's'= 1, the contents of the shadow registers, WS, STATUSS and BSRS, are loaded into their corresponding registers, W, STATUS and BSR. If 's' = 0, no update of these registers occurs (default). Words:

Q1	Q2	Q3	Q4
Decode	No	Process	POP PC
	operation	Data	from stack
No	No	No	No
operation	operation	operation	operation

2

Example: RETURN

After Instruction: PC = TOS

Cycles:

Q Cycle Activity:

RLC	RLCF Rotate Left f through Carry					
Synta	ax:	RLCF f	{,d {,a}}			
Oper	ands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$				
Oper	ation:	$(f) \rightarrow d$ $(f<7>) \rightarrow C$ $(C) \rightarrow dest$),	>,		
Statu	s Affected:	C, N, Z				
Enco	ding:	0011 01da ffff ffff				
Desc	ription:	one bit to the flag. If 'd' is 'W. If 'd' is 'w. If 'd' is 'in register If 'a' is 'o', selected. If select the 'd' is 'o' a set is enable operates in Addressing f ≤ 95 (5Fh "Byte-Orie Instruction"	The contents of register 'f' are rotated one bit to the left through the Carry flag. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is stored back in register 'f' (default). If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f≤95 (5Fh). See Section 21.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.			
Word	ls:	1	1			
Cycle	es:	1				
QC	ycle Activity:					
	Q1	Q2	Q3		Q4	
	Decode	Read register 'f'	Proce Data		Write to estination	

Example: RLCF REG, 0, 0

Before Instruction

REG = 1110 0110
C = 0

After Instruction

REG = 1110 0110
W = 1100 1100
C = 1

RLNCF	Rotate Left f (No Carry)	RRCF	Rotate Right f through Carry
Syntax:	RLNCF f {,d {,a}}	Syntax:	RRCF f {,d {,a}}
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$	Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$
Operation:	$(f) \rightarrow dest,$ $(f<7>) \rightarrow dest<0>$	Operation:	$(f) \rightarrow dest,$ $(f<0>) \rightarrow C,$
Status Affected:	N, Z		(C) → dest<7>
Encoding:	0100 01da ffff ffff	Status Affected:	C, N, Z
Description:	The contents of register 'f' are rotated	Encoding:	0011 00da ffff ffff
	one bit to the left. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is stored back in register 'f' (default). If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 21.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.	Description:	The contents of register 'f' are rotated one bit to the right through the Carry flag. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f' (default). If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 21.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.
Words:	1		C register f
Cycles:	1	MAla	
Q Cycle Activity:		Words:	1
Q1	Q2 Q3 Q4	Cycles:	1
Decode	Read Process Write to	Q Cycle Activity:	
	register 'f' Data destination	Q1	Q2 Q3 Q4
Example:	RLNCF REG, 1, 0	Decode	Read Process Write to register 'f' Data destination
Before Instru	ction		
REG	= 1010 1011	Example:	RRCF REG, 0, 0
After Instruct	ion	Before Instruc	etion
REG	= 0101 0111	REG C	= 1110 0110 = 0
		After Instruction	
		W C	= 1110 0110 = 0111 0011 = 0

Set f

SETF $f \{,a\}$ $0 \le f \le 255$

 $a\in \left[0,1\right]$

SETF

Syntax:

Operands:

RRNCF	Rotate Right f (No Carry)				
Syntax:	RRNCF f {,d {,a}}				
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$				
Operation:	$(f) \rightarrow dest,$ $(f<0>) \rightarrow dest<7>$				
Status Affected:	N, Z				
Encoding:	0100 00da ffff ffff				
Description:	The contents of register 'f' are rotated one bit to the right. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f' (default). If 'a' is '0', the Access Bank will be selected, overriding the BSR value. If 'a' is '1', then the bank will be selected as per the BSR value (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 21.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
Words:	1				
Cycles:	1				
Q Cycle Activity:					

	[-,-]					
Operation:	$FFh \to f$					
Status Affected:	None					
Encoding:	0110	100a	ffff	ffff		
Description:	The contents of the specified register are set to FFh. If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 21.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.					
Words:	1	1				
Cycles:	1	1				
Q Cycle Activity:						
Q1	Q2	Q3		Q4		
Decode	Read register 'f'	Proce Data		Write gister 'f'		
Example: Before Instruct REG	SETF ion = 5A	REG .h	, 1			
- 5711						

FFh

After Instruction

REG

 Example 1:
 RRNCF
 REG, 1, 0

 Before Instruction
 REG = 1101 0111
 0111 0111

 After Instruction
 REG = 1110 1011
 1011

 Example 2:
 RRNCF
 REG, 0, 0
 0

 Before Instruction

Q2

Read

register 'f'

Q3

Process

Data

Q4

Write to

destination

Q1

Decode

W REG

After Instruction W = 1110 1011 REG = 1101 0111

=

1101 0111

SLEEP Enter Sleep mode							
Synta	ax:	SLEEP					
Oper	ands:	None					
Oper	ation:						
Statu	s Affected:	$\overline{TO}, \overline{PD}$					
Enco	ding:	0000	0000	000	0	0011	
Description:		cleared. The set. Wate postscaler The proce	The Power-Down status bit (\$\overline{PD}\$) is cleared. The Time-out status bit (\$\overline{TO}\$) is set. Watchdog Timer and its postscaler are cleared. The processor is put into Sleep mode with the oscillator stopped.				
Word	ls:	1					
Cycle	es:	1	1				
Q Cycle Activity:							
	Q1	Q2	Q3			Q4	
	Decode	No operation	Proce Data			Go to Sleep	

Example:	SLEEP
Before Instruc	
TO =	?
PD =	?
After Instruction	n
TO =	1 †
DD	٠.

† If WDT causes wake-up, this bit is cleared.

SUBFWB	Subtrac	t f from W	/ with	Borrow
Syntax:	SUBFWB	f {,d {,a}}	}	
Operands:	$0 \le f \le 258$ $d \in [0,1]$ $a \in [0,1]$	5		
Operation:		$-(\overline{C}) \rightarrow des$	st	
Status Affected:	N, OV, C,	. ,		
Encoding:	0101	01da	ffff	ffff
Description:	Subtract register 'f' and Carry flag (borrow) from W (2's complement method). If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored in register 'f' (default). If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 21.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.			
Words:	1	details.		
Cycles:	1			
Q Cycle Activity:	•			
Q1	Q2	Q3		Q4
Decode	Read register 'f'	Process Data		Write to estination
Example 1:	SUBFWB	REG, 1	, 0	
Before Instruct REG W C After Instructio REG W C Z N	= 3 = 2 = 1 on = FF = 2 = 0 = 0	esult is nega REG, 0		
Before Instruct REG				
W C After Instructio REG W C	= 5 = 1 on = 2 = 3 = 1 = 0	soult in positi	itive	
Z N	= 0 .16	esult is posi		
	SUBFWB	REG, 1		
N	SUBFWB tion = 1 = 2 = 0	•		

SUBLW	Subtrac	t W fron	n Literal	
Syntax:	SUBLW	k		
Operands:	$0 \le k \le 25$	5		
Operation:	k – (W) –	W		
Status Affected:	N, OV, C,	DC, Z		
Encoding:	0000	1000	kkkk	kkkk
Description	W is subt			
Words:	1			
Cycles:	1			
Q Cycle Activity:				
Q1	Q2	Q3		Q4
Decode	Read literal 'k'	Proce Data		rite to W
Example 1: SUBLW 02h				
Before Instruction W = 01h C = ?				
After Instructio W C Z N	= 01h	esult is po	ositive	
Example 2:	SUBLW	02h		
Before Instruction W = 02h C = ? After Instruction W = 00h C = 1 ; result is zero Z = 1 N = 0				
Example 3:	•	02h		
Before Instruc W C After Instructio W C Z N	= 03h = ? on = FFh ;	(2's comp esult is n		

```
SUBWF
                        Subtract W from f
                        SUBWF f {,d {,a}}
Syntax:
Operands:
                        0 \le f \le 255
                        d\in \left[ 0,1\right]
                        a \in [0,1]
                        (f) - (W) \rightarrow dest
Operation:
Status Affected:
                        N, OV, C, DC, Z
Encoding:
                          0101
                                    11da
                                              ffff
                                                        ffff
Description:
                        Subtract W from register 'f' (2's
                        complement method). If 'd' is '0', the
                        result is stored in W. If 'd' is '1', the
                        result is stored back in register 'f'
                        (default).
                        If 'a' is '0', the Access Bank is
                        selected. If 'a' is '1', the BSR is used
                        to select the GPR bank (default).
                        If 'a' is '0' and the extended instruction
                        set is enabled, this instruction
                        operates in Indexed Literal Offset
                        Addressing mode whenever
                        f \le 95 (5Fh). See Section 21.2.3
                        "Byte-Oriented and Bit-Oriented
                        Instructions in Indexed Literal Offset
                        Mode" for details.
Words:
                        1
Cycles:
                        1
Q Cycle Activity:
                         Q2
                                         Q3
                                                        Q4
           Q1
        Decode
                                      Process
                                                     Write to
                        Read
                                                   destination
                      register 'f'
                                       Data
Example 1:
                        SUBWF
                                   REG, 1, 0
     Before Instruction
          REG
W
                          3
2
?
          Ċ
     After Instruction
          REG
          W
                          2
          C
                                ; result is positive
          Ž
N
                          Ö
                          0
Example 2:
                        SUBWF
                                   REG, 0, 0
     Before Instruction
REG =
                          2
          W
                          2
?
     After Instruction
                          2
          REG
W
                          ō
          CZN
                                ; result is zero
                          ò
Example 3:
                        SUBWF
                                   REG, 1, 0
     Before Instruction
          REG
                          2
          W
     After Instruction
REG =
                          FFh ;(2's complement)
          W
C
Z
N
                          2
0
0
                                ; result is negative
```

SUBWFB	Subtract	W from f with	Borrow	SWA	\PF	Swap f		
Syntax:	SUBWFB	f {,d {,a}}		Synta	ax:	SWAPF f{	,d {,a}}	
Operands:	$0 \leq f \leq 255$			Oper	ands:	$0 \le f \le 255$		
	$d \in [0,1]$					$d \in [0,1]$		
Operations	$a \in [0,1]$ (f) - (W) -	(C) dest				a ∈ [0,1]		
Operation: Status Affected:				Oper	ation:	$(f<3:0>) \rightarrow (f<7:4>) \rightarrow (f<7:4>)$	•	
	N, OV, C, E			01-1-	- A ((11	$(f<7:4>) \rightarrow$	uesi<3:0>	
Encoding: Description:	0101	10da fff			s Affected:	None	ı	
Description:		and the Carry er 'f' (2's comple	- ',	Enco	ŭ	0011	10da ff:	
	•	'd' is '0', the re:		Desc	ription:	• • • • • • • • • • • • • • • • • • • •		oles of register
		s '1', the result is	s stored back				angea. If a is W. If 'd' is '1',	'0', the result
	in register '	f′ (default). the Access Ban	k is salantad			•	gister 'f' (defa	
		the BSR is used						nk is selected.
	GPR bank	` ,				If 'a' is '1', the GPR bank (ed to select the
		and the extende					nd the extend	ed instruction
		led, this instruct Literal Offset A	•				-	ction operates
		never f ≤ 95 (5F	ŭ				Literal Offset A	0
		.2.3 "Byte-Orie					ever f ≤ 95 (5∣ . 2.3 "Byte-O r	,
		ed Instructions set Mode" for o					•	s in Indexed
Words:	1	oc mode nor c	iotano.				et Mode" for	details.
Cycles:	1			Word		1		
Q Cycle Activity:				Cycle	es:	1		
Q1	Q2	Q3	Q4	Q C	ycle Activity:			
Decode	Read	Process	Write to	ı	Q1	Q2	Q3	Q4
	register 'f'	Data	destination		Decode	Read	Process	Write to
Example 1:	SUBWFB	REG, 1, 0				register 'f'	Data	destination
Before Instruc REG	= 19h	(0001 100	1)	Exam	nnle [.]	SWAPF R	EG, 1, 0	
W C	= 0Dh = 1	(0000 110	1)	<u></u>	Before Instruc		10, 1, 0	
After Instructi	on				REG	= 53h		
REG W	= 0Ch = 0Dh	(0000 101 (0000 110			After Instruction	on		
Ċ	= 1	(0000 110			REG	= 35h		
Ž N	= 0 = 0	; result is po	sitive					
Example 2:	SUBWFB	REG, 0, 0						
Before Instruc								
REG W	= 1Bh = 1Ah	(0001 101 (0001 101						
C	= 0	,	•					
After Instructi REG	on = 1Bh	(0001 101	1)					
W	= 00h	(,,,,,	_,					
C Z	= 1 = 1	; result is ze	ro					
N -	= 0							
Example 3:	SUBWFB	REG, 1, 0						
Before Instruc REG	= 03h	(0000 001	1)					
W C	= 0Eh = 1	(0000 110	1)					
After Instructi								
REG	= F5h	(1111 010	0)					
W	= 0Eh	; [2's comp] (0000 110	1)					
C Z	= 0 = 0							
N	= 1	; result is ne	gative					

TBLRD Table Read TBLRD (*; *+; *-; +*) Syntax:

Operands: None

Operation: if TBLRD *,

(Prog Mem (TBLPTR)) → TABLAT;

TBLPTR - No Change

if TBLRD *+,

(Prog Mem (TBLPTR)) → TABLAT;

(TBLPTR) + $1 \rightarrow$ TBLPTR

if TBLRD *-,

(Prog Mem (TBLPTR)) → TABLAT;

 $(TBLPTR) - 1 \rightarrow TBLPTR$

if TBLRD +*,

(TBLPTR) + $1 \rightarrow$ TBLPTR;

 $(Prog Mem (TBLPTR)) \rightarrow TABLAT$

Status Affected: None

Encoding:

0000	0000	0000	10nn
			nn=0 *
			=1 *+
			=2 *-
			=3 +*

Description:

This instruction is used to read the contents of Program Memory (P.M.). To address the program memory, a pointer called Table

Pointer (TBLPTR) is used.

The TBLPTR (a 21-bit pointer) points to each byte in the program memory. TBLPTR

has a 2-Mbyte address range.

TBLPTR[0] = 0: Least Significant Byte of Program Memory

Word

TBLPTR[0] = 1: Most Significant Byte of Program Memory

Word

The TBLRD instruction can modify the value

of TBLPTR as follows:

· no change

post-increment

post-decrement

pre-increment

Words: 1 Cycles: 2 Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	No	No	No
	operation	operation	operation
No operation	No operation (Read Program Memory)	No operation	No operation (Write TABLAT)

TBLRD Table Read (Continued)

Example 1: TBLRD

Before Instruction

TABLAT 55h 00A356h **TBLPTR** MEMORY (00A356h) 34h

After Instruction

TABLAT 34h 00A357h **TBLPTR**

Example 2: TBLRD +*

Before Instruction

TABLAT TBLPTR MEMORY (01A357h) MEMORY (01A358h) AAh 01A357h = 12h 34h

After Instruction

TABLAT 34h TBLPTR 01A358h

TBLWT	Table W	rite			
Syntax:	TBLWT (*; *+; *-; +*	·)		
Operands:	None				
Operation:	if TBLWT *, (TABLAT) → Holding Register; TBLPTR – No Change if TBLWT *+, (TABLAT) → Holding Register; (TBLPTR) + 1 → TBLPTR				
	if TBLWT *-, (TABLAT) → Holding Register; (TBLPTR) - 1 → TBLPTR if TBLWT +*, (TBLPTR) + 1 → TBLPTR; (TABLAT) → Holding Register				
Status Affected:	None	,	gog.o.o.		
Encoding:	0000	0000	0000	11nn nn=0 * =1 *+ =2 *- =3 +*	
Description:	TBLPTR t 8 holding to. The ho program ti Memory (i "Flash Pr details on The TBLP each byte TBLPTR t The LSb o byte of the access. TBLF TBLF The TBLW value of T • no char • post-ind • post-de	registers to liding registers to liding registers to liding registers. (Registers to liding registers to l	ne which of the TABLA sters are used for the Sector of the	of the T is written used to ram tion 6.0 or additional memory.) points to nory. The sess range. The sess range ocation to significant of Program by Word if Program by Word or the sess range.	
NA/ - mala	• pre-inci	rement			
Words:	1				
Cycles:	2				
Q Cycle Activity:	Q1	02	03	04	
	Decode	Q2 No	Q3 No	Q4 No	
	Decode		operation	operation	
	No	No	No	No	

operation operation

(Read TABLAT)

TBLWT	Table Write	(Con	tinued)
Example 1:	TBLWT *+;		
Before Instru			
TABLAT TBLPTF HOLDIN		=	55h 00A356h
(00A3	,	=	FFh
	ions (table write	comp	,
TABLAT		=	55h
TBLPTF HOLDIN	NG REGISTER	=	00A357h
(00A3		=	55h
Example 2:	TBLWT +*;		
Before Instru	ction		
TABLAT TBLPTF HOLDIN		= =	34h 01389Ah
(01389		=	FFh
(01389		=	FFh
After Instruct	ion (table write o	comple	etion)
TABLAT TBLPTF HOLDIN		=======================================	34h 01389Bh
(01389		=	FFh
(01389		=	34h

operation (Write to

Holding Register)

TSTFSZ Test f, Skip if 0

Syntax: TSTFSZ f {,a} Operands: $0 \le f \le 255$ $a\in \left[0,1\right]$

Operation: skip if f = 0Status Affected: None

Encoding: 0110

011a ffff ffff Description: If 'f' = 0, the next instruction fetched during the current instruction execution is discarded and a NOP is executed, making this a two-cycle instruction. If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the

> GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 21.2.3 "Byte-Oriented and

Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.

Words: Cycles: 1(2)

Note: 3 cycles if skip and followed

by a 2-word instruction.

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	No
	register 'f'	Data	operation

If skip:

Q1	Q2	Q3	Q4
No	No	No	No
operation	operation	operation	operation

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No	No	No	No
operation	operation	operation	operation
No	No	No	No
operation	operation	operation	operation

Example: HERE TSTFSZ CNT, 1

NZERO ZERO

Before Instruction

PC Address (HERE)

After Instruction

If CNT 00h.

PC If CNT Address (ZERO) = # 00h

Address (NZERO)

XORLW Exclusive OR Literal with W

XORLW k Syntax: $0 \le k \le 255$ Operands: Operation: (W) .XOR. $k \rightarrow W$ Status Affected: N, Z Encoding: 0000 1010 kkkk kkkk

Description: The contents of W are XORed with the 8-bit literal 'k'. The result is placed

in W.

Words: Cycles:

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to W
	literal 'k'	Data	

Example: XORLW 0AFh

Before Instruction

W B5h

After Instruction

W 1Ah

XORWF Exclusive OR W with f

Syntax: XORWF $f \{,d \{,a\}\}$

 $0 \le f \le 255$ $d \in [0,1]$

 $a \in [0,1]$

Status Affected: N, Z

Operands:

Encoding: 0001 10da fffff ffff

Description: Exclusive OR the contents of W with

register 'f'. If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back

in the register 'f' (default).

If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the

GPR bank (default).

If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 21.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed

Literal Offset Mode" for details.

Words: 1 Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	register 'f'	Data	destination

Example: XORWF REG, 1, 0

Before Instruction

 $\begin{array}{ccc} \mathsf{REG} & = & \mathsf{AFh} \\ \mathsf{W} & = & \mathsf{B5h} \end{array}$

After Instruction

 $\begin{array}{lll} \mathsf{REG} & = & \mathsf{1Ah} \\ \mathsf{W} & = & \mathsf{B5h} \end{array}$

21.2 Extended Instruction Set

In addition to the standard 75 instructions of the PIC18 instruction set, PIC18F45J10 family devices also provide an optional extension to the core CPU functionality. The added features include eight additional instructions that augment indirect and indexed addressing operations and the implementation of Indexed Literal Offset Addressing mode for many of the standard PIC18 instructions.

The additional features of the extended instruction set are disabled by default. To enable them, users must set the XINST configuration bit.

The instructions in the extended set can all be classified as literal operations, which either manipulate the File Select Registers, or use them for indexed addressing. Two of the instructions, ADDFSR and SUBFSR, each have an additional special instantiation for using FSR2. These versions (ADDULNK and SUBULNK) allow for automatic return after execution.

The extended instructions are specifically implemented to optimize re-entrant program code (that is, code that is recursive or that uses a software stack) written in high-level languages, particularly C. Among other things, they allow users working in high-level languages to perform certain operations on data structures more efficiently. These include:

- dynamic allocation and deallocation of software stack space when entering and leaving subroutines
- function pointer invocation
- software stack pointer manipulation
- manipulation of variables located in a software stack

A summary of the instructions in the extended instruction set is provided in Table 21-3. Detailed descriptions are provided in **Section 21.2.2 "Extended Instruction Set"**. The opcode field descriptions in Table 21-1 (page 242) apply to both the standard and extended PIC18 instruction sets.

Note:

The instruction set extension and the Indexed Literal Offset Addressing mode were designed for optimizing applications written in C; the user may likely never use these instructions directly in assembler. The syntax for these commands is provided as a reference for users who may be reviewing code that has been generated by a compiler.

21.2.1 EXTENDED INSTRUCTION SYNTAX

Most of the extended instructions use indexed arguments, using one of the File Select Registers and some offset to specify a source or destination register. When an argument for an instruction serves as part of indexed addressing, it is enclosed in square brackets ("[]"). This is done to indicate that the argument is used as an index or offset. MPASMTM Assembler will flag an error if it determines that an index or offset value is not bracketed.

When the extended instruction set is enabled, brackets are also used to indicate index arguments in byte-oriented and bit-oriented instructions. This is in addition to other changes in their syntax. For more details, see Section 21.2.3.1 "Extended Instruction Syntax with Standard PIC18 Commands".

Note: In the past, square brackets have been used to denote optional arguments in the PIC18 and earlier instruction sets. In this text and going forward, optional arguments are denoted by braces ("{ }").

TABLE 21-3: EXTENSIONS TO THE PIC18 INSTRUCTION SET

Mnemonic,		Description	Cycles	Cycles 16-Bit Instruction Word			Status	
Operar	nds	Description	Cycles	MSb			LSb	Affected
ADDFSR	f, k	Add literal to FSR	1	1110	1000	ffkk	kkkk	None
ADDULNK	k	Add literal to FSR2 and return	2	1110	1000	11kk	kkkk	None
CALLW		Call subroutine using WREG	2	0000	0000	0001	0100	None
MOVSF	z_s , f_d	Move z _s (source) to 1st word	2	1110	1011	0zzz	ZZZZ	None
		f _d (destination) 2nd word		1111	ffff	ffff	ffff	
MOVSS	z_s, z_d	Move z _s (source) to 1st word	2	1110	1011	1zzz	ZZZZ	None
		z _d (destination) 2nd word		1111	xxxx	XZZZ	ZZZZ	
PUSHL	k	Store literal at FSR2, decrement FSR2	1	1110	1010	kkkk	kkkk	None
SUBFSR	f, k	Subtract literal from FSR	1	1110	1001	ffkk	kkkk	None
SUBULNK	k	Subtract literal from FSR2 and return	2	1110	1001	11kk	kkkk	None

21.2.2 EXTENDED INSTRUCTION SET

ADDESE AUG LILEI AI LO ESE	ADDFSR A	Add Literal	to FSR

Syntax: ADDFSR f, k Operands: $0 \le k \le 63$ $f \in [0, 1, 2]$

Operation: $\mathsf{FSR}(f) + k \to \mathsf{FSR}(f)$

Status Affected: None

Encoding: 1110 1000 ffkk kkkk

Description: The 6-bit literal 'k' is added to the

ription: The 6-bit literal 'k' is added to the contents of the FSR specified by 'f'.

Words: 1 Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	literal 'k'	Data	FSR

Example: ADDFSR 2, 23h

Before Instruction

FSR2 = 03FFh

After Instruction

FSR2 = 0422h

ADDULNK	Add Literal to FSR2 and Return

Syntax: ADDULNK k Operands: $0 \le k \le 63$

Operation: FSR2 + $k \rightarrow$ FSR2,

 $(TOS) \rightarrow PC$

Status Affected: None

Encoding: 1110 1000 11kk kkkk

Description: The 6-bit literal 'k' is added to the contents of FSR2. A RETURN is then executed by loading the PC with the

TOS.

2

The instruction takes two cycles to execute; a NOP is performed during

the second cycle.

This may be thought of as a special case of the ADDFSR instruction, where f = 3 (binary '11'); it operates

only on FSR2.

Words: 1

Q Cycle Activity:

Cycles:

,			
Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	literal 'k'	Data	FSR
No	No	No	No
Operation	Operation	Operation	Operation

Example: ADDULNK 23h

Before Instruction

FSR2 = 03FFhPC = 0100h

After Instruction

FSR2 = 0422hPC = (TOS)

Note: All PIC18 instructions may take an optional label argument preceding the instruction mnemonic for use in symbolic addressing. If a label is used, the instruction syntax then becomes: {label} instruction argument(s).

CALLW Subroutine Call Using WREG

Svntax: **CALLW**

Operands: None

Operation: $(PC + 2) \rightarrow TOS$, $(W) \rightarrow PCL$,

> $(PCLATH) \rightarrow PCH$, (PCLATU) → PCU

None Status Affected:

Encoding:

0000 0000 0001 0100 First, the return address (PC + 2) is

Description

pushed onto the return stack. Next, the contents of W are written to PCL; the existing value is discarded. Then, the contents of PCLATH and PCLATU are

latched into PCH and PCU, respectively. The second cycle is executed as a NOP instruction while the new next instruction is fetched. Unlike CALL, there is no option to

update W, STATUS or BSR.

Words: 1 2 Cycles:

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	PUSH PC to	No
	WREG	stack	operation
No	No	No	No
operation	operation	operation	operation

Example: HERE CALLW

Before Instruction

address (HERE)

PCLATH 10h **PCLATU** 00h 06h

After Instruction

001006h

TOS address (HERE + 2) PCLATH =

PCLATU =

1401/05		
MOVSF	Move Indexed to f	

 $\overline{\text{MOVSF}}$ [z_s], f_d Syntax: $0 \le z_s \le 127$ Operands: $0 \le f_d \le 4095$

 $((\text{FSR2}) + z_{\text{s}}) \rightarrow f_{\text{d}}$ Operation:

Status Affected: None

Encodina: 1st word (source)

2nd word (destin.)

Description:

1110	1011	0zzz	ZZZZs
1111	ffff	ffff	ffffd
			,

The contents of the source register are moved to destination register 'f_d'. The actual address of the source register is determined by adding the 7-bit literal offset 'zs' in the first word to the value of FSR2. The address of the destination register is specified by the 12-bit literal 'f_d' in the second word. Both addresses can be anywhere in the 4096-byte data

space (000h to FFFh). The MOVSF instruction cannot use the

PCL, TOSU, TOSH or TOSL as the

destination register.

If the resultant source address points to an indirect addressing register, the

value returned will be 00h.

Words: 2 2 Cycles:

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Determine	Determine	Read
	source addr	source addr	source reg
Decode	No	No	Write
	operation	operation	register 'f'
	No dummy		(dest)
	read		

Example: MOVSF [05h], REG2

Before Instruction

80h FSR2 Contents

of 85h 33h REG2 11h

After Instruction

FSR2 80h Contents 33h of 85h = REG2 33h

MOVSS Move Indexed to Indexed

Syntax: MOVSS $[z_s]$, $[z_d]$ Operands: $0 \le z_s \le 127$ $0 \le z_d \le 127$

Operation: $((FSR2) + z_S) \rightarrow ((FSR2) + z_d)$

Status Affected: None

Encoding: 1st word (source) 2nd word (dest.)

1110	1011	1zzz	ZZZZs
1111	xxxx	XZZZ	zzzzd

Description

The contents of the source register are moved to the destination register. The addresses of the source and destination registers are determined by adding the 7-bit literal offsets 'z_s' or 'z_d',

respectively, to the value of FSR2. Both registers can be located anywhere in the 4096-byte data memory space (000h to FFFh).

The MOVSS instruction cannot use the PCL, TOSU, TOSH or TOSL as the

destination register.

If the resultant source address points to an indirect addressing register, the value returned will be 00h. If the resultant destination address points to an indirect addressing register, the instruction will execute as a NOP.

Words: 2 Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Determine	Determine	Read
	source addr	source addr	source reg
Decode	Determine	Determine	Write
	dest addr	dest addr	to dest reg

Example: MOVSS [05h], [06h]

Before Instruction

FSR2 = 80h
Contents
of 85h = 33h
Contents
of 86h = 11h
After Instruction

FSR2 = 80h Contents of 85h = 33h Contents of 86h = 33h

PUSHL	Store Literal at FSR2.	Decrement FSR2
PUSHL	Store Literal at FSR2.	Decrement ronz

Syntax: PUSHL k

Operands: $0 \le k \le 255$ Operation: $k \to (FSR2)$,

 $\mathsf{FSR2} - \mathtt{1} \to \mathsf{FSR2}$

Status Affected: None

Encoding: 1111 1010 kkkk kkkk

Description: The 8-bit literal 'k' is written to the data memory address specified by FSR2. FSR2 is decremented by 1 after the operation.

This instruction allows users to push values

onto a software stack.

Words: 1
Cycles: 1
Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read 'k'	Process	Write to
		data	destination

Example: PUSHL 08h

Before Instruction

 $\begin{array}{lll} \text{FSR2H:FSR2L} & = & \text{01ECh} \\ \text{Memory (01ECh)} & = & \text{00h} \end{array}$

After Instruction

 $\begin{array}{lll} \text{FSR2H:FSR2L} & = & \text{01EBh} \\ \text{Memory (01ECh)} & = & \text{08h} \end{array}$

SUBFSR Subtract Literal from FSR

Syntax: SUBFSR f, k Operands: $0 \le k \le 63$

 $f \in [0, 1, 2]$

Operation: $FSR(f)-k \to FSRf$

Status Affected: None

Encoding: 1110 1001 ffkk kkkk

Description: The 6-bit literal 'k' is subtracted from the contents of the FSR specified by

ʻf'.

Words: 1 Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	register 'f'	Data	destination

Example: SUBFSR 2, 23h

Before Instruction

FSR2 = 03FFh

After Instruction

FSR2 = 03DCh

SUBULNK Subtract Literal from FSR2 and Return

Syntax: SUBULNK k
Operands: $0 \le k \le 63$

Operation: $FSR2 - k \rightarrow FSR2$

 $(\mathsf{TOS}) \to \mathsf{PC}$

Status Affected: None

Encoding: 1110 1001 11kk kkkk

Description: The 6-bit literal 'k' is subtracted from the contents of the FSR2. A RETURN is then

executed by loading the PC with the TOS. The instruction takes two cycles to execute; a NOP is performed during the

second cycle.

This may be thought of as a special case of the SUBFSR instruction, where f=3 (binary

'11'); it operates only on FSR2.

Words: 1
Cycles: 2
Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	register 'f'	Data	destination
No	No	No	No
Operation	Operation	Operation	Operation

Example: SUBULNK 23h

Before Instruction

FSR2 = 03FFh PC = 0100h

After Instruction

FSR2 = 03DCh PC = (TOS)

21.2.3 BYTE-ORIENTED AND BIT-ORIENTED INSTRUCTIONS IN INDEXED LITERAL OFFSET MODE

Note: Enabling the PIC18 instruction set extension may cause legacy applications to behave erratically or fail entirely.

In addition to eight new commands in the extended set, enabling the extended instruction set also enables Indexed Literal Offset Addressing mode (Section 5.5.1 "Indexed Addressing with Literal Offset"). This has a significant impact on the way that many commands of the standard PIC18 instruction set are interpreted.

When the extended set is disabled, addresses embedded in opcodes are treated as literal memory locations: either as a location in the Access Bank ('a' = 0), or in a GPR bank designated by the BSR ('a' = 1). When the extended instruction set is enabled and 'a' = 0, however, a file register argument of 5Fh or less is interpreted as an offset from the pointer value in FSR2 and not as a literal address. For practical purposes, this means that all instructions that use the Access RAM bit as an argument – that is, all byte-oriented and bitoriented instructions, or almost half of the core PIC18 instructions – may behave differently when the extended instruction set is enabled.

When the content of FSR2 is 00h, the boundaries of the Access RAM are essentially remapped to their original values. This may be useful in creating backward compatible code. If this technique is used, it may be necessary to save the value of FSR2 and restore it when moving back and forth between C and assembly routines in order to preserve the stack pointer. Users must also keep in mind the syntax requirements of the extended instruction set (see Section 21.2.3.1 "Extended Instruction Syntax with Standard PIC18 Commands").

Although the Indexed Literal Offset Addressing mode can be very useful for dynamic stack and pointer manipulation, it can also be very annoying if a simple arithmetic operation is carried out on the wrong register. Users who are accustomed to the PIC18 programming must keep in mind that, when the extended instruction set is enabled, register addresses of 5Fh or less are used for Indexed Literal Offset Addressing.

Representative examples of typical byte-oriented and bit-oriented instructions in the Indexed Literal Offset Addressing mode are provided on the following page to show how execution is affected. The operand conditions shown in the examples are applicable to all instructions of these types.

21.2.3.1 Extended Instruction Syntax with Standard PIC18 Commands

When the extended instruction set is enabled, the file register argument, 'f', in the standard byte-oriented and bit-oriented commands is replaced with the literal offset value, 'k'. As already noted, this occurs only when 'f' is less than or equal to 5Fh. When an offset value is used, it must be indicated by square brackets ("[]"). As with the extended instructions, the use of brackets indicates to the compiler that the value is to be interpreted as an index or an offset. Omitting the brackets, or using a value greater than 5Fh within brackets, will generate an error in the MPASM Assembler.

If the index argument is properly bracketed for Indexed Literal Offset Addressing, the Access RAM argument is never specified; it will automatically be assumed to be 'o'. This is in contrast to standard operation (extended instruction set disabled) when 'a' is set on the basis of the target address. Declaring the Access RAM bit in this mode will also generate an error in the MPASM Assembler.

The destination argument, 'd', functions as before.

Refer to the MPLAB[®] IDE, MPASM[™] or MPLAB C18 documentation for information on enabling Extended Instruction set support

21.2.4 CONSIDERATIONS WHEN ENABLING THE EXTENDED INSTRUCTION SET

It is important to note that the extensions to the instruction set may not be beneficial to all users. In particular, users who are not writing code that uses a software stack may not benefit from using the extensions to the instruction set.

Additionally, the Indexed Literal Offset Addressing mode may create issues with legacy applications written to the PIC18 assembler. This is because instructions in the legacy code may attempt to address registers in the Access Bank below 5Fh. Since these addresses are interpreted as literal offsets to FSR2 when the instruction set extension is enabled, the application may read or write to the wrong data addresses.

When porting an application to the PIC18F45J10 family, it is very important to consider the type of code. A large, re-entrant application that is written in 'C' and would benefit from efficient compilation will do well when using the instruction set extensions. Legacy applications that heavily use the Access Bank will most likely not benefit from using the extended instruction set.

ADD W to Indexed **ADDWF** (Indexed Literal Offset mode)

Syntax: **ADDWF** [k] {,d}

Operands: $0 \le k \le 95$

 $d\in \left[0,1\right]$

Operation: (W) + ((FSR2) + k) \rightarrow dest

Status Affected: N, OV, C, DC, Z

Encoding: 0010 01d0 kkkk kkkk

Description: The contents of W are added to the

contents of the register indicated by FSR2, offset by the value 'k'.

If 'd' is '0', the result is stored in W. If 'd'

is '1', the result is stored back in

register 'f' (default).

Words: Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4		
Decode	Read 'k'	Process Data	Write to destination		

Example: ADDWF [OFST] , 0

Before Instruction

17h **OFST** 2Ch FSR2 0A00h

Contents of 0A2Ch 20h

After Instruction

37h Contents

20h of 0A2Ch

Bit Set Indexed **BSF** (Indexed Literal Offset mode)

Syntax: BSF [k], b

> $0 \le f \le 95$ $0 \le b \le 7$

 $1 \rightarrow ((FSR2) + k) < b >$ Operation:

Status Affected: None

1000 bbb0 kkkk kkkk Encoding:

Description: Bit 'b' of the register indicated by FSR2,

offset by the value 'k', is set.

Words: Cycles: 1

Q Cycle Activity:

Operands:

Q1 Q2 Q3 Q4 Decode Read **Process** Write to register 'f' Data destination

Example: [FLAG_OFST], 7 BSF

Before Instruction

FLAG_OFST 0Ah 0A00h FSR2 Contents of 0A0Ah 55h

After Instruction

Contents D5h of 0A0Ah

Set Indexed **SETF** (Indexed Literal Offset mode)

Syntax: SETF [k]

Operands: $0 \le k \le 95$

Operation: $FFh \rightarrow ((FSR2) + k)$

Status Affected: None

Encoding: 0110 1000 kkkk kkkk

Description: The contents of the register indicated by FSR2, offset by 'k', are set to FFh.

1

Cycles: 1 Q Cycle Activity:

Words:

Q1 Q2 Q3 Q4 Decode Read 'k' **Process** Write Data register

Example: SETF [OFST]

Before Instruction

OFST 2Ch FSR2 0A00h Contents of 0A2Ch 00h

After Instruction

Contents of 0A2Ch FFh

21.2.5 SPECIAL CONSIDERATIONS WITH MICROCHIP MPLAB® IDE TOOLS

The latest versions of Microchip's software tools have been designed to fully support the extended instruction set of the PIC18F45J10 family of devices. This includes the MPLAB C18 C compiler, MPASM assembly language and MPLAB Integrated Development Environment (IDE).

When selecting a target device for software development, MPLAB IDE will automatically set default configuration bits for that device. The default setting for the XINST configuration bit is '0', disabling the extended instruction set and Indexed Literal Offset Addressing mode. For proper execution of applications developed to take advantage of the extended instruction set, XINST must be set during programming.

To develop software for the extended instruction set, the user must enable support for the instructions and the Indexed Addressing mode in their language tool(s). Depending on the environment being used, this may be done in several ways:

- A menu option, or dialog box within the environment, that allows the user to configure the language tool and its settings for the project
- A command line option
- · A directive in the source code

These options vary between different compilers, assemblers and development environments. Users are encouraged to review the documentation accompanying their development systems for the appropriate information.

22.0 DEVELOPMENT SUPPORT

The PICmicro[®] microcontrollers are supported with a full range of hardware and software development tools:

- Integrated Development Environment
 - MPLAB® IDE Software
- Assemblers/Compilers/Linkers
 - MPASM™ Assembler
 - MPLAB C17 and MPLAB C18 C Compilers
 - MPLINK[™] Object Linker/ MPLIB[™] Object Librarian
 - MPLAB C30 C Compiler
 - MPLAB ASM30 Assembler/Linker/Library
- Simulators
 - MPLAB SIM Software Simulator
 - MPLAB dsPIC30 Software Simulator
- Emulators
 - MPLAB ICE 2000 In-Circuit Emulator
 - MPLAB ICE 4000 In-Circuit Emulator
- In-Circuit Debugger
 - MPLAB ICD 2
- Device Programmers
 - PRO MATE® II Universal Device Programmer
 - PICSTART® Plus Development Programmer
 - MPLAB PM3 Device Programmer
- · Low-Cost Demonstration Boards
 - PICDEM™ 1 Demonstration Board
 - PICDEM.net™ Demonstration Board
 - PICDEM 2 Plus Demonstration Board
 - PICDEM 3 Demonstration Board
 - PICDEM 4 Demonstration Board
 - PICDEM 17 Demonstration Board
 - PICDEM 18R Demonstration Board
 - PICDEM LIN Demonstration Board
 - PICDEM USB Demonstration Board
- Evaluation Kits
 - KEELOQ® Evaluation and Programming Tools
 - PICDEM MSC
 - microID® Developer Kits
 - CAN
 - PowerSmart® Developer Kits
 - Analog

22.1 MPLAB Integrated Development Environment Software

The MPLAB IDE software brings an ease of software development previously unseen in the 8/16-bit microcontroller market. The MPLAB IDE is a Windows® based application that contains:

- An interface to debugging tools
 - simulator
 - programmer (sold separately)
 - emulator (sold separately)
 - in-circuit debugger (sold separately)
- · A full-featured editor with color coded context
- A multiple project manager
- Customizable data windows with direct edit of contents
- · High-level source code debugging
- Mouse over variable inspection
- · Extensive on-line help

The MPLAB IDE allows you to:

- Edit your source files (either assembly or C)
- One touch assemble (or compile) and download to PICmicro emulator and simulator tools (automatically updates all project information)
- · Debug using:
 - source files (assembly or C)
 - mixed assembly and C
 - machine code

MPLAB IDE supports multiple debugging tools in a single development paradigm, from the cost effective simulators, through low-cost in-circuit debuggers, to full-featured emulators. This eliminates the learning curve when upgrading to tools with increasing flexibility and power.

22.2 MPASM Assembler

The MPASM assembler is a full-featured, universal macro assembler for all PICmicro MCUs.

The MPASM assembler generates relocatable object files for the MPLINK object linker, Intel® standard HEX files, MAP files to detail memory usage and symbol reference, absolute LST files that contain source lines and generated machine code and COFF files for debugging.

The MPASM assembler features include:

- · Integration into MPLAB IDE projects
- User defined macros to streamline assembly code
- Conditional assembly for multi-purpose source files
- Directives that allow complete control over the assembly process

22.3 MPLAB C17 and MPLAB C18 C Compilers

The MPLAB C17 and MPLAB C18 Code Development Systems are complete ANSI C compilers for Microchip's PIC17CXXX and PIC18CXXX family of microcontrollers. These compilers provide powerful integration capabilities, superior code optimization and ease of use not found with other compilers.

For easy source level debugging, the compilers provide symbol information that is optimized to the MPLAB IDE debugger.

22.4 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK object linker combines relocatable objects created by the MPASM assembler and the MPLAB C17 and MPLAB C18 C compilers. It can link relocatable objects from precompiled libraries, using directives from a linker script.

The MPLIB object librarian manages the creation and modification of library files of precompiled code. When a routine from a library is called from a source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications.

The object linker/library features include:

- Efficient linking of single libraries instead of many smaller files
- Enhanced code maintainability by grouping related modules together
- Flexible creation of libraries with easy module listing, replacement, deletion and extraction

22.5 MPLAB C30 C Compiler

The MPLAB C30 C compiler is a full-featured, ANSI compliant, optimizing compiler that translates standard ANSI C programs into dsPIC30F assembly language source. The compiler also supports many command line options and language extensions to take full advantage of the dsPIC30F device hardware capabilities and afford fine control of the compiler code generator.

MPLAB C30 is distributed with a complete ANSI C standard library. All library functions have been validated and conform to the ANSI C library standard. The library includes functions for string manipulation, dynamic memory allocation, data conversion, time-keeping and math functions (trigonometric, exponential and hyperbolic). The compiler provides symbolic information for high-level source debugging with the MPLAB IDE.

22.6 MPLAB ASM30 Assembler, Linker and Librarian

MPLAB ASM30 assembler produces relocatable machine code from symbolic assembly language for dsPIC30F devices. MPLAB C30 compiler uses the assembler to produce it's object file. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. Notable features of the assembler include:

- · Support for the entire dsPIC30F instruction set
- · Support for fixed-point and floating-point data
- · Command line interface
- · Rich directive set
- Flexible macro language
- MPLAB IDE compatibility

22.7 MPLAB SIM Software Simulator

The MPLAB SIM software simulator allows code development in a PC hosted environment by simulating the PICmicro series microcontrollers on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a file, or user defined key press, to any pin. The execution can be performed in Single-Step, Execute Until Break or Trace mode.

The MPLAB SIM simulator fully supports symbolic debugging using the MPLAB C17 and MPLAB C18 C Compilers, as well as the MPASM assembler. The software simulator offers the flexibility to develop and debug code outside of the laboratory environment, making it an excellent, economical software development tool.

22.8 MPLAB SIM30 Software Simulator

The MPLAB SIM30 software simulator allows code development in a PC hosted environment by simulating the dsPIC30F series microcontrollers on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a file, or user defined key press, to any of the pins.

The MPLAB SIM30 simulator fully supports symbolic debugging using the MPLAB C30 C Compiler and MPLAB ASM30 assembler. The simulator runs in either a Command Line mode for automated tasks, or from MPLAB IDE. This high-speed simulator is designed to debug, analyze and optimize time intensive DSP routines.

22.9 MPLAB ICE 2000 High-Performance Universal In-Circuit Emulator

The MPLAB ICE 2000 universal in-circuit emulator is intended to provide the product development engineer with a complete microcontroller design tool set for PICmicro microcontrollers. Software control of the MPLAB ICE 2000 in-circuit emulator is advanced by the MPLAB Integrated Development Environment, which allows editing, building, downloading and source debugging from a single environment.

The MPLAB ICE 2000 is a full-featured emulator system with enhanced trace, trigger and data monitoring features. Interchangeable processor modules allow the system to be easily reconfigured for emulation of different processors. The universal architecture of the MPLAB ICE in-circuit emulator allows expansion to support new PICmicro microcontrollers.

The MPLAB ICE 2000 in-circuit emulator system has been designed as a real-time emulation system with advanced features that are typically found on more expensive development tools. The PC platform and Microsoft® Windows 32-bit operating system were chosen to best make these features available in a simple, unified application.

22.10 MPLAB ICE 4000 High-Performance Universal In-Circuit Emulator

The MPLAB ICE 4000 universal in-circuit emulator is intended to provide the product development engineer with a complete microcontroller design tool set for highend PICmicro microcontrollers. Software control of the MPLAB ICE in-circuit emulator is provided by the MPLAB Integrated Development Environment, which allows editing, building, downloading and source debugging from a single environment.

The MPLAB ICD 4000 is a premium emulator system, providing the features of MPLAB ICE 2000, but with increased emulation memory and high-speed performance for dsPIC30F and PIC18XXXX devices. Its advanced emulator features include complex triggering and timing, up to 2 Mb of emulation memory and the ability to view variables in real-time.

The MPLAB ICE 4000 in-circuit emulator system has been designed as a real-time emulation system with advanced features that are typically found on more expensive development tools. The PC platform and Microsoft Windows 32-bit operating system were chosen to best make these features available in a simple, unified application.

22.11 MPLAB ICD 2 In-Circuit Debugger

Microchip's In-Circuit Debugger, MPLAB ICD 2, is a powerful, low-cost, run-time development tool, connecting to the host PC via an RS-232 or high-speed USB interface. This tool is based on the Flash PICmicro MCUs and can be used to develop for these and other PICmicro microcontrollers. The MPLAB ICD 2 utilizes the in-circuit debugging capability built into the Flash devices. This feature, along with Microchip's In-Circuit Serial Programming™ (ICSP™) protocol, offers cost effective in-circuit Flash debugging from the graphical user interface of the MPLAB Integrated Development Environment. This enables a designer to develop and debug source code by setting breakpoints, single-stepping and watching variables, CPU status and peripheral registers. Running at full speed enables testing hardware and applications in real-time. MPLAB ICD 2 also serves as a development programmer for selected PICmicro devices.

22.12 PRO MATE II Universal Device Programmer

The PRO MATE II is a universal, CE compliant device programmer with programmable voltage verification at VDDMIN and VDDMAX for maximum reliability. It features an LCD display for instructions and error messages and a modular detachable socket assembly to support various package types. In Stand-Alone mode, the PRO MATE II device programmer can read, verify and program PICmicro devices without a PC connection. It can also set code protection in this mode.

22.13 MPLAB PM3 Device Programmer

The MPLAB PM3 is a universal, CE compliant device programmer with programmable voltage verification at VDDMIN and VDDMAX for maximum reliability. It features a large LCD display (128 x 64) for menus and error messages and a modular detachable socket assembly to support various package types. The ICSP™ cable assembly is included as a standard item. In Stand-Alone mode, the MPLAB PM3 device programmer can read, verify and program PICmicro devices without a PC connection. It can also set code protection in this mode. MPLAB PM3 connects to the host PC via an RS-232 or USB cable. MPLAB PM3 has high-speed communications and optimized algorithms for quick programming of large memory devices and incorporates an SD/MMC card for file storage and secure data applications.

22.14 PICSTART Plus Development Programmer

The PICSTART Plus development programmer is an easy-to-use, low-cost, prototype programmer. It connects to the PC via a COM (RS-232) port. MPLAB Integrated Development Environment software makes using the programmer simple and efficient. The PICSTART Plus development programmer supports most PICmicro devices up to 40 pins. Larger pin count devices, such as the PIC16C92X and PIC17C76X, may be supported with an adapter socket. The PICSTART Plus development programmer is CE compliant.

22.15 PICDEM 1 PICmicro Demonstration Board

The PICDEM 1 demonstration board demonstrates the capabilities of the PIC16C5X (PIC16C54 to PIC16C58A), PIC16C61, PIC16C62X, PIC16C71, PIC16C8X, PIC17C42, PIC17C43 and PIC17C44. All necessary hardware and software is included to run basic demo programs. The sample microcontrollers provided with the PICDEM 1 demonstration board can be programmed with a PRO MATE II device programmer or a PICSTART Plus development programmer. The PICDEM 1 demonstration board can be connected to the MPLAB ICE in-circuit emulator for testing. A prototype area extends the circuitry for additional application components. Features include an RS-232 interface, a potentiometer for simulated analog input, push button switches and eight LEDs.

22.16 PICDEM.net Internet/Ethernet Demonstration Board

The PICDEM.net demonstration board is an Internet/ Ethernet demonstration board using the PIC18F452 microcontroller and TCP/IP firmware. The board supports any 40-pin DIP device that conforms to the standard pinout used by the PIC16F877 or PIC18C452. This kit features a user friendly TCP/IP stack, web server with HTML, a 24L256 Serial EEPROM for Xmodem download to web pages into Serial EEPROM, ICSP/MPLAB ICD 2 interface connector, an Ethernet interface, RS-232 interface and a 16 x 2 LCD display. Also included is the book and CD-ROM "TCP/IP Lean, Web Servers for Embedded Systems," by Jeremy Bentham

22.17 PICDEM 2 Plus Demonstration Board

The PICDEM 2 Plus demonstration board supports many 18, 28 and 40-pin microcontrollers, including PIC16F87X and PIC18FXX2 devices. All the necessary hardware and software is included to run the demonstration programs. The sample microcontrollers provided with the PICDEM 2 demonstration board can be programmed with a PRO MATE II device programmer, PICSTART Plus development programmer, or MPLAB ICD 2 with a Universal Programmer Adapter. The MPLAB ICD 2 and MPLAB ICE in-circuit emulators may also be used with the PICDEM 2 demonstration board to test firmware. A prototype area extends the circuitry for additional application components. Some of the features include an RS-232 interface, a 2 x 16 LCD display, a piezo speaker, an on-board temperature sensor, four LEDs and sample PIC18F452 and PIC16F877 Flash microcontrollers.

22.18 PICDEM 3 PIC16C92X Demonstration Board

The PICDEM 3 demonstration board supports the PIC16C923 and PIC16C924 in the PLCC package. All the necessary hardware and software is included to run the demonstration programs.

22.19 PICDEM 4 8/14/18-Pin Demonstration Board

The PICDEM 4 can be used to demonstrate the capabilities of the 8, 14 and 18-pin PIC16XXXX and PIC18XXXX MCUs, including the PIC16F818/819, PIC16F87/88, PIC16F62XA and the PIC18F1320 family of microcontrollers. PICDEM 4 is intended to showcase the many features of these low pin count parts, including LIN and Motor Control using ECCP. Special provisions are made for low-power operation with the supercapacitor circuit and jumpers allow onboard hardware to be disabled to eliminate current draw in this mode. Included on the demo board are provisions for Crystal, RC or Canned Oscillator modes, a five volt regulator for use with a nine volt wall adapter or battery, DB-9 RS-232 interface, ICD connector for programming via ICSP and development with MPLAB ICD 2, 2 x 16 liquid crystal display, PCB footprints for H-Bridge motor driver, LIN transceiver and EEPROM. Also included are: header for expansion, eight LEDs, four potentiometers, three push buttons and a prototyping area. Included with the kit is a PIC16F627A and a PIC18F1320. Tutorial firmware is included along with the User's Guide.

22.20 PICDEM 17 Demonstration Board

The PICDEM 17 demonstration board is an evaluation board that demonstrates the capabilities of several Microchip microcontrollers, including PIC17C752, PIC17C756A, PIC17C762 and PIC17C766. A programmed sample is included. The PRO MATE II device programmer, or the PICSTART Plus development programmer, can be used to reprogram the device for user tailored application development. The PICDEM 17 demonstration board supports program download and execution from external on-board Flash memory. A generous prototype area is available for user hardware expansion.

22.21 PICDEM 18R PIC18C601/801 Demonstration Board

The PICDEM 18R demonstration board serves to assist development of the PIC18C601/801 family of Microchip microcontrollers. It provides hardware implementation of both 8-bit Multiplexed/Demultiplexed and 16-bit Memory modes. The board includes 2 Mb external Flash memory and 128 Kb SRAM memory, as well as serial EEPROM, allowing access to the wide range of memory types supported by the PIC18C601/801.

22.22 PICDEM LIN PIC16C43X Demonstration Board

The powerful LIN hardware and software kit includes a series of boards and three PICmicro microcontrollers. The small footprint PIC16C432 and PIC16C433 are used as slaves in the LIN communication and feature on-board LIN transceivers. A PIC16F874 Flash microcontroller serves as the master. All three microcontrollers are programmed with firmware to provide LIN bus communication.

22.23 PICkit[™] 1 Flash Starter Kit

A complete "development system in a box", the PICkit™ Flash Starter Kit includes a convenient multi-section board for programming, evaluation and development of 8/14-pin Flash PIC® microcontrollers. Powered via USB, the board operates under a simple Windows GUI. The PICkit 1 Starter Kit includes the User's Guide (on CD ROM), PICkit 1 tutorial software and code for various applications. Also included are MPLAB® IDE (Integrated Development Environment) software, software and hardware "Tips 'n Tricks for 8-pin Flash PIC® Microcontrollers" Handbook and a USB interface cable. Supports all current 8/14-pin Flash PIC microcontrollers, as well as many future planned devices.

22.24 PICDEM USB PIC16C7X5 Demonstration Board

The PICDEM USB Demonstration Board shows off the capabilities of the PIC16C745 and PIC16C765 USB microcontrollers. This board provides the basis for future USB products.

22.25 Evaluation and Programming Tools

In addition to the PICDEM series of circuits, Microchip has a line of evaluation kits and demonstration software for these products.

- KEELOQ evaluation and programming tools for Microchip's HCS Secure Data Products
- CAN developers kit for automotive network applications
- Analog design boards and filter design software
- PowerSmart battery charging evaluation/ calibration kits
- IrDA[®] development kit
- microID development and rfLabTM development software
- SEEVAL® designer kit for memory evaluation and endurance calculations
- PICDEM MSC demo boards for Switching mode power supply, high-power IR driver, delta sigma ADC and flow rate sensor

Check the Microchip web page and the latest Product Selector Guide for the complete list of demonstration and evaluation kits.

NOTES:

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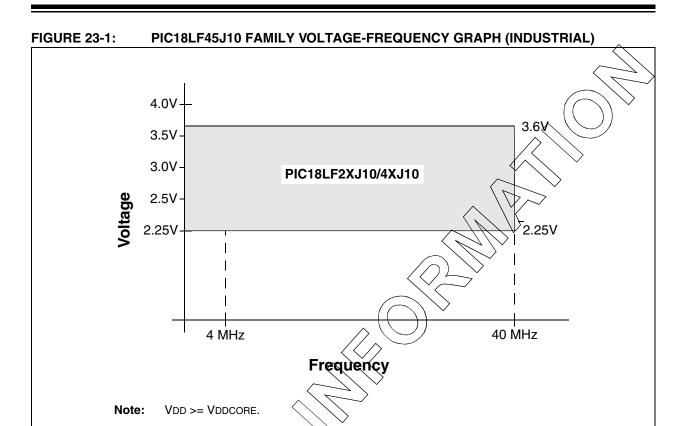
23.0 ELECTRICAL CHARACTERISTICS

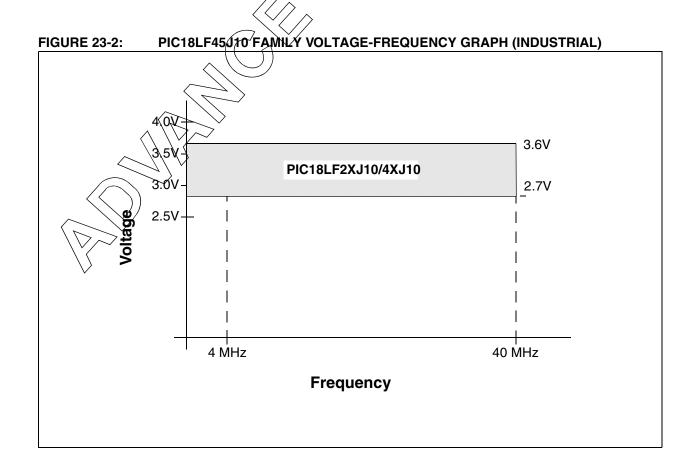
(+)

Absolute Maximum Ratings ^(T)	
ج-/ Ambient temperature under bias	40°C to +125°C
Storage temperature	65°¢ to +150°C
Voltage on any digital-only I/O pin with respect to Vss (except VDD and MCLR)	0.3V to 5.5V
Voltage on any combined digital and analog pin with respect to Vss (except VDD and MCLR)0.3V	to (VDD + 0.3V)
Voltage on VDDCORE with respect to Vss	0.3V to 2.75V
	0.3V to 3.6V
Voltage on MCLR with respect to Vss	0V to 5.5V
~ \ \\ \ \ \	1.0W
Maximum current out of Vss pin	300 mA
Maximum current into VDD pin	250 mA
Input clamp current, IiK (VI < 0 or VI > VDD)	TBD
Output clamp current, lok (Vo < 0 or Vo > VDD)	
Maximum output current sunk by PORTB and PORTC I/O pins	25 mA
Maximum output current sunk by PORTA, PORTD, and PORTE I/O pins	2 mA
Maximum output current sourced by PORTB and PORTC NO pins	25 mA
Maximum output current sourced by PORTA, PORTQ, and PORTE I/O pins	2 mA
Maximum current sunk by all ports	200 mA
Maximum current sourced by all ports	200 mA

Note 1: Power dissipation is calculated as follows: Pdis = VDD x {IDD $- \Sigma | \text{OH} \} + \Sigma \setminus \{(\text{VDD} - \text{VOH}) \times \text{IDH}\} + \Sigma \setminus \{(\text{VDD} - \text{VOH}) \times \text{IOH}\} + \Sigma \setminus \{(\text{VDD} - \text{VOH}) \times \text{IOH}\}$

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.





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23.1 DC Characteristics: Supply Voltage

PIC18F24J10/25J10/44J10/45J10 (Industrial) PIC18LF24J10/25J10/44J10/45J10 (Industrial)

	5J10 Fami l strial)	Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial					
Param No.	Symbol	Characteristic	Min	Тур	Max	Units	Conditions
D001	VDD	Supply Voltage	VDDCORE ⁽²⁾	_	3.6	V	
D001B	VDDCORE	External Supply for Microcontroller Core	2.0	_	2.75	> <	Valid only in parts designated "LF". See Section 20.3 "On-Chip Voltage Regulator" for details.
D002	VDR	RAM Data Retention Voltage ⁽¹⁾	1.5	_	-//	X	
D003	VPOR	VDD Start Voltage to ensure internal Power-on Reset signal	_	- ((TBD.		See Section 4.3 "Power-on Reset (POR)" for details
D004	SVDD	VDD Rise Rate to ensure internal Power-on Reset signal	0.05	> \\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	<i>)</i>		See Section 4.3 "Power-on Reset (POR)" for details
D005A	VBOR	Brown-out Reset Voltage		>	2.6	V	On-chip voltage regulator enabled. See Section 4.3 "Power-on Reset (POR)" for details.

Legend: $TBD = \overline{To Be Determined}$

Note 1: This is the limit to which VDD can be lowered in Sleep mode, or during a device Reset, without losing RAM

2: In parts designated with an "F", VDD \$\square 2.7V.

23.2 DC Characteristics: Power-Down and Supply Current

PIC18F24J10/25J10/44J10/45J10 (Industrial) PIC18LF24J10/25J10/44J10/45J10 (Industrial)

PIC18F4	Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{Ta} \le +85^{\circ}\text{C}$ for industrial							
Param No.	Device	Тур	Max	Units	Conditions			
	Power-Down Current (IPD) ⁽¹⁾							
	All devices	TBD	TBD	μΑ	-40°C			
		TBD	TBD	μΑ	+25°C	VDD = 2.5V, (Sleep mode)		
		TBD	TBD	μΑ	+85°C	(Sies b mode)		
	All devices	TBD	TBD	μΑ	-40°C			
		TBD	TBD	μΑ	+25°C	VDD = 3.3V, (Sleep mode)		
		TBD	TBD	μΑ	+85°C	(Cicch mode)		

Legend: TBD = To Be Determined

Note 1: The power-down current in Sleep mode does not depend on the oscillator type Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and fied to Vob or Vss and all features that add delta current disabled (such as WDT, Timer1 oscillator, BOR, etc.).

The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all 1/Q pins tri-stated, pulled to VDD;

MCLR = VDD; WDT enabled/disabled as specified.

3: For RC oscillator configurations, current through REXT is not included. The current through the resistor can be estimated by the formula Ir = VDD/2REXT (mA) with REXT in kQ.

4: Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

23.2 DC Characteristics: Power-Down and Supply Current

PIC18F24J10/25J10/44J10/45J10 (Industrial) PIC18LF24J10/25J10/44J10/45J10 (Industrial) (Continued)

PIC18F45J10 Family (Industrial)		Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial							
Param No.	Тур	Max	Units		Conditions				
	Supply Current (IDD)(2,3)								
	All devices	TBD	TBD	μΑ	-40°C				
		TBD	TBD	μΑ	+25°C	VDD = 2.5V			
		TBD	TBD	μΑ	+85°C		Fose = 31 kHz		
	All devices	TBD	TBD	μΑ	-40°C	\	RC_RUN mode, Internal oscillator source)		
		TBD	TBD	μΑ	+25°C	VDD = 3.3V	~		
		TBD	TBD	μΑ	+85°C				
	All devices	TBD	TBD	μΑ	-40°C				
		TBD	TBD	μΑ	+25°C	VDB = 2.5V			
		TBD	TBD	μΑ	+85°C//		FOSC = 31 kHz		
	All devices	TBD	TBD	μΑ	-40°C		(RC_IDLE mode, Internal oscillator source)		
		TBD	TBD	μΑ	₹25°C	VDD = 3.3V	,		
		TBD	TBD	μΑ	(+85°C)				

Legend: TBD = To Be Determined

Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to VDD or Vss and all features that add delta current disabled (such as WDT, Timer1 oscillator, ROR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

MCLR = VDD; WDT enabled disabled as specified.

3: For RC oscillator configurations, current through REXT is not included. The current through the resistor can be estimated by the formula Ir = VDD/2REXT (mA) with REXT in kΩ.

4: Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

23.2 DC Characteristics: Power-Down and Supply Current

PIC18F24J10/25J10/44J10/45J10 (Industrial)

PIC18LF24J10/25J10/44J10/45J10 (Industrial) (Continued)

PIC18F49	Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial							
Param No.	Тур	Max	Units		Conditions			
	Supply Current (IDD)(2,3)						^(())	
	All devices	TBD	TBD	μΑ	-40°C			
		TBD	TBD	μΑ	+25°C	VDD = 2.5V	\langle \square \square \qquare \qqquare \qqqq \qqq \qqqq \qqq \qqqq \qqq \qqqq \qqq \qqqq \qqq \qqqq \qqq \qqqq \qqq \qqqq	
		TBD	TBD	μΑ	+85°C	<u> </u>	Fosc = 1 MHz (PRI_RUN mode,	
	All devices	TBD	TBD	mA	-40°C		EC oscillator)	
		TBD	TBD	mA	+25°C	VDD = 3.3V		
		TBD	TBD	mA	+85°C)	
	All devices	TBD	TBD	mA	-40°C			
		TBD	TBD	mA	+25°C	VDD = 2:5V	Face ANUL	
		TBD	TBD	mA	+85°C/) ×	Fosc = 4 MHz (PRI_RUN mode,	
	All devices	TBD	TBD	mA	-40°C		EC oscillator)	
		TBD	TBD	mA	+25°C	✓VDD = 3.3V		
		TBD	TBD	mA	<u> </u>			
	All devices	TBD	TBD	mA/	<u></u>			
		TBD	TBD	mA\	[∨] < +25°C	VDD = 2.5V	F000 40 MU-	
		TBD	TBD	mA/	√+85°C		Fosc = 40 MHz (PRI_RUN mode,	
	All devices	TBD	TBD	Am	.> -40°C		EC oscillator)	
		TBD	TBQ	mA	+25°C	VDD = 3.3V		
		TBD	TBD	mA	+85°C			

Legend: TBD = To Be Determined

Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pine in high-impedance state and tied to VDD or Vss and all features that add delta current disabled (such as WDT, Timen oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all LDD measurements in active operation mode are:

QSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

MCLR = VDD, WDT enabled/disabled as specified.

3: For RC oscillator configurations, current through REXT is not included. The current through the resistor can be estimated by the formula In= VDD/2REXT (mA) with REXT in kΩ.

4: Standard low-bost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

23.2 DC Characteristics: Power-Down and Supply Current

PIC18F24J10/25J10/44J10/45J10 (Industrial)
PIC18LF24J10/25J10/44J10/45J10 (Industrial) (Continued)

PIC18F45J10 Family (Industrial)		Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial							
Param No.	Device	Тур	Max	Units		Conditions			
	Supply Current (IDD)(2)								
	All devices	TBD	TBD	mA	-40°C				
		TBD	TBD	mA	+25°C	VDD = 2.5V	Fosc = 4 MHz. (PRI_RUN HS mode)		
		TBD	TBD	mA	+85°C		(FIII_(IOI II3 III0de)		
	All devices	TBD	TBD	mA	-40°C				
		TBD	TBD	mA	+25°C	VDD = 3.3V	Fosc = 4 MHz, (PRI_RUN HS mode)		
		TBD	TBD	mA	+85°C		(FIII_HON H3 mode)		
	All devices	TBD	TBD	mA	-40°C				
		TBD	TBD	mA	+25°C	VDB = 2.5V	Fosc = 10 MHz, (PRI_RUN_HS mode)		
		TBD	TBD	mA	+85°C//	\rangle	(I III_IIOI IIIO IIIoac)		
	All devices	TBD	TBD	mA	-40°C		Fosc = 10 MHz, (PRI_RUN HS mode)		
		TBD	TBD	mA	¥25°C	VDD = 3.3V			
		TBD	TBD	mA	(+85°C)		(i iii_iioit iio iiiode)		

Legend: TBD = To Be Determined

Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to VDD or Vss and all features that add delta current disabled (such as WDT, Timer1 oscillator, ROR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

MCLR = VDD; WDT enabled disabled as specified.

3: For RC oscillator configurations, current through REXT is not included. The current through the resistor can be estimated by the formula Ir = VDD/2REXT (mA) with REXT in kΩ.

4: Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

23.2 DC Characteristics: Power-Down and Supply Current

PIC18F24J10/25J10/44J10/45J10 (Industrial)

PIC18LF24J10/25J10/44J10/45J10 (Industrial) (Continued)

PIC18F45J10 Family (Industrial)		Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{Ta} \le +85^{\circ}\text{C}$ for industrial								
Param No.	Device	Тур	Max	Units		Conditions				
	Supply Current (IDD) ^(2,3)									
	All devices	TBD	TBD	μΑ	-40°C					
		TBD	TBD	μΑ	+25°C	VDD = 2.5V				
		TBD	TBD	μΑ	+85°C	<	Fosc = 1 MHz (PRI_IDLE mode,			
	All devices	TBD	TBD	μΑ	-40°C		EC oscillator)			
		TBD	TBD	μΑ	+25°C	VDD = 3.3V				
		TBD	TBD	μΑ	+85°C					
	All devices	TBD	TBD	μΑ	-40°C					
		TBD	TBD	μΑ	+25°C	VDD = 2.5V	Food 4 MUL			
		TBD	TBD	μΑ	+85°C//		Fosc = 4 MHz (PRI_IDLE mode,			
	All devices	TBD	TBD	mA	-40°C		EC oscillator)			
		TBD	TBD	mA	≠25°C	VDD = 3.3V				
		TBD	TBD	mA	(+85°C)					
	All devices	TBD	TBD	mA	-40°C					
		TBD	TBD	mA	//+25°C	VDD = 2.5V	F000 40 MH-			
		TBD	TBD	MM	+85°C		Fosc = 40 MHz (PRI_IDLE mode,			
	All devices	TBD	TBD	mA			EC oscillator)			
		TBD	TÉD	Am	+25°C	VDD = 3.3V				
		TBD	TBD	mA	+85°C					

Legend: TBD = To Be Determined

Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to VDD or Vss and all features that add delta current disabled (such as WDV, Timer oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

MCLR = VDD, WDT enabled/disabled as specified.

3: For RC oscillator configurations, current through REXT is not included. The current through the resistor can be estimated by the formula Ir = VDD/2REXT (mA) with REXT in kΩ.

4: Standard low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

23.2 DC Characteristics: Power-Down and Supply Current

PIC18F24J10/25J10/44J10/45J10 (Industrial) PIC18LF24J10/25J10/44J10/45J10 (Industrial) (Continued)

PIC18F45J10 Family (Industrial)		Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial								
Param No.	Тур	Max	Units		Conditions					
	Supply Current (IDD) ^(2,3)									
	All devices	TBD	TBD	μА	-40°C					
		TBD	TBD	μΑ	+25°C	VDD = 2.5V				
		TBD	TBD	μΑ	+85°C	_	FOSC = 32 kHz ⁽⁴⁾			
	All devices	TBD	TBD	μΑ	-40°C	~	(SEC_RUN mode, 5mer1 as clock)			
		TBD	TBD	μΑ	+25°C	VDD = 3.8V	<i>y</i>			
		TBD	TBD	μΑ	+85°C	$\backslash \backslash \backslash $	~			
	All devices	TBD	TBD	μΑ	-40°C)			
		TBD	TBD	μΑ	+25°C	(VEQ =12.5V)	(4)			
		TBD	TBD	μΑ	+85°C		Fosc = 32 kHz ⁽⁴⁾			
	All devices	TBD	TBD	μΑ	-40°C		(SEC_IDLE mode, Timer1 as clock)			
		TBD	TBD	μΑ	+25°C	VDD = 3.3V				
		TBD	TBD	μΑ	+85°C	\succeq				

Legend: TBD = To Be Determined

Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to VDD or Vss and all features that add delta current disabled (such as WDT, Timer1 oscillator, BQR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from call-to-rail; all I/O pins tri-stated, pulled to VDD;

MCLR = VDD; WDT enabled disabled as specified.

3: For RC oscillator configurations, current through REXT is not included. The current through the resistor can be estimated by the formula Ir = VDD/2REXT (mA) with REXT in kΩ.

4: Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a nuch higher cost.

23.2 DC Characteristics: Power-Down and Supply Current

PIC18F24J10/25J10/44J10/45J10 (Industrial)

PIC18LF24J10/25J10/44J10/45J10 (Industrial) (Continued)

PIC18F45 (Indus	Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial								
Param No.	Device	Тур	Max	Units	Conditions				
	Module Differential Currents (∆lwdt, ∠	\loscb,	∆ IAD)					
D022	Watchdog Timer	TBD	TBD	μΑ	-40°C				
(∆lwdt)		TBD	TBD	μΑ	+25°C	VDD = 2.5V			
		TBD	TBD	μΑ	+85°C	,			
		TBD	TBD	μΑ	-40°C	<	Y Y		
		TBD	TBD	μΑ	+25°C	VDD = 3. 3 √	\searrow		
		TBD	TBD	μΑ	+85°C		\geqslant		
D025	Timer1 Oscillator	TBD	TBD	μΑ	-40°C				
(∆loscb)		TBD	TBD	μΑ	+25°C	VDD=8.5V \	32 kHz on Timer1 ⁽³⁾		
		TBD	TBD	μΑ	+85°C				
		TBD	TBD	μΑ	-40°C				
		TBD	TBD	μΑ	+25°Q <	VDD ¥ 3.3V	32 kHz on Timer1 ⁽³⁾		
		TBD	TBD	μΑ	+85°C				
D026	A/D Converter	TBD	TBD	μΑ	-40°/C/10 +85°/C	\checkmark VDD = 2.5V	A/D on, not converting		
(ΔIAD)		TBD	TBD	μΑ	-40°C to +85°C	VDD = 3.3V	A/D on, not converting		

Legend: TBD = To Be Determined

Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to VDD or Vss and all features that add delta current disabled (such as WDT, Timer1 oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

MCLR = VDD; WDT enabled/disabled as specified.

3: For RC oscillator configurations, current through REXT is not included. The current through the resistor can be estimated by the formula Ir = VDD/2 / Fext (mA) with REXT in kΩ.

4: Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

23.3 DC Characteristics: PIC18F24J10/25J10/44J10/45J10 (Industrial) PIC18LF24J10/25J10/44J10/45J10 (Industrial)

DC CHA	ARACTE	RISTICS				inless otherwise stated) ≤ +85°C for industrial
Param No.	Symbol	Characteristic	Min	Max	Units	Conditions
	VIL	Input Low Voltage				
		I/O ports:			7	
D030		with TTL buffer	Vss	0.15 VDD	\sqrt{N}	√DD < 3.3V
D030A			_	0.8	K/	3.3V ≤ VDD ≤ 3.6V
D031		with Schmitt Trigger buffer	Vss	0.2 VDB	7 M	
D032		MCLR	Vss	0.2 YDD	γV	
D033		OSC1	Vss [≺]	0.3 VDD	V	HS, HSPLL modes
D033A		OSC1	Vss	0.2 VDD	V	EC mode ⁽¹⁾
D034		T1CKI	Vss (0.3	V	
	VIH	Input High Voltage				
		I/O ports:				
D040		with TTL buffer	0.25 VDD + 0.8V	VDD	V	VDD < 3.3V
D040A			2.0	VDD	V	$3.3V \le VDD \le 3.6V$
D041		with Schmitt Trigger buffer	№ .8 VDD	VDD	V	
D042		MCLR	◇ 0.8 Vdd	VDD	V	
D043		OSC1	0.7 Vdd	VDD	V	HS, HSPLL modes
D043A		OSC1	0.8 VDD	VDD	V	EC mode
D044		T1CKI (TBD	VDD	V	
	lı∟	Input Leakage Current(2,3)				
D060		I/O ports	_	TBD	μΑ	Vss ≤ VPIN ≤ VDD, Pin at high-impedance
D061		MCLR	_	TBD	μΑ	VSS ≤ VPIN ≤ VDD
D063		0\$¢1\//~	_	TBD	μA	$Vss \le Vpin \le Vdd$
	IPU <	Weak Pull-up Current				
D070	IPURB	PORTB weak pull-up current	50	400	μΑ	VDD = 3.3V, VPIN = VSS

Legend: (BD) To Be Determined

Note 1: In RC oscillator configuration, the OSC1/CLKI pin is a Schmitt Trigger input. It is not recommended that the PlCmicro® device be driven with an external clock while in RC mode.

The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

23.3 DC Characteristics: PIC18F24J10/25J10/44J10/45J10 (Industrial) PIC18LF24J10/25J10/44J10/45J10 (Industrial) (Continued)

DC CHA	RACTE	RISTICS	Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for industrial					
Param No.	Symbol	Characteristic	Min	Max	Units	Conditions		
	Vol	Output Low Voltage						
D080A		I/O ports	_	TBD	V	TBD, VpD = 3.3V, -40°C to +85°C		
D080B			_	_				
D080C		0000/01 KO (FO!-)	_	_	\ \ \ /	100 4 1/22 001/		
D083		OSC2/CLKO (EC mode)	_	0.6	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	100 = 1.6 mA, VDD = 3.3V, -40°C to +85°C		
	Vон	Output High Voltage ⁽³⁾			10	\sim		
D090A		I/O ports	TBD	-	\ \\ \'\	TBD, VDD = 3.3V,		
D090B			_		\bigvee	-40°C to +85°C		
D090C			_		\rangle			
D092		OSC2/CLKO (EC mode)	VDD - 0.7		V	IOH = -1.3 mA, VDD = $3.3V$, -40° C to $+85^{\circ}$ C		
		Capacitive Loading Specs on Output Pins		\rightarrow				
D . a a (4)	Cocco	OSC2 pin		15	рF	In HS mode when		
D100 ⁽⁴⁾	00802	Ο Ο Ο Σ		15	μr	external clock is used to drive OSC1		
D101	Cio	All I/O pins and OSC2		50	pF	To meet the AC Timing Specifications		
D102	Св	SCLx, SDAx	\triangleright –	400	pF	I ² C™ Specification		

Legend: TBD = To Be Determined

Note 1: In RC oscillator configuration, the OSC1/CLKI pin is a Schmitt Trigger input. It is not recommended that the PICmicro® device be driven with an external clock while in RC mode.

- 2: The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
- 3: Negative current is defined as current sourced by the pin.

TABLE 23-1: MEMORY PROGRAMMING REQUIREMENTS

DC CHA	DC CHARACTERISTICS			Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for industrial						
Param No.	Sym	Characteristic	Min	Min Typ† Max Units			Conditions			
		Program Flash Memory					_			
D130	EР	Cell Endurance	100	1K	_	E/W	-40°C to +85°C			
D131	VPR	VDD for Read	VMIN	_	3.6	٧	VMIN = Minimum operating			
D132B	VPEW	VDD for Self-Timed Write	VMIN	_	3.6	V	Voltage VMIN = Minimum operating voltage			
D133A	Tıw	Self-Timed Write Cycle Time	_	10	_	ms				
D134	TRETD	Characteristic Retention	10	20	_	Year	Provided no other			
D135	IDDP	Supply Current during Programming	_	10	_ <	mA	specifications are violated			

† Data in "Typ" column is at 3.3V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

TABLE 23-2: COMPARATOR SPECIFICATIONS

Operating Conditions: 3.0V < VDD < 3.6V, -40°C < TA < +85°C (unless otherwise stated)

-												
Param No.	Sym	Characteristics	Min	Тур	Max	Units	Comments					
D300	VIOFF	Input Offset Voltage	_	±5.0	±10	mV						
D301	VICM	Input Common Mode Voltage*	0	_	VDD - 1.5	V						
D302	CMRR	Common Mode Rejection Ratio*	55	_	_	dB						
300	TRESP	Response Time ^{(1)*}	_	150	400	ns						
301	Тмс2оv	Comparator Mode Change to Output Valid*			10	us						

^{*} These parameters are characterized but not tested.

Note 1: Response time measured with one comparator input at (VDD – 1.5)/2, while the other input transitions from Vss to VDD.

TABLE 23-3: VOLTAGE REFERENCE SPECIFICATIONS

Operating	Operating Conditions: 3.0V < VDD < 3.6V, -40°C < TA < +85°C (unless otherwise stated)									
Param No.	Sym	Characteristics	Min	Typ	Max	Units	Comments			
D310	VRES	Resolution	VDD/2A		VDD/32	LSb				
D311	VRAA	Absolute Accuracy	$\downarrow \checkmark \checkmark$	/ _	1/2	LSb				
D312	VRur	Unit Resistor Value (R)	17	> 2k	_	Ω				
310	TSET	Settling Time ⁽¹⁾		_	10	μs				

Note 1: Settling time measured while CVRR = 1 and CVR3:CVR0 transitions from '0000' to '1111'.

TABLE 23-4: INTERNAL VOLTAGE REGULATOR SPECIFICATIONS

Operatin	Operating Conditions: -40°C < TA < +85°C (unless otherwise stated)									
Param No.	Sym	Characteristics	Min	Тур	Max	Units	Comments			
	VRGOUT	Regulator Output Voltage	_	2.5	_	V				
	CEFC	External Filter Capacitor	1	10	1	μF	Capacitor must be low ESR			

^{*} These parameters are characterized but not tested. Parameter numbers not yet assigned for these specifications.

23.4 AC (Timing) Characteristics

23.4.1 TIMING PARAMETER SYMBOLOGY

The timing parameter symbols have been created following one of the following formats:

1. TppS2ppS	3	3. Tcc:st	(I ² C specifications only)
2. TppS		4. Ts	(I ² C specifications only)
Т			
F	Frequency	Т	Time
Lowercase le	etters (pp) and their meanings:		
рр			
СС	CCP1	osc	OSC1
ck	CLKO	rd	RD
cs	CS	rw	RD or WR
di	SDI	sc	SCK
do	SDO	ss	SS
dt	Data in	tO	TOCKI
io	I/O port	t1	T1CKI
mc	MCLR	wr	WR
Uppercase le	etters and their meanings:		
S			
F	Fall	Р	Period
Н	High	R	Rise
1	Invalid (High-impedance)	V	Valid
L	Low	Z	High-impedance
I ² C only			
AA	output access	High	High
BUF	Bus free	Low	Low
TCC:ST (I ² C s	specifications only)		
CC			
HD	Hold	SU	Setup
ST			
DAT	DATA input hold	STO	Stop condition
STA	Start condition		

23.4.2 TIMING CONDITIONS

The temperature and voltages specified in Table 23-5 apply to all timing specifications unless otherwise noted. Figure 23-3 specifies the load conditions for the timing specifications.

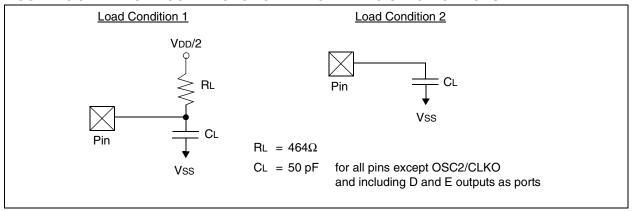
TABLE 23-5: TEMPERATURE AND VOLTAGE SPECIFICATIONS - AC

AC CHARACTERISTICS

Standard Operating Conditions (unless otherwise stated)

Operating temperature -40°C ≤ TA ≤ +85°C for industrial
Operating voltage VDD range as described in DC spec Section 23.1 and
Section 23.3.

FIGURE 23-3: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS



23.4.3 TIMING DIAGRAMS AND SPECIFICATIONS



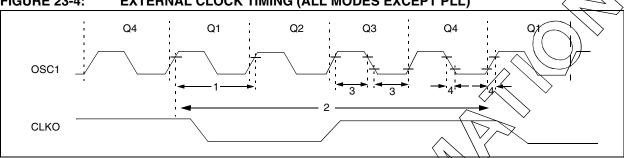


TABLE 23-6: EXTERNAL CLOCK TIMING REQUIREMENTS

Param. No.	Symbol	Characteristic	Min	Max	Units	Conditions
1A	Fosc	External CLKI Frequency ⁽¹⁾	DC 🔿	(40)	MHz	HS Oscillator mode
		Oscillator Frequency ⁽¹⁾	DC//	→ 40	MHz	HS Oscillator mode
1	Tosc	External CLKI Period ⁽¹⁾	25	_	ns	HS Oscillator mode
		Oscillator Period ⁽¹⁾	25	→ 250	ns	HS Oscillator mode
2	TCY	Instruction Cycle Time ⁽¹⁾ <	100	_	ns	Tcy = 4/Fosc, Industrial
3	TosL,	External Clock in (OSC1)	10	_	ns	HS Oscillator mode
	TosH	High or Low Time	>			
4	TosR,	External Clock in (QSQ1)	_	7.5	ns	HS Oscillator mode
	TosF	Rise or Fall Time				

Note 1: Instruction cycle period (TCY) equals four times the input oscillator time base period for all configurations. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKI pin. When an external clock input is used, the "max:" cycle time limit is "DC" (no clock) for all devices.

TABLE 23-7: PLL CLOCK TIMING SPECIFICATIONS (VDD = 2.5V TO 3.6V)

Param No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
F10	Fosc	Oscillator Frequency Range	4		10	MHz/	HS mode only
F11	Fsys	On-Chip VCO System Frequency	16		40	MHz	HS mode only
F13	Δ CLK	CLKO Stability (Jitter)	-2	_	+2		

† Data in "Typ" column is at 5V, 25°C, unless otherwise stated. These parameters are for design guidance only and are not tested.

TABLE 23-8: AC CHARACTERISTICS: INTERNAL RC ACCURACY
PIC18F24J10/25J10/44J10/45J10 (INDUSTRIAL)

Param No.	Characteristic	Min	Тур	Max Units	Conditions
	INTRC Accuracy @ Freq = 31 kHz ⁽¹⁾	26.562	_	35.938 kHz	-40°C to +85°C, VDD = 2.0-3.3V

Note 1: INTRC frequency after calibration. Change of INTRC frequency as VDD changes.

FIGURE 23-5: CLKO AND I/O TIMING

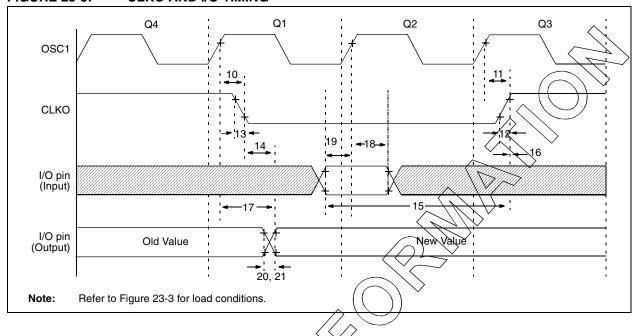


TABLE 23-9: CLKO AND I/O TIMING REQUIREMENTS

Param		LRO AND I/O HIMING REQUIREMENT	,	_			
No.	Symbol	Characteristic	Min	Тур	Max	Units	Conditions
10	TosH2ckL	OSC1 ↑ to CLKO↓	_	TBD	TBD	ns	
11	TosH2ckH	OSC1 ↑ to CLKO ↑//	_	TBD	TBD	ns	
12	TCKR	CLKO Rise Time	_	TBD	TBD	ns	
13	TCKF	CLKO Fall Time	_	TBD	TBD	ns	
14	TCKL2IOV	CLKO ↓ to Rort Out Valid	_		0.5 Tcy + 20	ns	
15	TioV2ckH	Port In Valid before CLKO ↑	0.25 Tcy + 25	1	_	ns	
16	TckH2ioI	Port In Hold after CLKO ↑	0		_	ns	
17	TosH2IOV	OSC1 (Q1 eycle) to Port Out Valid	_	50	150	ns	
18	TosH2iol (QSC1/2 (Q2 cycle) to Port Input Invalid	100	1	_	ns	
18A		(I/Q in hold time)	200		_	ns	
19	TIOV205H	Port Input Valid to OSC1 ↑	0	_	_	ns	
		(I/O in setup time)					
20	TìoR	Port Output Rise Time	_	TBD	TBD	ns	
20A N			_	1	TBD	ns	
21	7/0F	Port Output Fall Time	_	TBD	TBD	ns	
21A \	\triangleright				TBD	ns	
22†	TINP	INT pin High or Low Time	Tcy		_	ns	
23†	TRBP	RB7:RB4 Change INT High or Low Time	Tcy		_	ns	

Legend: TBD = To Be Determined

[†] These parameters are asynchronous events not related to any internal clock edges.

FIGURE 23-6: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING

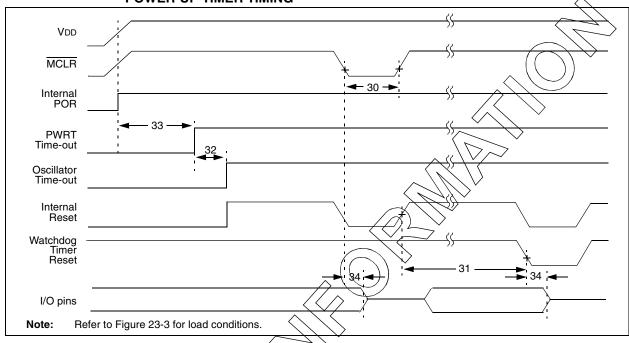


FIGURE 23-7: BROWN-OUT RESET TIMING

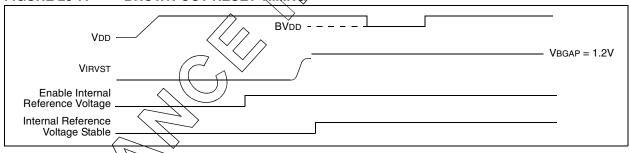


TABLE 23-10: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER AND BROWN-OUT RESET REQUIREMENTS

Param No.	Symbol	Characteristic	Min	Тур	Max	Units	Conditions
30	TMOL	MCLR Pulse Width (low)	2	_	_	μs	
31	TWDT	Watchdog Timer Time-out Period (no postscaler)	TBD	TBD	TBD	ms	
32	Tost	Oscillation Start-up Timer Period	1024 Tosc	-	1024 Tosc	l	Tosc = OSC1 period
33	TPWRT	Power-up Timer Period	55.6	65.5	75	ms	
34	Tioz	I/O High-Impedance from MCLR Low or Watchdog Timer Reset	_	2	_	μs	
38	TCSD	CPU Start-up Time	_	200	_	μs	
39	TIOBST	Time for INTRC to Stabilize	_	TBD	_	μs	

Legend: TBD = To Be Determined

FIGURE 23-8: TIMERO AND TIMER1 EXTERNAL CLOCK TIMINGS

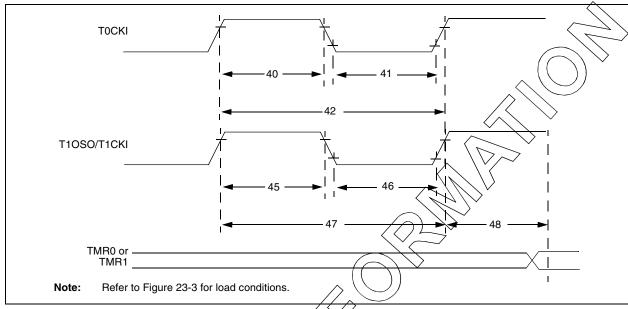


TABLE 23-11: TIMERO AND TIMER1 EXTERNAL CLOCK REQUIREMENTS

IADLE	ABLE 23-11: TIMERU AND TIMERT EXTERNAL CLOCK REQUIREMENTS								
Param No.	Symbol		Characteristic		Min	Max	Units	Conditions	
40	Тт0Н	T0CKI High F	ulse Width	No prescaler	0.5 Tcy + 20	_	ns		
				With prescaler	10		ns		
41	TT0L	T0CKI Low P	ulse Width	No prescaler	0.5 Tcy + 20		ns		
		\wedge		With prescaler	10		ns		
42	Тт0Р	T0CKI Period		No prescaler	Tcy + 10		ns		
			>	With prescaler	Greater of: 20 ns or (TcY + 40)/N	_	ns	N = prescale value (1, 2, 4,, 256)	
45	TT1H	T\CKI High	Synchronous, no prescaler		0.5 Tcy + 20	_	ns		
		Time V	Synchronous, with prescaler		10	_	ns		
			Asynchronous		30	_	ns		
46	TT/L))	T1CKI Low	Synchronous, n	o prescaler	0.5 Tcy + 5		ns		
		Time	Synchronous, w	vith prescaler	10		ns		
1/	\nearrow		Asynchronous		30	_	ns		
47	Т т1Р	T1CKI Input Period	Synchronous		Greater of: 20 ns or (TCY + 40)/N	_	ns	N = prescale value (1, 2, 4, 8)	
			Asynchronous		60	_	ns		
	FT1	T1CKI Oscilla	ator Input Frequency Range		DC	50	kHz		
48	TCKE2TMRI	Delay from Ex Timer Increme	kternal T1CKI Clo ent	ock Edge to	2 Tosc	7 Tosc	_		

FIGURE 23-9: CAPTURE/COMPARE/PWM TIMINGS (INCLUDING ECCP MODULE)

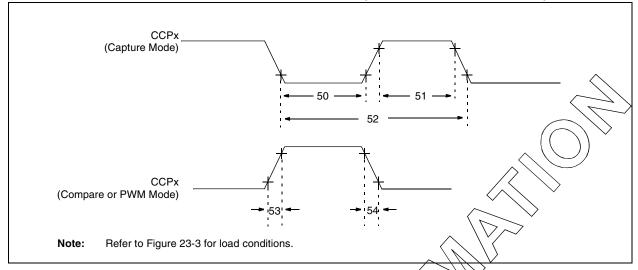


TABLE 23-12: CAPTURE/COMPARE/PWM REQUIREMENTS (KNCLUDING ECCP MODULE)

Param No.	Symbol	С	haracteristic	Min	Max	Units	Conditions
50	TccL	CCPx Input Low	No prescaler	0.5 TcY + 20	_	ns	
	Time	Time	With prescaler	10	_	ns	
51	TccH	CCPx Input	No prescaler	0.5 Tcy + 20	1	ns	
	High Time	With prescaler	10	_	ns		
52	TCCP	CCPx Input Perio	od (\\)	3 Tcy + 40	_	ns	N = prescale
			,	N			value (1, 4 or 16)
53	TCCR	CCPx Output Fal	Il Time/	_	25	ns	
54	TccF	CCPx Output Fal	Il Time //	_	25	ns	

TABLE 23-13: PARALLEL SLAVE PORT REQUIREMENTS

Param. No.	Symbol	Characteristic	Min	Max	Units	Conditions
62	TdtV2wrH∕	Data In Valid before WR ↑ or CS ↑ (setup time)	20	_	ns	
63	TwrH2dtl \	WR ↑ or CS ↑ to Data-In Invalid (hold time)	20	1	ns	
64	TrdL2dtV	RD ↓ and CS ↓ to Data–Out Valid		80	ns	
65	7røH2dtl	RD ↑ or CS ↓ to Data–Out Invalid	10	30	ns	
66		Inhibit of the IBF Flag bit being Cleared from WR ↑ or CS ↑	_	3 Tcy		

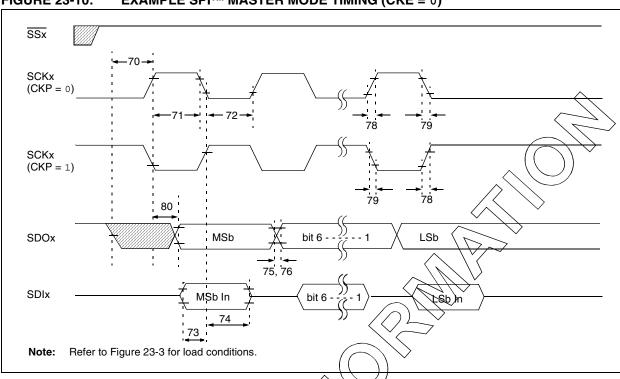


FIGURE 23-10: EXAMPLE SPI™ MASTER MODE TIMING (CKE = 0)

TABLE 23-14: EXAMPLE SPI™ MODE REQUIREMENTS (MASTER MODE, CKE = 0)

Param No.	Symbol	Characteristic		Min	Max	Units	Conditions
70	TssL2scH, TssL2scL	SSx ↓ to SCKx ↓ or SCKx ↑ Input		Tcy	_	ns	
71	TscH	SCKx Input High Time	Continuous	1.25 Tcy + 30	_	ns	
71A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
72	TscL	SCKx Input Low Time	Continuous	1.25 Tcy + 30	_	ns	
72A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
73	TDIV2SCH, TDIV2SCL	Setup Time of SDIx Data Input to SCKx Edge		100	_	ns	
73A	Тв2в	Cast Clock Edge of Byte 1 to the 1st Clock Edge of Byte 2		1.5 Tcy + 40	_	ns	(Note 2)
74	TSCH2BIL, TSCL2DIL	Hold Time of SDIx Data Input to SCKx Edge		100	_	ns	
75 /	7DOR	SDOx Data Output Rise Time		_	25	ns	
76 _ `	TOOF	SDOx Data Output Fall Time		_	25	ns	
78	TSCP	SCKx Output Rise Time (Master mode)		_	25	ns	
79 🗸	TscF	SCKx Output Fall Time (Master mode)		_	25	ns	
80	TscH2DoV, TscL2DoV	SDOx Data Output Valid after	SCKx Edge	_	50	ns	

Note 1: Requires the use of Parameter #73A.

2: Only if Parameter #71A and #72A are used.

FIGURE 23-11: EXAMPLE SPI™ MASTER MODE TIMING (CKE = 1)

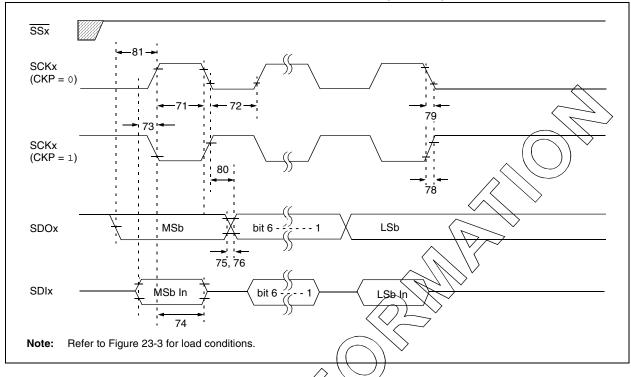


TABLE 23-15: EXAMPLE SPI™ MODE REQUIREMENTS (MASTER MODE, CKE = 1)

Param. No.	Symbol	Characteristic		Min	Max	Units	Conditions
71	TscH	SCKx Input High Time	Continuous	1.25 Tcy + 30	_	ns	
71A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
72	TscL	SCKx Input Low Time	Continuous	1.25 Tcy + 30	_	ns	
72A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
73	TDIV2SCH, TDIV2SCL	Setup Time of SDIx Data Input to SCKx Edge		100	_	ns	
73A	Тв2в	Last Clock Edge of Byte 1 to the 1st Clock Edge of Byte 2		1.5 Tcy + 40	_	ns	(Note 2)
74	TSCH2DIL, TSCL2DIL	Hold Time of SDIx Data Input to SCKx Edge		100	_	ns	
75	TDØR \\	SDOx Data Output Rise Time		_	25	ns	
76	IDOF	SDOx Data Output Fall Time		_	25	ns	
78 (TSCR	SCKx Output Rise Time (Mas	ter mode)	_	25	ns	
79	TSCF/	SCKx Output Fall Time (Master mode)		_	25	ns	
80	TSCH2DOV, TSCL2DOV	SDOx Data Output Valid after SCKx Edge		_	50	ns	
81 🚫	TDOV2scH, TDOV2scL	SDOx Data Output Setup to S	CKx Edge	Tcy		ns	

Note 1: Requires the use of Parameter #73A.

2: Only if Parameter #71A and #72A are used.

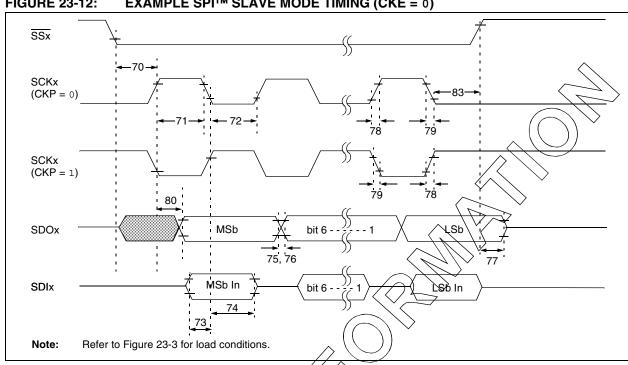


FIGURE 23-12: EXAMPLE SPITM SLAVE MODE TIMING (CKE = 0)

TABLE 23-16: EXAMPLE SPI™ MODE REQUIREMENTS (SLAVE MODE TIMING, CKE = 0)

Param No.	Symbol	Characteristic		Min	Max	Units	Conditions
70	TssL2scH, TssL2scL	SSx ↓ to SCKx ↓ or S6Kx ↑ Input		Tcy	_	ns	
71	TscH	SCKx Input High Time	Continuous	1.25 Tcy + 30	_	ns	
71A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
72	TscL	SCKx Input Low Time	Continuous	1.25 Tcy + 30	_	ns	
72A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
73	TDIV2scH, TDIV2scL	Setup Time of SDIx Data Input to SCKx Edge		100	_	ns	
73A	Тв2в	Last Clock Edge of Byte 1 to the First Clock Edge of Byte 2		1.5 Tcy + 40	_	ns	(Note 2)
74	TSCH2DIL, TSCL2DIL	Hold Time of SDIx Data Input to SCKx Edge		100	_	ns	
75	TOOR \	SDOx Data Output Rise Time		_	25	ns	
76	TBQF))	SDOx Data Output Fall Time		_	25	ns	
77/	TssH2roZ	SSx ↑ to SDOx Output High-Impedance)	10	50	ns	
78	TSC/R	SCKx Output Rise Time (Master mode)		_	25	ns	
79	TscF	SCKx Output Fall Time (Master mode)		_	25	ns	
80	TscH2DoV, TscL2DoV	SDOx Data Output Valid after SCKx Edge		_	50	ns	
83	TscH2ssH, TscL2ssH	SSx ↑ after SCKx Edge		1.5 Tcy + 40	_	ns	

Note 1: Requires the use of Parameter #73A.

2: Only if Parameter #71A and #72A are used.

FIGURE 23-13: EXAMPLE SPI™ SLAVE MODE TIMING (CKE = 1)

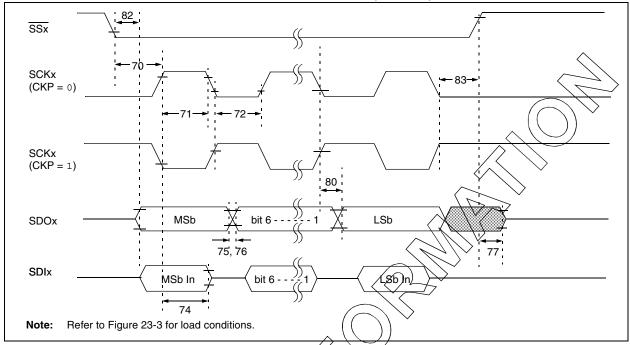


TABLE 23-17: EXAMPLE SPI™ SLAVE MODE REQUIREMENTS (CKE = 1)

Param No.	Symbol	Characteristic		Min	Max	Units	Conditions
70	TssL2scH, TssL2scL	SSx ↓ to SCKx ↓ or SCKx ↑ Input		Tcy	_	ns	
71	TscH	SCKx Input High Time	Continuous	1.25 Tcy + 30	_	ns	
71A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
72	TscL	SCKx Input Low Time	Continuous	1.25 Tcy + 30	_	ns	
72A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
73A	Тв2в	Last Clock Edge of Byte 1 to the First Clock Edge of Byte 2		1.5 Tcy + 40	_	ns	(Note 2)
74	TSCH2DIL, TSCL2DIL	Hold Time of SDIx Data Input to SCKx Edge		100	_	ns	
75	TDOR (SDOx Data Output Rise Time		_	25	ns	
76	TDOF_	Spox Data Output Fall Time		_	25	ns	
77	TS8H2DOZ	SSx ↑ to SDOx Output High-Impedance		10	50	ns	
78	TSCR	SCKx Output Rise Time (Master mo	ode)	_	25	ns	
79	TSCF	SCKx Output Fall Time (Master mo	de)	_	25	ns	
80	TSCH2DOV, TSCL2DOV	SDOx Data Output Valid after SCKx Edge		_	50	ns	
82 \	TssL2DoV	SDOx Data Output Valid after SSx ↓ Edge		_	50	ns	
83	TscH2ssH, TscL2ssH	SSx ↑ after SCKx Edge		1.5 Tcy + 40	_	ns	

Note 1: Requires the use of Parameter #73A.

2: Only if Parameter #71A and #72A are used.

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FIGURE 23-14: I²C™ BUS START/STOP BITS TIMING

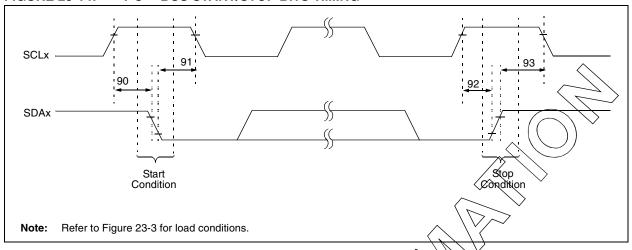


TABLE 23-18: I²C™ BUS START/STOP BITS REQUIREMENTS (SLAVE MODE)

Param. No.	Symbol	Characte	Min	Max	Units	Conditions	
90	Tsu:sta	Start Condition	100 kHz mode	4700	l) —	ns	Only relevant for Repeated
		Setup Time	400 kHz mode	600	_		Start condition
91	THD:STA	Start Condition	100 kHz møde	4000	_	ns	After this period, the first
		Hold Time	400 kHz mode	600	_		clock pulse is generated
92	Tsu:sto	Stop Condition	100 kHz mode	4700	_	ns	
		Setup Time	400 kHz mode	600	_		
93	THD:STO	Stop Condition	100 kHz mode	4000	_	ns	
		Hold Time	400 kHz mode	600	_		

FIGURE 23-15: I²C™ BUS DATA TIMING

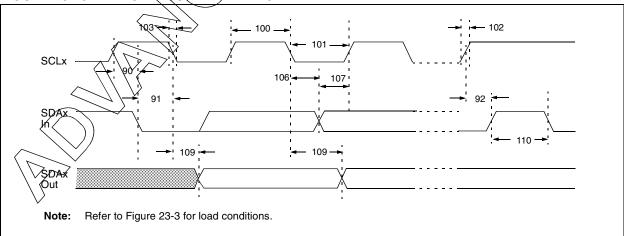


TABLE 23-19: I²C™ BUS DATA REQUIREMENTS (SLAVE MODE)

Param. No.	Symbol	Characteris	tic	Min	Max	Units	Conditions
100	THIGH	Clock High Time	100 kHz mode	4.0		μs	PIC18F45J10 must operate at a minimum of 1.5 MHz
			400 kHz mode	0.6	1	μs	PIC18F45J10 must operate at a minimum of 10 MHz
			MSSP Module	1.5 Tcy	_		
101	TLOW	Clock Low Time	100 kHz mode	4.7	_	μs	PIC18F45J10 must operate at a minimum of 1.5 MHz
			400 kHz mode	1.3	_	μs	PIC 18F45J10 must operate at a minimum of 10 MHz
			MSSP Module	1.5 TcY	_	~	
102	TR	SDAx and SCLx Rise Time	100 kHz mode	_	1000	ns /	
			400 kHz mode	20 + 0.1 CB	300	ns	B is specified to be from 10 to 400 pF
103	TF	SDAx and SCLx Fall Time	100 kHz mode	_	300	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	
			400 kHz mode	20 + 0.1 CB	300	prs	CB is specified to be from 10 to 400 pF
90	Tsu:sta	Start Condition Setup Time	100 kHz mode	4.7		μs	Only relevant for Repeated
			400 kHz mode	9.6	\rightarrow	μs	Start condition
91	THD:STA	Start Condition Hold Time	100 kHz mode	(4.0))	_	μs	After this period, the first clock
			400 kHz mode /	0.6	_	μs	pulse is generated
106	THD:DAT	Data Input Hold Time	100 kHz mode	// 0	_	ns	
			400 kHz mode	0	0.9	μs	
107	TSU:DAT	Data Input Setup Time	100 kHz mode	250	_	ns	(Note 2)
			400 kHz mode	100	_	ns	
92	Tsu:sto	Stop Condition Setup Time	100 kHz mode	4.7	_	μs	
		//	400 kHz mode	0.6	_	μs	
109	TAA	Output Valid from Clock	100 kHz mode	_	3500	ns	(Note 1)
			400 kHz mode	_	_	ns	
110	TBUF	Bus Free Time (100 kHz mode	4.7	_	μs	Time the bus must be free
			400 kHz mode	1.3	_	μs	before a new transmission can start
D102	Св	Bus Capacitive Loading			400	pF	

Note 1: As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300 ns) of the falling edge of SCLx to avoid unintended generation of Start or Stop conditions.

2: A Fast mode\ Com bus device can be used in a Standard mode I²C bus system, but the requirement, Tsu:DAT ≥ 250 ns, must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCLx signal. If such a device does stretch the LOW period of the SCLx signal, it must output the next data bit to the SDAx line,

TR max. → Tsu:DAT = 1000 + 250 = 1250 ns (according to the Standard mode I²C bus specification), before the SCLx line is released.

FIGURE 23-16: MASTER SSP I²C™ BUS START/STOP BITS TIMING WAVEFORMS

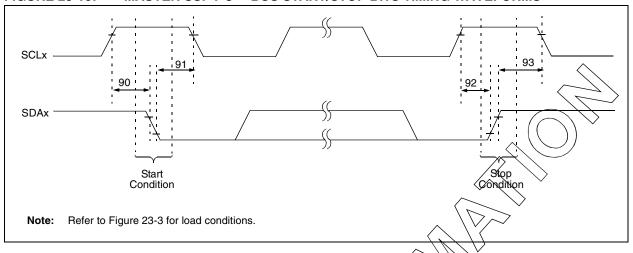


TABLE 23-20: MASTER SSP I²C™ BUS START/STOP BITS REQUIREMENTS

	MB22 20: 11.10-21.10 B00 01.11.11.11.11.11.11.11.11.11.11.11.11.1												
Param. No.	Symbol	Characte	ristic	Min	Max	Units	Conditions						
90	Tsu:sta	Start Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	ns	Only relevant for						
		Setup Time	400 kHz mode	2(Tosc)(BRG + 1)	_		Repeated Start						
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_		condition						
91	THD:STA	Start Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	ns	After this period, the						
	Hold Time		400 kHz mode	2(7osc)(BRG + 1)	_		first clock pulse is						
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_		generated						
92	Tsu:sto	Stop Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	ns							
		Setup Time <	400 kHz mode	2(Tosc)(BRG + 1)	_								
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_								
93	THD:STO	Stop Condition (100 kHz mode	2(Tosc)(BRG + 1)	_	ns							
		Hold Time	400 kHz mode	2(Tosc)(BRG + 1)	_								
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_								

Note 1: Maximum pin capacitance = 10 pF for all I²C[™] pins.

FIGURE 23-17: \ MASTER SSP I²C™ BUS DATA TIMING

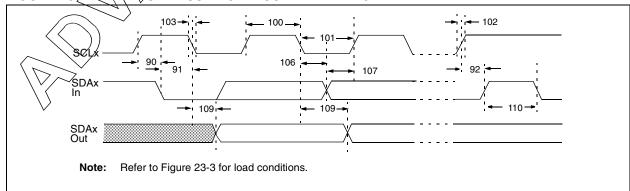


TABLE 23-21: MASTER SSP I²C™ BUS DATA REQUIREMENTS

Param. No.	Symbol	Charac	teristic	Min	Max	Units	Conditions
100	THIGH	Clock High Time	100 kHz mode	2(Tosc)(BRG + 1)	_	ms	
			400 kHz mode	2(Tosc)(BRG + 1)		ms	
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_	ms	
101	TLOW	Clock Low Time	100 kHz mode	2(Tosc)(BRG + 1)	_	ms	
			400 kHz mode	2(Tosc)(BRG + 1)	_	ms	
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_	ms	
102	TR	SDAx and SCLx	100 kHz mode	_	1000	ns /	CB is specified to be from
		Rise Time	400 kHz mode	20 + 0.1 CB	300	ns	10 to 400 pF
			1 MHz mode ⁽¹⁾	_	300	\ns_	
103	TF	SDAx and SCLx	100 kHz mode	_	300	ns/	B is specified to be from
		Fall Time	400 kHz mode	20 + 0.1 CB	300	ns	10 to 400 pF
			1 MHz mode ⁽¹⁾	_ <	400/	\\ns	
90	Tsu:sta	Start Condition	100 kHz mode	2(Tosc)(BRG + 1)	7	ms	Only relevant for
		Setup Time	400 kHz mode	2(Tosc)(BRG +1)	\nearrow	ms	Repeated Start
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	<u> </u>	ms	condition
91	THD:STA	Start Condition	100 kHz mode	2(Tos¢)(BRG)+1)	_	ms	After this period, the first
		Hold Time	400 kHz mode	2(70sc)(BRG + 1)	_	ms	clock pulse is generated
			1 MHz mode ⁽¹⁾	2(TØ\$C)(BRG + 1)	-	ms	
106	THD:DAT	Data Input	100 kHz mode	0	_	ns	
		Hold Time	400 kHz mode	2 0	0.9	ms	
			1 MHz mode ⁽¹⁾	TBD	_	ns	
107	Tsu:dat	Data Input	100 kHz mode	250	_	ns	(Note 2)
		Setup Time	400 kHz mode	100	_	ns	
			1 MHz mode ⁽¹⁾	TBD	_	ns	
92	Tsu:sto	Stop Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	ms	
		Setup Time	400 kHz mode	2(Tosc)(BRG + 1)	_	ms	
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_	ms	
109	Таа	Output Valid	100 kHz mode	_	3500	ns	
		from Clock	400 kHz mode		1000	ns	
	\land		1 MHz mode ⁽¹⁾	_	_	ns	
110	TBUE	Bus Free Time	100 kHz mode	4.7	_	ms	Time the bus must be free
		\ \ \	400 kHz mode	1.3	_	ms	before a new transmission
			1 MHz mode ⁽¹⁾	TBD	_	ms	can start
D102	CB)	Bus Capacitive Lo	oading	_	400	pF	

Legend: TBD = To Be Determined

Note 1: Maximum pin capacitance = 10 pF for all I^2C^{TM} pins.

^{2:} A Fast mode I²C bus device can be used in a Standard mode I²C bus system, but parameter #107 ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCLx signal. If such a device does stretch the LOW period of the SCLx signal, it must output the next data bit to the SDAx line, parameter #102 + parameter #107 = 1000 + 250 = 1250 ns (for 100 kHz mode), before the SCLx line is released.

FIGURE 23-18: EUSART SYNCHRONOUS TRANSMISSION (MASTER/SLAVE) TIMING

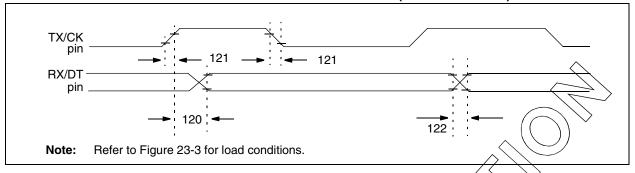


TABLE 23-22: EUSART SYNCHRONOUS TRANSMISSION REQUIREMENTS

Param No.	Symbol	Characteristic	Min	Max	Units	Conditions
120	TCKH2DTV	SYNC XMIT (MASTER and SLAVE) Clock High to Data Out Valid		40	ns	
121	TCKRF	Clock Out Rise Time and Fall Time (Master mode)	\supset	20	ns	
122	TDTRF	Data Out Rise Time and Fall Time	> −	20	ns	

FIGURE 23-19: EUSART SYNCHRONOUS RECEIVE (MASTER/SLAVE) TIMING

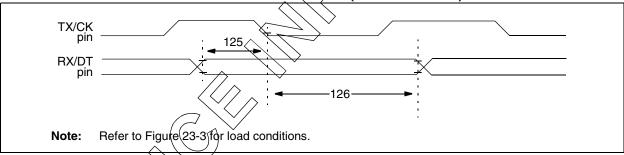


TABLE 23-23: EUSART SYNCHRONOUS RECEIVE REQUIREMENTS

Param. No.	Symbol	Characteristic	Min	Max	Units	Conditions
125	TDTV2CKL	SYNC RCV (MASTER and SLAVE) Data Hold before CK ↓ (DT hold time)	10		20	
		Data Hold before CK & (DT Hold tillle)	10		ns	
126	TCKL)2DTL	Data Hold after CK ↓ (DT hold time)	15	_	ns	

TABLE 23-24: A/D CONVERTER CHARACTERISTICS: PIC18F24J10/25J10/44J10/45J10 (INDUSTRIAL)

Param No.	Symbol	Characteristic	Min	Тур	Max	Units	Conditions
A01	NR	Resolution		_	10	bit	ΔVREF ≥ 3.0V
A03	EIL	Integral Linearity Error	_	_	<±1	LSb	ΔVREF ≥ 3.0V
A04	EDL	Differential Linearity Error	_	_	<±1	LSb	ΔVREF≥3.0V
A06	Eoff	Offset Error	_	_	<±1.5	LSb	ΔVREF ≥ 3.0V
A07	Egn	Gain Error	_	_	<±1	LSb	1VREF ≥ 3.0V
A10	_	Monotonicity	Gı	uarantee	d ⁽¹⁾	-//	VSS ≤ VAIN ≤ VREF
A20	ΔVREF	Reference Voltage Range (VREFH – VREFL)	1.8 3			\(\frac{\frac}\frac{\frac}\fint}}}{\frac{\frac{\frac{\frac{\frac{\frac}{\frac{\frac{\frac{\frac{\frac{\frac{\frac{\frac{\frac{\frac{\frac}{\frac{\frac{\frac{\frac{\frac{\frac{\frac{\frac{\frac}{\frac{\frac{\frac{\frac}{\frac{\frac{\frac{\frac{\frac{\frac{\frac{\frac{\frac}}}}}}{\frac{\frac{\frac{\frac{\frac{\frac{\frac{\frac{\frac{\frac{\frac}}}}}}{\firac{\frac{\frac{\frac{\frac}{\frac{\frac{\frac{\frac}}}{\firac{\frac{\frac{\frac{\frac{\frac{\frac{\frac{\frac{\frac{\frac}}}}}{\frac{\frac{\frac{\frac{\frac{\frac{\frac{\frac{\frac}}}}}{\frac{\frac{\frac{\frac{\frac{\frac{\frac{\frac{\frac	VDD < 3.0V VDD ≥ 3.0V
A21	VREFH	Reference Voltage High	Vss	_	VREFH	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	>
A22	VREFL	Reference Voltage Low	Vss - 0.3V		VDD - 3.0V	\ v	
A25	VAIN	Analog Input Voltage	VREFL	_	VPEPH	V	
A30	ZAIN	Recommended Impedance of Analog Voltage Source	_	_/	2.5	kΩ	
A50	IREF	VREF Input Current ⁽²⁾			5 150	μ Α μ Α	During VAIN acquisition. During A/D conversion cycle.

Note 1: The A/D conversion result never decreases with an increase in the input voltage and has no missing codes.

2: VREFH current is from RA3/AN3/VREF+ pin or VDQ, whichever is selected as the VREFH source. VREFL current is from RA2/AN2/VREF- pin or VSS, whichever is selected as the VREFL source.



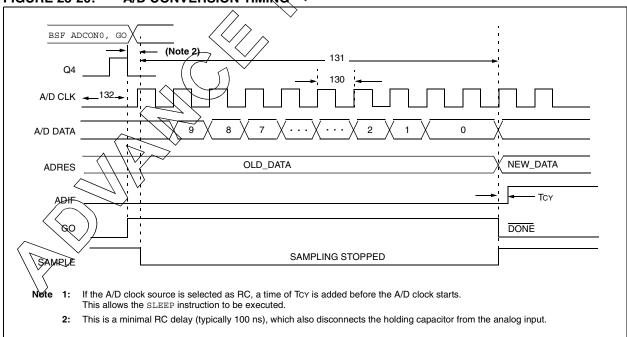


TABLE 23-25: A/D CONVERSION REQUIREMENTS

Param No.	Symbol	Characteristic	Min	Max	Units	Conditions
130	TAD	A/D Clock Period	0.7	25.0 ⁽¹⁾	μs	Tosc based, VREF ≥ 3.0V
			TBD	1	μs	A/D RC mode
131	TCNV	Conversion Time (not including acquisition time) (Note 2)	11	12	TAD	
132	TACQ	Acquisition Time (Note 3)	1.4 TBD	_	μs μs	-40°C to +86°C 0°C ≤ to ≤ +85°C
135	Tswc	Switching Time from Convert → Sample	_	(Note 4)		

Legend: TBD = To Be Determined

Note 1: The time of the A/D clock period is dependent on the device frequency and the TAD clock divider.

2: ADRES registers may be read on the following TcY cycle.

3: The time for the holding capacitor to acquire the "New" input voltage when the voltage changes full scale after the conversion (VDD to Vss or Vss to VDD). The source impedance (Rs) on the input channels is 50Ω.

4: On the following cycle of the device clock.

NOTES:

24.0 DC AND AC CHARACTERISTICS GRAPHS AND TABLES

Graphs and tables are not available at this time.

NOTES:

25.0 PACKAGING INFORMATION

25.1 Package Marking Information

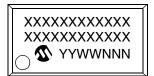
28-Lead SPDIP



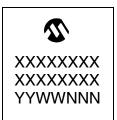
28-Lead SOIC



28-Lead SSOP



28-Lead QFN



Example



Example



Example



Example



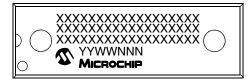
Legend: XX...X Customer-specific information
Y Year code (last digit of calendar year)
YY Year code (last 2 digits of calendar year)
WW Week code (week of January 1 is week '01')
NNN Alphanumeric traceability code

© Pb-free JEDEC designator for Matte Tin (Sn)
* This package is Pb-free. The Pb-free JEDEC designator (©3)
can be found on the outer packaging for this package.

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

Package Marking Information (Continued)

40-Lead PDIP



Example



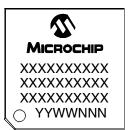
44-Lead QFN



Example



44-Lead TQFP



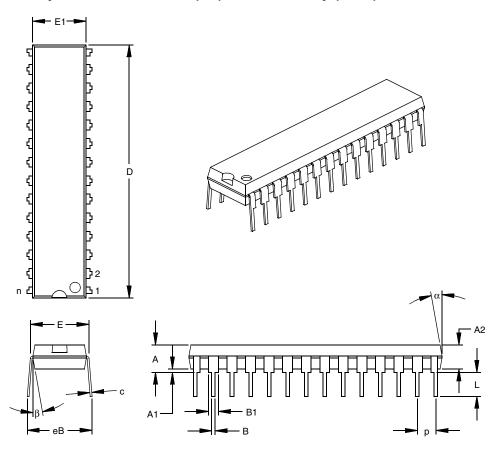
Example



25.2 **Package Details**

The following sections give the technical details of the packages.

28-Lead Skinny Plastic Dual In-line (SP) – 300 mil Body (PDIP)



	Units		INCHES*		N	MILLIMETERS		
Dimension	Limits	MIN	NOM	MAX	MIN	NOM	MAX	
Number of Pins	n		28			28		
Pitch	р		.100			2.54		
Top to Seating Plane	Α	.140	.150	.160	3.56	3.81	4.06	
Molded Package Thickness	A2	.125	.130	.135	3.18	3.30	3.43	
Base to Seating Plane	A1	.015			0.38			
Shoulder to Shoulder Width	E	.300	.310	.325	7.62	7.87	8.26	
Molded Package Width	E1	.275	.285	.295	6.99	7.24	7.49	
Overall Length	D	1.345	1.365	1.385	34.16	34.67	35.18	
Tip to Seating Plane	L	.125	.130	.135	3.18	3.30	3.43	
Lead Thickness	С	.008	.012	.015	0.20	0.29	0.38	
Upper Lead Width	B1	.040	.053	.065	1.02	1.33	1.65	
Lower Lead Width	В	.016	.019	.022	0.41	0.48	0.56	
Overall Row Spacing §	eB	.320	.350	.430	8.13	8.89	10.92	
Mold Draft Angle Top	α	5	10	15	5	10	15	
Mold Draft Angle Bottom	β	5	10	15	5	10	15	

^{*} Controlling Parameter

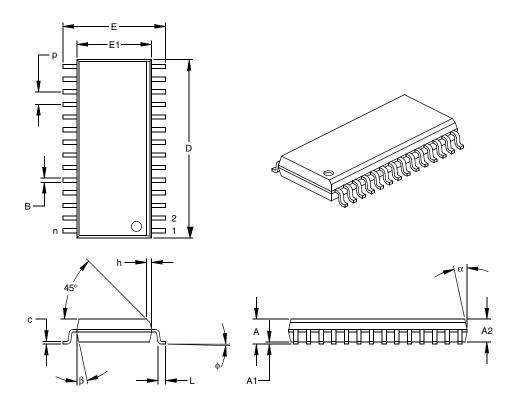
Dimension D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed

.010" (0.254mm) per side. JEDEC Equivalent: MO-095

Drawing No. C04-070

[§] Significant Characteristic

28-Lead Plastic Small Outline (SO) - Wide, 300 mil Body (SOIC)



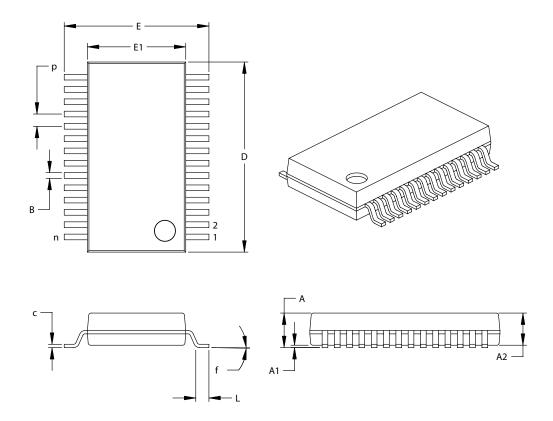
	Units		INCHES*		MILLIMETERS			
Dimension	Limits	MIN	NOM	MAX	MIN	NOM	MAX	
Number of Pins	n		28		·	28		
Pitch	р		.050			1.27		
Overall Height	Α	.093	.099	.104	2.36	2.50	2.64	
Molded Package Thickness	A2	.088	.091	.094	2.24	2.31	2.39	
Standoff §	A1	.004	.008	.012	0.10	0.20	0.30	
Overall Width	Е	.394	.407	.420	10.01	10.34	10.67	
Molded Package Width	E1	.288	.295	.299	7.32	7.49	7.59	
Overall Length	D	.695	.704	.712	17.65	17.87	18.08	
Chamfer Distance	h	.010	.020	.029	0.25	0.50	0.74	
Foot Length	L	.016	.033	.050	0.41	0.84	1.27	
Foot Angle Top	ф	0	4	8	0	4	8	
Lead Thickness	С	.009	.011	.013	0.23	0.28	0.33	
Lead Width	В	.014	.017	.020	0.36	0.42	0.51	
Mold Draft Angle Top	α	0	12	15	0	12	15	
Mold Draft Angle Bottom	β	0	12	15	0	12	15	

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: MS-013 Drawing No. C04-052

^{*} Controlling Parameter § Significant Characteristic

28-Lead Plastic Shrink Small Outline (SS) – 209 mil Body, 5.30 mm (SSOP)



	Units				MILLIMETERS*			
Dimension Lim	MIN	NOM	MAX	MIN	NOM	MAX		
Number of Pins	n		28		28			
Pitch	р		.026			0.65		
Overall Height	Α	-	-	.079	-	-	2.0	
Molded Package Thickness	A2	.065	.069	.073	1.65	1.75	1.85	
Standoff	A1	.002	-	-	0.05	-	-	
Overall Width	Е	.295	.307	.323	7.49	7.80	8.20	
Molded Package Width	E1	.009	.209	.220	5.00	5.30	5.60	
Overall Length	D	.390	.402	.413	9.90	10.20	10.50	
Foot Length	L	.022	.030	.037	0.55	0.75	0.95	
Lead Thickness	С	.004	-	.010	0.09	-	0.25	
Foot Angle	f	0°	4°	8°	0°	4°	8°	
Lead Width	В	.009	-	.015	0.22	-	0.38	

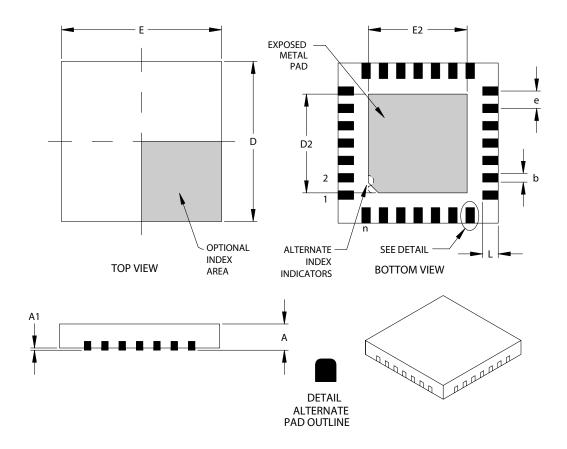
*Controlling Parameter

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: MO-150 Drawing No. C04-073

28-Lead Plastic Quad Flat No Lead Package (ML) 6x6 mm Body (QFN) – With 0.55 mm Contact Length (Saw Singulated)



	Units		INCHES		MILLIMETERS*			
Dimension Limi	ts	MIN	NOM	MAX	MIN	NOM	MAX	
Number of Pins	n		28			28		
Pitch	е		.026 BSC			0.65 BSC		
Overall Height	Α	.031	.035	.039	0.80	0.90	1.00	
Standoff	A1	.000	.001	.002	0.00	0.02	0.05	
Contact Thickness	А3		.008 REF			0.20 REF		
Overall Width	Е	.232	.236	.240	5.90	6.00	6.10	
Exposed Pad Width	E2	.140	.146	.152	3.55	3.70	3.85	
Overall Length	D	.232	.236	.240	5.90	6.00	6.10	
Exposed Pad Length	D2	.140	.146	.152	3.55	3.70	3.85	
Contact Width	b	.009	.011	.013	0.23	0.28	0.33	
Contact Length	L	.018	.022	.024	0.45	0.55	0.65	

*Controlling Parameter

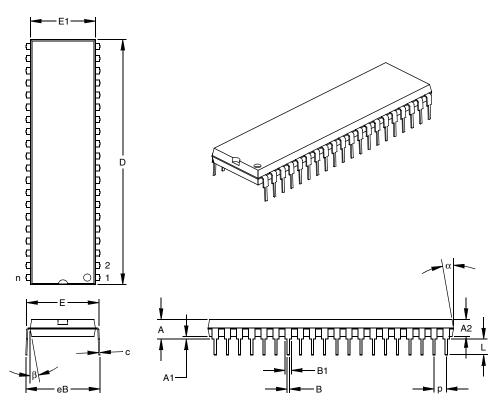
Notes:

JEDEC equivalent: MO-220

Drawing No. C04-105

Revised 02-18-05

40-Lead Plastic Dual In-line (P) - 600 mil Body (PDIP)



	Units INCHES* MILLIMETERS			INCHES*			3
Dimensio	n Limits	MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		40			40	
Pitch	р		.100			2.54	
Top to Seating Plane	Α	.160	.175	.190	4.06	4.45	4.83
Molded Package Thickness	A2	.140	.150	.160	3.56	3.81	4.06
Base to Seating Plane	A1	.015			0.38		
Shoulder to Shoulder Width	Е	.595	.600	.625	15.11	15.24	15.88
Molded Package Width	E1	.530	.545	.560	13.46	13.84	14.22
Overall Length	D	2.045	2.058	2.065	51.94	52.26	52.45
Tip to Seating Plane	L	.120	.130	.135	3.05	3.30	3.43
Lead Thickness	С	.008	.012	.015	0.20	0.29	0.38
Upper Lead Width	B1	.030	.050	.070	0.76	1.27	1.78
Lower Lead Width	В	.014	.018	.022	0.36	0.46	0.56
Overall Row Spacing §	eВ	.620	.650	.680	15.75	16.51	17.27
Mold Draft Angle Top	α	5	10	15	5	10	15
Mold Draft Angle Bottom	β	5	10	15	5	10	15

Notes:

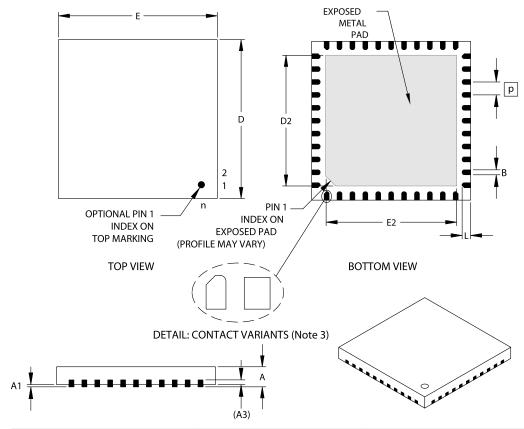
Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed

.010" (0.254mm) per side. JEDEC Equivalent: MO-011

Drawing No. C04-016

^{*} Controlling Parameter § Significant Characteristic

44-Lead Plastic Quad Flat No Lead Package (ML) 8x8 mm Body (QFN)



	Units	INCHES			MILLIMETERS*		
Dimension Limi	ts	MIN	NOM	MAX	MIN	NOM	MAX
Number of Contacts	n		44		44		
Pitch	р		.026 BSC	1		0.65 BSC 1	
Overall Height	Α	.031	.035	.039	0.80	0.90	1.00
Standoff	A1	.000	.001	.002	0	0.02	0.05
Base Thickness	(A3)	.010 REF 2			0.25 REF 2		
Overall Width	E	.309	.315	.321	7.85	8.00	8.15
Exposed Pad Width	E2	.246	.268	.274	6.25	6.80	6.95
Overall Length	D	.309	.315	.321	7.85	8.00	8.15
Exposed Pad Length	D2	.246	.268	.274	6.25	6.80	6.95
Contact Width	В	.008	.013	.013	0.20	0.33	0.35
Contact Length	L	.014	.016	.019	0.35	0.40	0.48

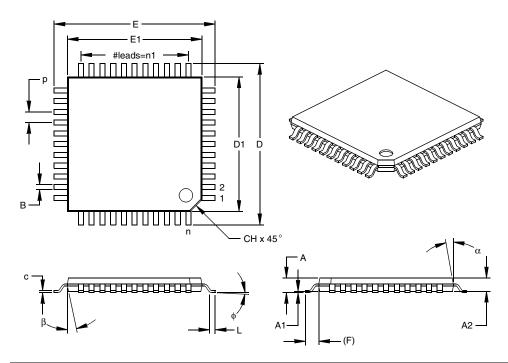
*Controlling Parameter

Notes:

- 1. BSC: Basic Dimension. Theoretically exact value shown without tolerances.
- REF: Reference Dimension, usually without tolerance, for information purposes only. See ASME Y14.5M
- 3. Contact profiles may vary.

JEDEC equivalent: M0-220 Drawing No. C04-103

44-Lead Plastic Thin Quad Flatpack (PT) 10x10x1 mm Body, 1.0/0.10 mm Lead Form (TQFP)



Units	INCHES			MILLIMETERS*		
n Limits	MIN	NOM	MAX	MIN	NOM	MAX
n		44			44	
р		.031			0.80	
n1		11			11	
Α	.039	.043	.047	1.00	1.10	1.20
A2	.037	.039	.041	0.95	1.00	1.05
A1	.002	.004	.006	0.05	0.10	0.15
L	.018	.024	.030	0.45	0.60	0.75
(F)		.039		1.00		
ф	0	3.5	7	0	3.5	7
Е	.463	.472	.482	11.75	12.00	12.25
D	.463	.472	.482	11.75	12.00	12.25
E1	.390	.394	.398	9.90	10.00	10.10
D1	.390	.394	.398	9.90	10.00	10.10
С	.004	.006	.008	0.09	0.15	0.20
В	.012	.015	.017	0.30	0.38	0.44
CH	.025	.035	.045	0.64	0.89	1.14
α	5	10	15	5	10	15
β	5	10	15	5	10	15
	n Limits n p n1 A A2 A1 L (F) φ E D E1 D1 c B CH α	n Limits MIN n p n1 A .039 A2 .037 A1 .002 L .018 (F) φ 0 E .463 D .463 E1 .390 D1 .390 c .004 B .012 CH .025 α 5	Note	Note	Name	Name

* Controlling Parameter § Significant Characteristic

Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed

.010" (0.254mm) per side.
JEDEC Equivalent: MS-026
Drawing No. C04-076

NOTES:

APPENDIX A: REVISION HISTORY

Revision A (March 2005)

Original data sheet for PIC18F45J10 family devices.

APPENDIX B: MIGRATION
BETWEEN HIGH-END

DEVICE FAMILIES

Devices in the PIC18F45J10 family and PIC18F4520 families are very similar in their functions and feature sets. However, there are some potentially important differences which should be considered when migrating an application across device families to achieve a new design goal. These are summarized in Table B-1. The areas of difference which could be a major impact on migration are discussed in greater detail later in this section.

TABLE B-1: NOTABLE DIFFERENCES BETWEEN PIC18F4520 AND PIC18FXXXX FAMILIES

Characteristic	PIC18FXXXX Family	PIC18F4520 Family
Operating Frequency	40 MHz @ 2.15V	40 MHz @ 4.2V
Supply Voltage	2.0V-3.6V	2.0V-5.5V
Operating Current	Low	Lower
Program Memory Endurance	1,000 write/erase cycles (typical)	100,000 write/erase cycles (typical)
I/O Sink/Source at 25 mA	PORTB and PORTC only	All ports
Input Voltage Tolerance on I/O pins	5.5V on digital only pins	VDD on all I/O pins
I/O	32	36
Pull-ups	PORTB	PORTB
Oscillator Options	Limited options (EC, HS, fixed 32 kHz INTRC)	More options (EC, HS, XT, LP, RC, PLL, flexible INTRC)
Program Memory Retention	10 years (minimum)	40 years (minimum)
Programming Time (Normalized)	156 μs/byte (10 ms/64-byte block)	15.6 μs/byte (1 ms/64-byte block)
Programming Entry	Low Voltage, Key Sequence	VPP and LVP
Code Protection	Single block, all or nothing	Multiple code protection blocks
Configuration Words	Stored in last 4 words of Program Memory space	Stored in Configuration Space, starting at 300000h
Start-up Time from Sleep	200 μs (typical)	10 μs (typical)
Power-up Timer	Always on	Configurable
Data EEPROM	Not available	Available
BOR	Simple BOR ⁽¹⁾	Programmable BOR
LVD	Not available	Available
A/D Calibration	Required	Not required
In-Circuit Emulation	Not available	Available
TMR3	Not available	Available
Second MSSP	Available ⁽²⁾	Not available

Note 1: BOR is not available on PIC18LFXXJ10 devices.

2: Available on 40/44-pin devices only.

B.1 Power Requirement Differences

The most significant difference between the PIC18F45J10 family and PIC18F4520 device families is the power requirements. PIC18F45J10 family devices are designed on a smaller process; this results in lower maximum voltage and higher leakage current.

The operating voltage range for PIC18F45J10 family devices is 2.0V to 3.6V. One of the VDD pins is separated for the core logic supply (VDDCORE). This pin has specific voltage and capacitor requirements as described in **Section 23.0** "Electrical Characteristics".

The current specifications for PIC18F45J10 family devices are yet to be determined.

B.2 Pin Differences

There are several differences in the pinouts between the PIC18F45J10 family and the PIC18F4520 families:

- · Input voltage tolerance
- Output current capabilities
- Available I/O

Pins on the PIC18F45J10 family that have digital only input capability will tolerate voltages up to 5.5V and are thus tolerant to voltages above VDD. Table 9-1 in **Section 9.0 "I/O Ports"** contains the complete list.

In addition to input differences, there are output differences as well. Not all I/O pins can source or sink equal levels of current. Only PORTB and PORTC support the 25 mA source/sink capability that is supported by all output pins on the PIC18F4520. Table 9-2 in **Section 9.0 "I/O Ports"** contains the complete list of output capabilities.

There are additional differences in how some pin functions are implemented on PIC18F45J10 family devices. First, the OSC1/OSC2 oscillator pins are strictly dedicated to the external oscillator function; there is no option to re-allocate these pins to I/O (RA6 or RA7) as on PIC18F4520 devices. Second, the MCLR pin is dedicated only to MCLR and cannot be configured as an input (RE3). Finally, RA4 does not exist on PIC18F45J10 family devices.

All of these pin differences (including power pin differences) should be accounted for when making a conversion between PIC18F4520 and PIC18F45J10 family devices.

B.3 Oscillator Differences

PIC18F4520 family devices have a greater range of oscillator options than PIC18F45J10 family devices. The latter family is limited primarily to operating modes that support HS and EC oscillators.

In addition, the PIC18F45J10 family has an internal RC oscillator with only a fixed 32 kHz output. The higher frequency RC modes of the PIC18F4520 family are not available.

B.4 Peripherals

The PIC18F45J10 family is able to operate at 40 MHz down to 2.15 volts unlike the PIC18F4520 family where 40 MHz operation is limited to 4.2 +V applications.

Peripherals must also be considered when making a conversion between the PIC18F45J10 family and the PIC18F4520 families:

- Data EEPROM: PIC18F45J10 family devices do not have this module.
- BOR: PIC18F45J10 family devices do not have a programmable BOR. Simple brown-out capability is provided through the use of the internal voltage regulator (not available in PIC18LFXXJ10 devices).
- LVD: PIC18F45J10 family devices do not have this module.
- Timer3 (TMR3) has been removed from the PIC18F45J10 family.
- The T0CKI/C1OUT pins have been moved from RA4 to RB5.
- The 40/44-pin devices in the PIC18F45J10 family have a second MSSP module available on pins RD0:RD3

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Device	Temperature Package Pattern Range	a) PIC18LF45J10-I/P 301 = Industrial temp., PDIP package, Extended VDD limits, QTP pattern #301. b) PIC18LF24J10-I/SO = Industrial temp., SOIC
Device	PIC18F24J10/25J10 ⁽¹⁾ , PIC18F44J10/45J10 ⁽¹⁾ , PIC18F24J10/25J10T ⁽²⁾ , PIC18F44J10/45J10T ⁽²⁾ ; VDD range 4.2V to 5.5V PIC18LF24J10/25J10 ⁽¹⁾ , PIC18LF44J10/45J10T ⁽¹⁾ , PIC18LF24J10/25J10T ⁽²⁾ , PIC18LF44J10/45J10T ⁽²⁾ ; VDD range 2.0V to 5.5V	package, Extended VDD limits. c) PIC18LF44J10-I/P = Industrial temp., PDIP package, normal VDD limits.
Temperature Range	I = -40°C to +85°C (Industrial) E = -40°C to +125°C (Extended)	
Package	PT = TQFP (Thin Quad Flatpack) SO = SOIC SP = Skinny Plastic DIP P = PDIP ML = QFN	Note 1: F = Standard Voltage Range LF = Wide Voltage Range 2: T = in tape and reel TQFP packages only.
Pattern	QTP, SQTP, Code or Special Requirements (blank otherwise)	



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